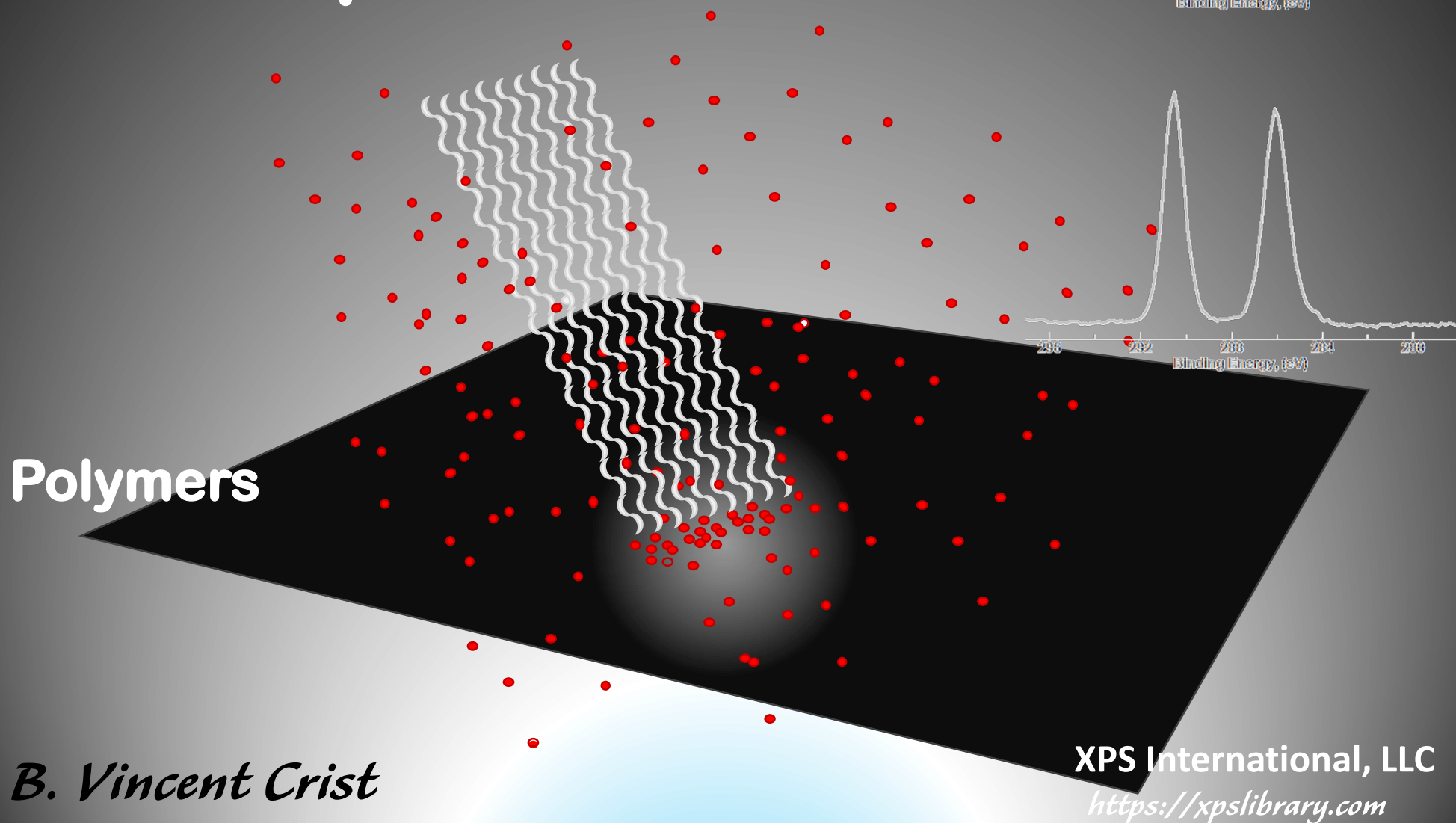


Monochromatic XPS Spectra



B. Vincent Crist

XPS International, LLC
<https://xpslibrary.com>

Handbooks of Monochromatic XPS Spectra

Volume 4 – *Polymers*

B. Vincent Crist, Ph.D.

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Published by XPS International, LLC
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APPENDIX "A"

ALPHABETICAL LIST OF XPS SPECTRA IN VOLUME FOUR

POLYMERS & POLYMERS DAMAGED BY X-RAYS

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INTRODUCTION

This handbook contains wide scan spectra, narrow scan spectra, and some valence band spectra from pure polymers and pure co-polymers. The polymer powders used for the X-ray Damage Study were 99% pure as sold by the Scientific Polymer Products Company. The polymers are non-conductive. As a result the BEs in some of the spectra will be lower than expected due to charge shifting caused by flooding the sample with a low energy beam of electrons (1-10 eV). The correct BE for these samples depends on which reference energy the user prefers to use. We at XPS International prefer to assign the C (1s) BE of the hydrocarbon component to be 285.0 eV and to use this BE value as our means of charge referencing all the other signals generated by that binary oxide that was found to be non-conductive during analysis by XPS. Please refer to section "F" (Energy Scale Reference Energies and Calibration Details) for more details about calibration.

Volume 4 – Polymers and Polymers Damaged by Long Term Exposure to Monochromatic X-rays

Section 1 - Polymers from the National ESCA and Surface Analysis Center for Biomedical Problems (NESAC/BIO) at the University of Washington:

Includes wide scan spectra, high energy resolution carbon (1s) spectra, high energy resolution oxygen (1s) spectra, and other principal signal high energy resolution spectra (i.e. N (1s), F (1s), Cl (2p) S (2p), or others) known as: poly-ethylene (PE), poly-vinyl chloride (PVC), poly-vinylidene di-fluoride (PVDF), poly-tetrafluoroethylene (PTFE), poly-styrene (PS), poly- α -methyl styrene (AMPS), poly-4-methyl styrene (4MPS), poly-4-octylstyrene (POS), poly-4-hydroxystyrene (PHS), poly-4-hydroxystyrene-derivatized with trifluoro acetic anhydride, poly-4-ethoxystyrene (PES), poly-4,4'-dimethoxy benzophenone (4DBP), poly-ether ether ketone (PEEK), poly-ethylene terephthalate (PET), poly-ethyl acrylate (PEA), poly-methyl acrylate (PMA), poly-methyl methacrylate (PMMA) on copper, poly-ethyl methacrylate (EMA), poly-2-hydroxyl methacrylate (HEMA), poly-trimethyl silane hydroxyethyl methacrylate (CLMA), poly-ethylene glycol (PEG), poly-propylene glycol (PPG), poly-tetramethylene glycol (PTMG), poly-vinyl alcohol (PVA), Biomer™, poly-methylene di-isocyanate/propane-diamine copolymer (MDPD), poly-methylene diisocyanate/butane-diol copolymer (MDBD), poly-methylene diisocyanate/propane-diamine/butane-diol terpolymer (MDBP), poly-dimethyl siloxane (PDMS) and Whatman™ filter paper (cellulose)

Section 2 - Polymers Damaged by Long Term Exposure to Monochromatic X-rays:

Includes wide scan spectra, and >15 repetitive cycles of high energy resolution carbon (1s) spectra, high energy resolution oxygen (1s) spectra, other principal signal high energy resolution spectra (i.e. N (1s), F (1s), Cl (2p) S (2p), or others) known as: poly-acetal, poly-acrylonitrile (PAN), poly-amide, poly-1-butene, poly-caprolactam (nylon 6), poly-carbonate bis-phenol A (PC), poly-ethylene (HDPE), poly-ethylene oxide (PEO), poly-ethylene terephthalate (PET), poly-imide (Kapton), poly-methylmethacrylate (PMMA), poly-4-methyl-1-pentene, poly-phenylene sulfide (PPS), poly-propylene (PP), poly-styrene (PS), poly-sulfone resin, poly-tetrafluoroethylene (PTFE), poly-vinyl acetate (PVA), poly-vinyl chloride (PVC), poly-vinylidene fluoride, and nitrocellulose. Each sample was analyzed overnight for >12 hours to observe the X-ray induced changes that occur from extended exposure to X-rays.

ORGANIZATION AND DETAILS OF SPECTRAL SETS

Organization of Spectra

A set of spectra for a particular chemical is located by looking for the chemical formula abbreviation written in the upper right hand corner of each page. For the binary oxide called “aluminium oxide” the user will find the chemical abbreviation “Al₂O₃” in the upper right corner of the pages that belong to that set of data and spectra. The spectra are organized by using the chemical abbreviation. This means that “Antimony Oxide” spectra will be found by looking for the chemical formula: “Sb₂O₃”.

Contents of Each Set of Spectra

The spectra are presented exactly as printed by the Spectral Data Processor software provided in each XI SpecMaster Data-Base system. The first page of a set includes the “Detailed Surface Composition Table” which reports the peak assignments, binding energies, relative sensitivity factors, and Atom % abundance of each major signal contained in the wide scan survey spectrum for that chemical. In the title line of this first page the user will find the full chemical name along with other basic information about the chemical, such as Formula Weight, Chemical Abstract Services number, common name, and a few key words about the analysis conditions.

The second page of each set is the wide scan survey spectrum with information about the experimental conditions used to collect the spectrum, the history of the sample, the source of the sample if known, and peak labels. Detailed information about the operating capabilities of the SSI systems and the instrument and analysis conditions used to collect these data are presented in the next section of this book.

The remaining pages of each set are the high energy resolution narrow scan spectra which were obtained by measuring the strongest signals found in the wide scan survey spectrum. These spectra normally contained detailed peak-fit results in a table and display the actual peak-fit results for each spectrum. The binding energies of insulating materials are reported without any charge correction because there is currently no standard method or standard reference energy for charge referencing spectra from insulating materials. The FWHM values for each peak of a high energy resolution spectrum is adjacent to the binding energy for that peak. The percentage numbers given for each peak is a relative percentage that is based on the intensity of that signal only (It is not an atom % value).

In this edition the spectra do not have labels which identify the XPS signal so the reader needs to refer to the energy range to determine which signal has been reported. In many cases valence band region spectra, Auger signal spectra, and spectra from weaker XPS signals are also included, but only for materials which were expected to be commercially pure.

Philosophy of Data Collection Methods

Our philosophy is to collect spectra under analysis conditions that are practical, readily reproduced, and typically used in laboratories that use monochromatic X-ray sources and work under real world practical analysis conditions. We have assumed that the most XPS laboratories need practical reference spectra and will not spend the time or money to produce and to analyze pure, clean surfaces under ultimate energy resolution

conditions. However, we did spend extra time to collect data with above average signal to noise (S/N) ratios which reveal the presence of minor components that might otherwise be missed. In the production of these spectra we did not attempt to produce clean surfaces which would make charge referencing of insulators a difficult task. For practical reasons we used the C (1s) spectra from the naturally formed layer of adventitious hydrocarbons because that signal is the “de facto” standard for charge referencing insulating materials.

The spectral data contained within these handbooks are designed to assist engineers, scientists, analysts, theoreticians, and teachers who use XPS on an everyday basis under practical working conditions. We believe that these spectra will help XPS users to analyze industrial problems, gather reference data, perform basic research, test theories, and teach others. Our spectra are designed to be practical tools for everyday use and were obtained under practical working conditions. We have not actually attempted to produce research grade spectra, but we have, in fact, produced research grade spectra because of our self-consistent methods.

In the production of these spectra no attempt to produce a pure, clean surface, but an effort was made to produce surfaces with a minimum amount of natural surface contamination. When ion etching was used to clean a material that contained more than one element, then ion etching was done with conditions that should minimize preferential sputtering.

Peak-Fitting (Curve-Fitting) of High Energy Resolution Spectra

Peak-fitting was performed by using the software provided with the Surface Science Instruments XPS system. This software allows the user to control full width at half maxima (FWHM) value of any peak, the binding energy (BE) of any peak, peak areas, the ratio of two peak areas, the energy difference between two peak maxima, the shape of a peak as a sum-function of Gaussian and Lorentzian peak shapes in any peak, and the percentage of asymmetry in any peak..

By empirically peak-fitting the spectra from large sets of closely related materials in a trial and error method and analyzing the trends, it was possible to recognize several fundamental peak-shape and peak-fitting parameters for pure elements, binary oxides, polymers, and semiconductors. We used those empirical results to guide our efforts to peak-fit many of the spectra which had complicated peak shapes. In some cases we used the theoretical ratio of spin-orbit coupled signals to assist the peak-fitting of many spectra and also the energy interval between spin-orbit couple signals which were derived from pure element spectra. No attempt was made to fit the spectra in accordance with theoretical expectations or calculations.

The reduced “chi-squared” value, which indicates the goodness of a peak-fit, was used to determine if a peak-fit was reasonable or not. Based on practical experience a “chi-squared” value between 1 and 2 implies a relatively good peak-fit. A “chi-squared” value between 2 and 4 implies that the fit has not yet been optimized. A “chi-squared” value larger than 4 implies that one or more signals may be missing from the peak-fit effort.

A Shirley-type baseline was used for most peak-fits. Peak shapes for the main XPS signals from chemical compounds (e.g. oxides or polymers,) were typically optimized by using a Gaussian:Lorentzian ratio between 80:20 and 90:10. For pure metals Gaussian:Lorentzian ratio for the main XPS signals was normally between 50:50 and 70:30. For the main XPS signals from semi-conductor materials, the Gaussian:Lorentzian ratio was usually between 70:30 and 80:20.

From the peak-fitting of the binary oxides, we have observed that FWHM for the C (1s), O (1s) and the main metal signal from the binary oxide are usually in range 1.0-1.4 eV. This trend helped us to decide if we had good charge compensation.

Charge Compensation of Insulating Materials

Charge compensation of insulating materials was normally handled by using the patented SSI mesh-screen together with a low voltage flood gun of electrons which used an acceleration voltage that was adjusted to 2-4 eV for optimum results. The mesh-screen device uses a 90% transmission electro-formed mesh made of nickel metal that is supported above the surface of the sample by mounting the mesh on a conductive metal frame that is grounded to the sample mount. To achieve good charge compensation the mesh-screen is positioned so that the distance between the mesh and the surface of the sample is between 0.5 - 1.0 mm. When the distance between the mesh-screen and the surface of the sample is greater than 1.2 mm, the usefulness of the mesh screen flood gun system was null.

The mesh-screen is understood to function as a electron cut-off lense with some tendency to allow incoming flood gun electrons to focus on the area being irradiated with monochromatic X-ray beam because the X-ray beam does not have a uniform flux density of the area of the beam. In effect, the mesh-screen produces a nearly uniform electric potential at the surface of the sample and allows incoming flood-gun electrons to pass through whenever they are needed.

The mesh-screen was used on every insulating material except for a few materials that were analyzed before the mesh-screen method was developed.

Abbreviations Used

Due to the limited space provided to describe each sample in each electronic data-file, it was necessary to use various abbreviations. The abbreviations are:

scr = screen used for charge compensation
scrn = screen used for charge compensation
TOA = take-off-angle for the electrons
Aldr = Aldrich Chemical Co.
RMC = Rare Metalics Co.
SPP = Scientific Polymer Products Co.
MS Co. = Metal Samples Company
FG = flood gun,

lmm = 1 mm height used for the mesh-screen,
semi-con = semi-conductive behavior
conduc. = conductive behavior
Tech = technical grade purity,
Tech = technical grade purity,
pellet = sample pressed into pellet form by pellet press used
pel = pellet
plt = pellet

INSTRUMENT AND ANALYSIS DETAILS USED TO MAKE XPS SPECTRA

A. Instrument Details

Manufacturer:	Surface Science Instruments (SSI)
Model:	X-Probe
	S-Probe (upgraded from M-Probe model 2703)
Software Version:	1.36.05 (Compiled in MS-DOS "C" version 6.0)
Analyzer Type:	Fixed Analyzer Transmission (FAT)
	Fixed (Constant) Pass Energy = Constant Analyser Energy (CAE)
	180° Hemi-spherical (truncated)
Input Lens Field of View:	30° for sample normal to lens axis (1" diameter port)
	(always larger than X-ray beam; retarding potential scanned)
X-ray Type:	Al ^o monochromatic (one 2 " diameter thin natural SiO ₂ crystal wafer glued onto Zerodur substrate heated to 65° C)
X-ray kV and mA Emission:	10 KV, 1.5-22.0 mA (depending on spot size used)
X-ray Energy Defined as:	1486.7 eV (8.3393 Å), Bragg Angle=78.5°
Excitation Source Window:	0.6 μ aluminum in S-Probe (10μ mylar in X-Probe)
Angle of X-ray Incidence:	$\alpha = 71^\circ$ (relative to sample normal)
Electron Emission Angle:	$\beta = 0^\circ$ (relative to sample normal)
Angle Between X-ray Axis and Electron Analyzer Axis:	$\phi = 71^\circ$ (fixed, non-variable)
Pass Energy of Analyzer:	150 V for Resolution 4 setting
	100 V for Resolution 3 setting
	50 V for Resolution 2 setting
	25 V for Resolution 1 setting
Type & Size of Input Slit:	Fixed (2 mm X 35 mm); magnetic compression
Type & Size of Output Slit:	None (dispersion limited by hemisphere voltages)
Electron Collection Lens Field of View:	~ 1 mm ² for $b = 0^\circ$ at 1000 eV KE
Electron Collection Lens Efficiency:	7% over 2π steradians
Sample Surface to Tip of Electron Collection Lens Distance:	~33 mm
X-ray Crystal to Sample Surface Distance:	~190 mm
X-ray Crystal to X-ray Anode Distance:	~190 mm

True Background Count of Noise:	<10 electrons/second at -50 eV (shot noise limited)
Detector Type:	SSI Position Sensitive Detector, resistive anode, 40 mm X 40 mm electronically defined as 128 active channels with max ct rate 1,000,000
Dead Time:	normally zero (unless ion etching pure element while collecting XPS data)
Base Pressure:	$4. \times 10^{-10}$ torr
Normal Operating Pressure:	1.6×10^{-9} torr
FWHM of X-rays Diffracted by natural SiO ₂ :	~0.25 eV
Power Settings:	200 Watts in a 250 x 1100 μ X-ray beam 100 Watts in a 150 x 800 μ X-ray beam 45 Watts in a 80 x 350 μ X-ray beam 15 Watts in a 40 x 250 μ X-ray Beam
X-ray Induced Current:	1.1×10^{-9} amps for a 600 μ spot in X-Probe
Converted from amps to watts	
Approximate True X-ray Power :	$\sim 6 \times 10^{-6}$ W in a 600 μ spot
Approximate True X-ray Irradiance:	~ 8 W/m ²
Approximate True X-ray Photon Flux:	$\sim 7 \times 10^9$ photons/sec

B. Experimental Details

Electron Take-Off-Angle:	90° relative to sample surface (unless otherwise reported)
Pass Energies Used:	Wide scans were done at PE = 150 eV Narrow scans were normally done at PE = 50 eV Valence band scans were done at PE=150 eV
X-ray Beam Size Used: (for S-Probe)	Wide scans: 250 x 1500 μ ellipse (at 90° TOA) 250 x 1100 μ ellipse (at 35° TOA) Narrow Scans: 250 x 1500 μ ellipse (at 90° TOA) 150 x 1000 μ ellipse (at 90° TOA)
SSI Mesh-Screen:	A 90% transmission (20 μ diameter wire with 200 μ spacing) nickel metal mesh screen was adhered to a small 25 mm x 25 mm x 1.5 mm (W x L x H) aluminum plate over a 20 mm x 20 mm aperture. This mesh-screen was placed over all oxide samples so that the distance between the sample surface and the mesh-screen was <1.0 mm but >0.3 mm.
Dwell Time (counting time):	200 milliseconds/channel (usual setting)
Data Transfer Time:	4 milliseconds
Max. Number of Channels:	5000 (channels = data points)
Scan Time for One Wide Scan:	~ 3.5 minutes (using 1024 data points)
Scan Time for One Narrow Scan:	~100 seconds (using 256 data points)

Energy Range:	-100 to +1400 eV (BE range)
Typical Step Size:	0.1 eV/step (i.e. 0.1 eV/data point)

C. Data Processing Details

Baseline Subtraction:	None, unless S/BG gave a small display. When the baseline was removed, the intensity of the lowest point was subtracted from all points.
Data Smoothing:	None
Energy Shifting:	None
Intensity Scaling:	None

D. Sample Details

The "Description" given on each XPS spectrum reports the empirical elemental formula for the oxide, purity, source, production lot number, a note, if appropriate, about being conductive or semi-conductive, the abbreviation "scrn" which means that the SSI mesh-screen was used, and a number, e.g. 90 which reports the electron take-off-angle used to collect the data for that sample. Abbreviations used in the description and their full meaning include: Aldr = Aldrich Chemical Co., RMC = Rare Metallics Co., semi-con = semi-conductive behavior, scrn = SSI mesh-screen used, TOA = electron Take-Off-Angle, Tech = technical grade purity, pellet = sample pressed into pellet form, plt = pellet, pel = pellet, MS Co. = Metal Samples Company in Munford, Alabama USA (Tel 205-358-4202), SPP = Scientific Polymer Products Inc. in Ontario, New York state, USA (Tel 716-265-0413)

Sources of Elements and Chemical Compounds Used for Element Series

The pure element samples were obtained from various sources without any specific information about sample purity so pure element samples must be assumed to be pure at the 99% level. The "halide" salts used to produce spectra from gaseous or highly reactive elements were also obtained from various sources. These halide samples were obtained as crystalline "windows" which are normally used in Infrared spectroscopy and have purities at the 99% level. The Boron Nitride (BN) sample was a white ceramic standoff which was fractured in air. The copper foil material, which was always used to determine reference energies, were obtained as 99% pure foil which was designed as a multiple purpose foil for use around the home. The gold ingot material, which was also used to determine reference energies was obtained as a 99.999% pure sample from Aldrich Chem. Co..

Source of Polymer Materials

A special kit (#205) of the 100 polymer materials was obtained from Scientific Polymer Products, Inc. which is located at 6265 Dean Parkway, Ontario, New York, USA 13519 (Tel 716-265-0413).

Source of Alloys

A special kit of 54 metallic alloys was obtained from the Metal Samples Co., which is located at Route #1, Box 152, Munford, Alabama, USA, 36268 (Tel 205-358-4202). This kit includes a materials analysis report on each alloy in weight percents. The National Research Institute for Metals in Tsukuba Japan has provided a series of various binary alloys made of AuCu and CoNi alloys.

Sources of Semi-Conductor Materials

Over the course of many years, many people in the Japanese semi-conductor business have given samples of various semi-conductor materials in crystalline wafer form. Various samples were donated by the Oki Electric Company, Mitsubishi Materials, Canon, and various universities. The source of each material is included with the individual sample descriptions whenever that information was provided.

Sources of Binary Oxide Samples

Most of the commercially pure binary oxides were purchased from the Aldrich Chem. Co.. Many packages from the Aldrich Chemical Co. included an "Analytical Information" sheet which described an ICP or AA analysis summary, a production lot number, the Aldrich product number, sample purity number (e.g. 99+%), sample appearance (color and physical form), date of chemical analysis, formula weight and a label on the bottle that reports the melting point, toxicity, Chemical Abstracts registry number and density. The samples from Aldrich were generally quite pure at the surface. Other oxide samples were obtained from either Cerac Inc. (USA) or Rare Metallics Co., Ltd. (Japan). The packages from Cerac Inc. included a "Certificate of Analysis" with an ICP or AA analysis summary, a production lot number, a product number, purity (e.g. 99+%), and mesh size. The packages from Rare Metallics Co. did not include analytical data reports, but instead had stock numbers and a purity statement. Two samples (i.e. SiO₂ natural crystal and Al₂O₃ fused plate) were obtained from in-house sources and do not have any purity reports.

Powdered Samples Pressed into 3mm Diameter Pellet

Until analyzed, all finely powdered samples were kept stored in their original glass or plastic containers, which were packaged inside of plastic-lined aluminum bags. Just prior to XPS analysis, each bottle was opened in the normal air of the room where the XPS system was kept, and a small 50-100 mg portion of the sample was removed via a clean nichrome spatula and placed in the compression chamber of a hand-operated, stainless steel pellet press. All finely powdered samples were compressed without any chemical treatments, which, if done, may have introduced unusual contamination or produced some change in the samples. The resulting pellets varied in thickness from 0.3 - 0.8 mm. To avoid iron and /or chromium contamination from the anvil, a thin sheet of paper was placed over the sample in the compression chamber. Any powders, which were clumped together, were very gently pressed into a powder just prior to compression. To avoid unnecessary heat-

induced oxidation, those samples which were hard and granular were very gently ground into a fine powder in a agate marble mortar and pestle. As soon as each sample was removed from the compression chamber, it was mounted onto silver (Ag°) paint inside of a 5mm wide round brass boat which was 1.3 mm in height. Silver paint was used so that conductive oxides could behave as true conductors thereby providing true electron binding energies for those oxides that were indeed conductive. In general, each oxide was exposed to room air for <15 min..

Benefits of Pressing Powders into Pellets (increased counts and simple charge control)

A comparison of the electron counts obtained from powdered samples pressed onto double-sided adhesive tape and positioned at a 35° electron take-off-angle with the electron counts obtained from hand-pressed glossy or semi-glossy pellets positioned at a 90° electron take-off-angle (TOA) revealed that a pellet at a 90° electron TOA produces 3-5 times higher electron counts than a powdered sample pressed onto double-sided tape at a 35° electron TOA.

By pressing the finely powdered oxides into pellets, it was also found the surface charging behavior of these glossy or semi-glossy samples was very easy to control by using the mesh-screen electron flood-gun combination with the flood gun set to 4-6 eV acceleration energy and approximately 0.5 mA filament current.

Problems Caused by Pressing Samples into Pellets

By pressing the finely powdered oxides into pellets, the surface of the resulting samples were usually smooth enough to appear glossy or semi-glossy, but some samples had iron or chromium contamination which indicated that the oxide had undergone a pressure induced reaction with the stainless steel anvil. Very strong hand pressure caused some oxides to react with the stainless steel anvil, but medium hand pressure usually did not produce undesired iron and chromium contamination. All analyses that showed any unexpected contamination were repeated. Other forms of accidental contamination (chlorine or previously analyzed oxides) were caused by insufficient cleaning of the stainless steel anvil, which was normally cleaned with a metal polishing solution (Pikal) and rinsed with distilled water and isopropanol. All analyses that showed any unexpected contamination were repeated.

Solution to Pressure Induced Contamination of Pellets

Experiments on ways to avoid the pressure-induced iron or chromium contamination, produced pellets with semi-smooth non-glossy surfaces which required more effort to produce good charge control. These non-glossy surfaces also gave electron count rates that were about 10-50% lower than the glossy or semi-glossy surfaces. As a result, it appears that very smooth surfaces, which appear glossy or semi-glossy, greatly simplify efforts to control surface charging under the charge-control mesh-screen and also enhance the electron count rate by 10-50% more than a pellet that has a semi-rough non-glossy appearance.

Extensive experiments on different methods to avoid contamination of the pellets revealed that contamination is minimized or avoided by using freshly cleaned aluminum foil as a "buffer" between the oxide powders and the metals in the steel anvil components. The aluminum foil, which is sold as a kitchen wrap material, is cleaned with 100% isopropanol (isopropyl alcohol) just prior to use. The foil is cut to a size that is readily useful with the pellet press device after it is cleaned. Alternately, we have also used a type of "glycine" paper which is commonly used to as a paper to hold powders when weighing a powdered sample. This "weighing" paper is common in many chemical laboratories and can be substituted for the aluminum foil whenever the pressing results with the aluminum foil produce undesired binding results. The glycine paper method sometimes introduces very small amounts of contaminants which produce a N (1s) and C (1s) signals. The amount of these contaminants is much smaller than the amount of contaminants that occur by simply pressing the powder without any sort of paper or aluminum foil buffers.

Source of Pellet Press Equipment

"Qwik Handi-Press" from Barnes Analytical Division, Spectra-Tech, Inc. 652 Glenbrook Road, Stamford, Connecticut, 06906 (FAX 203-357-0609) Kit: Part # 0016-111 to 0016-121 contains 1,3, and 7 mm die sets. Originally purchased through Aldrich Chem. Co. in 1989.

E. Energy Resolution Details

Table 1: Experimentally Observed Relation Between Energy Resolution (FWHM) and Resolution Variables

Element (XPS signal)	Resulting FWHM	Resolution Setting	Pass Energy	X-ray Spot Size
Si (2p _{3/2}) crystal - fractured edge	0.38 eV	5	10 eV	40 x 250μ
Si (2p _{3/2}) crystal - fractured edge	0.43 eV	1	25 eV	80 x 350μ
Au (4f _{7/2}) foil - ion etched clean	0.64 eV	5	10 eV	250 x 1000μ
Au (4f _{7/2}) foil - ion etched clean	0.79 eV	1	25 eV	250 x 1000μ
Au (4f _{7/2}) foil - ion etched clean	0.86 eV	2	50 eV	250 x 1000μ
Au (4f _{7/2}) foil - ion etched clean	1.40 eV	4	150 eV	250 x 1000μ
Ag (3d _{5/2}) foil - ion etched clean	0.42 eV	5	10 eV	40 x 250μ
Ag (3d _{5/2}) foil - ion etched clean	0.64 eV	1	25 eV	40 x 250μ
Ag (3d _{5/2}) foil - ion etched clean	0.75 eV	2	50 eV	40 x 250μ
Ag (3d _{5/2}) foil - ion etched clean	1.00 eV	3	100 eV	40 x 250μ
Ag (3d _{5/2}) foil - ion etched clean	1.30 eV	4	150 eV	40 x 250μ
Cu (2p _{3/2}) foil - ion etched clean	0.85 eV	5	10 eV	250 x 1000μ
Cu (2p _{3/2}) foil - ion etched clean	0.94 eV	1	25 eV	250 x 1000μ
Cu (2p _{3/2}) foil - ion etched clean	1.06 eV	2	50 eV	250 x 1000μ
Cu (2p _{3/2}) foil - ion etched clean	1.60 eV	4	150 eV	250 x 1000μ
Cu (2p _{3/2}) foil - ion etched clean	0.85 eV	5	10 eV	150 x 800μ
Cu (2p _{3/2}) foil - ion etched clean	0.96 eV	1	25 eV	150 x 800μ
Cu (2p _{3/2}) foil - ion etched clean	1.05 eV	2	50 eV	150 x 800μ
Cu (3s) foil - ion etched clean	2.35 eV	2	50 eV	250 x 1000μ

Table 2: Theoretical Analyzer Resolution versus Pass Energy Settings

Theoretical Analyser Resolution	Pass Energy	Effective Detector Width
0.25 eV	25.0 eV	3.5 eV
0.50	50	7.0
1.00	100	14.0
1.50	150	21.0

F. Energy Scale Reference Energies and Calibration Details

From May 1986 to January 1993

Energy Scale Reference Energies: 932.47 eV for Cu (2p_{3/2}) signal
122.39 eV for Cu (3s) signal
83.96 eV for Au (4f_{7/2}) signal
Binding Energy Uncertainty: less than ±0.08 eV
Digital-to-Analog (DAC) Conversion Setting: 163.88

After January 1993

Energy Scale Reference Energies: 932.67 <±0.05 eV for Cu (2p_{3/2}) signal
122.45 <±0.05 eV for Cu (3s) signal
83.98 <±0.05 eV for Au (4f_{7/2}) signal
Observed Reference Energy: 75.01 <±0.05 eV for Cu (3p₃) signal
Binding Energy Uncertainty: less than ±0.08 eV
Digital-to-Analog (DAC) Conversion Setting: 163.87

Reference Energies of Adventitious Hydrocarbon Contaminants

From May 1986 to January 1993 the electron binding energy of adventitious hydrocarbons was assumed to occur at 284.6 eV based on SSI and C. D. Wagner's research and recommendations. Publications by P. Swift (Surface and Interface Analysis **4**, 47 (1982), S. Kohiki and K. Oki (J. Electron Spectrosc. Related Phenom. **33**, 375-380 (1984), and G. Barth, R. Linder and C. E. Bryson, III (Surface and Interface Analysis **11**, 307-311 (1988) have shown that the electron binding energy for various hydrocarbon contaminants and polymers is not necessarily a constant number. Research by this author indicates that the electron binding energy for adventitious hydrocarbons lies somewhere between 284.4 and 287.0 eV depending on the underlying oxide materials. By taking a simple average of all available binding energies, the author has found that 285.0 eV is preferred for

hydrocarbons on ion etched metals where the hydrocarbon is many hours old. For naturally-formed native oxides the preferred binding energy is 285.2 eV. Oxide based materials at the far left of the periodic element table (columns 1-4) tend to have higher values (285.2-287.0 eV, while most of the transition metal oxides center around 285.0 eV. Near the far right of the periodic table, the binding energy again rises to a 285.2-286.5 eV range (columns 12-14). In routine practice, this author prefers to use the 285.0 eV number. Some potential factors that may cause this rather large range of electron binding energies for adventitious hydrocarbon contamination includes the dipole moment at the surface of the oxide material, which is expected to be much stronger than the dipole moment of a pure metal, and also, in the case of naturally formed native oxide films, the thickness of the native oxide, any physical or chemical treatments, the thickness of the adventitious hydrocarbon layer, and the type of instrument used to analyze the sample. The type of instrument being used may cause different shifts in the observed binding energy of the adventitious hydrocarbon contamination because the source may or may not generate different amounts of low energy secondary electrons from the window that protects the X-ray source. The heat from the source and contamination that degases from a just turned on source may also influence the observed binding energy. Electron flood guns may or may not influence the binding energy as well.

Instrument Stability and Long Term Calibration

Initially each of the three SSI systems, that we have used, was calibrated 2-3 times per week because its ability to maintain accurate voltage settings was unknown. Once it was determined that the systems could maintain reliable voltage settings for 1-3 months, it was decided that good calibration could be maintained by checking and, if necessary, correcting the pass energies of the system on a 2-4 week basis. Each of the three SSI XPS instruments, that we have used, have been calibrated on a routine basis every 2-4 weeks by using SSI's reference energies. By using this method over several years time, it was found that the maximum uncertainty (error in pass energies) was normally $\leq \pm 0.10$ eV, but a few times rose to ± 0.15 eV or less. In a very rare case, the uncertainty rose to 0.20 eV. Long term use of the SSI systems has shown that the DAC circuit does not change enough to be observed unless the room temperature changes by more than 10 deg Centigrade. If the room temperature changes within a few hours time by more than 10 deg or the temperature of the DAC chip is changed by more than 10 deg, then a >0.1 eV shift, which is much smaller than the reliability of almost all literature BEs, can be observed. Variables, which seem to cause pass energy settings to change slightly, include building line-voltages, ion etching conditions, and the addition or removal of some electrical device.

G. Electron Counting and Instrument Response Function Details (for the X-Probe System only)

Instrument Response Functions

Instrument Response Function: $Q(E)=E^{+0.27}$ for 150 eV PE (ref.3)

Instrument Response Function: $Q(E)=E^{+1.0}$ for 50 eV PE (ref.3)

Signal/Background Ratios for Ion Etched Silver using a 250x1000 μ Spot*

Pass Energy	25 eV	50 eV	100 eV	150 eV
S/BG ratio**	>140	>110	>70	>50

* Using a 90° electron take-off-angle and a smooth Ag°/mylar film.

** The S/BG ratio is a simple numerical ratio of electrons counts at the peak maximum relative to the average electron counts observed at approximately 10 eV lower BE.

Lens Voltage Settings Available via Software under Instrument Calibration

Pass Energy*	29.6-29.8	54.7-54.9	105.1-105.3	155.9-156.2
Detector Widths	3.743	7.486	14.954	22.297
Sensitivity Exponent	0.7	1.1	1.3	1.5
V1 Offset	30	55	105	155
V1 Slope	0.600	0.611	0.676	0.709

* These pass energies include corrections for instrument work function. True pass energies were set to 25, 50, 100, and 150 eV ± 0.1 eV.

H. Effects of Poorly Focussing the Distance between the Sample and the Electron Lens

If the focus distance between the sample surface and the electron collection lens is poorly adjusted, then the number of electron counts drops very quickly. A 0.5mm error in focus produces a >300% decrease in counts, but does not produce any observable error in binding energies, which is a common problem with many other instruments. A 0.1mm error in focus produces a 15% decrease in peak area counts and is easily observed as a horizontal displacement in the static (un-scanned mode) XPS signal as observed on the standard CRT display of the detector response. Such a decrease in signal intensity generally causes the operator to correct the focus error so as to maximize the electron count rate. In this manner, the operator has avoided any chance of obtaining false BE readings and has accurately reproduced a nearly absolute focus point which greatly increases the quantitative accuracy of any unknown sample. Experiments with the Bragg angle alignment of the crystal indicated that the maximum error due to an unusual bad alignment of the crystal would be <0.1 eV. To observe an error greater than 0.1 eV, the electron counts were found to decrease by >50%.

I. Quantitation Details and Choice of "Sensitivity Exponents"

By default, the SSI software uses a 0.7 number as the sensitivity exponent factor for each pass energy setting which are used in an equation that modifies theoretically calculated atomic photo-ionization cross-sections (John H. Scofield) to generate relative sensitivity factors that are valid for this XPS systems and which can be used to generate valid atomic percentages. The 0.7 value produces a $\pm 10\%$ accuracy in quantitative results for XPS signals obtained by using a 150 eV pass energy and occur within the 0-700 eV BE range. For signals that occur at higher BEs, it is generally necessary to change the sensitivity exponent factor to a 1.1 or higher value. To measure signals obtained by using other pass energies for quantitation, it is necessary to use other sensitivity exponent factors, if the user desires to maximize quantitative accuracy. To determine useful sensitivity exponents, it is possible to use freshly ion etched poly-crystalline copper foil to test the validity of the sensitivity exponent for larger BE ranges and different pass energies. By integrating the peak areas of the Cu (2p₁), Cu (2p₃), Cu (3s), Cu (3p) and Cu (3d) signals with a modest amount of attention to baseline end points it is possible to perform trial and error choices of the sensitivity exponents until a useful number is determined. Once a useful number has been entered into the computer software routine, then the software can generate fictional atomic percentages for each of the integrated copper signals which will generate 20 atom % values with a uncertainty of $\pm 1-2$ atom %. If the exponent factor is severely wrong then the atomic percentages will generate numbers such as 10%, 11%, 26%, 24%, and 29% or perhaps 31%, 28%, 14%, 13%, and 14%. This trial-and-error approach may require 1-2 hours time and can be done on either wide scan data or more preferably narrow scan data for each of the 4-5 pass energies. This method, in effect, assumes that all five of the relative sensitivity factors for copper are reasonably correct. If wide scan data are used, this method requires a little extra effort to avoid the satellites associated with the Cu (2p) signals. This method, in effect, pretends that the pure copper sample is a standard material that is composed of 5 components which are present in 20 atomic % concentration. The objective is to change the sensitivity exponent until the software

generates a 20 atom % result for each of the five copper signals. After useful sensitivity exponents are found, they are tested by analyzing freshly exposed bulk regions of crystalline materials such as SiO₂, Al₂O₃, and NaCl.

The high and low BE signals of the NaCl crystal are especially useful to test the validity of the sensitivity exponents. As further checks, the freshly exposed bulk of common polymers (e.g. mylar or PMMA) or a thin film of high purity silicone oil can also be analyzed. Teflon has repeatedly given slightly larger than desirable error by comparison to the other materials listed above. For that reason Teflon is a less desirable material to test the sensitivity exponents.

J. Crude Tests of the Reliability of Relative Sensitivity Factors

Crude testing of Scofield's numbers are included in atomic percentage composition tables that give atomic percentages for only one element. This testing used the software's automatic peak area integration software that is reasonably accurate. The results indicate that some of the relative sensitivity factors for some of the weaker signals are less reliable. If, however, all factors are taken into account, then Scofield's numbers are reliable to a 95% accuracy level for truly homogeneous materials.

K. Traceability Details

The definition of traceability reported by Martin P. Seah and Cedric J. Powell in the J. Vac. Soc. Technol. Vol 8, p.736 (1990) publication is: "The property of a result of a measurement whereby it can be related to appropriate standards, generally international or national standards, through an unbroken chain of comparisons."

Traceability of Reference Binding Energies (Calibration)

At this time, there are no international standards for binding energies or reference energies. Numbers which are considered to be standard binding energies (BE), which would lead to traceability in BEs, include (a) those provided by Martin P. Seah at the National Physical Laboratory (NPL) in the United Kingdom (England), and (b) those provided by the ASTM in the USA "Standard Practice for Checking the Operating Characteristics of XPS Spectrometers" designated as "E 902-88". Other nations also have similar national standards, which tend to imitate those set by the USA and the UK. Recently, many people in the world have been using NPL's reference energies, which have become "de facto" standards but have not yet been accepted by the International Standards Organization (ISO). There are still many workers and researchers using various numbers provided by the instrument makers. The author of this book was using Surface Science Instruments (SSI) Co. reference energies until December 1992 and then switched to NPL BEs in January 1993. SSI reference energies came from Hewlett-Packard (HP). SSI and HP both used high precision voltage meters from HP to calibrate their ESCA machines (i.e. X, M, and S-Probe and HP-5950 A-type and B-type, resp.). Hewlett Packard was the first company to offer a commercial ESCA system, which used reference energies developed in cooperation with Kai Siegbahn at Uppsala, who effectively developed ESCA into a useful science and received the Nobel Prize. In a recent effort to improve the accuracy of BEs obtained from pure elements, the S-Probe pass energies were checked and corrected, if needed, almost every work-day for two months to obtain high precision and high accuracy BEs for the pure elements that are metals. This study used the NPL reference energies with Cu (2p_{3/2}) at 932.67 eV with ± 0.02 uncertainty and Au (4f_{7/2}) 83.98 eV with ± 0.02 uncertainty by using 0.02 eV/pt. steps for the calibrations. To determine the "true" BE of each of the pure elements, which were scraped clean in air and then ion etched in vacuum, a 0.05 eV/pt. step was used. A repetitive ion etching (depth profile) style was used to collect wide scan,

valence (Fermi edge) band, and narrow scans of the main signals for each metal at 50, 25 and 10 eV pass energies. Each repetitive experiment run lasted about 4 hours. Therefore, if NPL's BE numbers are accepted as "de facto" international standards, then the ultimate traceability of BEs in this data collection can be related to NPL BE numbers for Cu (2p₃) and Au (4f₇). In a different, but similar manner, the BEs used to calibrate the S-Probe are traceable to Siegbahn's work and HP's high precision, high voltage meters.

Traceability Transfer from Pure Metals to Non-conductive Binary Oxides

A question that should be posed is traceability to the oxide BEs. Traceability begins with NPL's BEs for pure copper and gold as state above. Traceability then transfers to pure element BEs which are based on NPL reference BEs. Traceability then transfers to pure element BEs based on SSI's reference BEs, and then the naturally formed native oxide data published in Volume 2 of our XPS Spectral Handbook series where BEs were measured from pure element signals and also the naturally formed native oxide signals. Naturally formed native oxides typically have thin oxide films (10-80Å) which, in general, behave as good or true electrical conductors, which allows a direct measure of the true binding energy of many, but not all, binary oxides. To determine if traceability can indeed be transferred to true binary oxides, it was necessary to study the behavior of the naturally formed native oxides by applying various flood gun settings with the samples grounded and insulated. The results from that study can be used to transfer traceability to the experimentally observed BEs of pure binary oxides. The most difficult transfer of traceability occurs for the naturally formed native oxide systems. If the flood gun study was not done, then it is difficult to transfer traceability in a reliable manner from a conductive metal to one of its corresponding non-conductive binary oxides.

Traceability of Instrument Response (Throughput) Function

Copper, gold and silver data obtained from the M-Probe system were submitted to Martin P. Seah at the NPL for a round robin test on transmission function; the results of which were published in Surface and Interface Analysis, p.243 (1993). In that publication, M-Probe data, which we contributed, were attributed to group #35. That paper reported that instrument has a $Q(E) = E^{0.27}$ for Rex 4 pass energy (PE=150 V) and a $Q(E) = E^{1.0}$ for the Res 2 pass energy (PE=50 V). If the NPL method is accepted as a "de-facto" standard, even though it is not an internationally recognized standard, then the transmission function and quantitation results of the S-Probe system are traceable to the "metrology spectrometer" at NPL.

Traceability of Relative Sensitivity Factors used for Quantitation

Scofield's theoretically calculated photo-ionization cross-sections are internationally used as the "de-facto" standard theoretical numbers, except in Russia and a few other places, where Band's numbers are preferred but are almost identical to Scofields. The SSI system uses a very simple equation that modifies Scofield's numbers to generate relative sensitivity factors that are used by the SSI software to calculate atom %. That equation corrects for pass energy differences, transmission function differences, and inelastic mean free path versus kinetic energy dependency. The SSI system relies on Scofield numbers and that simple equation. Other instrument makers prefer to blend Scofield's numbers and experimentally determined numbers.

Traceability of Sample Purity

The purity of the commercially pure (99+%) binary oxides can be traced to Aldrich's ICP or AA analyses performed by Aldrich. Copies of their results are included in the handbook at the beginning of each group of spectra. Similar data sheets were also obtained for samples bought from Cerac. A set of gold, copper, and silver samples, i.e. "Reference Metal Samples SCAA90" set, kit #367, was obtained from the NPL and used to test the instrument response function of the M-Probe system. Binding energies obtained from those gold, copper, and silver samples were identical to binding energies obtained from our commonplace gold, copper, and silver samples within the expected uncertainty of ± 0.08 eV used for routine instrument calibration.

L. Reference Papers Describing Capabilities of X-Probe, M-Probe, and S-Probe XPS systems

- | | |
|--|-------------------------|
| 1. Robert L. Chaney, <i>Surface and Interface Analysis</i> , 10 , 36-47 (1987) | [re: X-Probe] |
| 2. Noel H. Turner, <i>Surface and Interface Analysis</i> , 18 , 47-51 (1992) | [re: Quantitation] |
| 3. M. P. Seah, <i>Surface and Interface Analysis</i> , 20 , 243-266 (1993) | [re: Response Function] |
| 4. L.T. Weng et al, <i>Surface and Interface Analysis</i> , 20 , 179-192 (1993) | [re: Response Function] |
| 5. L.T. Weng et al, <i>Surface and Interface Analysis</i> , 20 , 193-205 (1993) | [re: Response Function] |
| 6. B. Vincent Crist, <i>Surface Science Spectra</i> , 1 , 292-296 (1993) | [re: KBr spectra] |
| 7. B. Vincent Crist, <i>Surface Science Spectra</i> , 1 , 376-380 (1993) | [re: Ar/C spectra] |

Spectra of Polymers

Polymers in NECSA/BIO Collection (at the University of Washington, USA)

HC Polymers

Poly-4-methyl styrene
Poly-8-octyl styrene
Poly-ethylene
Poly-styrene
Poly- α -methyl styrene

Acronym

4MPS
POS
PE
PS
AMPS

HCO Polymers

Poly-2-hydroxy ethyl methacrylate
Poly-4-ethoxy styrene
Poly-4-hydroxy styrene
Poly-ether ether ketone
Poly-ethyl acrylate
Poly-ethyl methacrylate
Poly-ethylene glycol
Poly-ethylene terephthalate
Poly-methyl acrylate
Poly-methyl methacrylate
Poly-propylene glycol
Poly-tetra-methylene glycol
Poly-vinyl alcohol

PHEMA
PES
PHS
PEEK
PEA
PEMA
PEG
PET
PMA
PMMA
PPG
PTMG
PVA

HCON Polymers

Biomer™
Methylene di-isocyanate/butane diol co-polymer
Methylene di-isocyanate/propane diamine co-polymer
Methylene di-isocyanate/propane diamine/butane diol ter-polymer

Acronym

HCX Polymers (X=Cl, F)

Poly-2-chloro ethyl methacrylate
Poly-tetra-fluoro ethylene
Poly-vinyl chloride
Poly-vinylidene di-fluoride

CLMA
PTFE
PVC
PVDF

Miscellaneous

Cellulose (filter paper)
4,4'-Di-methoxy benzophenone
Poly-4-hydroxy styrene -
tri-fluoro acetic anhydride derivative
Poly-di-methyl siloxane
Poly-hydroxy ethyl methacrylate -
tri-methyl silane derivative

4DBP
TFAA
PDMS
HTMS

X

Poly - α -Methyl Styrene (4% in toluene)

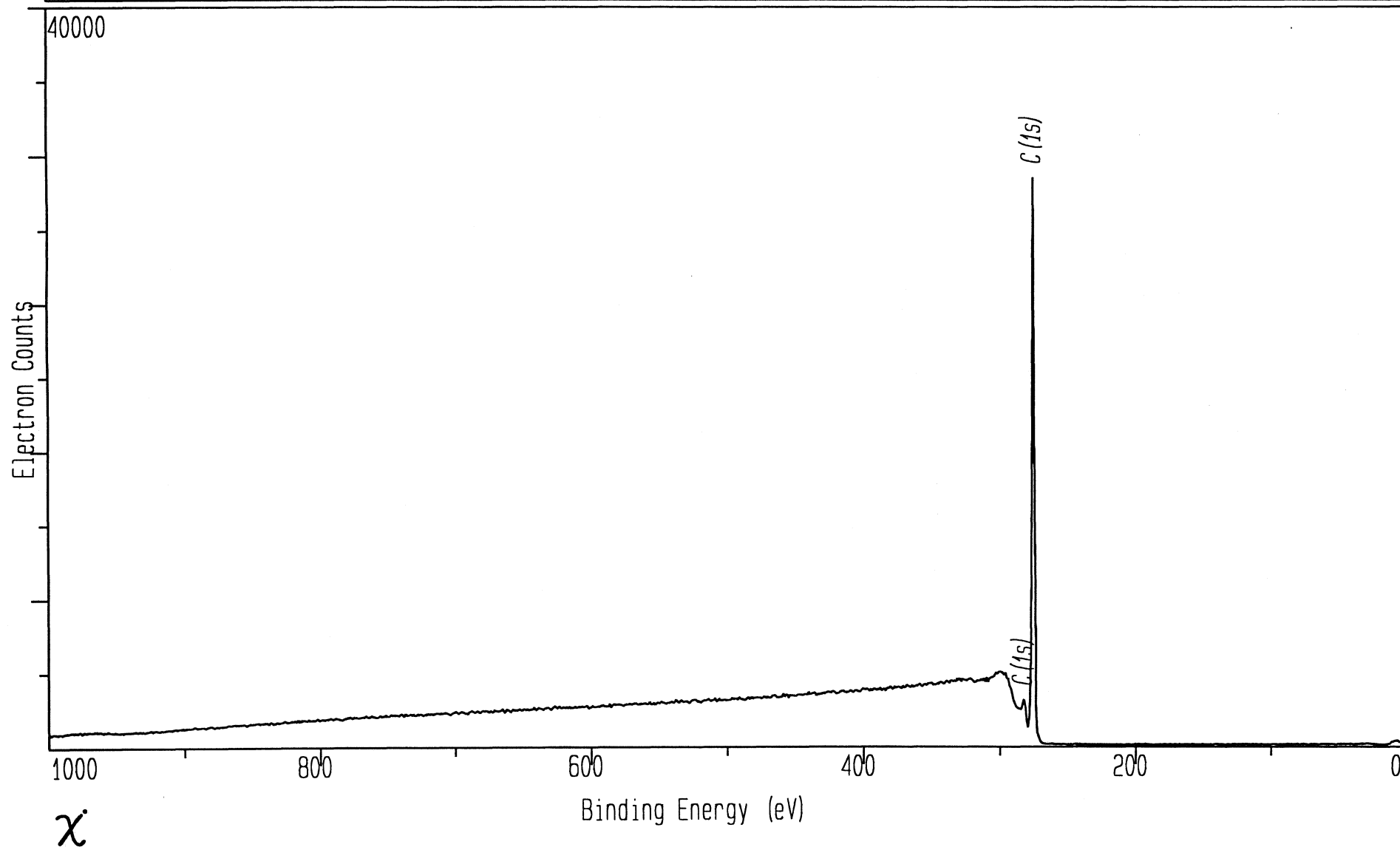
Detailed Surface Composition Table

File name: AMPS_SU.MRS
Region: 1
Description: Poly(alpha-methyl styrene), 4% IN TOLUENE, 4/11/88

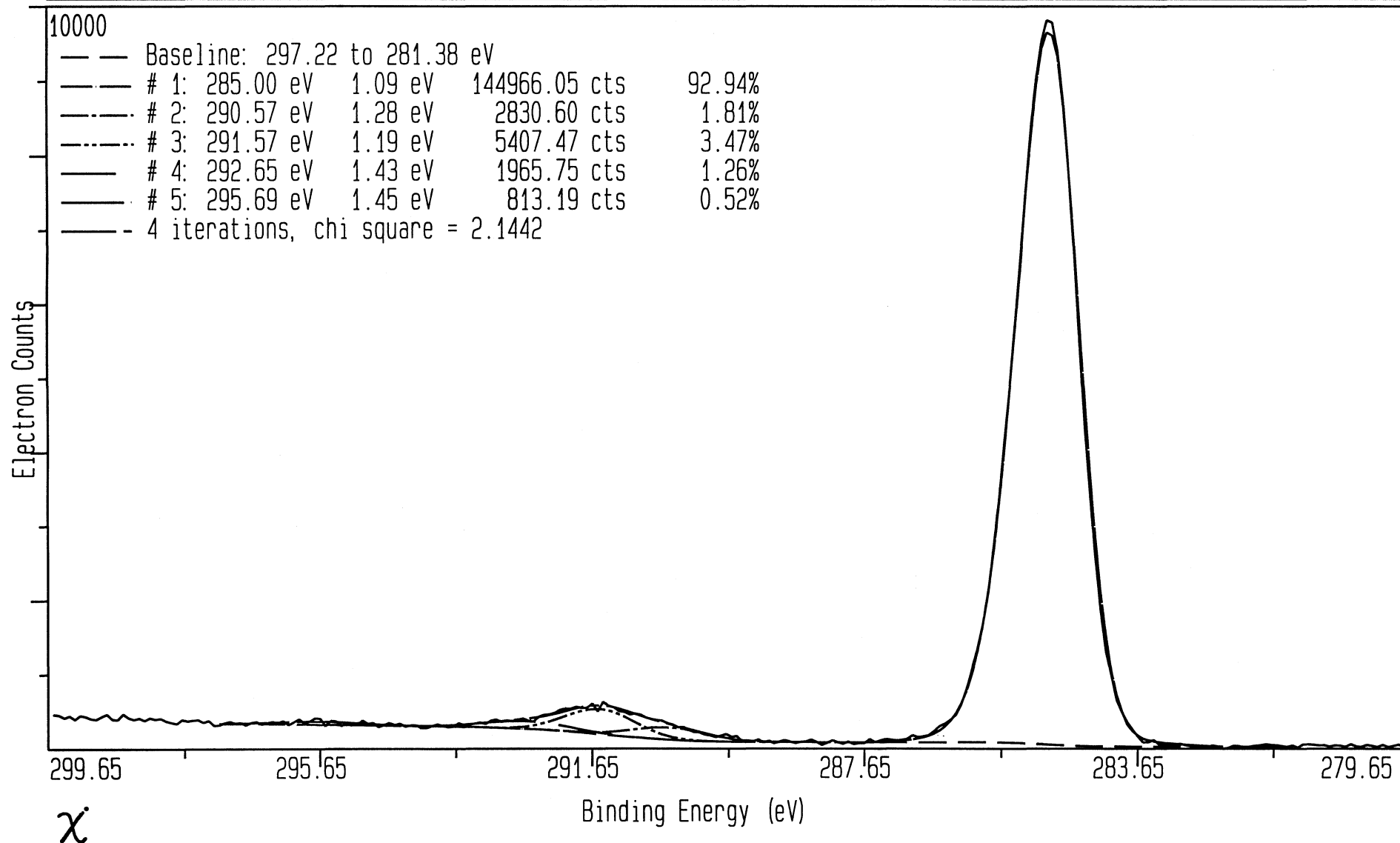
Operator: DGC
Date: Tue Apr 11 1988

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> %
* C 1s	280.0	275.0	1.01	153353	152501	94.37
* C 1s	287.5	282.5	1.00	9102	9091	5.63

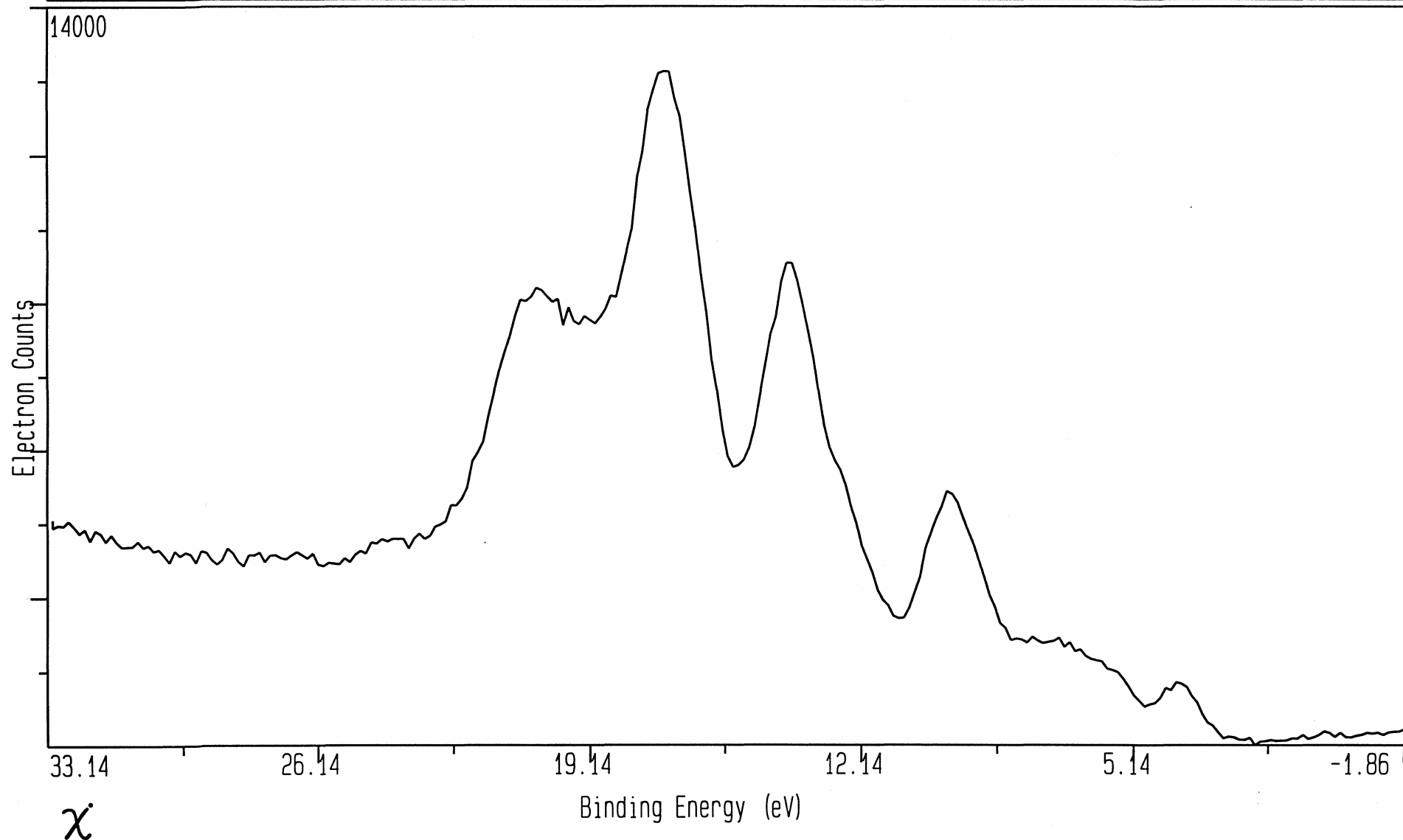
File: AMPS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 4/12/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Sample Description: p(alpha-methyl styrene), 4% IN TOLUENE, 4/11/88 (null)				



File: AMPS_C	Spot: 150	Flood Gun: 5.0	Data Points: 256	Date: 4/12/1988
Region: 2	Resolution: 1	Scans, Time: 80	Time/Point: 200	Operator: DGC
Description: p(alpha-methyl styrene), 4% IN TOLUENE, 4/11/88 (null)				



File: AMPS_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 6/14/1988
Region: 4	Resolution: 2	Scans, Time: 608	Time/Point: 200	Operator: DGC
Description: p(alpha methyl styrene), FROM 4% TOLUENE, 6/10/88 (null)				



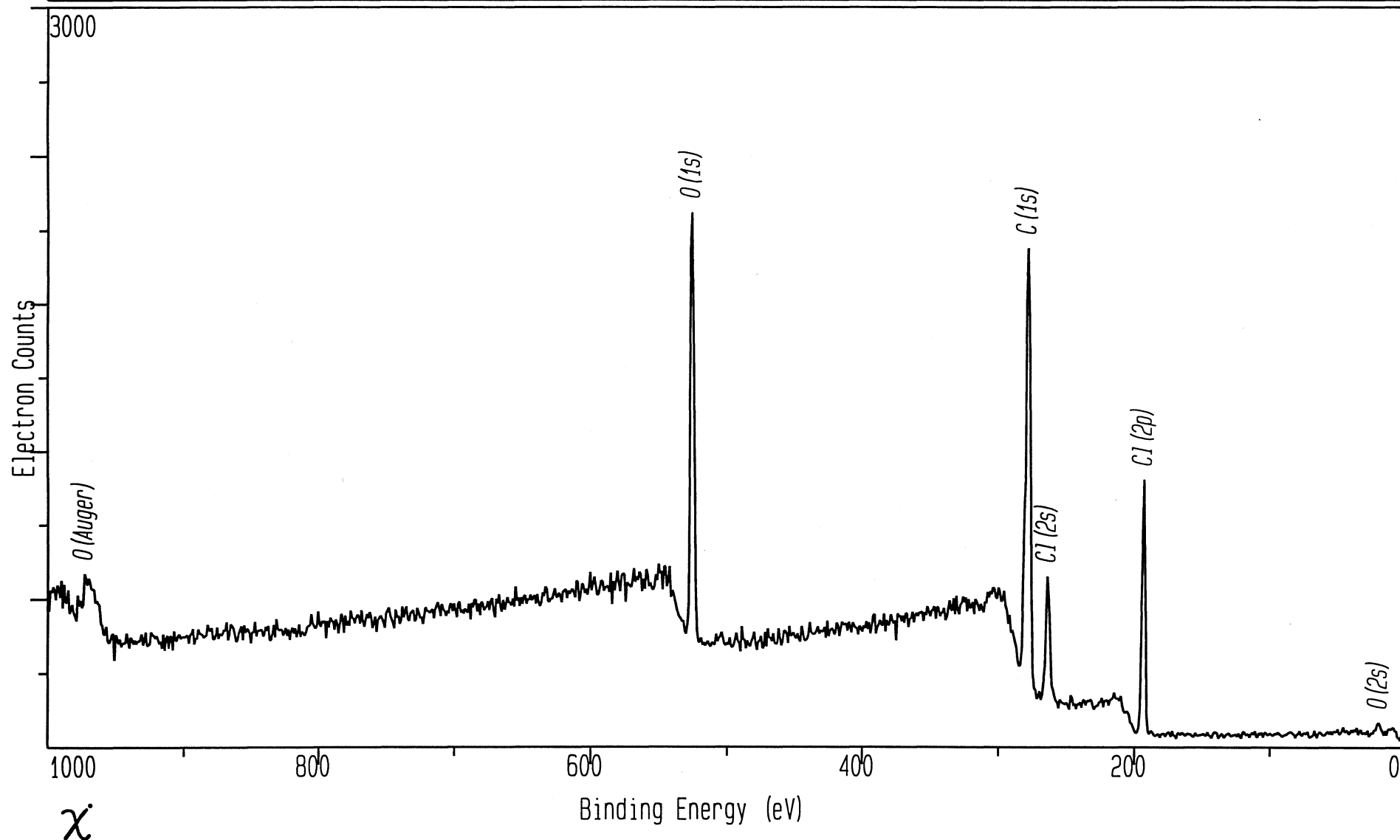
Poly 2-Chloro Ethyl Methacrylate (3% solution)

Detailed Surface Composition Table

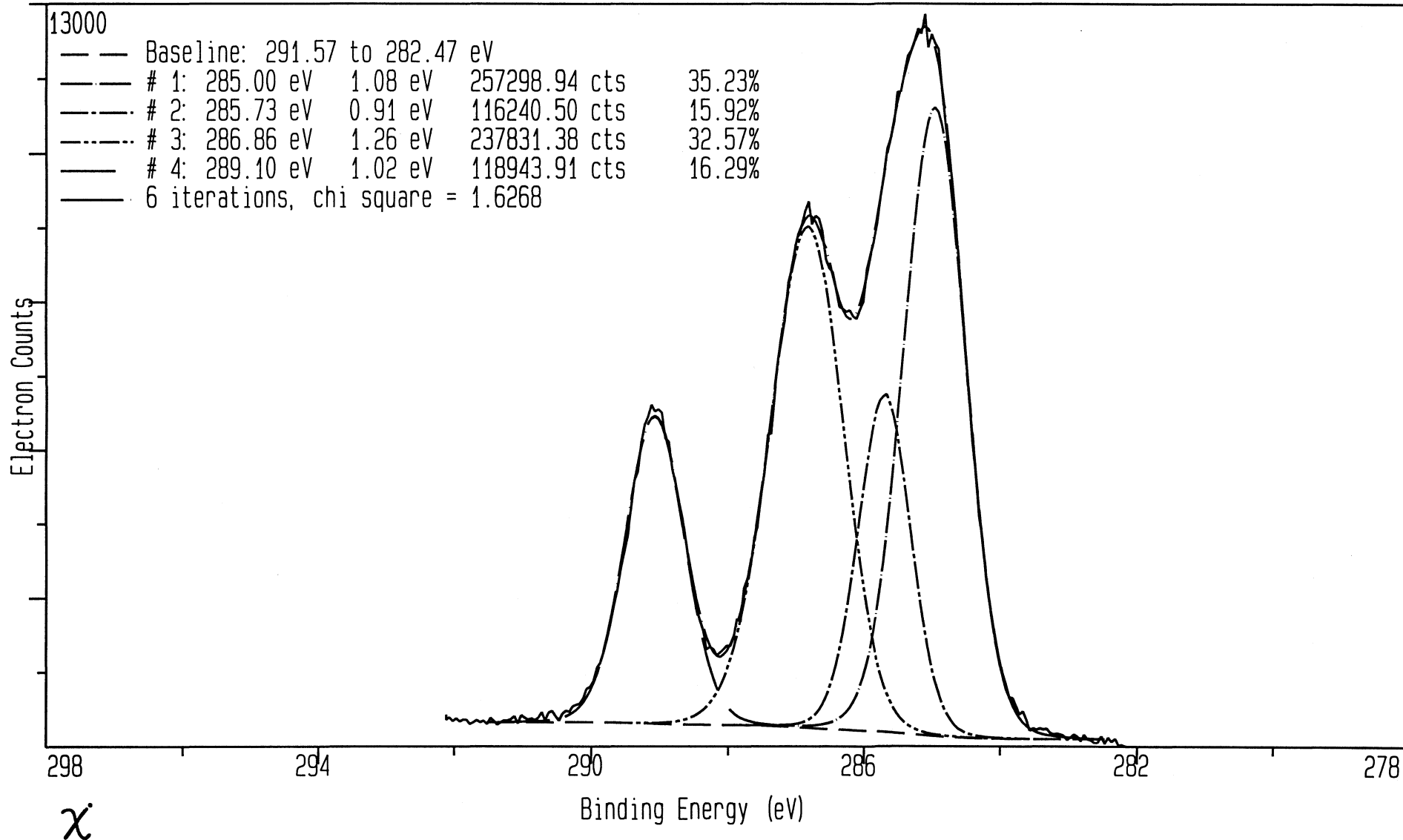
File name: CLMA_SU.MRS
Region: 1
Description: 3% P(2-Cl EMA)/GLASS; TOA~0, NEW SAMPLE, P(2-Cl-EMA) = Poly 2-chloro ethyl methacrylate
Operator: DGC
Date: Thu Mar 12 14:13 1992

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	977.6	972.6	0.00	6548	0	
* O 1s	529.8	524.8	2.45	57206	23337	21.66
* C 1s	282.3	277.3	1.00	72311	71964	66.81
Cl2s	268.2	263.2	1.71	18551	10823	
* Cl2p	197.3	192.3	2.42	30110	12420	11.53
O 2s	24.2	19.2	0.16	1988	12105	

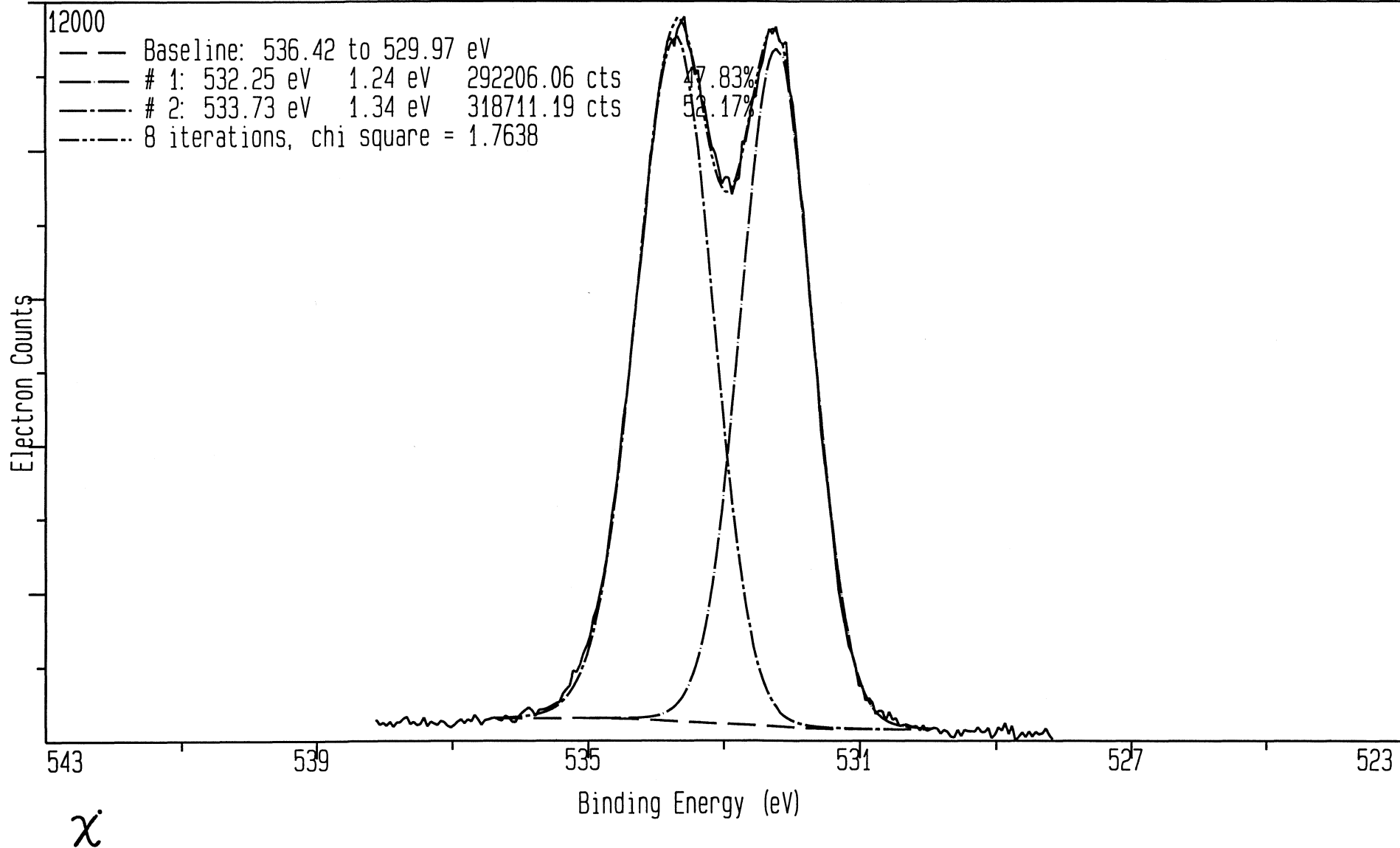
File: CLMA_SU	Spot: 250x1000	Flood Gun: 5.0	Data Points: 1001	Date: Mar 12 1992
Region: 1	Resolution: 4	Scans, Time: 1	Time/Point: 100	Operator: DGC
Description: 3% P(2-Cl EMA)/GLASS; T.O.ANG~0, NEW SAMPLE P(2-Cl EMA) = Poly 2-chloro ethyl methacrylate				



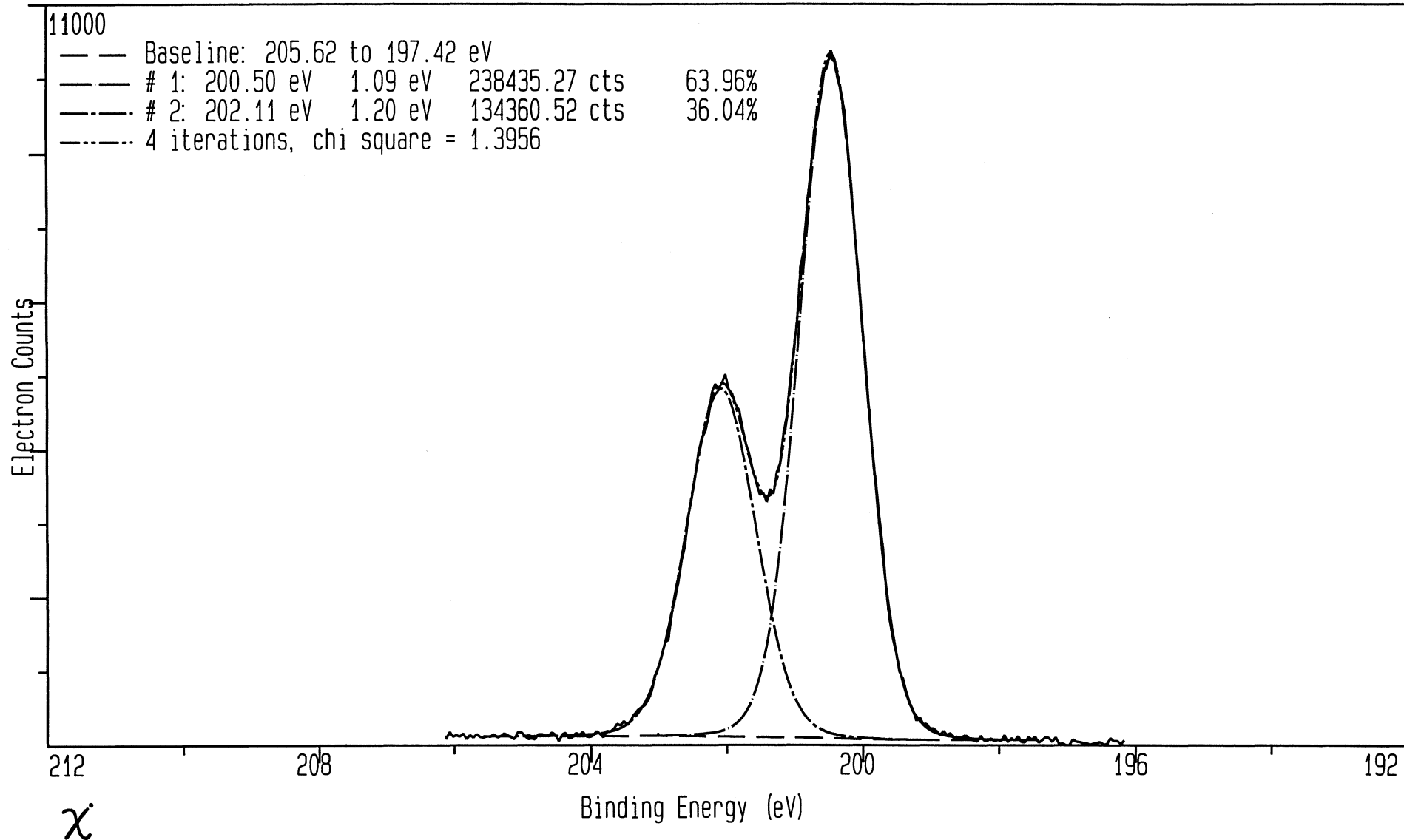
File: CLMA_C	Spot: 250x1000	Flood Gun: 5.0	Data Points: 201	Date: Mar 12 1992
Region: 2	Resolution: 1	Scans, Time: 20	Time/Point: 400	Operator: DGC
Description: 3% P(2-Cl EMA)/GLASS; TOA~0, NEW SAMPLE Poly 2-chloro ethyl methacrylate				



File: CLMA_0	Spot: 250x1000	Flood Gun: 5.0	Data Points: 201	Date: Mar 12 1992
Region: 3	Resolution: 1	Scans, Time: 20	Time/Point: 400	Operator: DGC
Description: 3% P(2-Cl EMA)/GLASS; T.O.ANG~0, NEW SAMPLE				
P(2-Cl EMA) = Poly 2-chloro ethyl methacrylate				



File: CLMA_CL	Spot: 250x1000	Flood Gun: 5.0	Data Points: 201	Date: Mar 12 1992
Region: 4	Resolution: 1	Scans, Time: 30	Time/Point: 400	Operator: DGC
Description: 3% P(2-Cl EMA) /GLASS; T.O.ANG~0, NEW SAMPLE P(2-Cl EMA) = Poly 2-chloro ethyl methacrylate				



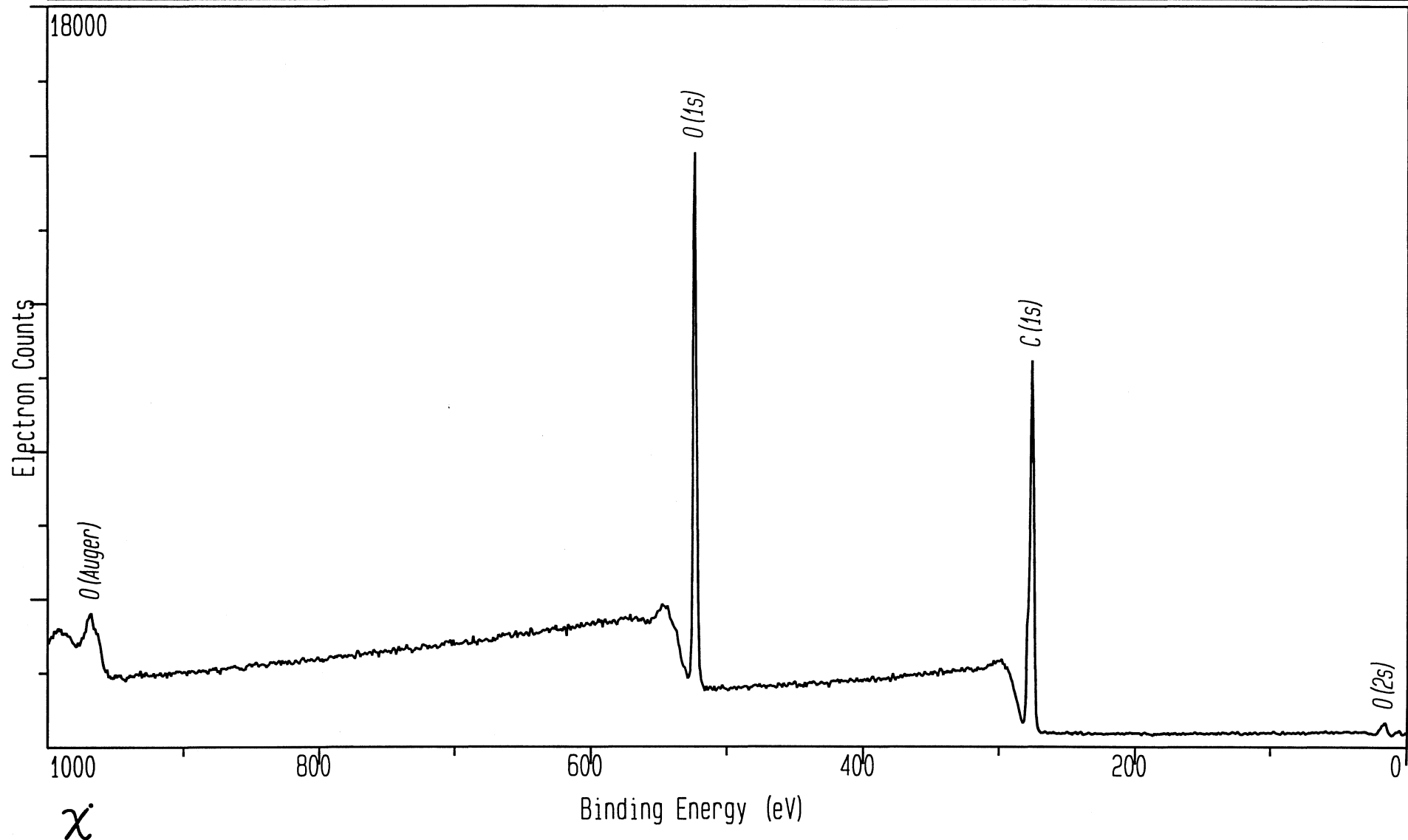
Poly 2-Hydroxyethyl Methacrylate

Detailed Surface Composition Table

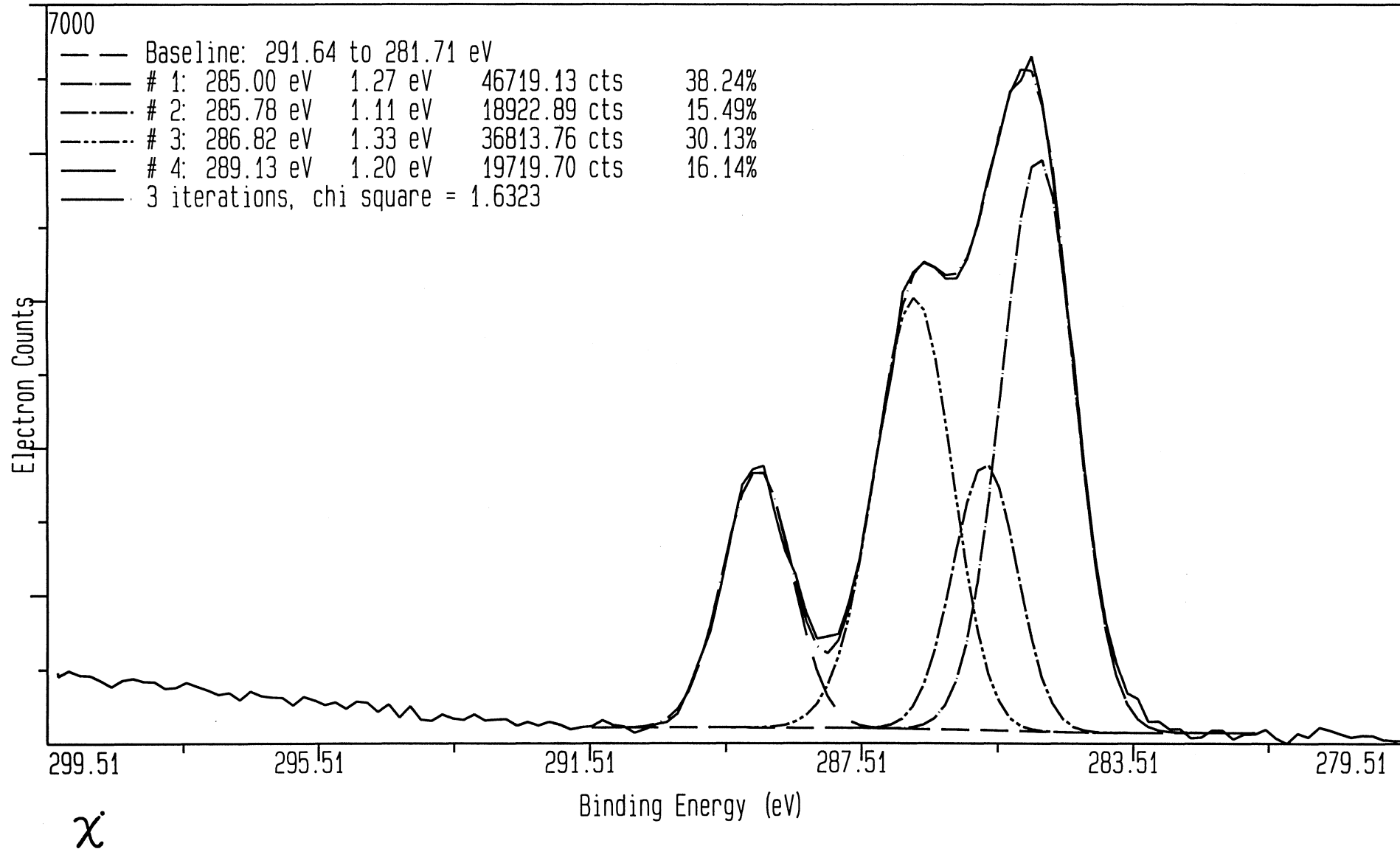
File name: HEMA_SU.MRS
Region: 1
Description: NAKAHAMA,WC11-18-8, AH92-26, pHEMA = Poly 2-hydroxyethyl methacrylate
Operator: DGC
Date: Sat Jun 12 1993

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> <u>%</u>
O Auger	973.0	968.0	0.00	15262	0	
* O 1s	527.8	522.8	2.51	49057	19542	31.46
* C 1s	280.1	275.1	1.01	42803	42566	68.54
O 2s	20.4	15.4	0.16	1892	11734	

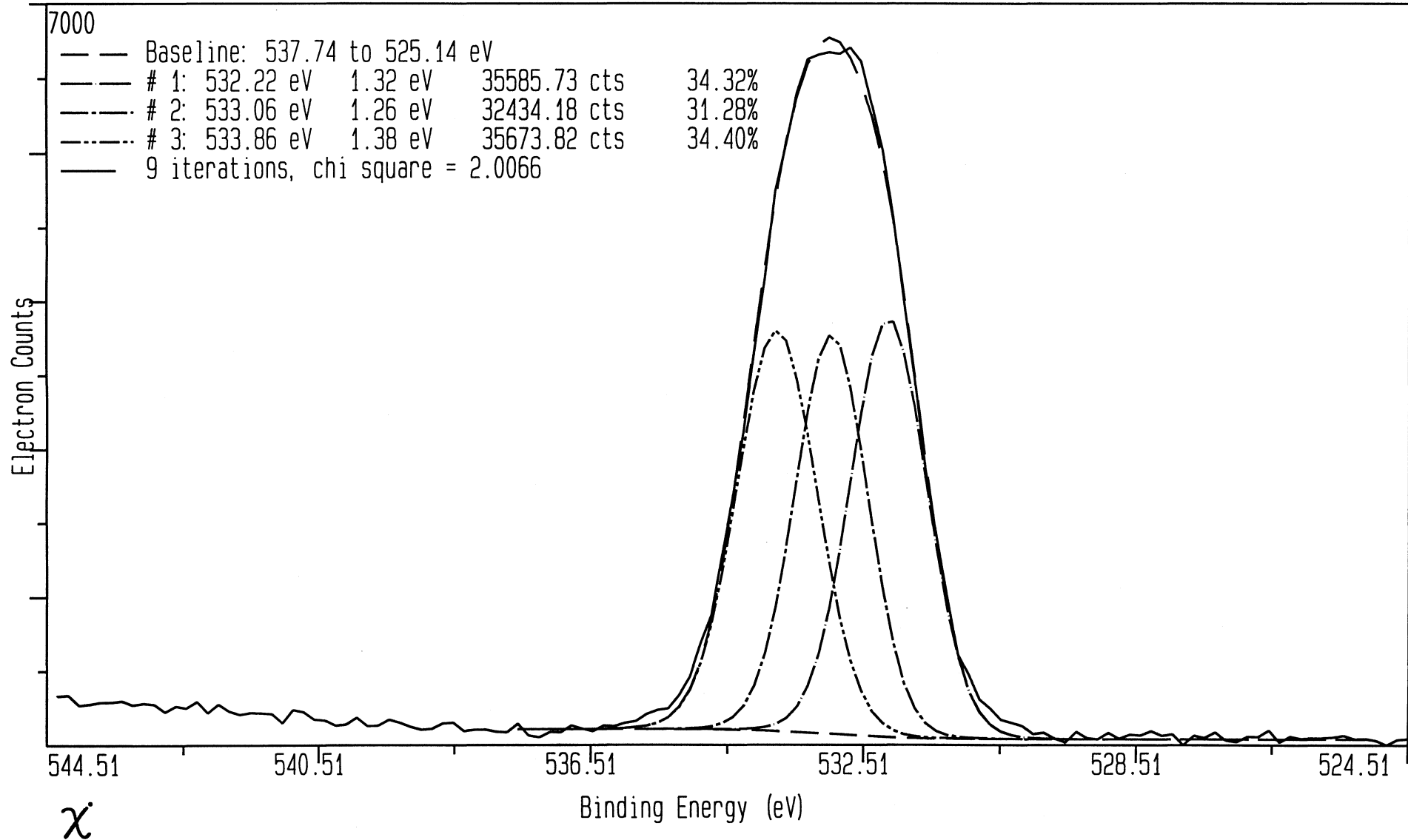
File: HEMA_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 6/12/1993
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-8, AH92-26, pHEMA pHEMA = Poly 2-hydroxyethyl methacrylate				



File: HEMA_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/12/1993
Region: 2	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-8, AH92-26, pHEMA pHEMA = Poly 2-hydroxy ethyl methacrylate				



File: HEMA_0	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/12/1993
Region: 3	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-8, AH92-26, pHEMA pHEMA = Poly 2-hydroxy ethyl methacrylate				



Poly 2-Hydroxy Ethyl Methacrylate, trimethyl silane

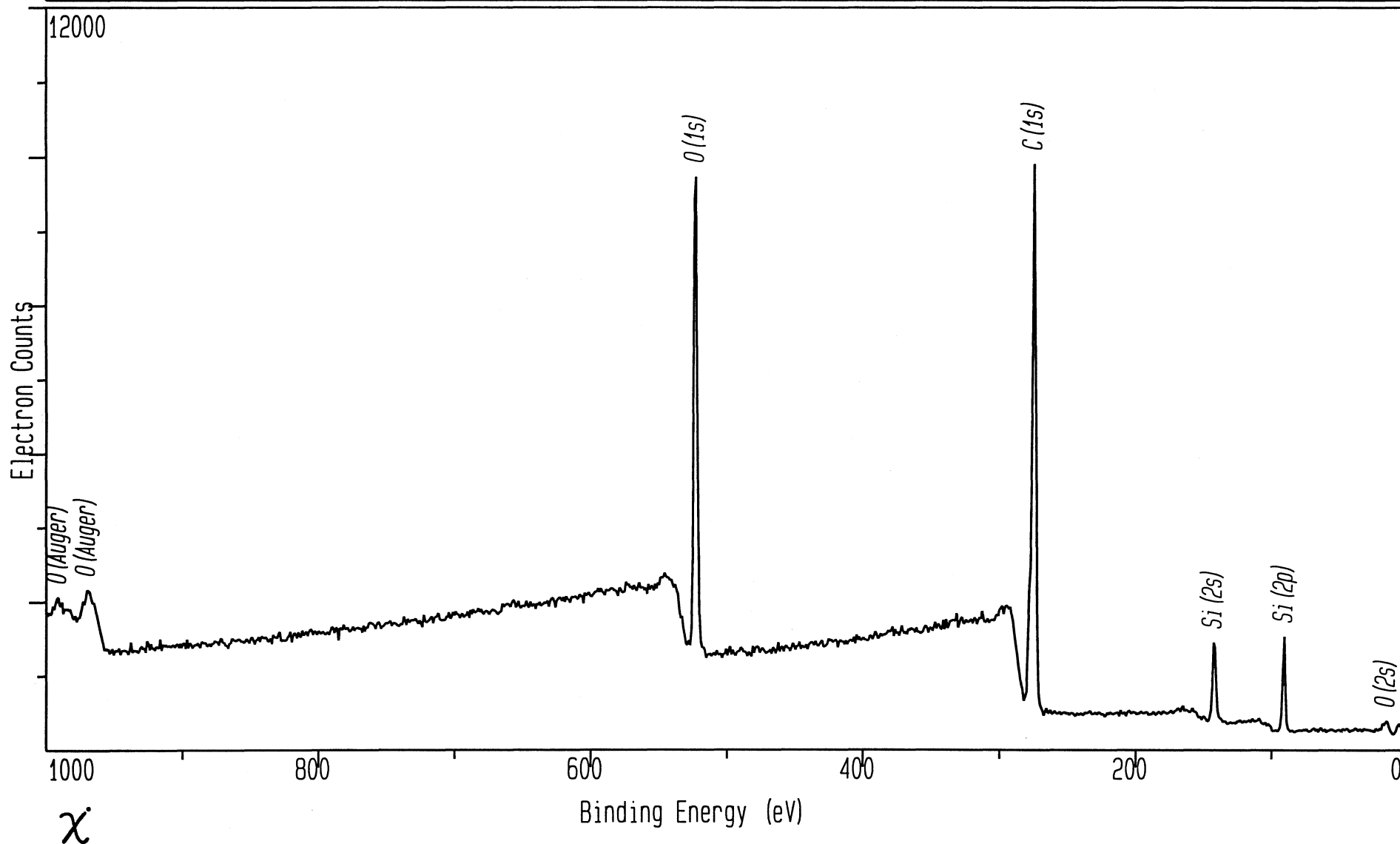
Detailed Surface Composition Table

File name: HTMS_SU.MRS
Region: 1
Description: NAKAHAMA, WC11-18-9, AH92-26', Poly 2-hydroxy ethyl methacrylate, trimethyl derivative
Operator: DGC
Date: Sat Jun 12 1993

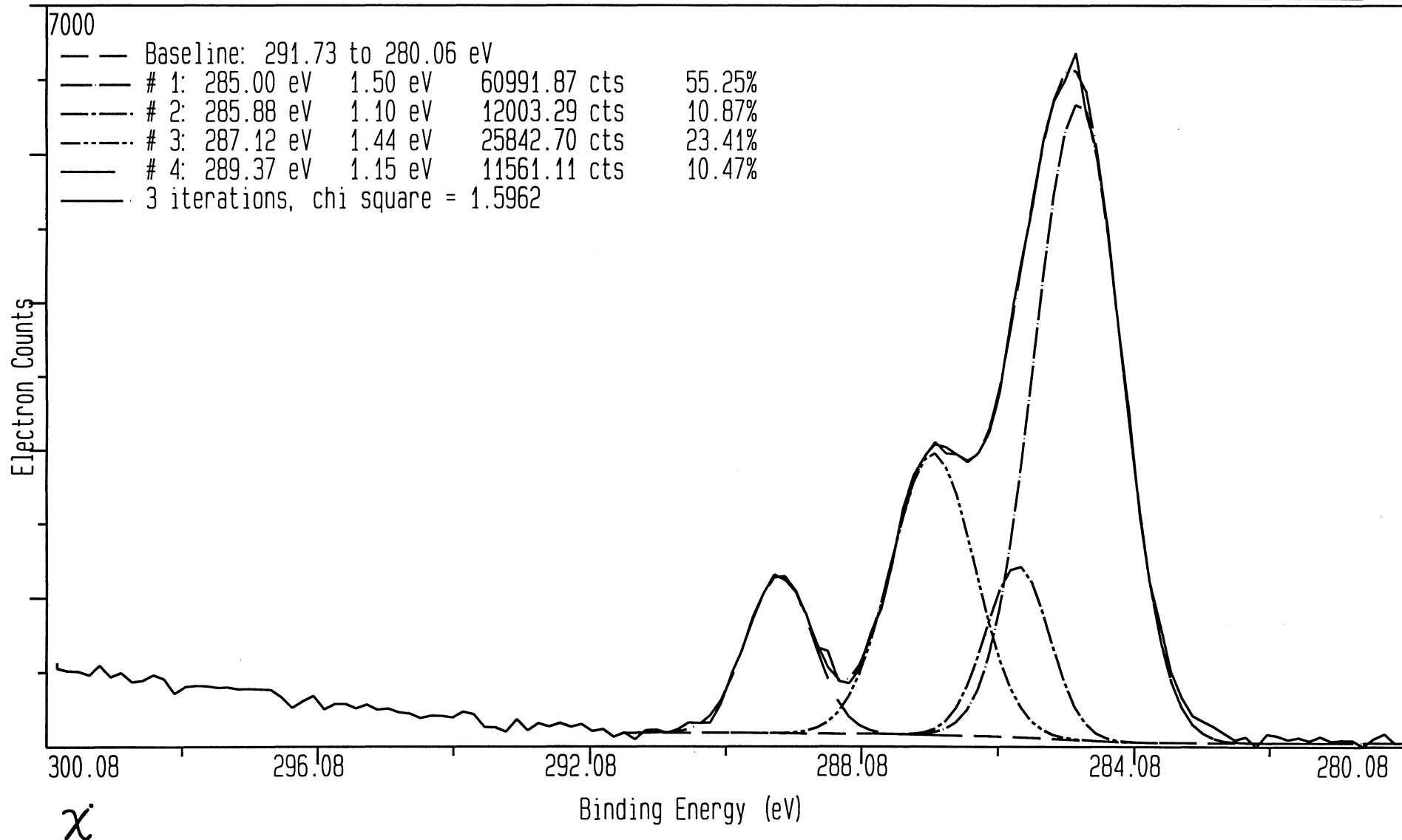
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	996.5	991.5	0.00	1390	0	
O Auger	974.3	969.3	0.00	9353	0	
* O 1s	527.0	522.0	2.51	30369	12090	21.89
* C 1s	279.0	274.0	1.01	38435	38200	69.17
* Si2s	146.5	141.5	1.03	5099	4935	8.94
Si2p	95.2	90.2	0.91	4532	4994	
O 2s	19.7	14.7	0.16	1652	10240	

X

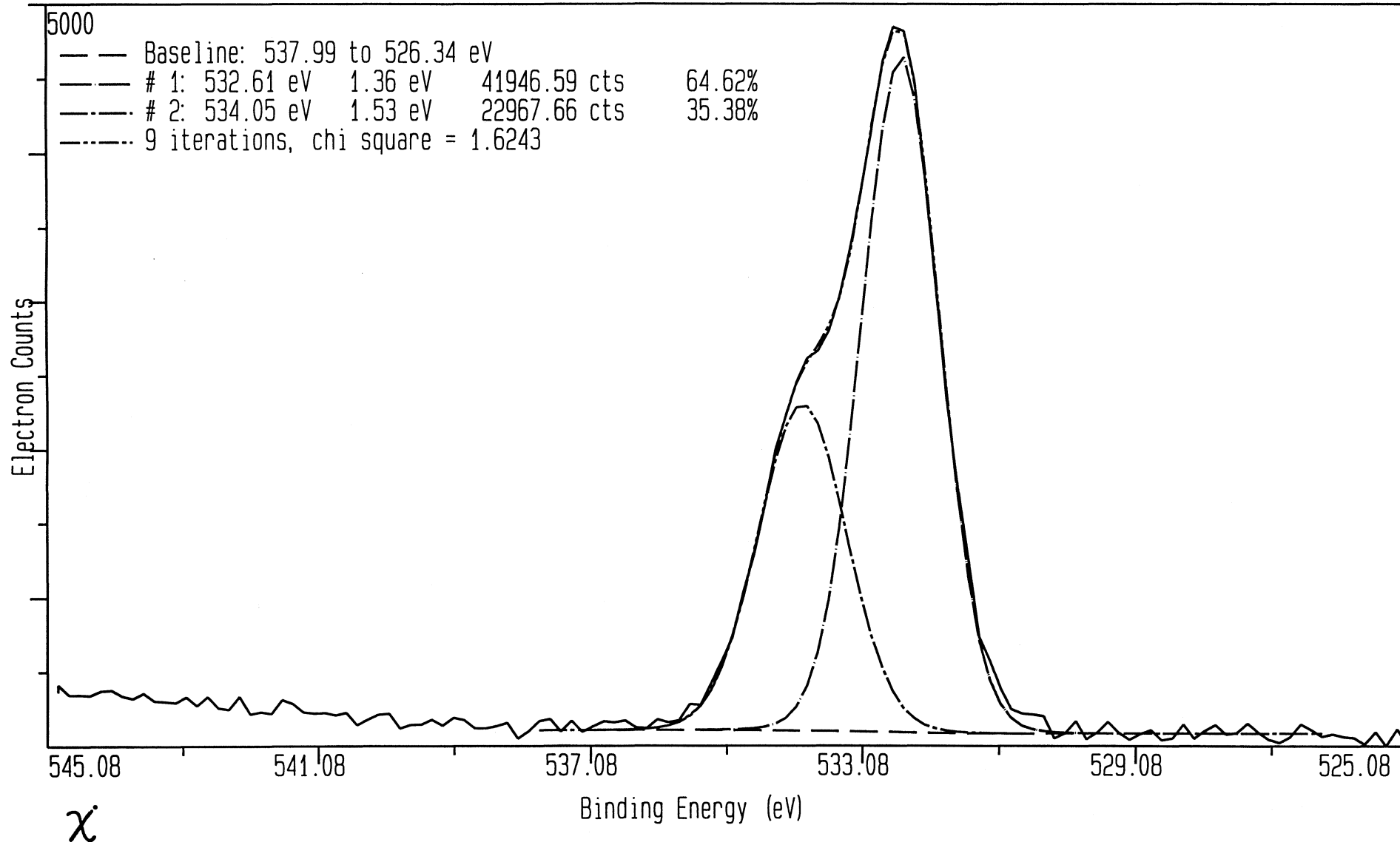
File: HTMS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 6/12/1993
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-9, AH92-26', pHEMA-TMS Poly 2-hydroxy ethyl methacrylate trimethyl silane				



File: HTMS_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/12/1993
Region: 2	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-9, AH92-26', pHEMA-TMS Poly 2-hydroxy ethyl methacrylate trimethyl silane				



File: HTMS_0	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/12/1993
Region: 3	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-9, AH92-26', pHEMA-TMS Poly 2-hydroxy ethyl methacrylate trimethyl silane				



4,4' Dimethoxybenzophenone (FW=242.27)

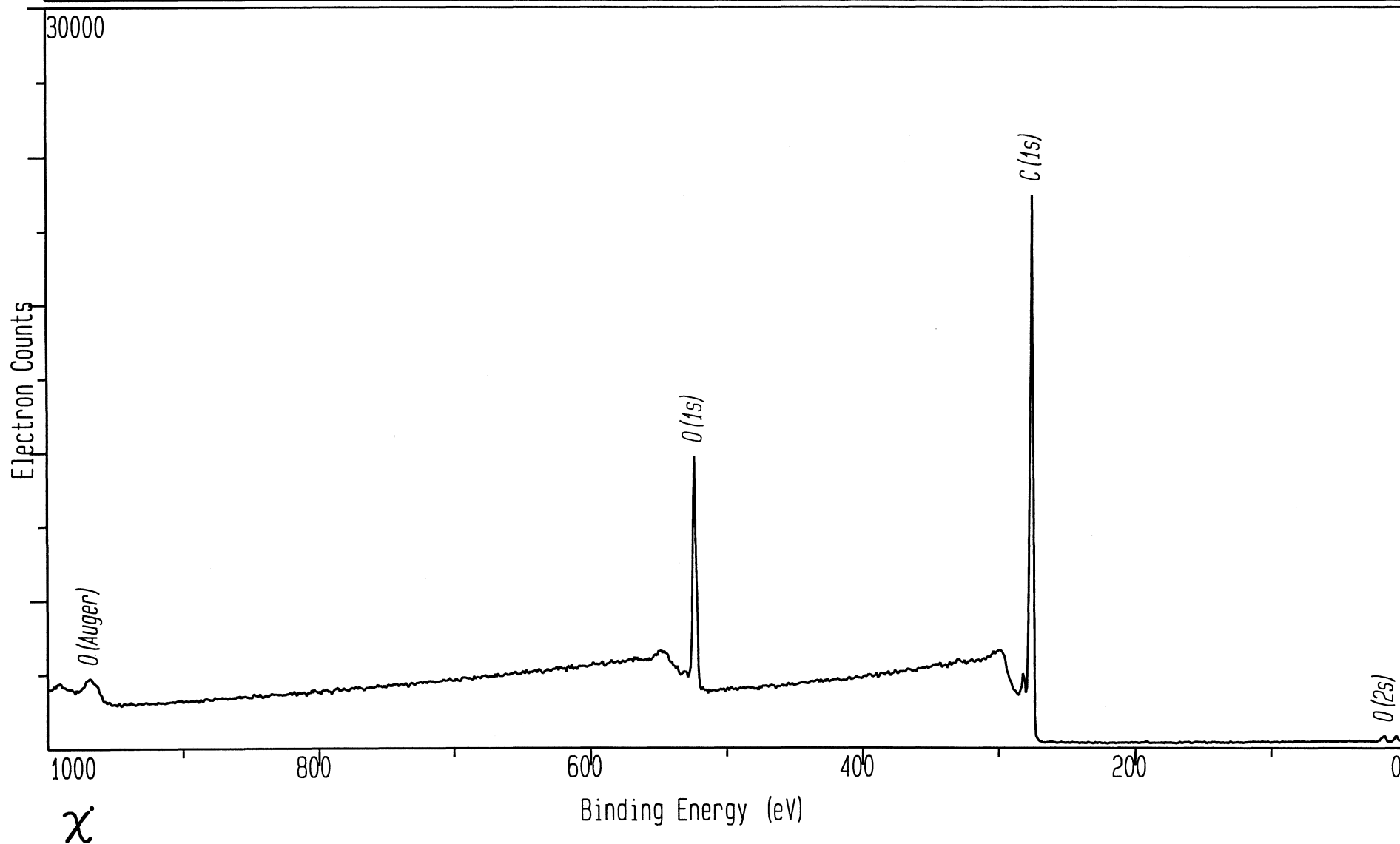
Detailed Surface Composition Table

File name: 4DBP_SU.MRS
Region: 1
Description: 4,4' DIMETHOXY BENZOPHENONE

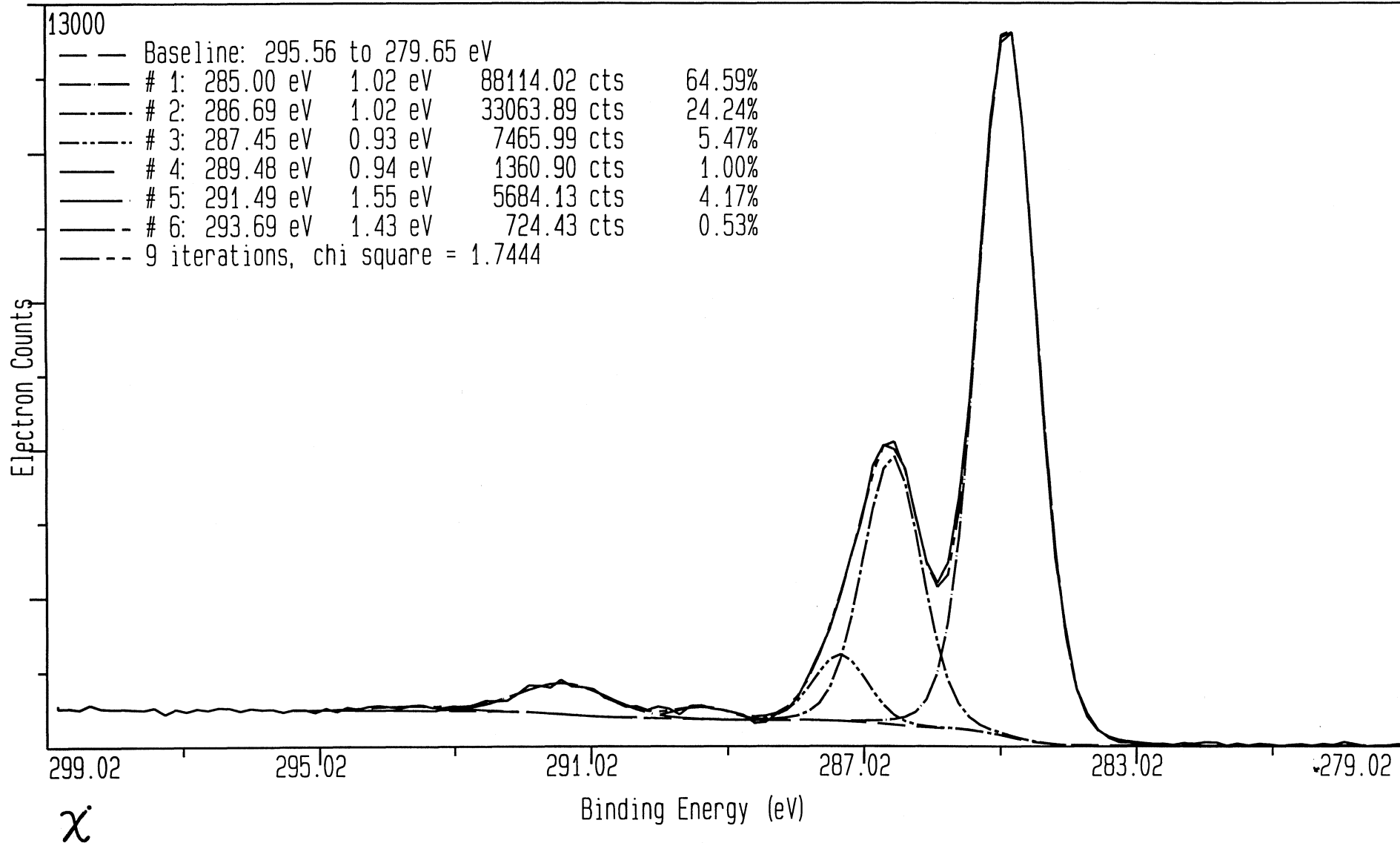
Operator: RDM
Date: Sat Sep 26 1987

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	973.3	968.3	0.00	10654	0	
* O 1s	528.7	523.7	2.51	37165	14815	15.57
* C 1s	280.1	275.1	1.01	80786	80343	84.43
O 2s	21.0	16.0	0.16	1105	6852	

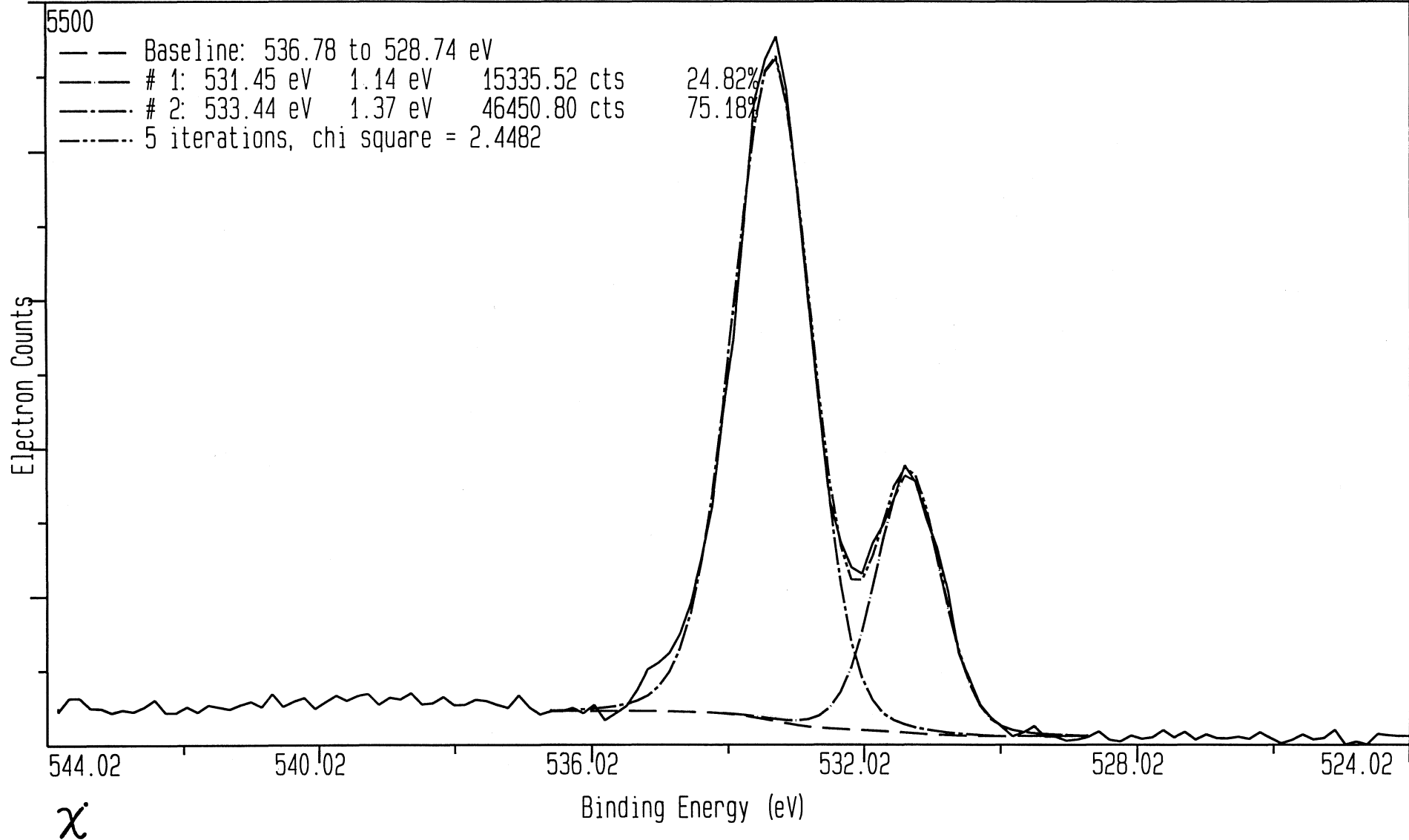
File: 4DBP_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 9/26/1987
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: RDM
Description: 4,4' DIMETHOXY BENZOPHENONE (null)				



File: 4DBP_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 9/26/1987
Region: 2	Resolution: 1	Scans, Time: 80	Time/Point: 200	Operator: RDM
Description: 4,4' DIMETHOXY BENZOPHENONE (null)				



File: 4DBP_0	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 9/26/1987
Region: 3	Resolution: 1	Scans, Time: 70	Time/Point: 200	Operator: RDM
Description: 4,4' DIMETHOXY BENZOPHENONE (null)				



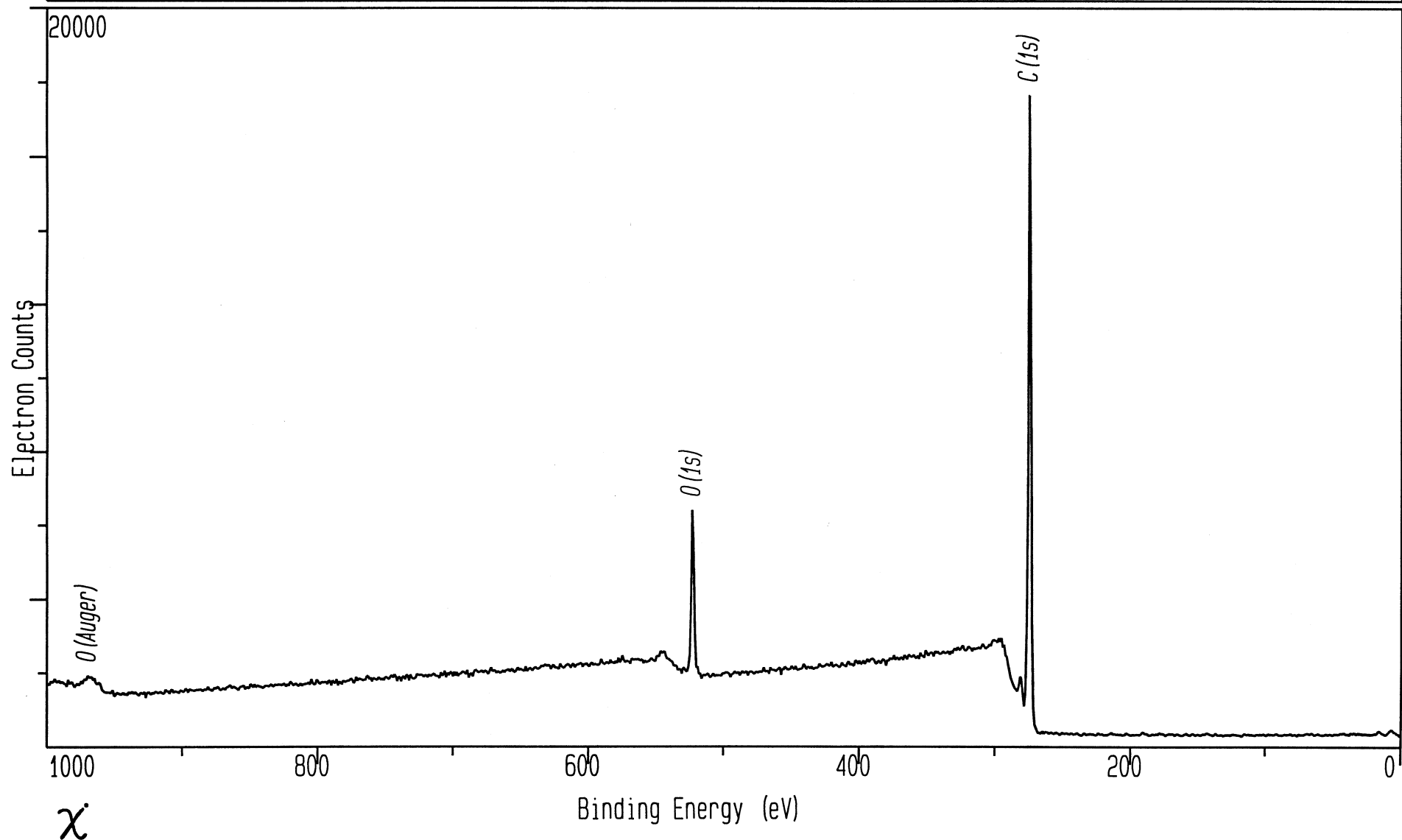
Poly - 4-Ethoxy Styrene

Detailed Surface Composition Table

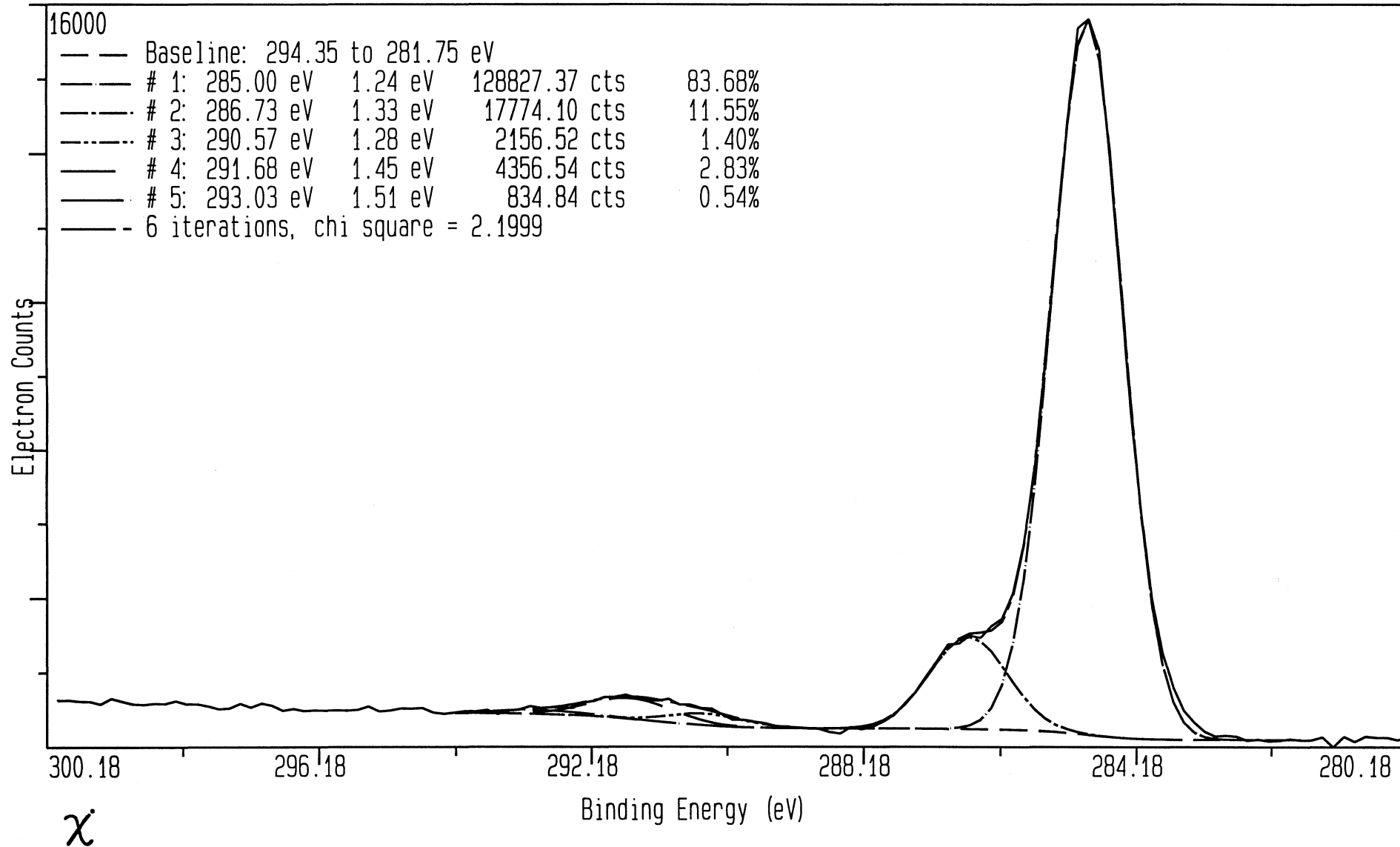
File name: PES_SU.MRS
Region: 1
Description: NAKAHAMA, WC11-18-1, AH92-17, POLY(EtOH Styrene)
Poly 4-Ethoxy Styrene (PES)
Operator: DGC
Date: Fri Jun 11 1993

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	974.5	969.5	0.00	1970	0	
* O 1s	527.2	522.2	2.51	14984	5966	10.55
* C 1s	278.8	273.8	1.01	50911	50593	89.45

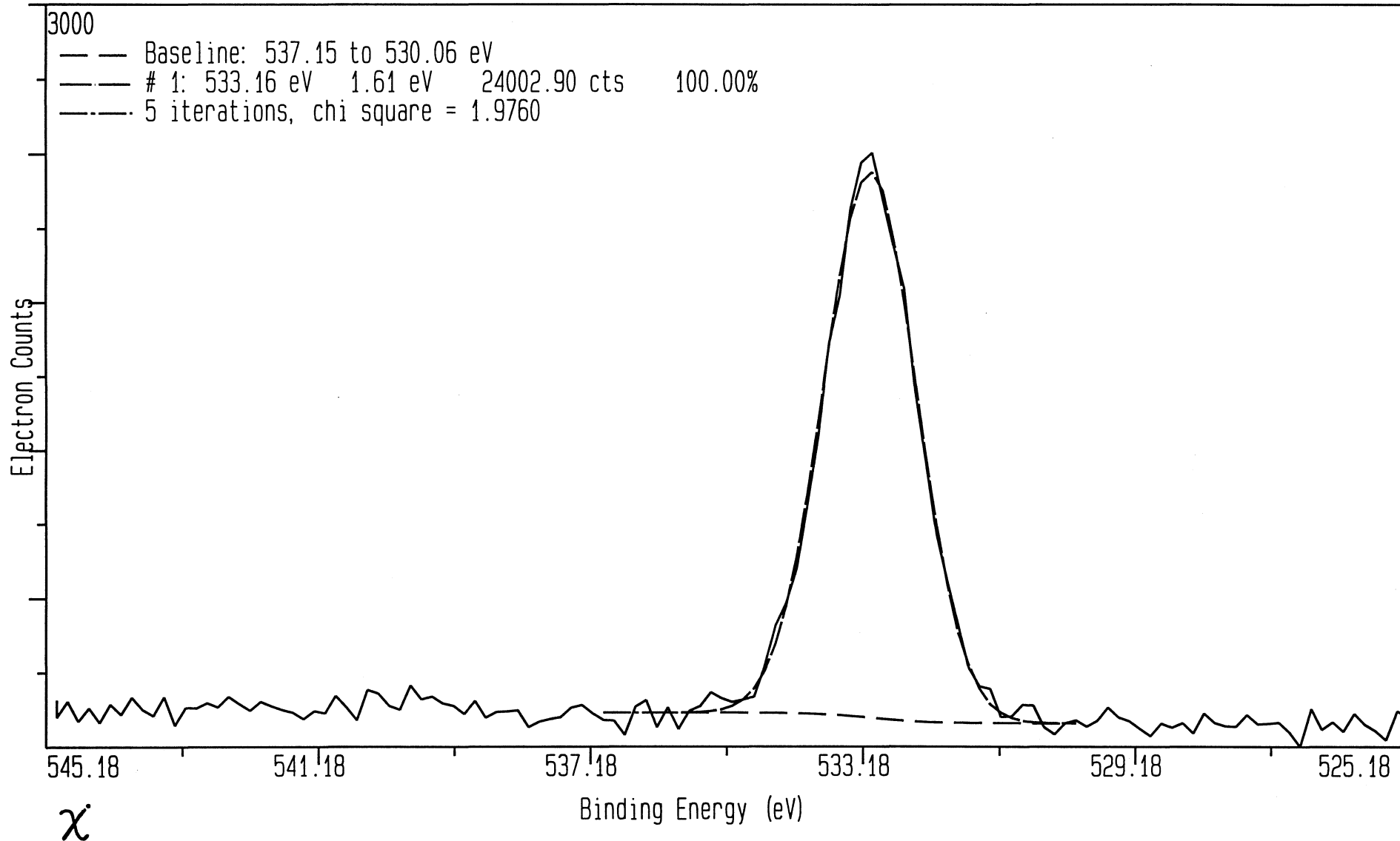
File: PES_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 6/11/1993
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-1, AH92-17, POLY (EtOH Styrene) Poly 4-Ethoxy Styrene (PES)				



File: PES_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/11/1993
Region: 2	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-1, AH92-17, POLY (EtOH Styrene) Poly 4-ethoxy styrene (PES)				



File: PES_0	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/11/1993
Region: 3	Resolution: 1	Scans, Time: 24	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-1, AH92-17, POLY (EtOH Styrene) Poly 4-ethoxy styrene (PES)				



Poly - 4-Hydroxy Styrene

Detailed Surface Composition Table

File name: PHS_SU.MRS

Region: 1

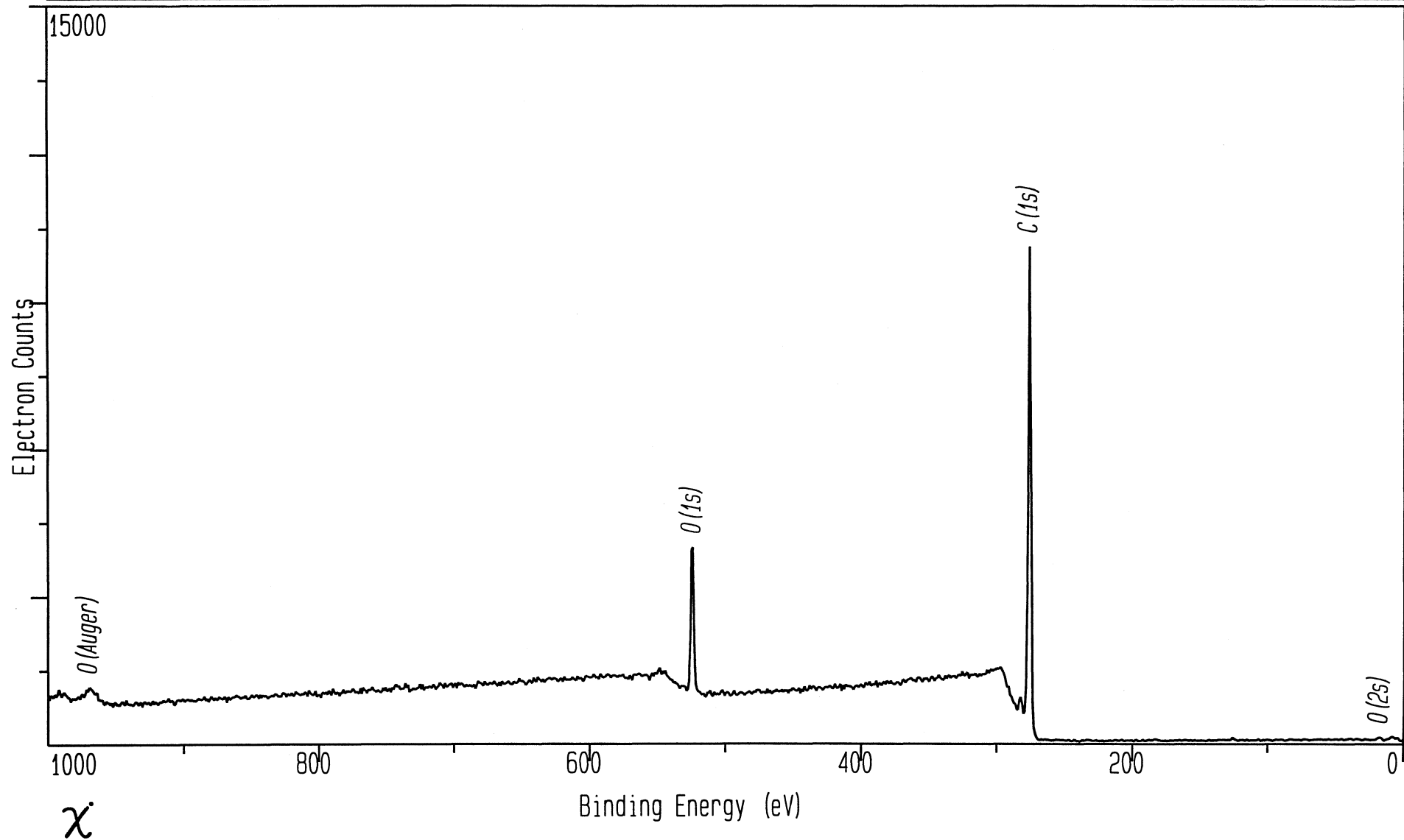
Description: COMMERCIAL poly (4 hydroxystyrene)

Operator: MRR

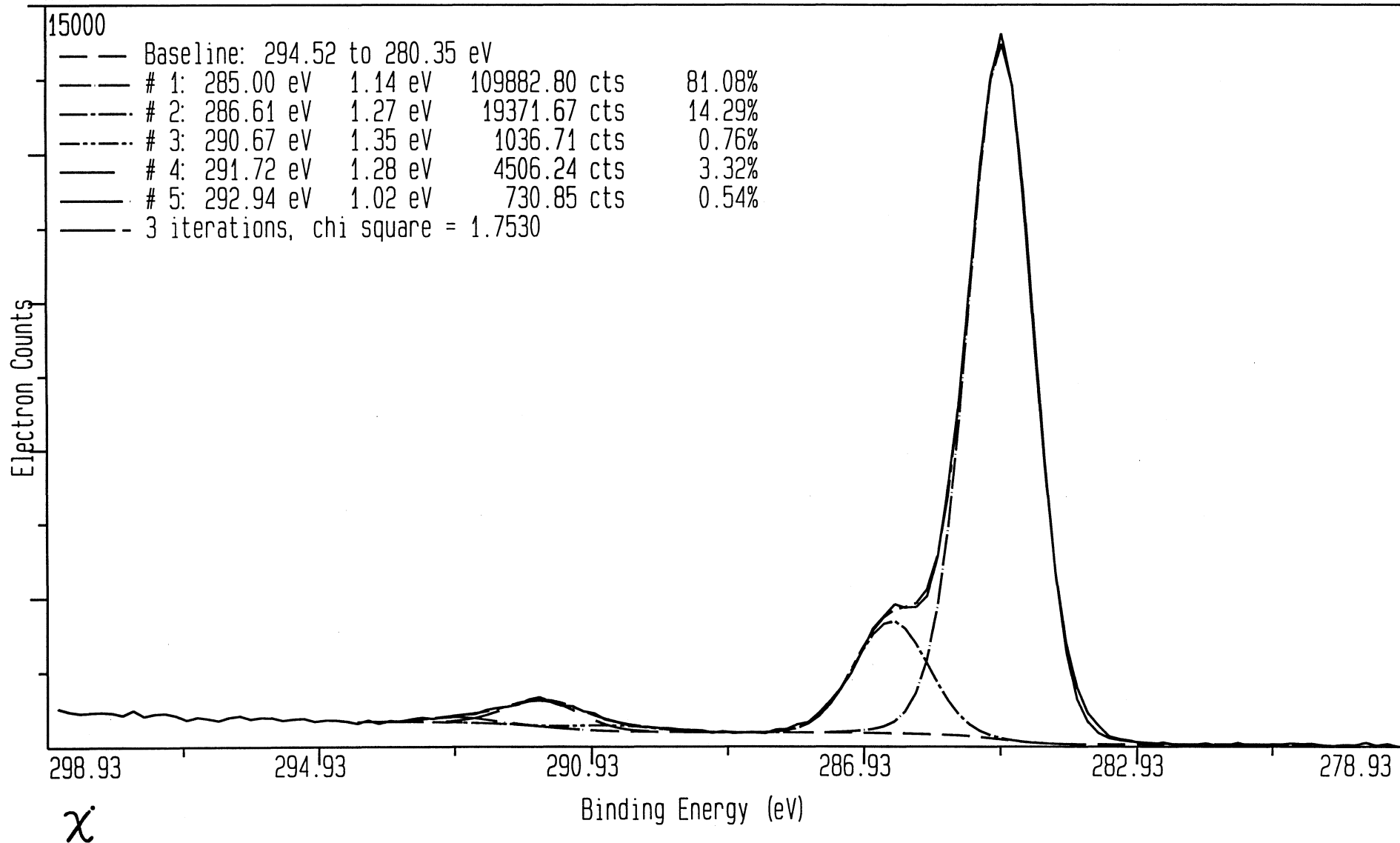
Date: Mon May 22 1989

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	974.4	969.4	0.00	5077	0	
* O 1s	529.0	524.0	2.51	20720	8261	11.65
* C 1s	280.0	275.0	1.01	62999	62650	88.35
O 2s	21.4	16.4	0.16	482	2989	

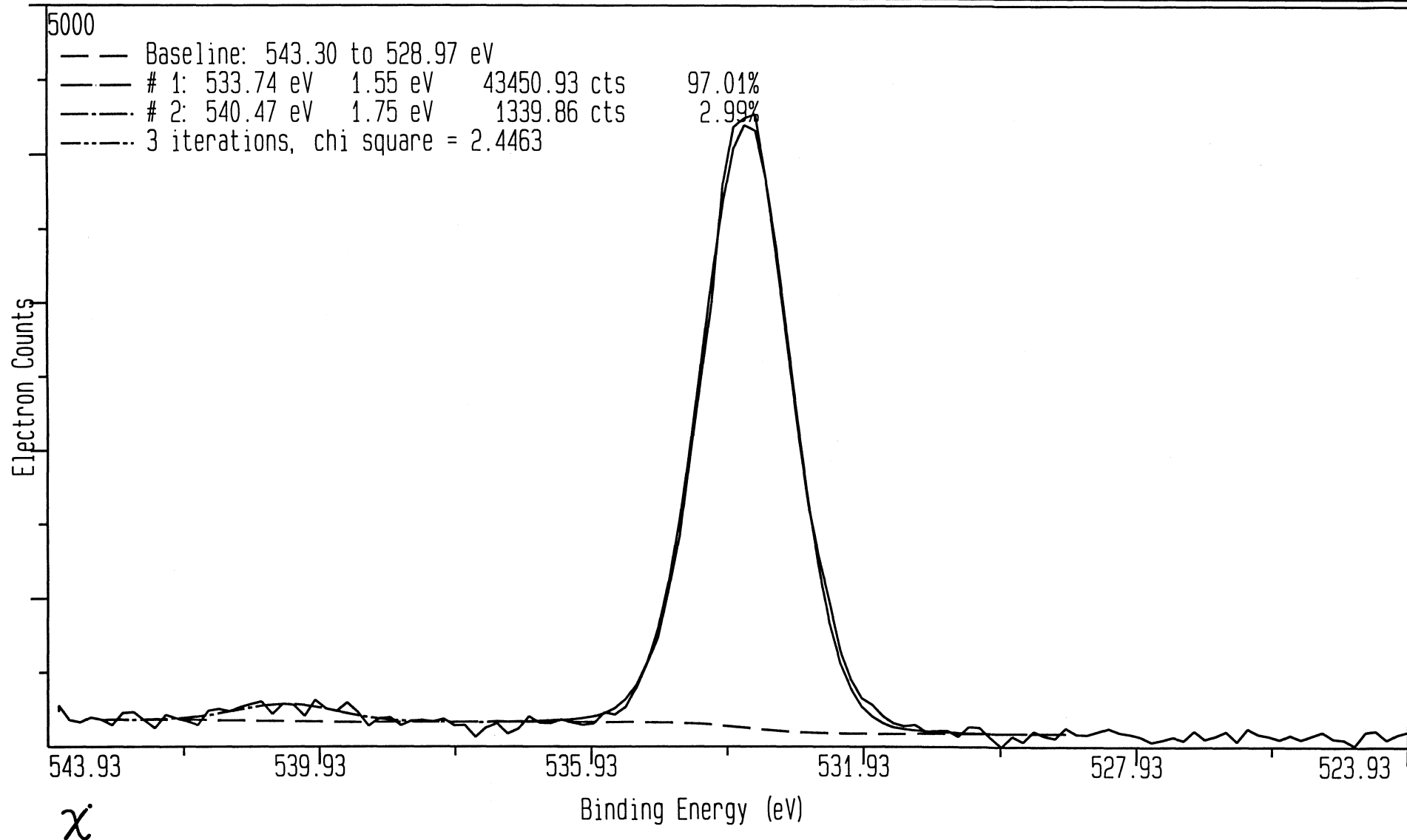
File: PHS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 5/22/1989
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: MRR
Description: COMMERCIAL poly (para hydroxystyrene)				



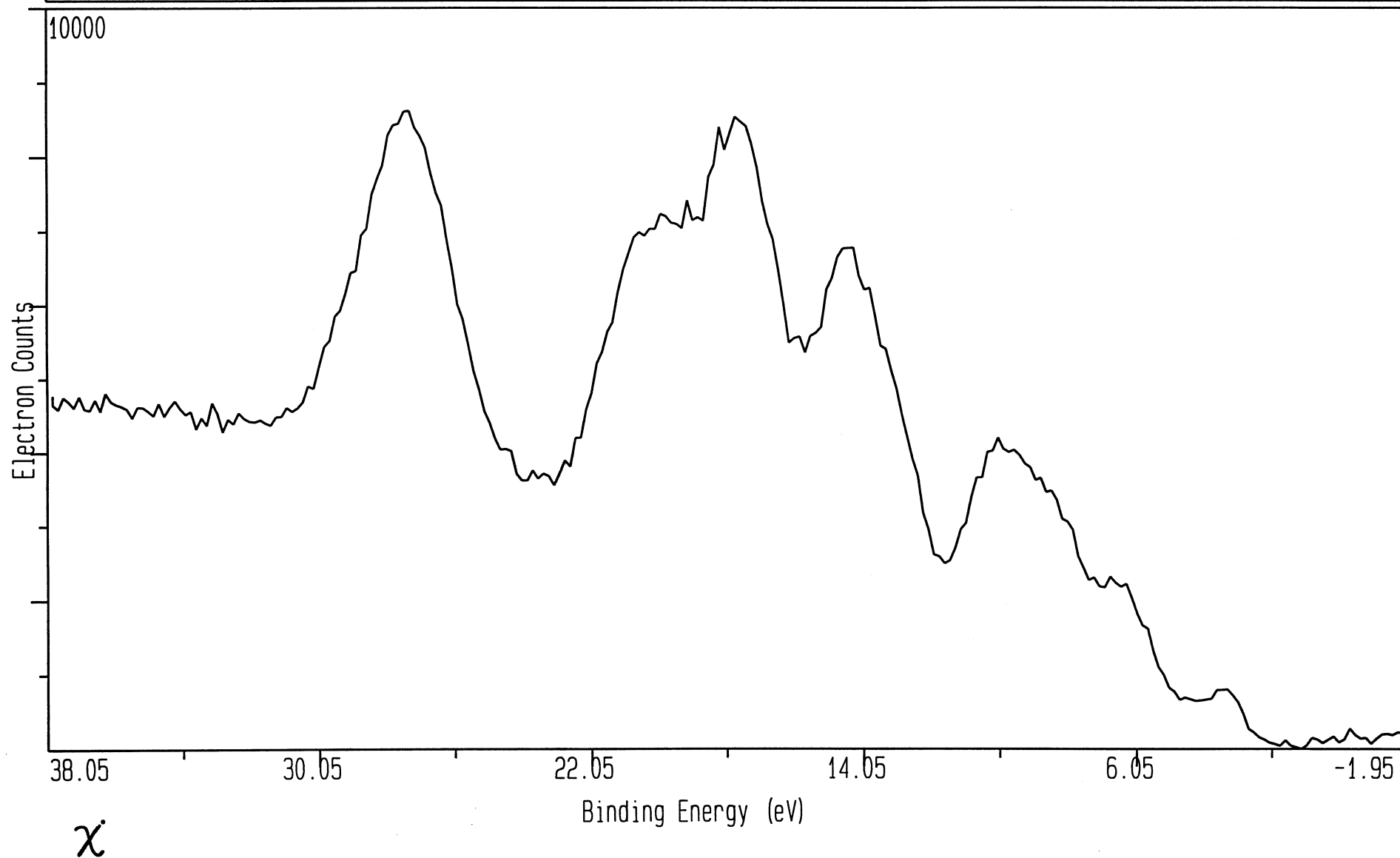
File: PHS_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 5/22/1989
Region: 2	Resolution: 1	Scans, Time: 100	Time/Point: 200	Operator: MRR
Description: COMMERCIAL poly (para hydroxystyrene)				



File: PHS_0	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 5/22/1989
Region: 3	Resolution: 1	Scans, Time: 70	Time/Point: 200	Operator: MRR
Description: COMMERCIAL poly (para hydroxystyrene)				



File: PHS_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 5/22/1989
Region: 5	Resolution: 2	Scans, Time: 692	Time/Point: 200	Operator: MRR
Description: COMMERCIAL poly (para hydroxystyrene)				



Poly - 4-Methyl Styrene (2% w/v toluene)

[CAS# 24936-41-5]

Detailed Surface Composition Table

File name: 4MPS_SU.MRS

Region: 1

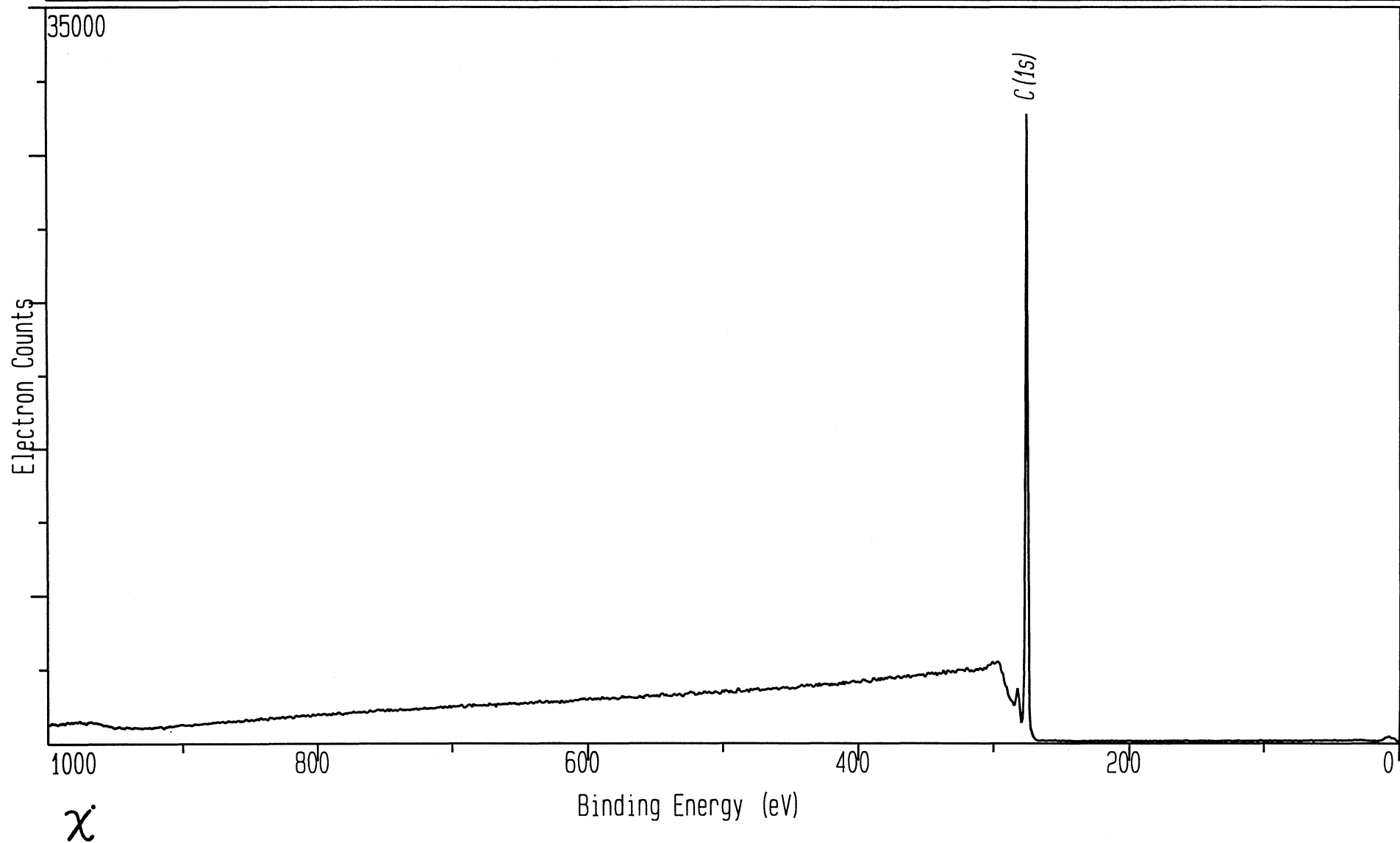
Description: POLY (4-METHYL STYRENE); DISSOLVED IN 2% W/V IN TOLUENE; MeOH Precipitated

Operator: RDM

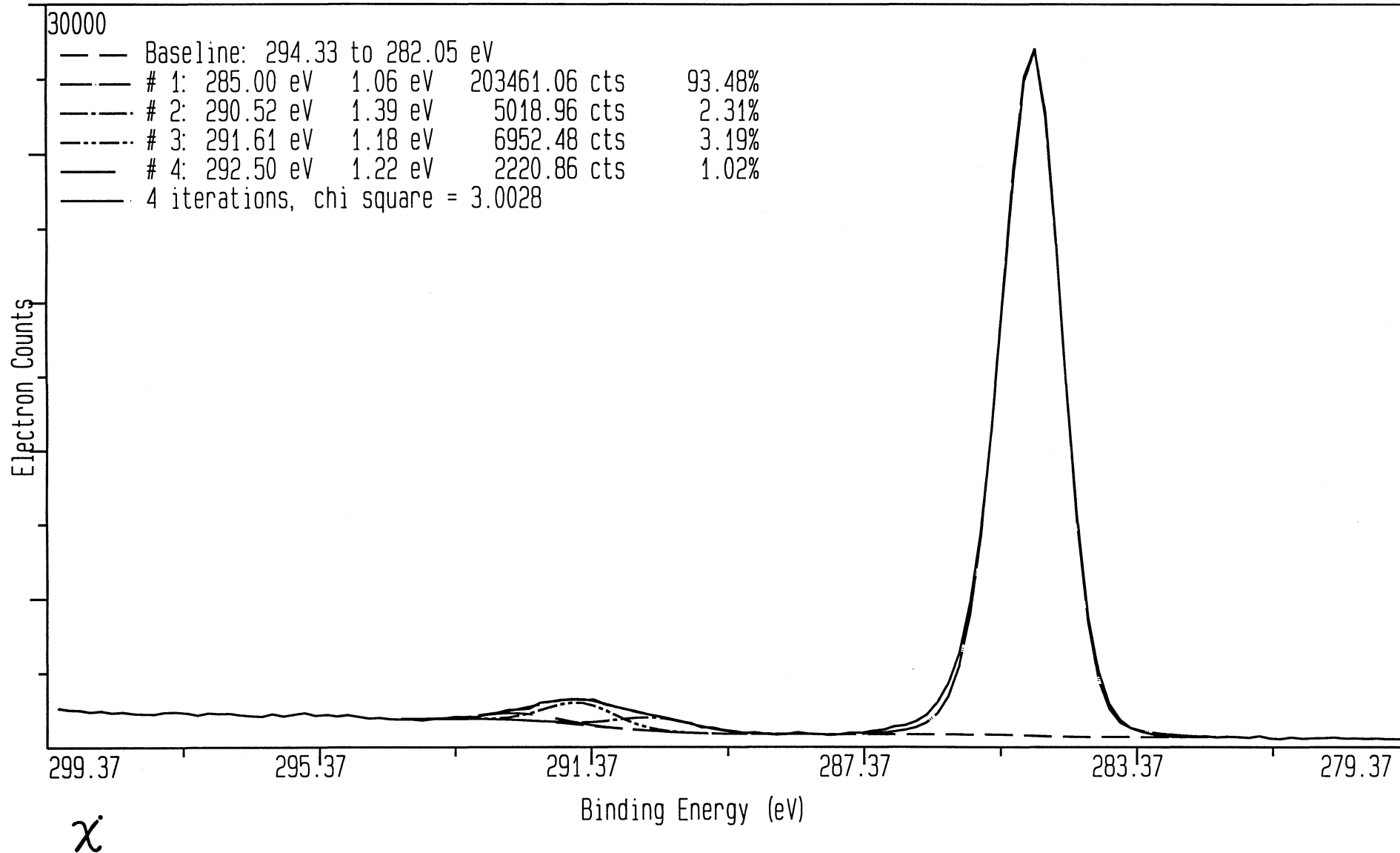
Date: Sun April 17 1988

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
* C 1s	280.0	275.0	1.01	151943	151098	100.00

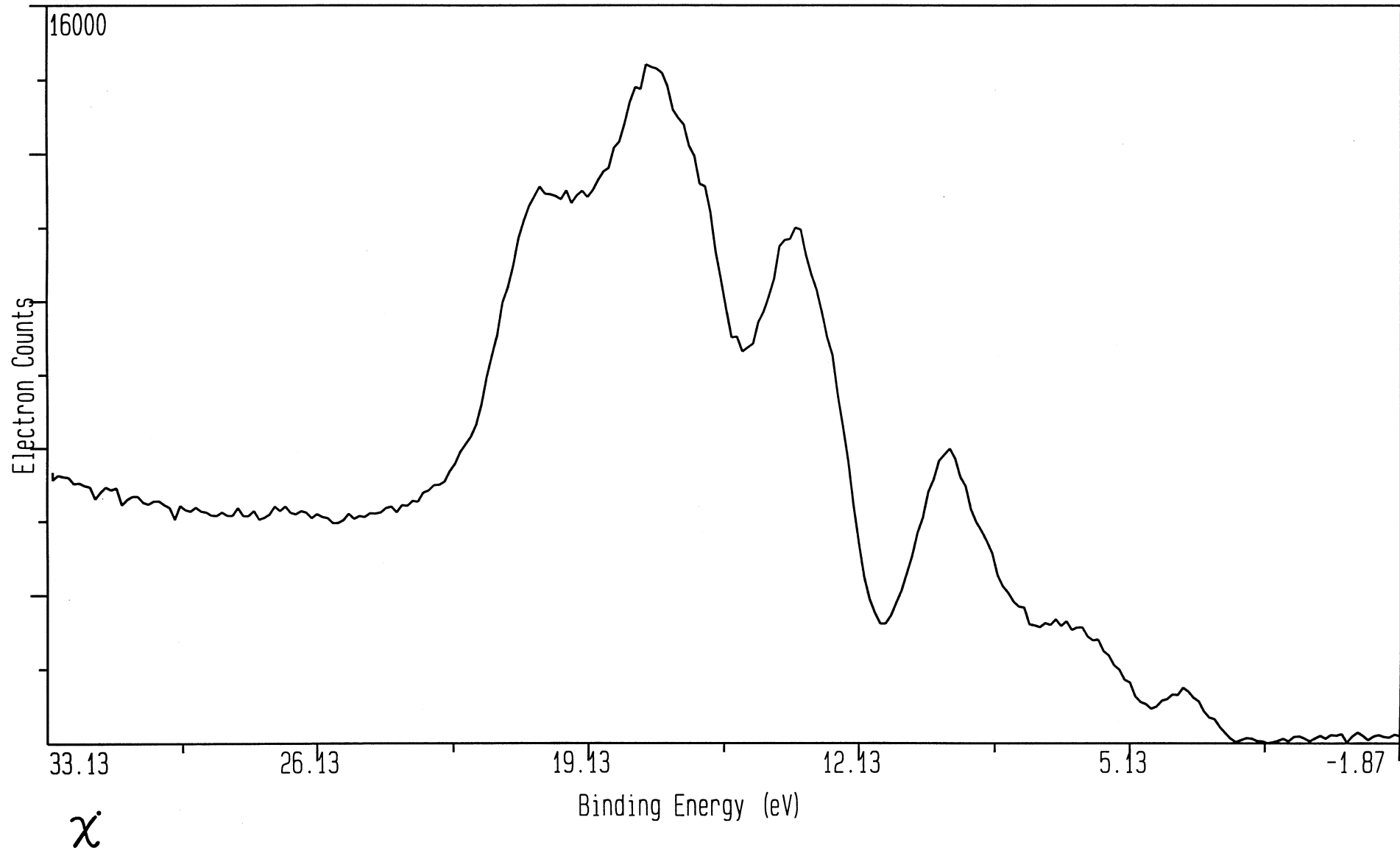
File: 4MPS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 4/17/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: RDM
Description: P (4-METHYL STYRENE); 2% W/V IN TOLUENE; MeOH PPT. (null)				



File: 4MPS_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 4/17/1988
Region: 2	Resolution: 1	Scans, Time: 100	Time/Point: 200	Operator: RDM
Description: P (4-METHYL STYRENE); 2% W/V IN TOLUENE; MeOH PPT. (null)				



File: 4MPS_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 4/17/1988
Region: 4	Resolution: 2	Scans, Time: 620	Time/Point: 200	Operator: RDM
Description: P (4-METHYL STYRENE); 2% W/V IN TOLUENE; MeOH PPT. (null)				



Poly – 4-Octyl Styrene

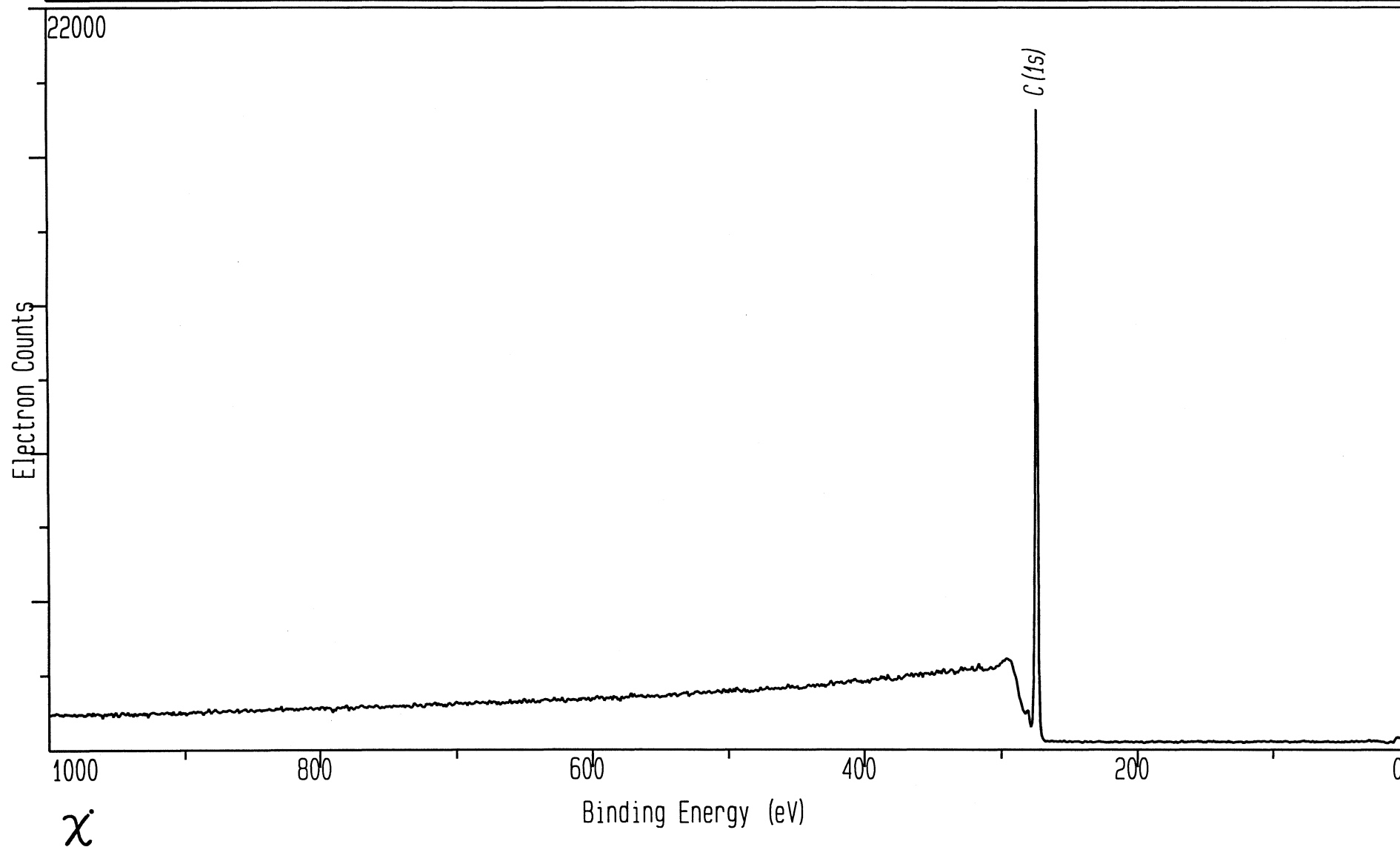
Detailed Surface Composition Table

File name: POS_SU.MRS
Region: 1
Description: NAKAHAMA, WC11-18-10, NH-49, poly 4-Octyl-Styrene

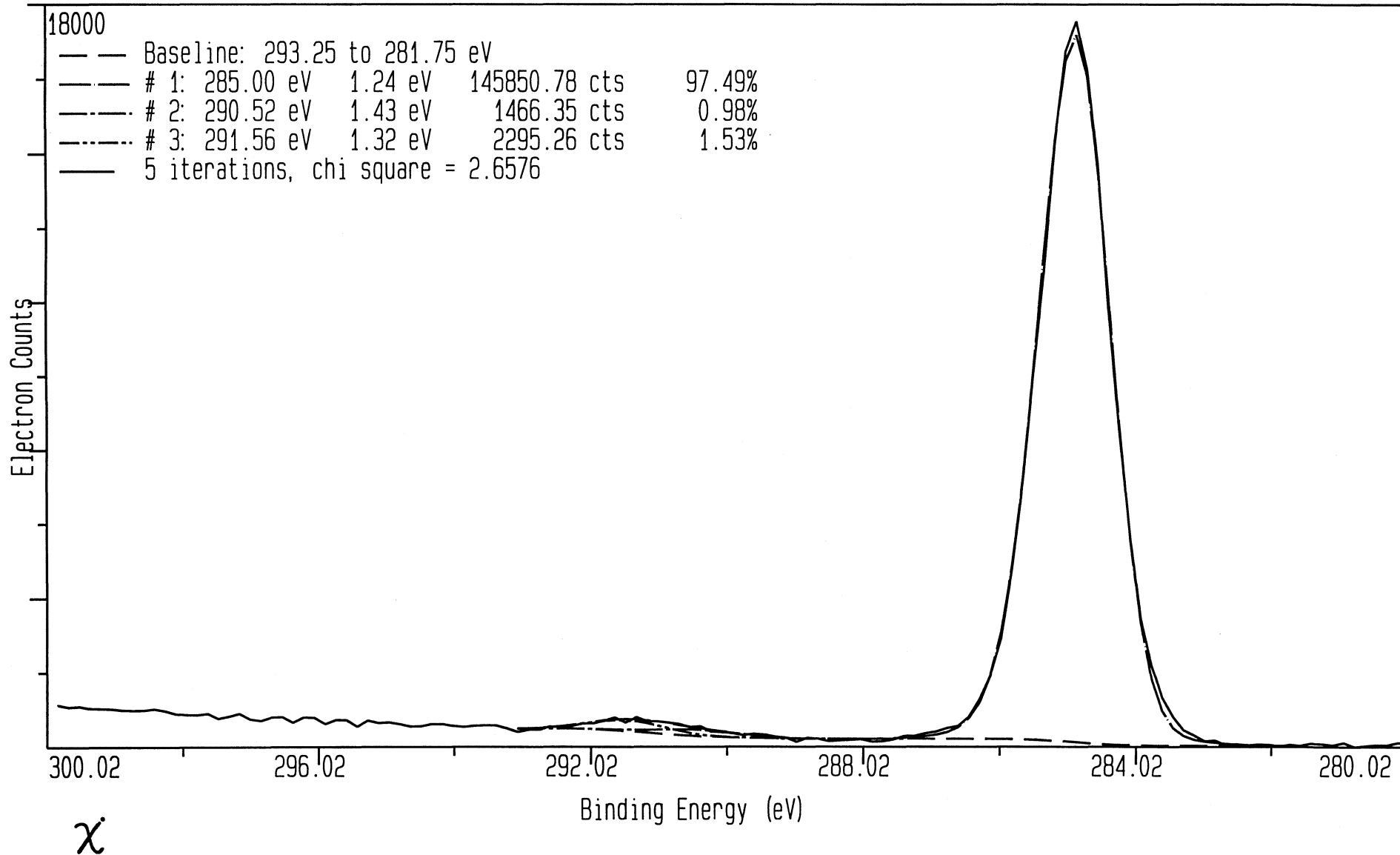
Operator: DGC
Date: Sat Jun 12 1993

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> %
* C 1s	278.9	273.9	1.01	49584	49277	100.00

File: POS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 6/12/1993
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-10, NH-49, poly (Octyl-Styrene)				



File: POS_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/12/1993
Region: 2	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: NAKAHAMA, WC11-18-10, NH-49, poly (Octyl-Styrene)				



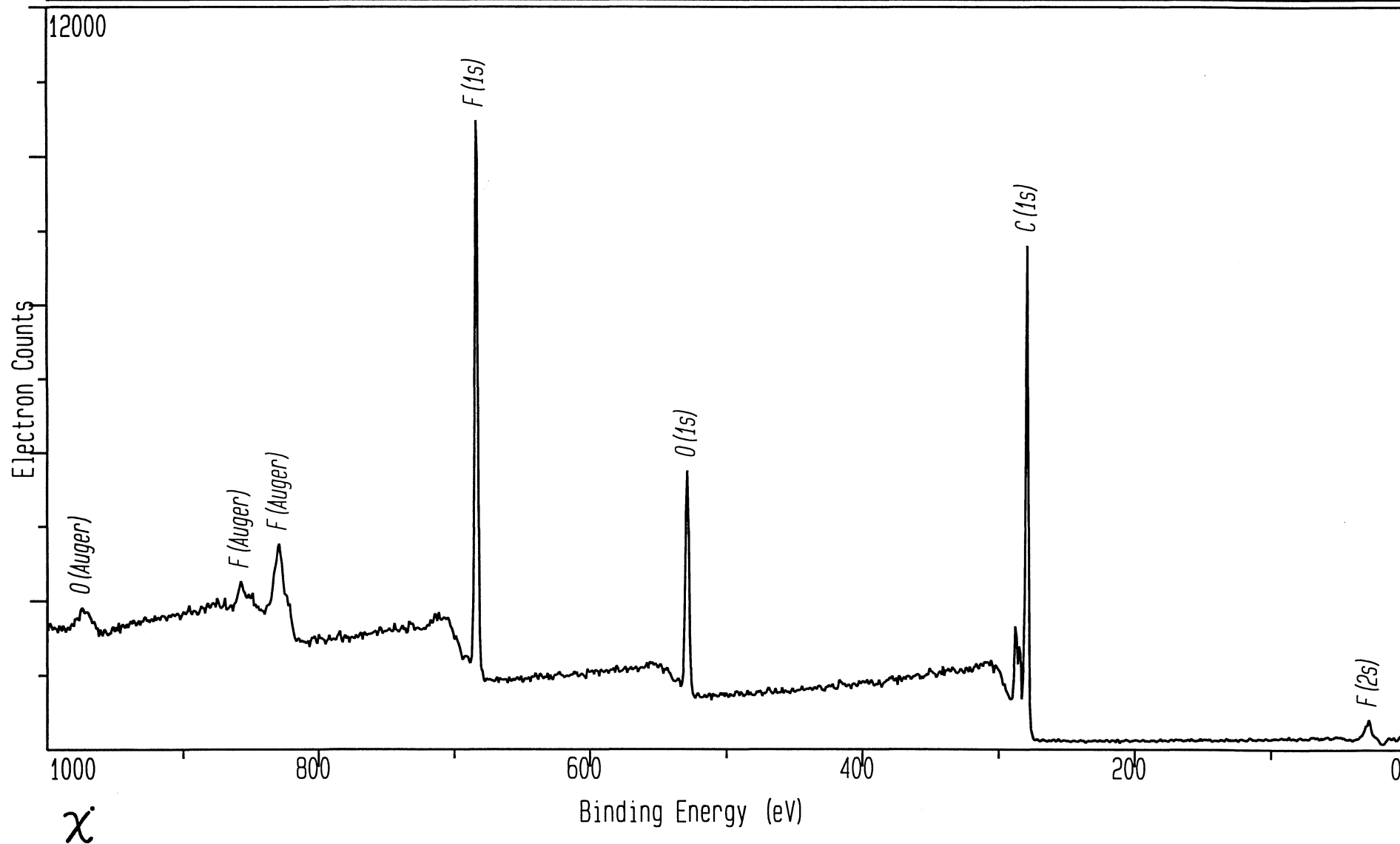
Poly - 4-Vinyl Phenol (TFAA derivative)

Detailed Surface Composition Table

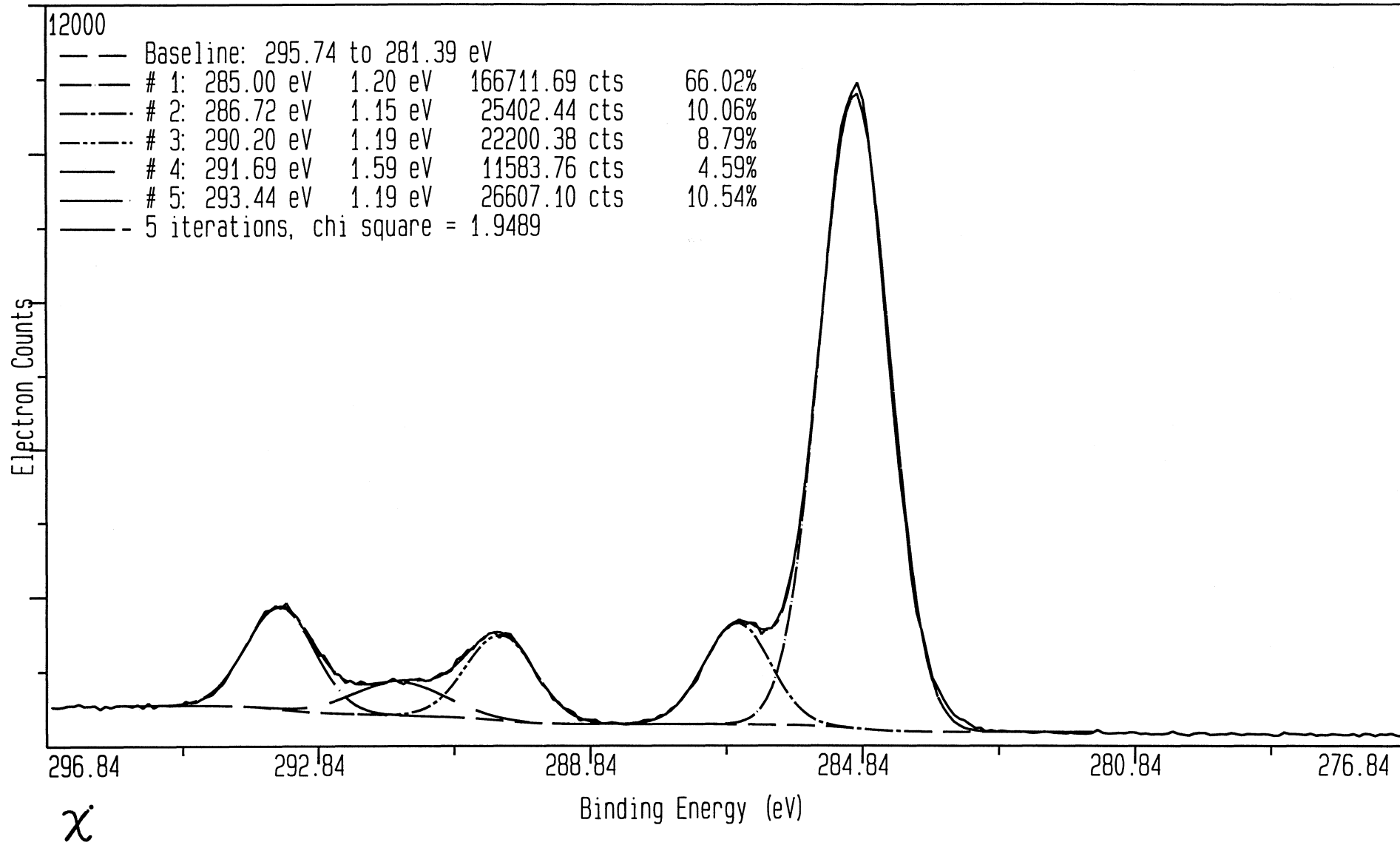
File name: TFAA_SU.MRS
Region: 1
Description: Poly(4-VINYL PHENOL)-TFAA Deriv. FROM 4% DIOXANE
TFAA = Tri-fluoro acetic anhydride derivative
Operator: DGC
Date: Thu Juul 6 1989

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> <u>%</u>
O Auger	976.3	974.3	0.00	4604	0	
F Auger	859.0	857.0	0.00	5413	0	
F Auger	831.0	829.0	0.00	31521	0	
* F 1s	685.6	683.6	3.34	64890	19427	20.90
* O 1s	530.5	528.5	2.50	28943	11577	12.46
* C 1s	281.0	279.0	1.00	62128	61926	66.64
F 2s	29.3	27.3	0.24	6224	25874	

File: TFAA_SU	Spot: 1000	Flood Gun: 2.0	Data Points: 1024	Date: 7/6/1989
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: Poly(4-VINYL PHENOL)-TFAA Deriv. FROM 4% DIOXANE TFAA = Tri-fluoro acetic anhydride derivative				



File: TFAA_C	Spot: 600	Flood Gun: 2.0	Data Points: 256	Date: 7/6/1989
Region: 2	Resolution: 1	Scans, Time: 40	Time/Point: 200	Operator: DGC
Description: Poly (4-VINYL PHENOL)-TFAA deriv. FROM 4% DIOXANE TFAA = Tri-fluoro acetic anhydride derivative				



Biomer (2% in HFIP)

Detailed Surface Composition Table

File name: BIOM_SU.MRS

Region: 1

Description: WC8-15-VII-1,2% BIOMER IN HFIP (2X PPTED) ON GLASS (HFIP = Hexafluoro isopropanol)

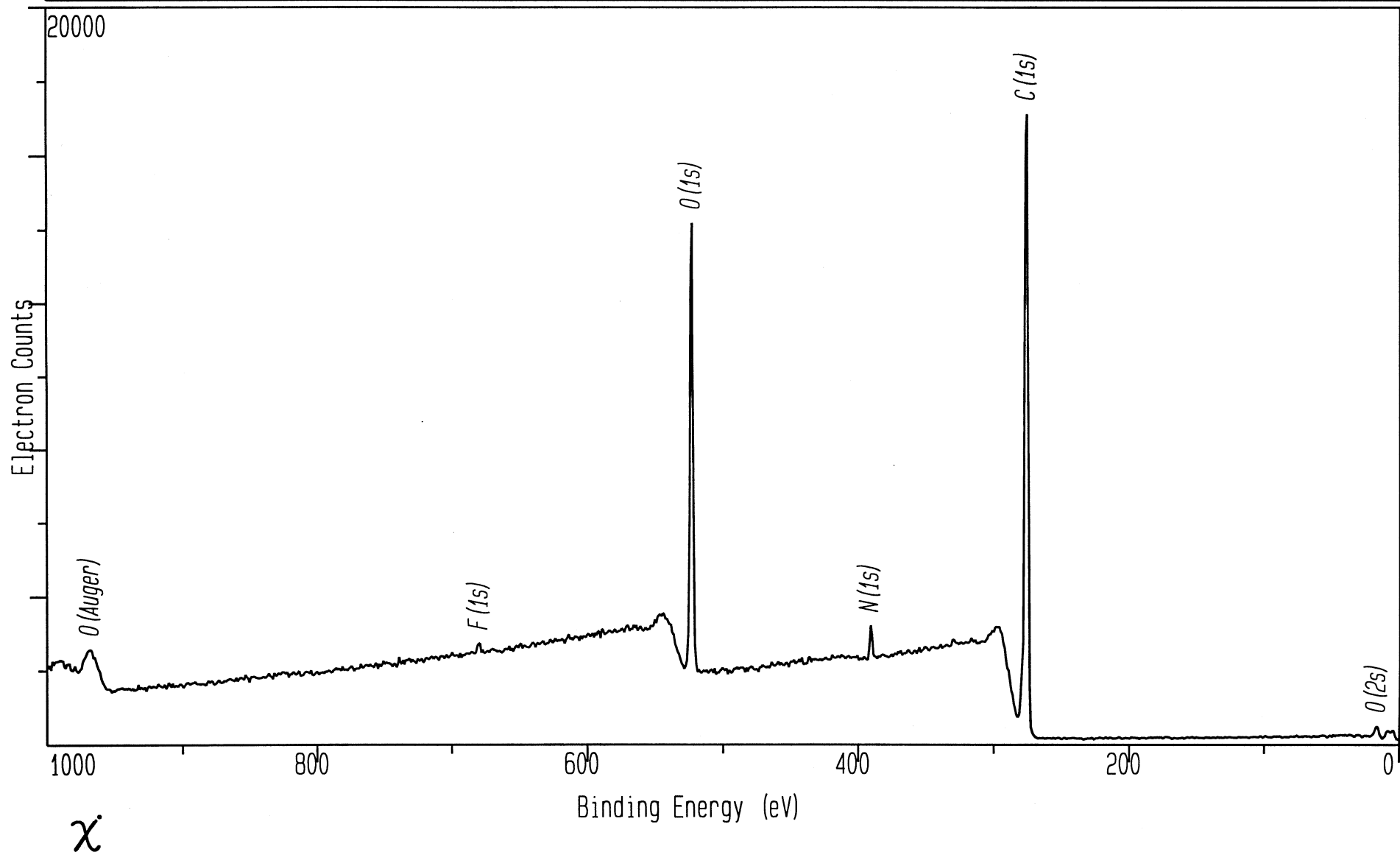
Operator: DGC

Date: Tue Sep 22 1987

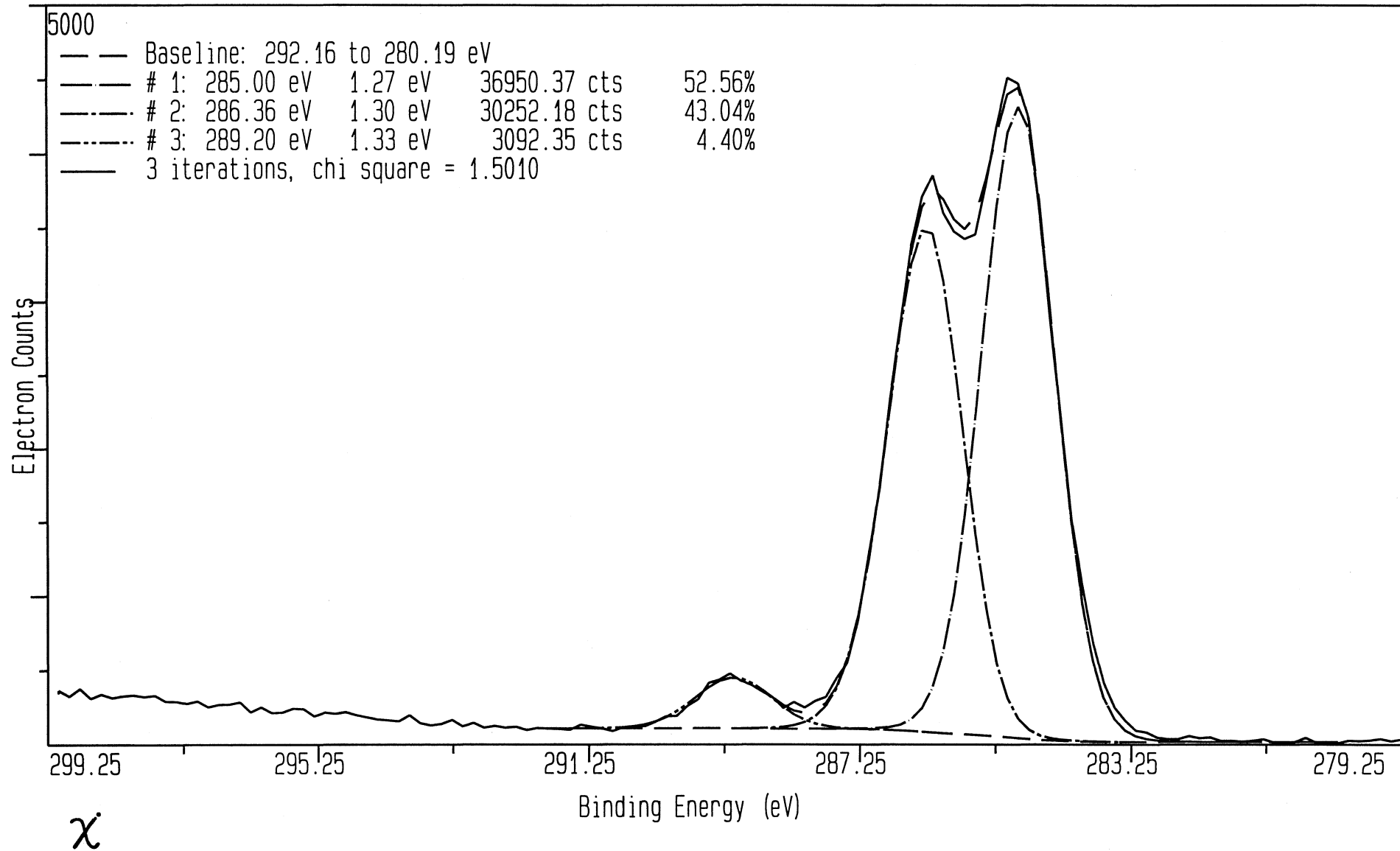
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> <u>%</u>
O Auger	972.9	967.9	0.00	11289	0	
* F 1s	684.5	679.5	3.36	979	291	0.34
* O 1s	527.9	522.9	2.51	40547	16153	19.07
* N 1s	395.2	390.2	1.70	2430	1433	1.69
* C 1s	280.4	275.4	1.01	67207	66848	78.90
O 2s	20.8	15.8	0.16	1447	8976	

χ

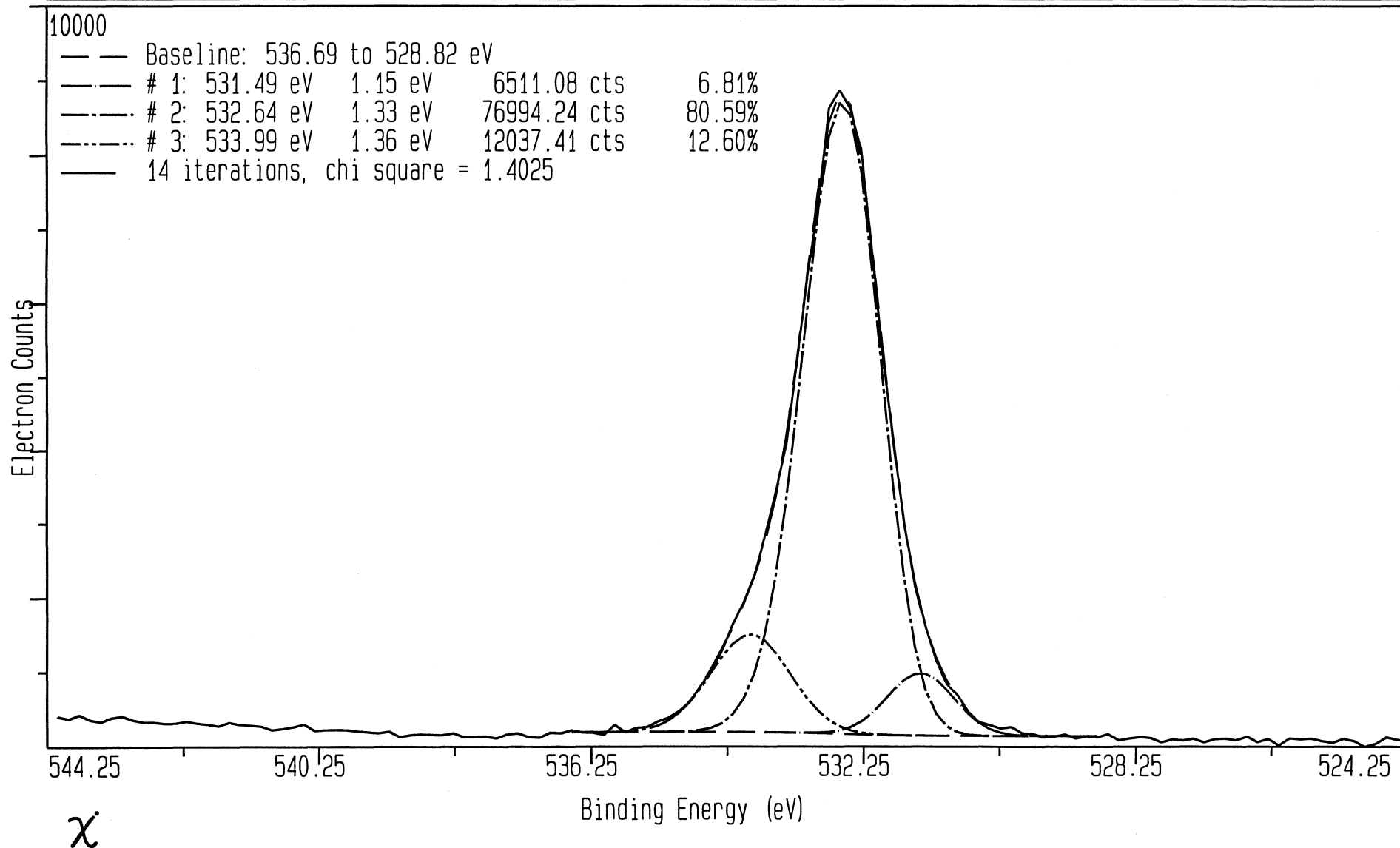
File: BIOM_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 9/22/1987
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: WC8-15-VII-1, 2% BIOMER IN HFIP (2X PPTED) ON GLASS (null)				



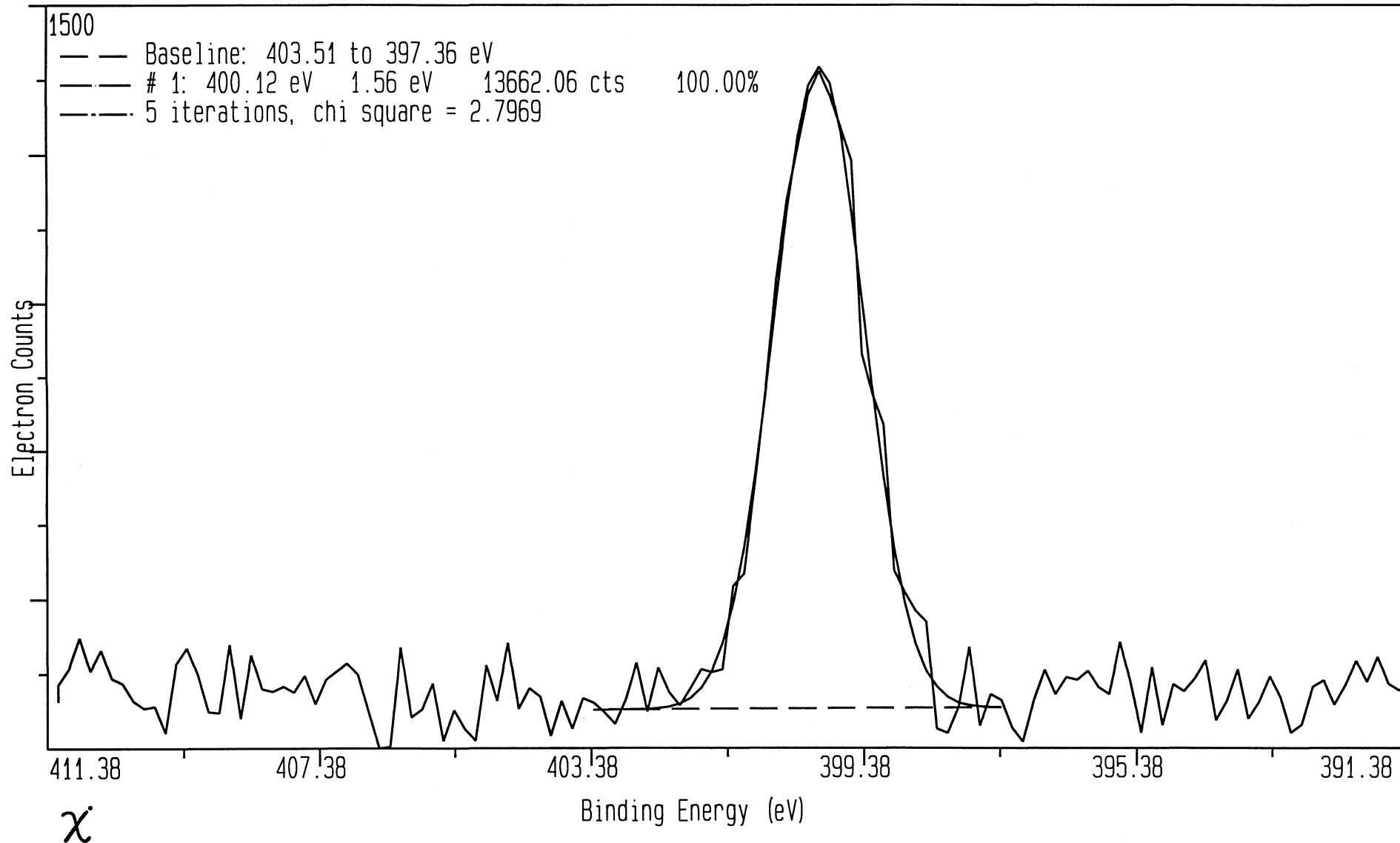
File: BIOM_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 9/22/1987
Region: 3	Resolution: 1	Scans, Time: 20	Time/Point: 200	Operator: DGC
Description: WC8-15-VII-1, 2% BIOMER IN HFIP (2X PPTED) ON GLASS (null)				



File: BIOM_0	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 9/22/1987
Region: 4	Resolution: 1	Scans, Time: 40	Time/Point: 200	Operator: DGC
Description: WC8-15-VII-1, 2% BIOMER IN HFIP (2X PPTED) ON GLASS (null)				



File: BIOM_N	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 9/22/1987
Region: 5	Resolution: 1	Scans, Time: 100	Time/Point: 200	Operator: DGC
Description: WC8-15-VII-1, 2% BIOMER IN HFIP (2X PPTED) ON GLASS (null)				



Cellulose (filter paper)

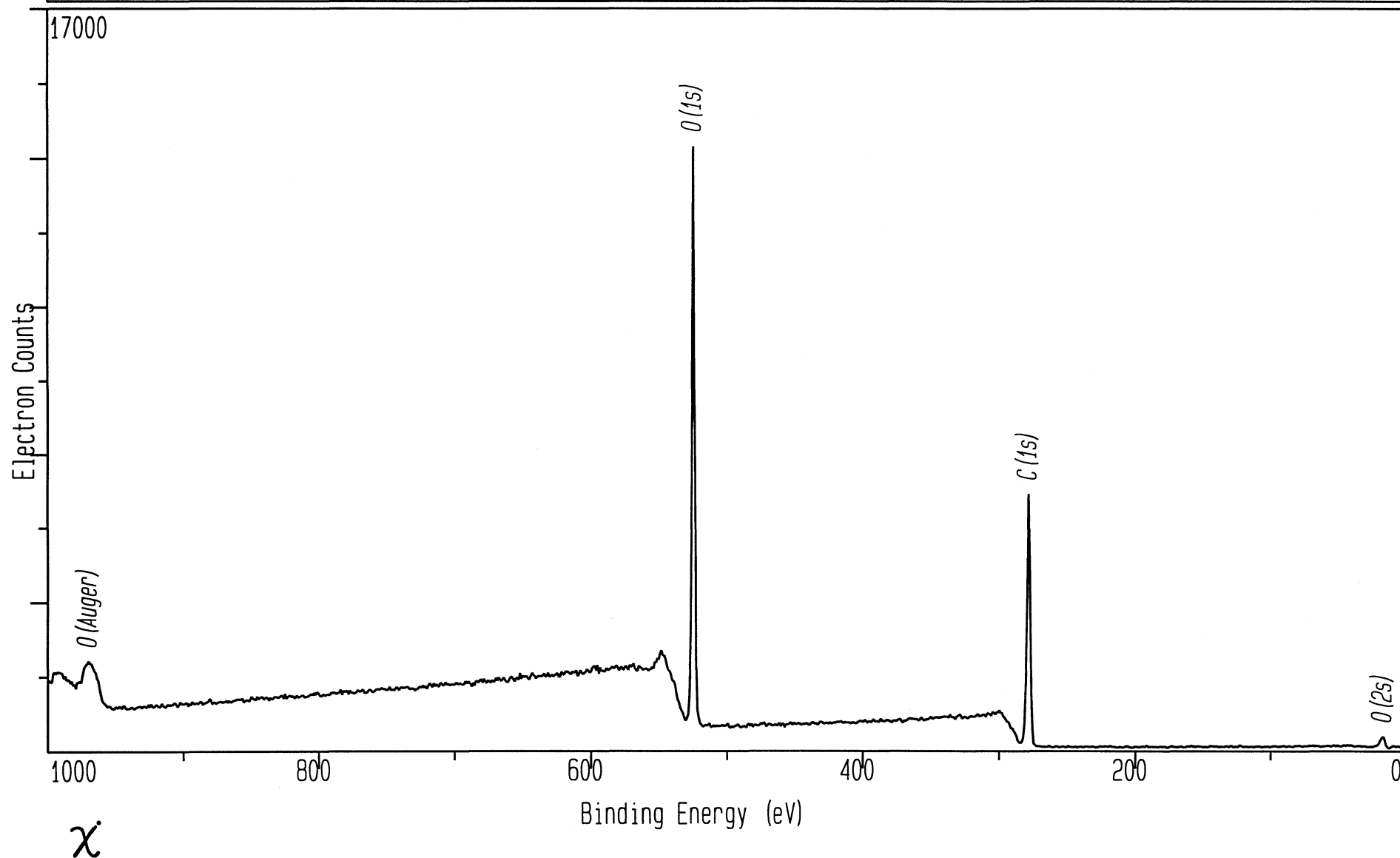
Detailed Surface Composition Table

File name: CELL_SU.MRS
Region: 1
Description: WHATMAN™ CELLULOSE FILTER PAPER, CONTROL

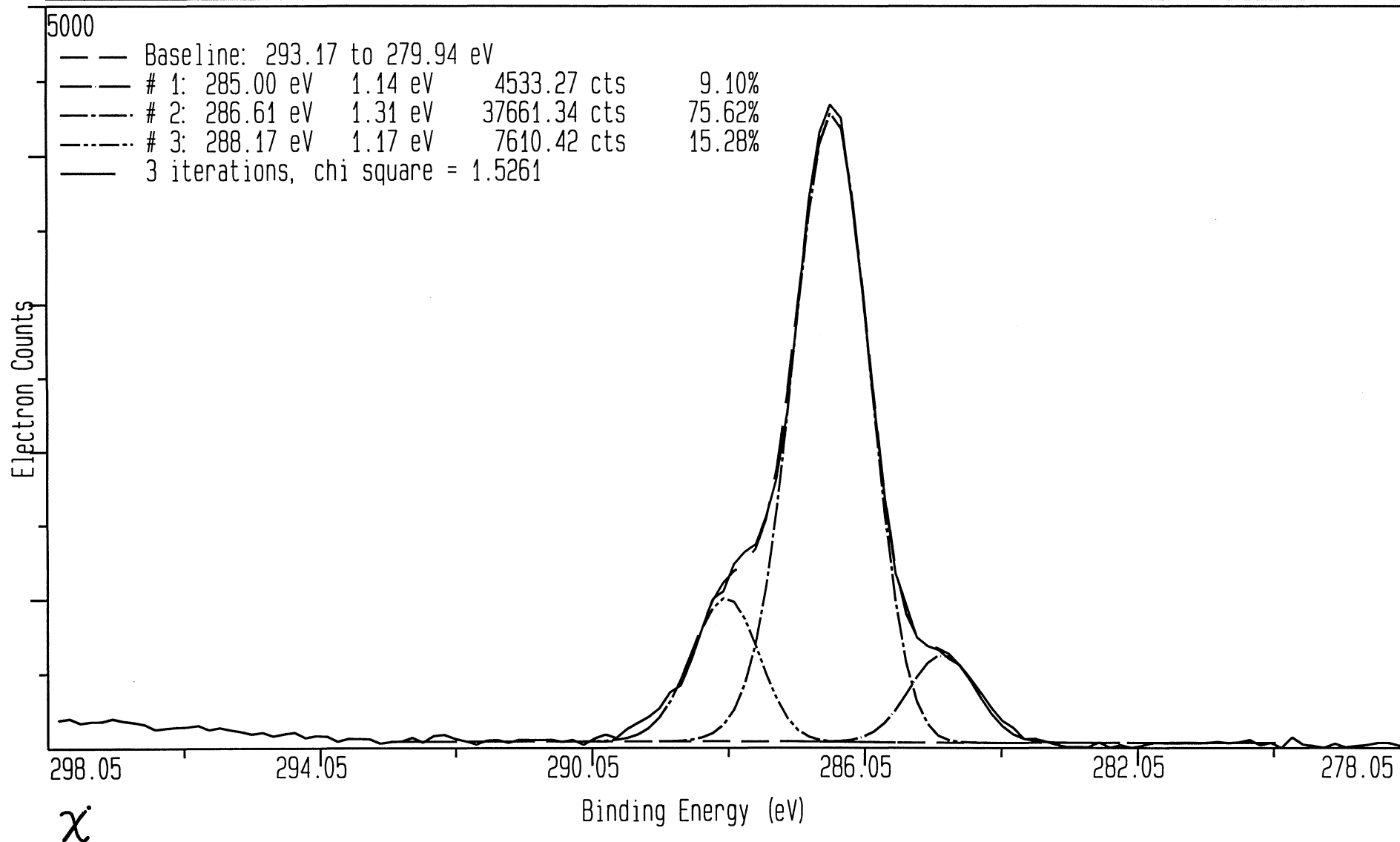
Operator: DLS
Date: Wed Nov 21 1990

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	974.7	969.7	0.00	11021	0	
* O 1s	529.4	524.4	2.51	39563	15779	43.71
* C 1s	282.8	277.8	1.00	20401	20320	56.29
O 2s	21.8	16.8	0.16	1540	9555	

File: CELL_SU Region: 1	Spot: 1000 Resolution: 4	Flood Gun: 5.0 Scans, Time: 4	Data Points: 1024 Time/Point: 200	Date: 11/21/1990 Operator: DLS
Description: WHATMAN CELLULOSE FILTER PAPER, CONTROL (null)				



File: CELL_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 11/21/1990
Region: 2	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: DLS
Description: WHATMAN CELLULOSE FILTER PAPER, CONTROL (null)				



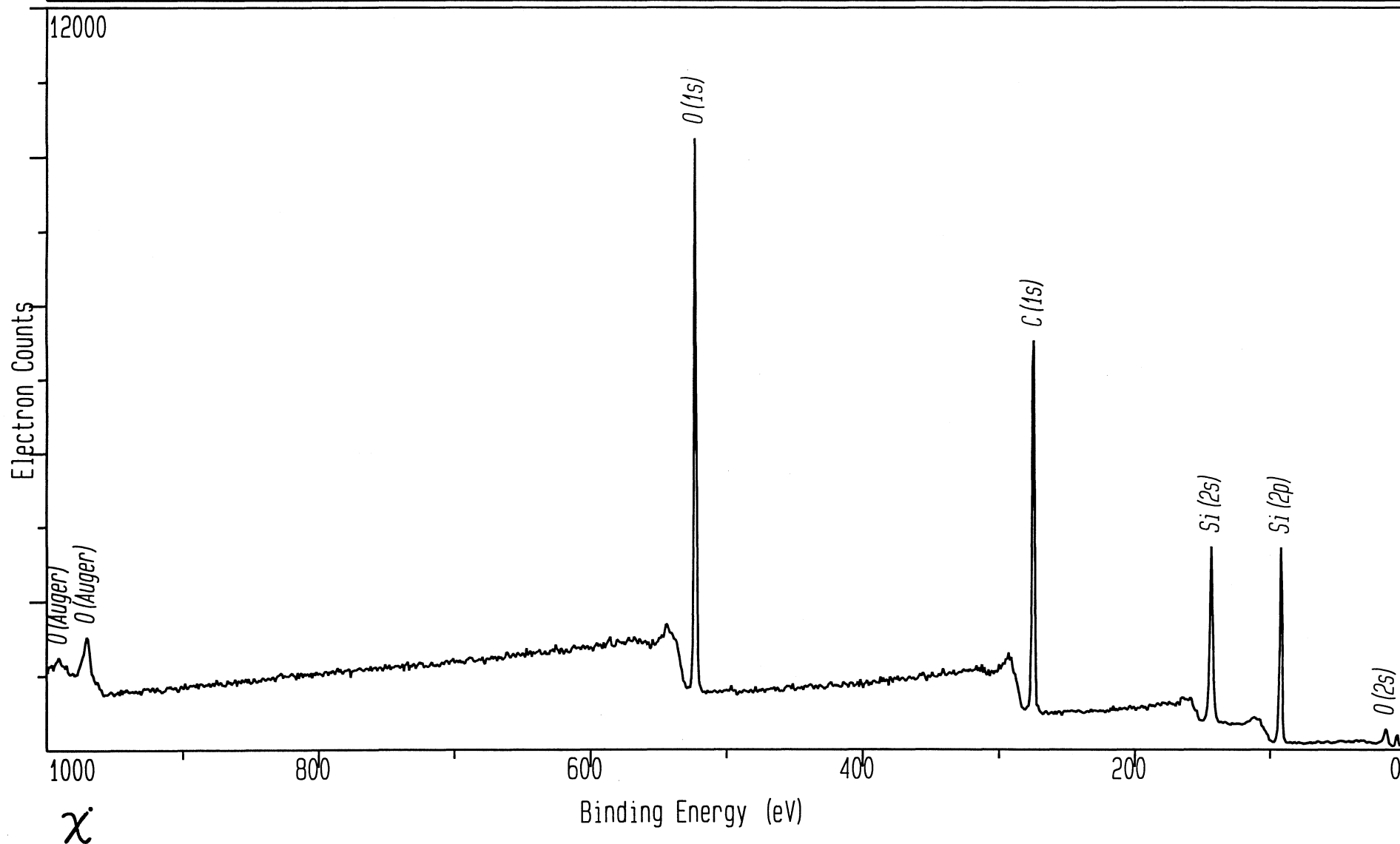
Poly - Dimethylsiloxane (as received)

Detailed Surface Composition Table

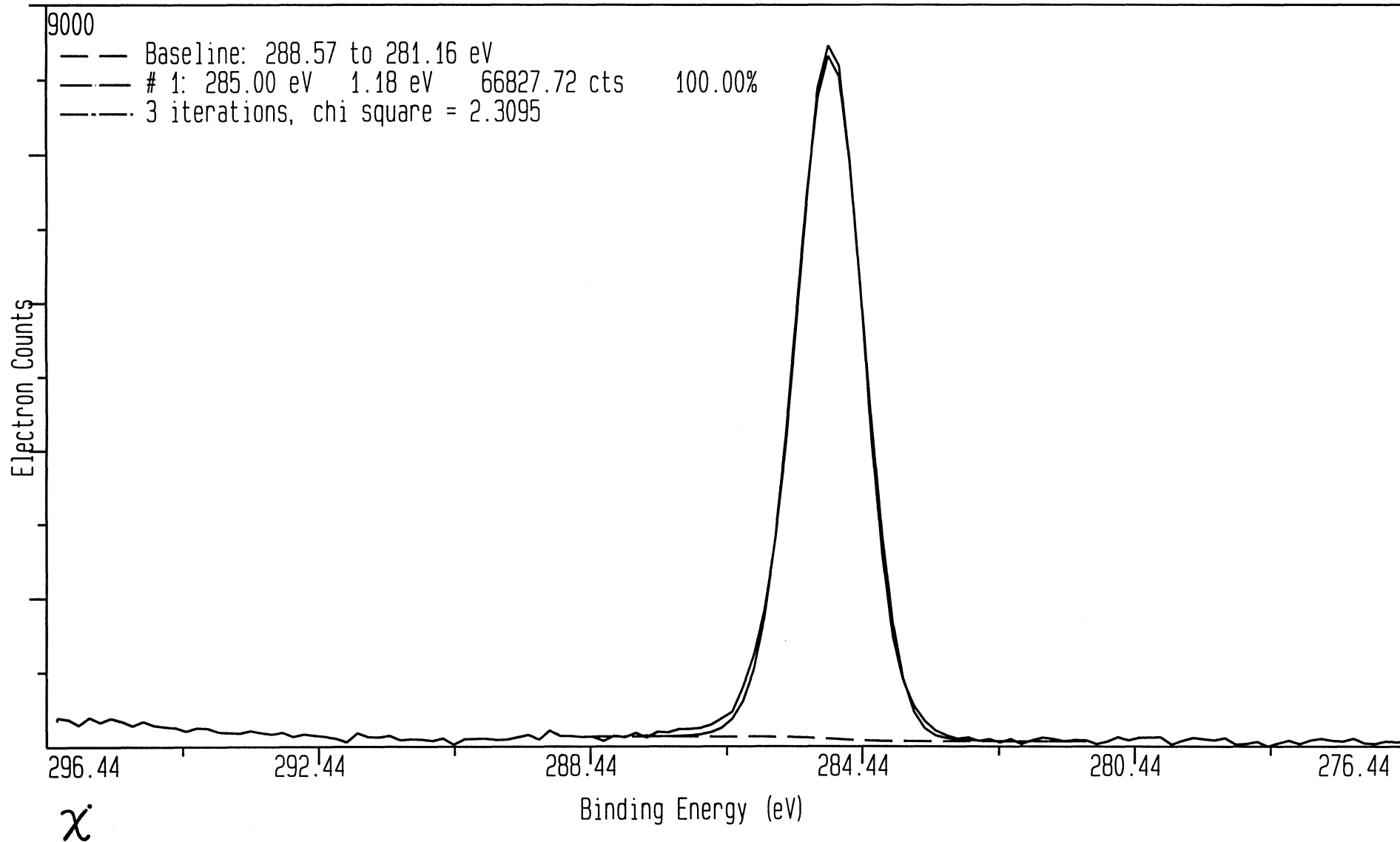
File name: PDMS_SU.MRS
Region: 1
Description: PDMS VB & Hi Res, NIH STANDARD, TOA=0
Poly-dimethyl siloxane (National Institute Health)
Operator: DGC
Date: Sun Aug 21 1988

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	996.1	991.1	0.00	4784	0	
O Auger	975.4	970.4	0.00	13996	0	
* O 1s	527.5	522.5	2.51	45868	18267	24.64
* C 1s	279.4	274.4	1.01	36432	36217	48.86
* Si2s	147.9	142.9	1.03	20283	19645	26.50
Si2p	96.8	91.8	0.91	17827	19662	
O 2s	19.4	14.4	0.16	2480	15373	

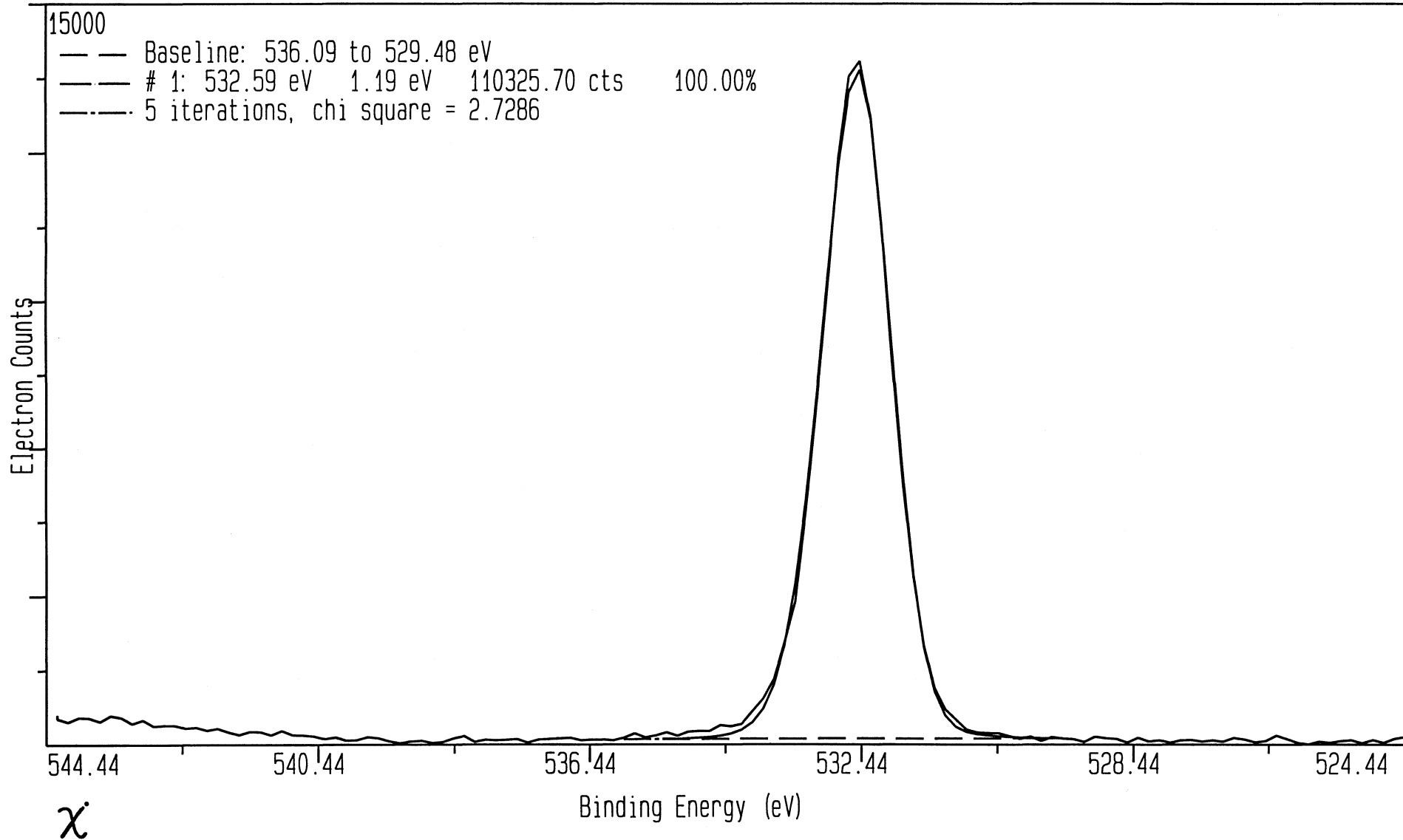
File: PDMS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 8/21/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: PDMS VB & Hi Res, NIH STANDARD, T.O. ANG=0 Poly-dimethyl siloxane (National Institute Health)				



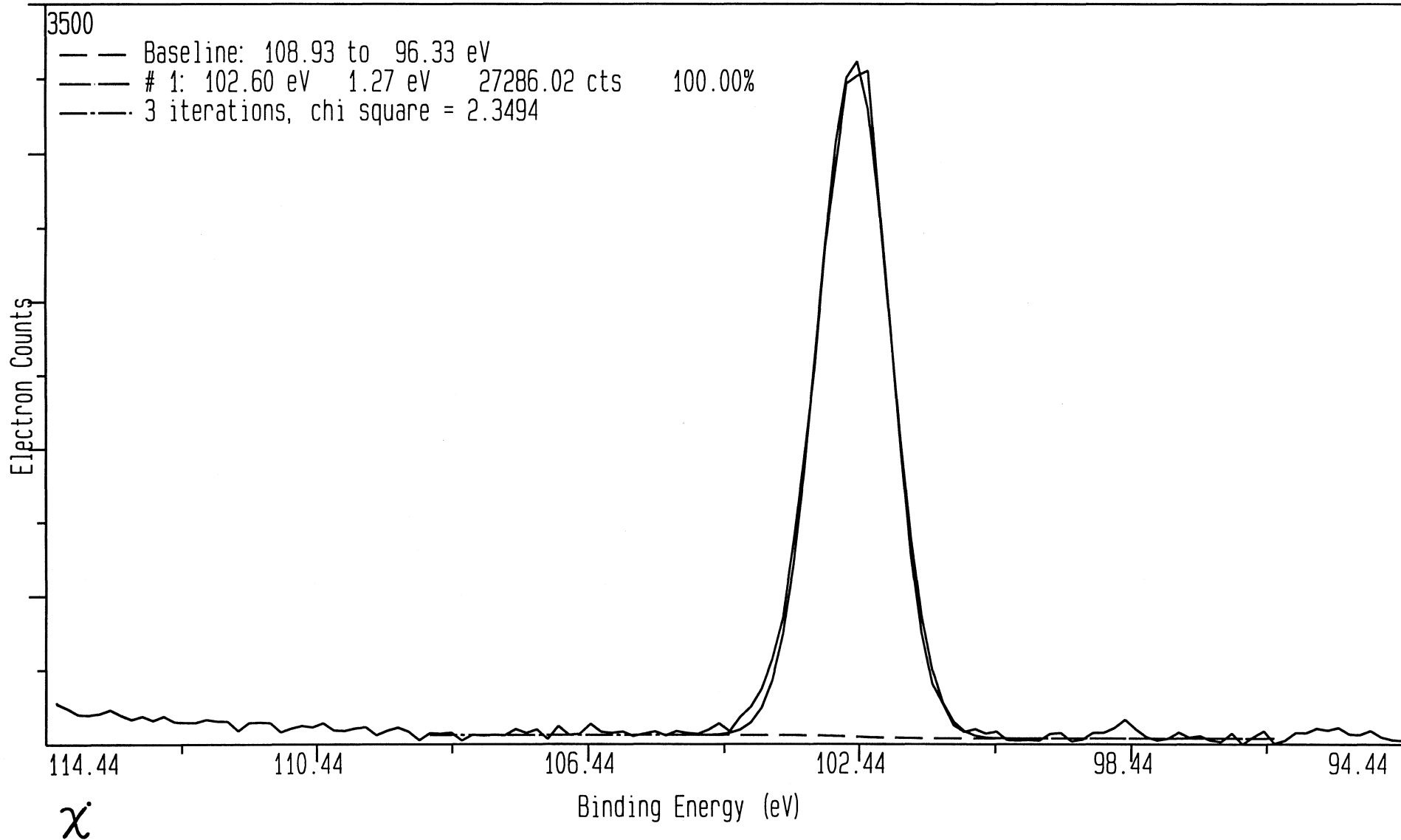
File: PDMS_C Region: 8	Spot: 300 Resolution: 1	Flood Gun: 5.0 Scans, Time: 50	Data Points: 128 Time/Point: 200	Date: 8/21/1988 Operator: DGC
Description: PDMS VB & Hi Res, NIH STANDARD, T.O. ANG=0 Poly-dimethyl siloxane (National Institute Health)				



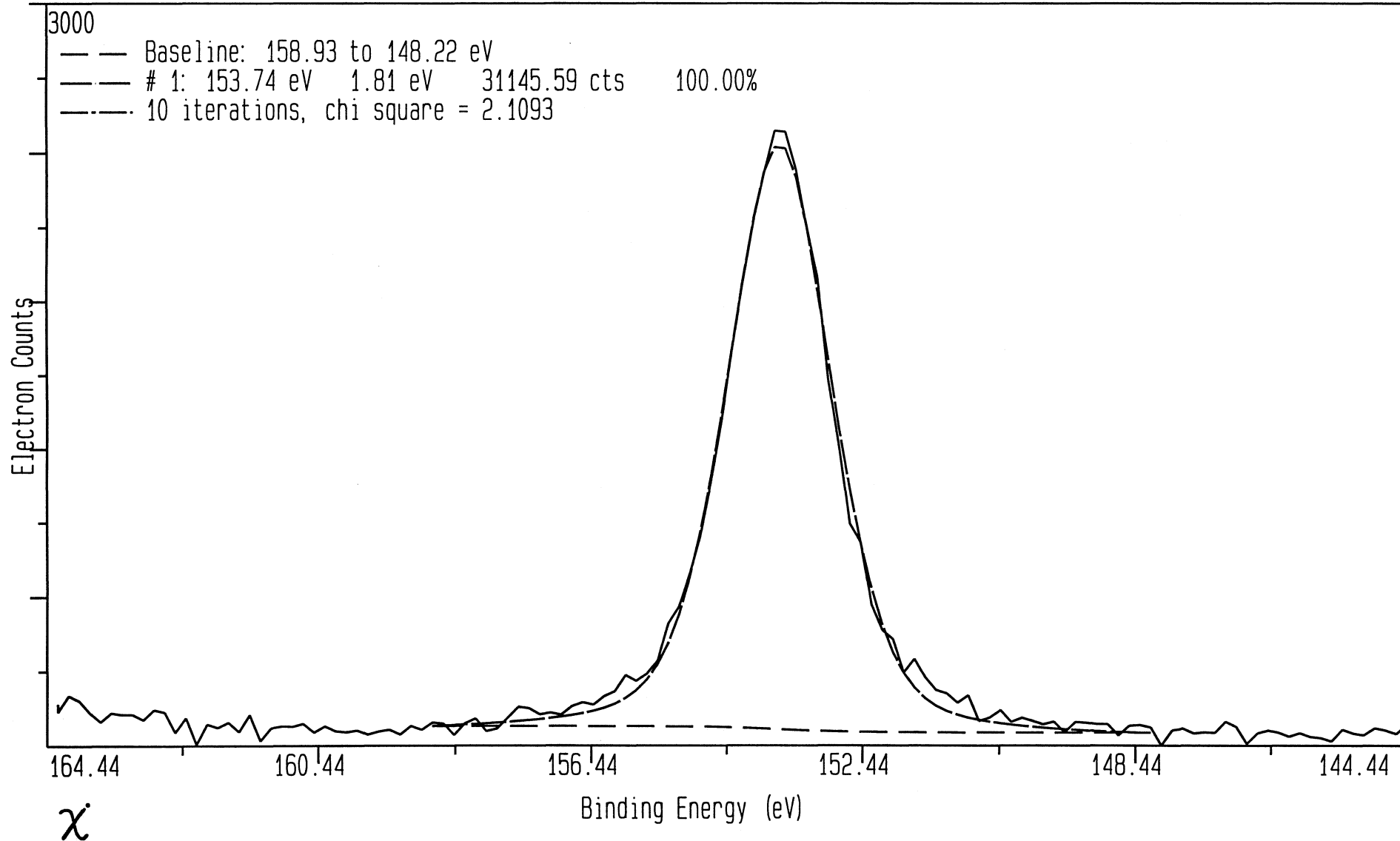
File: PDMS_0	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 8/21/1988
Region: 9	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: PDMS VB & Hi Res, NIH STANDARD, T.O. ANG=0 Poly-Dimethyl siloxane (National Institute Health)				



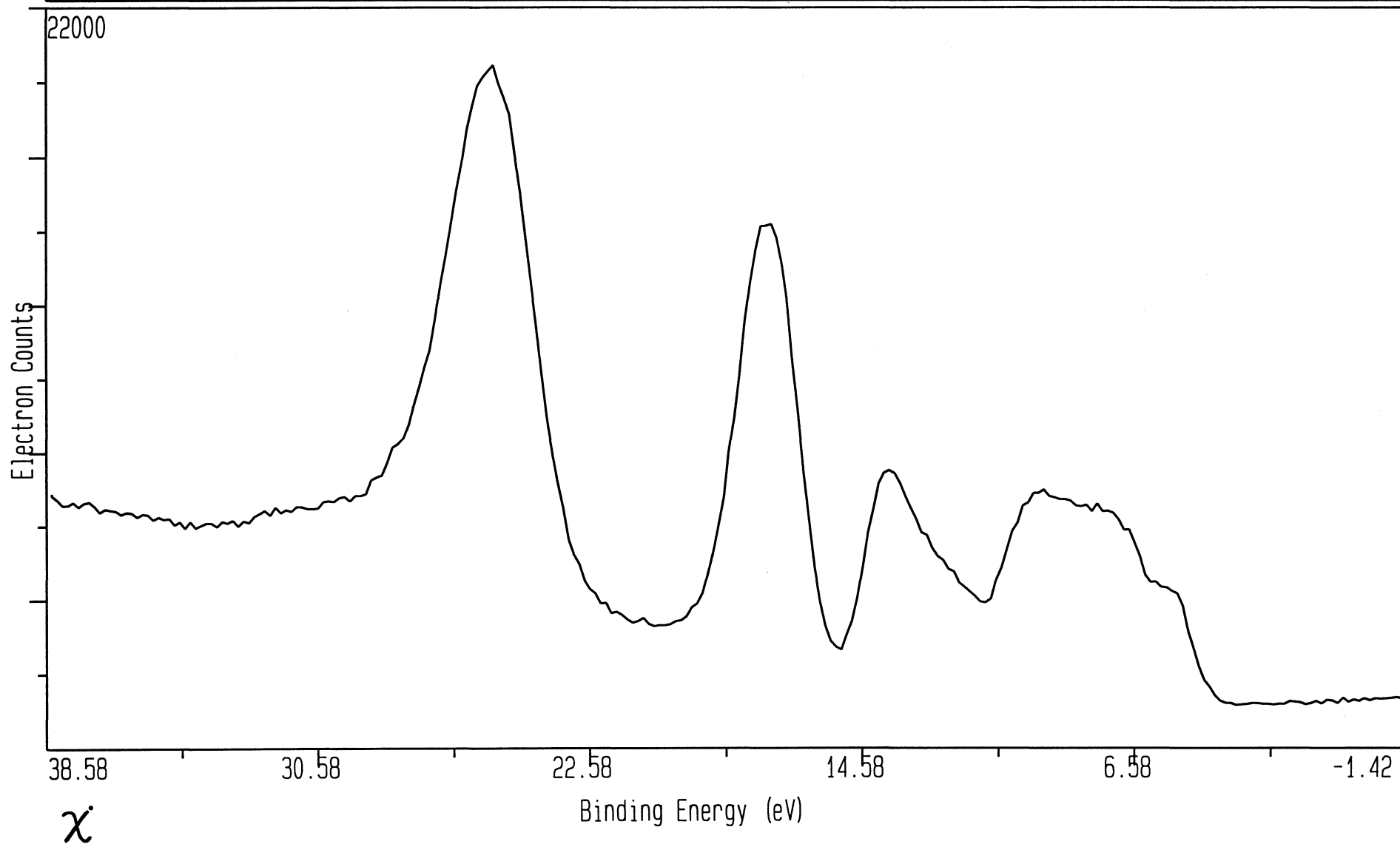
File: PDMS_SI1	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 8/21/1988
Region: 6	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: PDMS VB & Hi Res, NIH STANDARD, T.O. ANG=0 Poly-dimethyl siloxane (National Institute Health)				



File: PDMS_SI2	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 8/21/1988
Region: 7	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: PDMS VB & Hi Res, NIH STANDARD, T.O. ANG=0 Poly-dimethyl siloxane (National Institute Health)				



File: PDMS_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 8/21/1988
Region: 11	Resolution: 2	Scans, Time: 530	Time/Point: 200	Operator: DGC
Description: PDMS VB & Hi Res, NIH STANDARD, T.O. ANG=0 Poly-dimethyl siloxane (National Institute Health)				



Poly - Ether Ether Ketone (pressed wafer)

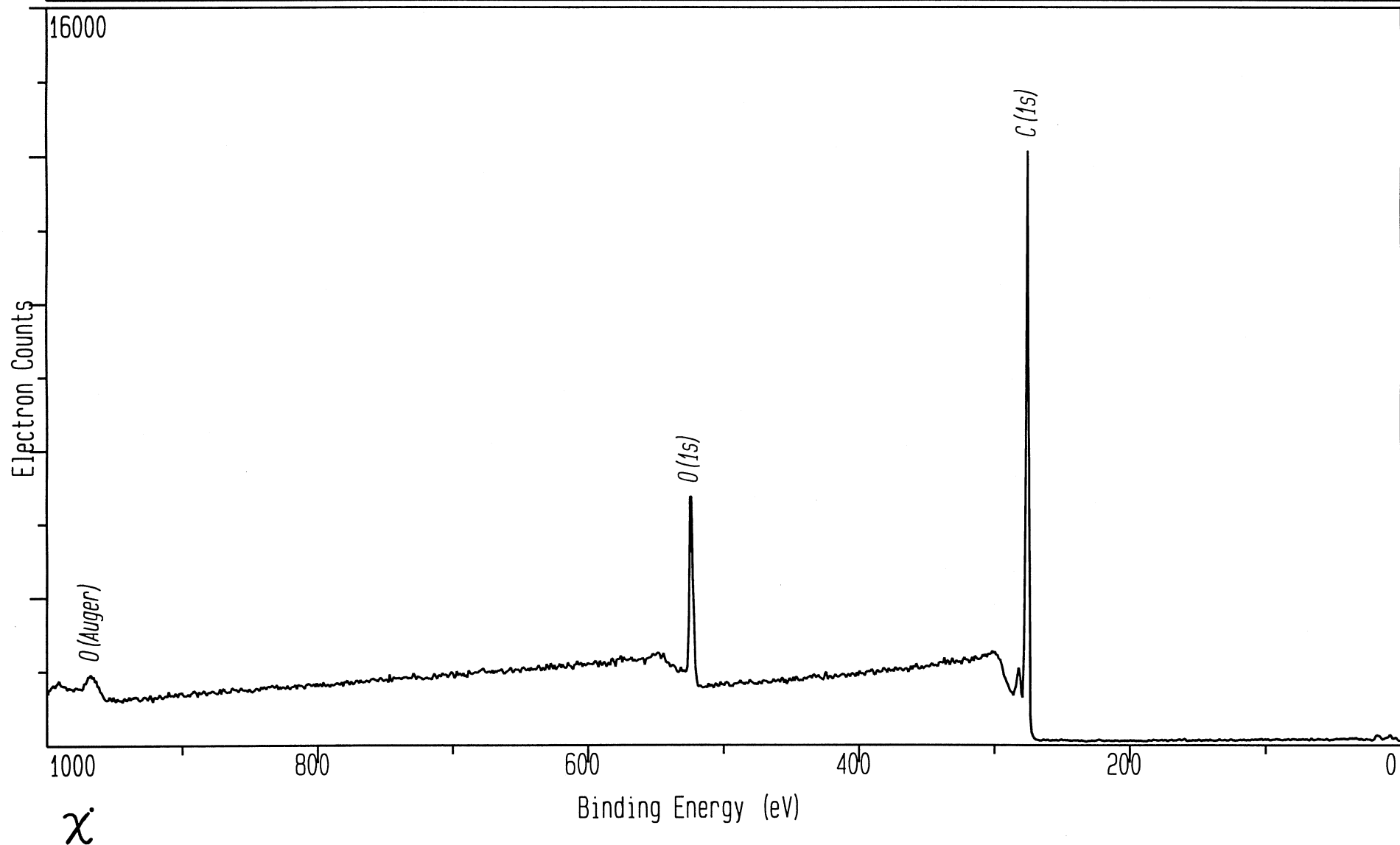
Detailed Surface Composition Table

File name: PEEK_SU.MRS
Region: 1
Description: PRESSED WAFER OF PEEK; TOA=0, 2nd SPOT, PEEK = Poly Ether Ether Ketone

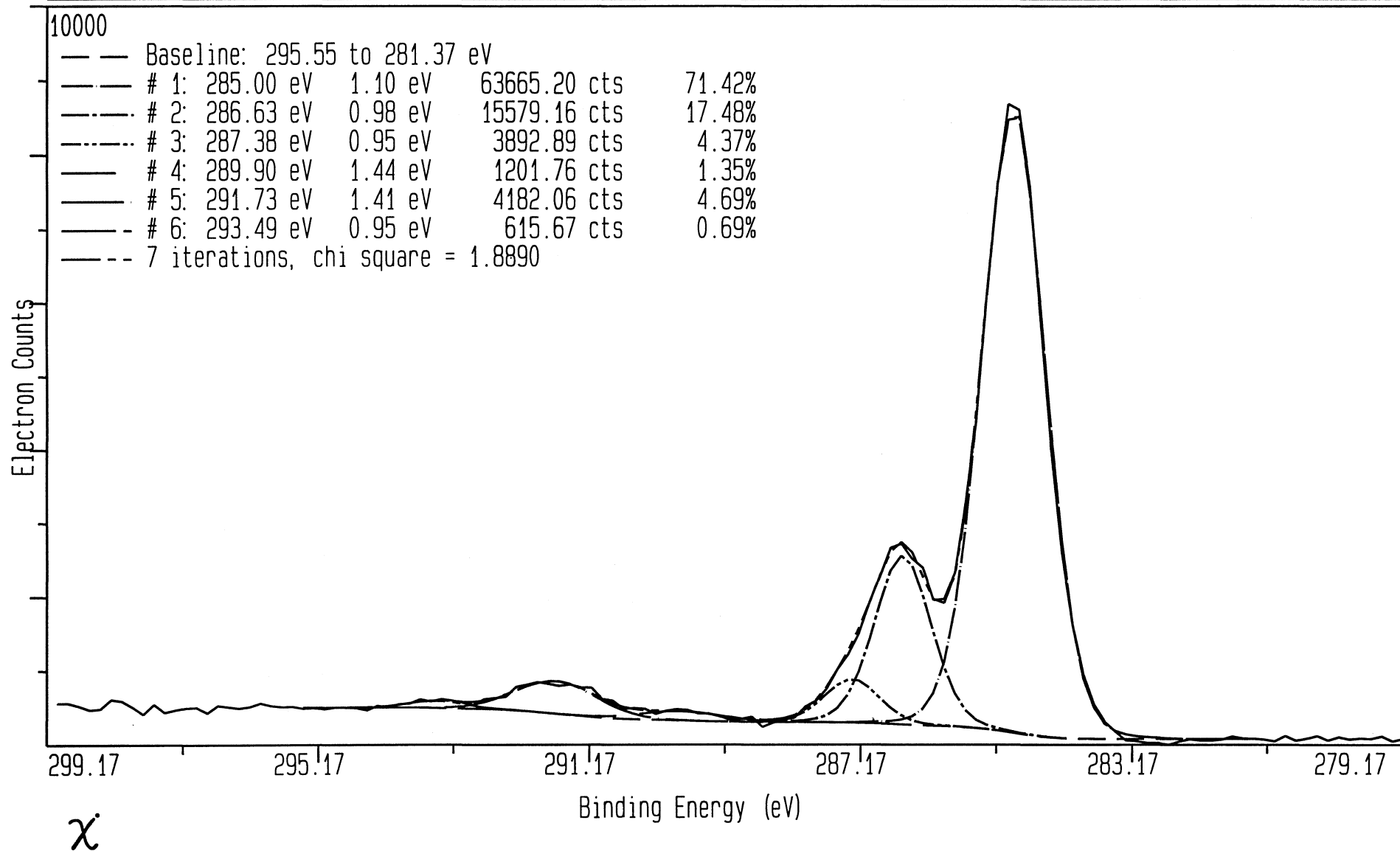
Operator: DGC
Date: Wed Aug 6 1997

<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
O Auger	972.8	967.8	0.00	10580	0	
* O 1s	529.0	524.0	2.51	34489	13751	14.10
* C 1s	280.1	275.1	1.01	84211	83748	85.90

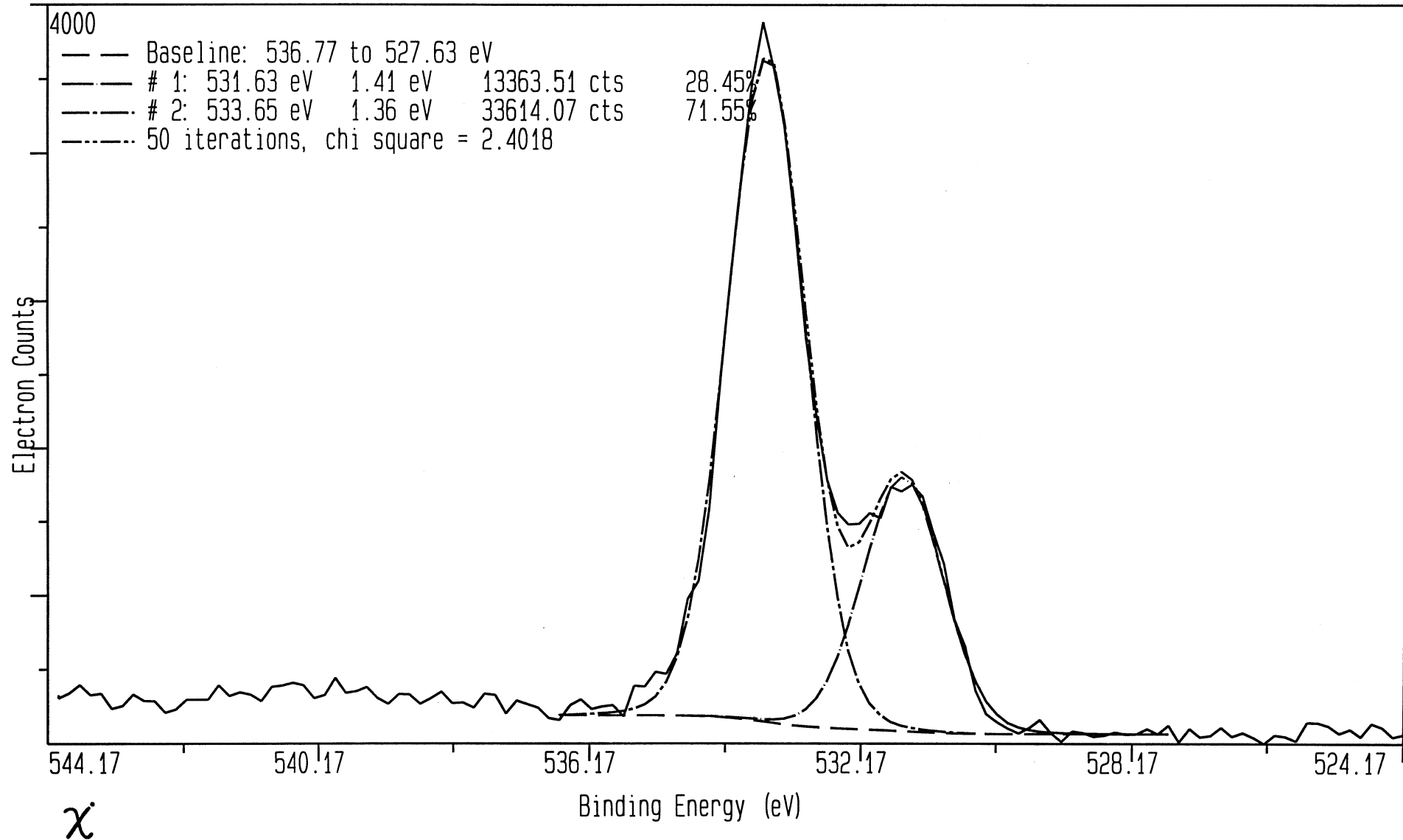
File: PEEK_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 8/6/1997
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: PRESSED WAFER OF PEEK; T.O. ANG=0, 2nd SPOT Poly Ether Ether Ketone (PEEK)				



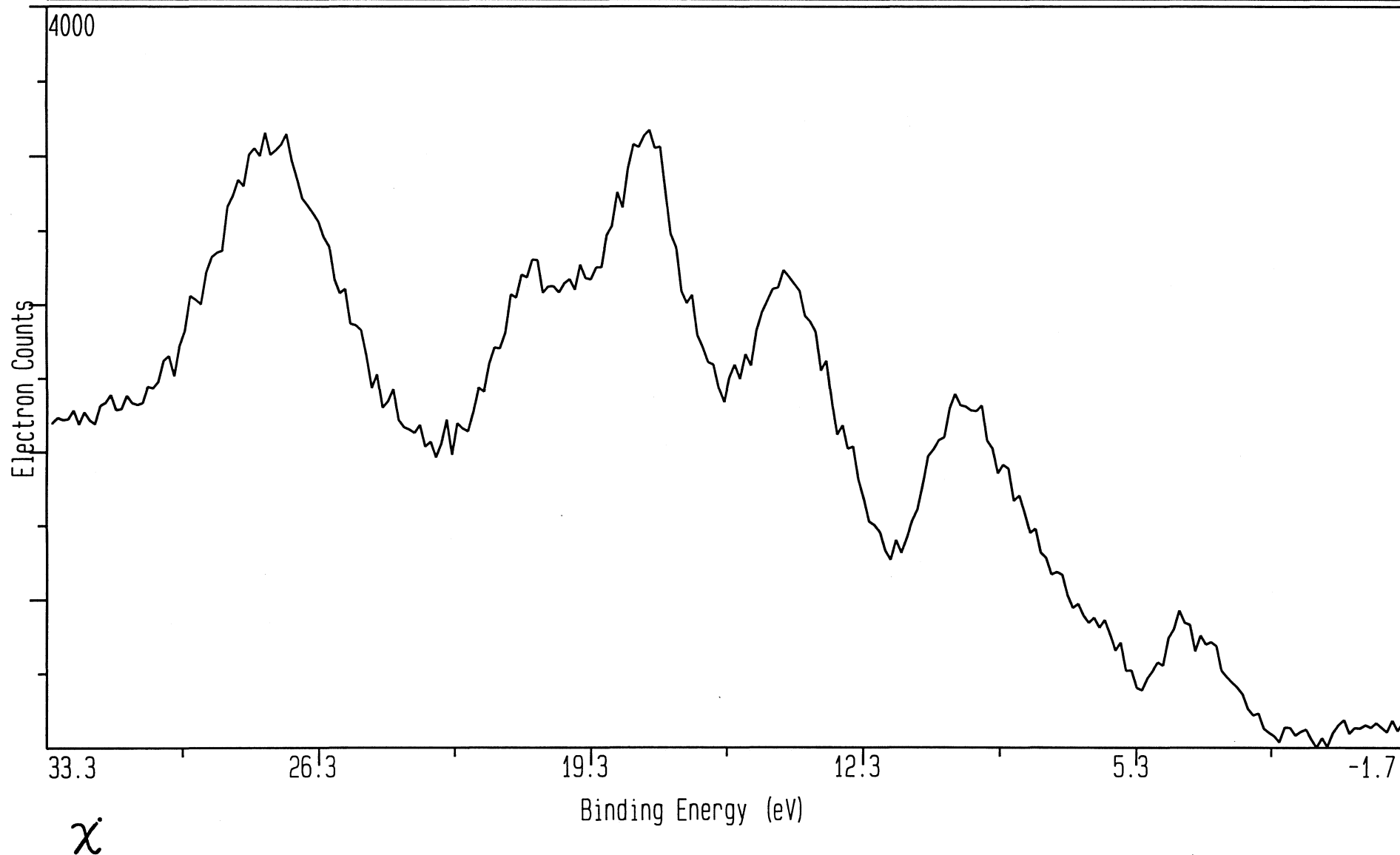
File: PEEK_C	Spot: 150	Flood Gun: 5.0	Data Points: 128	Date: 8/6/1997
Region: 1	Resolution: 1	Scans, Time: 200	Time/Point: 200	Operator: DGC
Description: PRESSED WAFER OF PEEK; T.O. ANG=0, 2nd SPOT Poly Ether Ether Ketone (PEEK)				



File: PEEK_0	Spot: 150	Flood Gun: 5.0	Data Points: 128	Date: 8/6/1997
Region: 1	Resolution: 1	Scans, Time: 200	Time/Point: 200	Operator: DGC
Description: PRESSED WAFER OF PEEK; T.O. ANG=0, 2nd SPOT Poly Ether Ether Ketone (PEEK)				



File: PEEK_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 5/8/1988
Region: 5	Resolution: 2	Scans, Time: 332	Time/Point: 200	Operator: RDM
Description: Valence Band Region of PEEK 0 deg TOA Poly Ether Ether Ketone (PEEK)				



Poly - Ethyl Acrylate

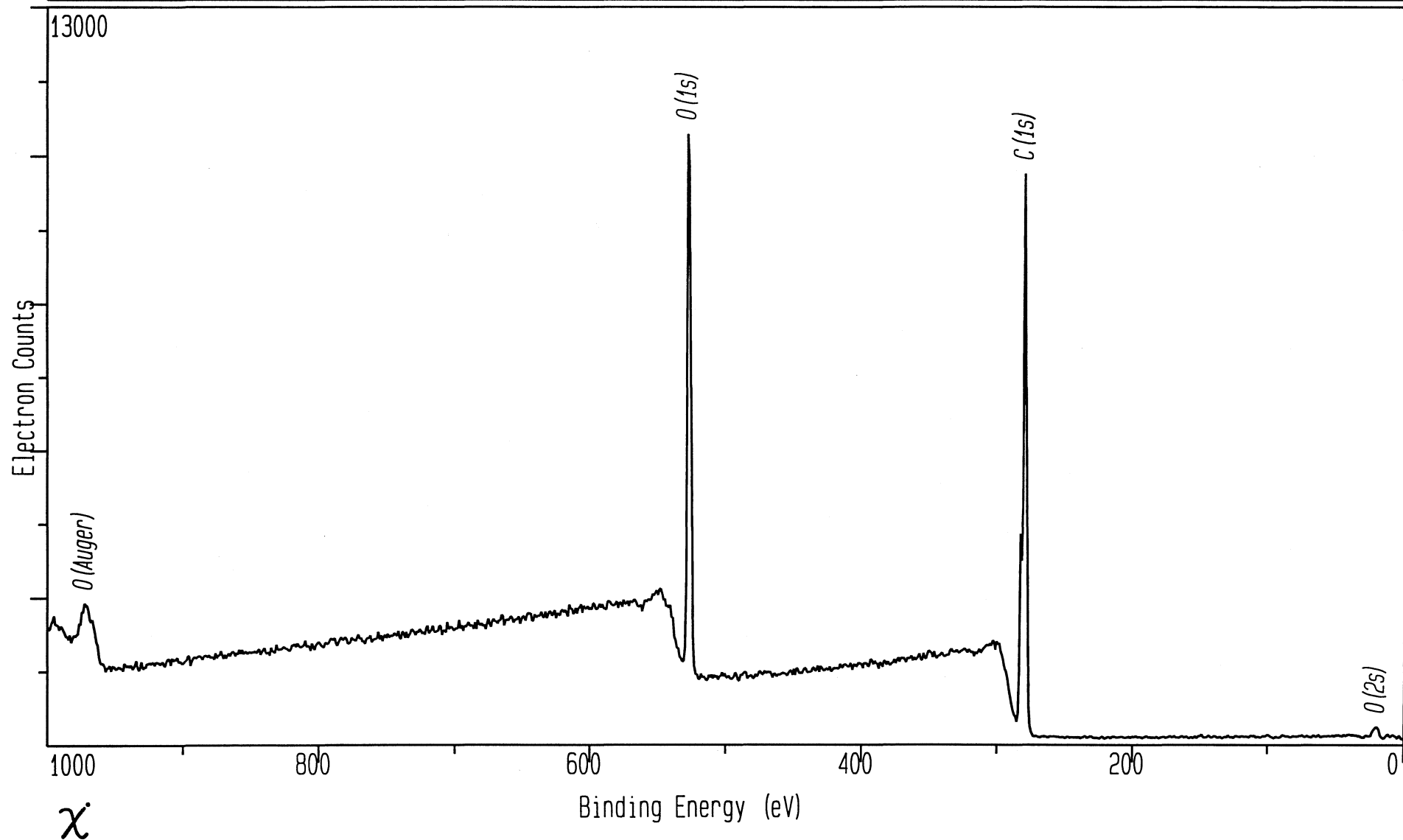
Detailed Surface Composition Table

File name: PEA_SU.MRS
Region: 3
Description: Poly (ETHYL ACRYLATE), 8/28/90, TOA = 0 ca.

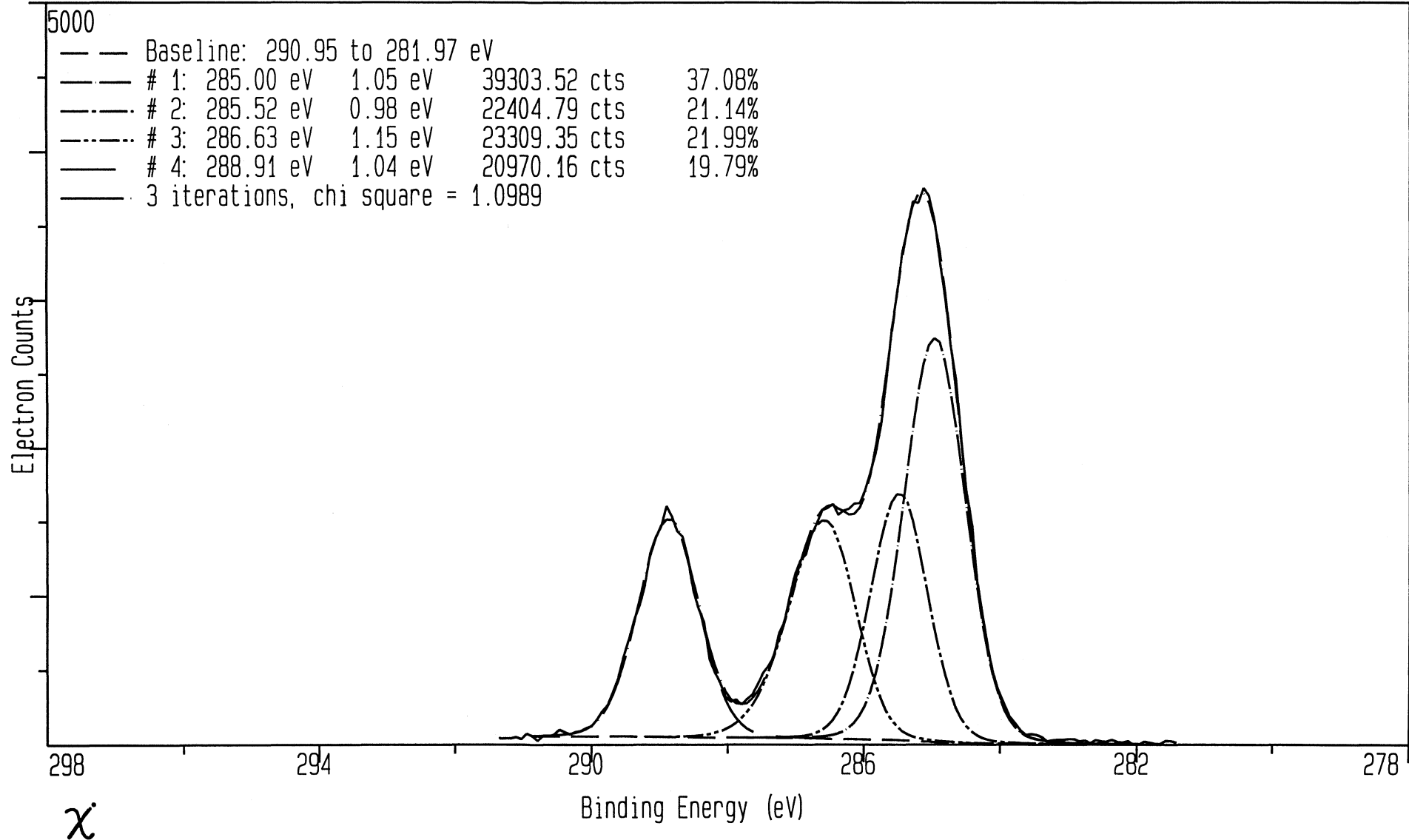
Operator: DGC
Date: Tue Aug 28 1990

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> <u>%</u>
O Auger	974.3	972.3	0.00	24375	0	
* O 1s	528.0	526.0	2.50	74990	29944	27.33
* C 1s	280.1	278.1	1.00	79934	79631	72.67
O 2s	21.4	19.4	0.16	3014	18721	

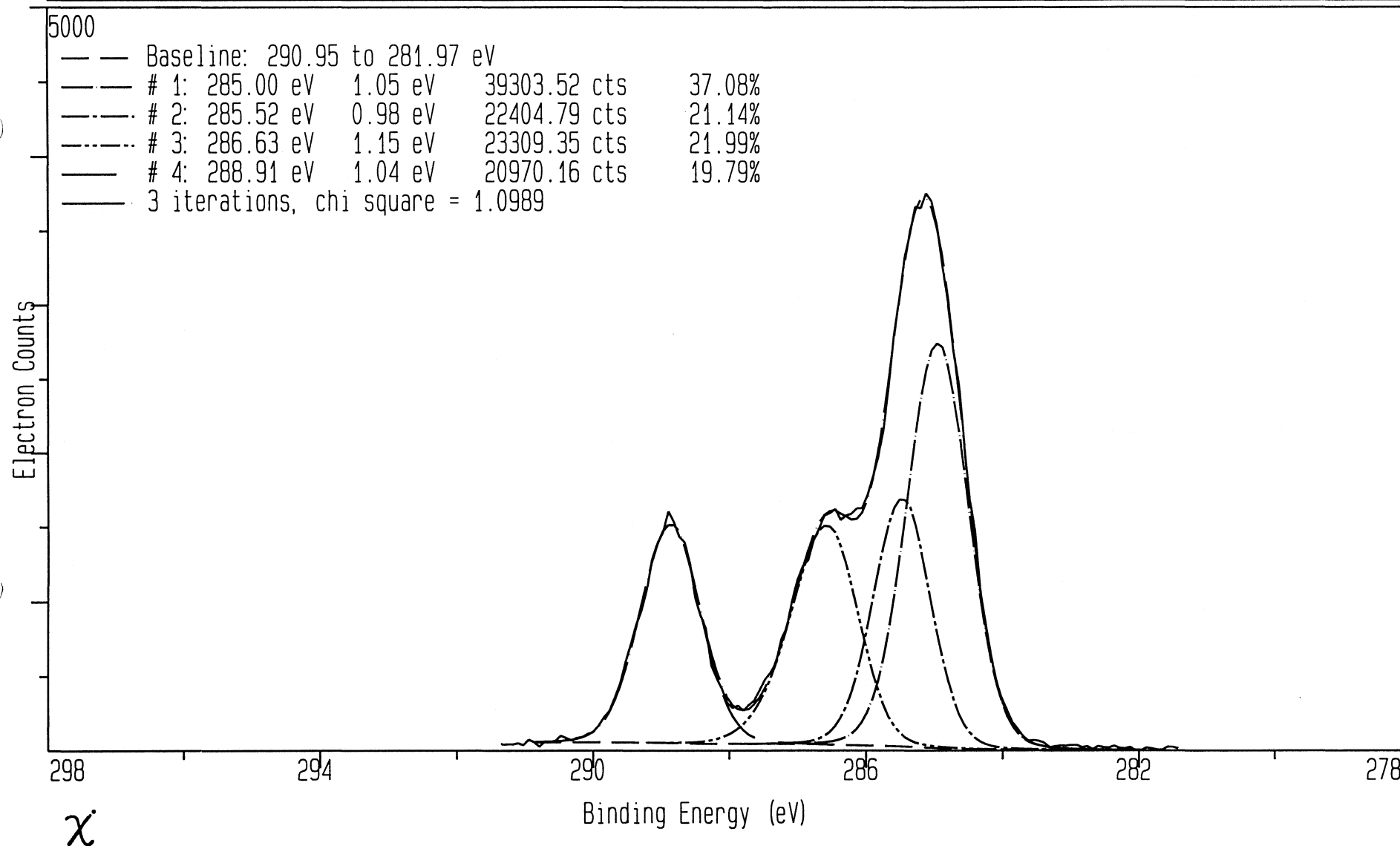
File: PEA_SU	Spot: 1000	Flood Gun: 2.0	Data Points: 1024	Date: 8/28/1990
Region: 3	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: Poly (ETHYL ACRYLATE), 8/28/90, T.O. ANG ca. 0 DEG				



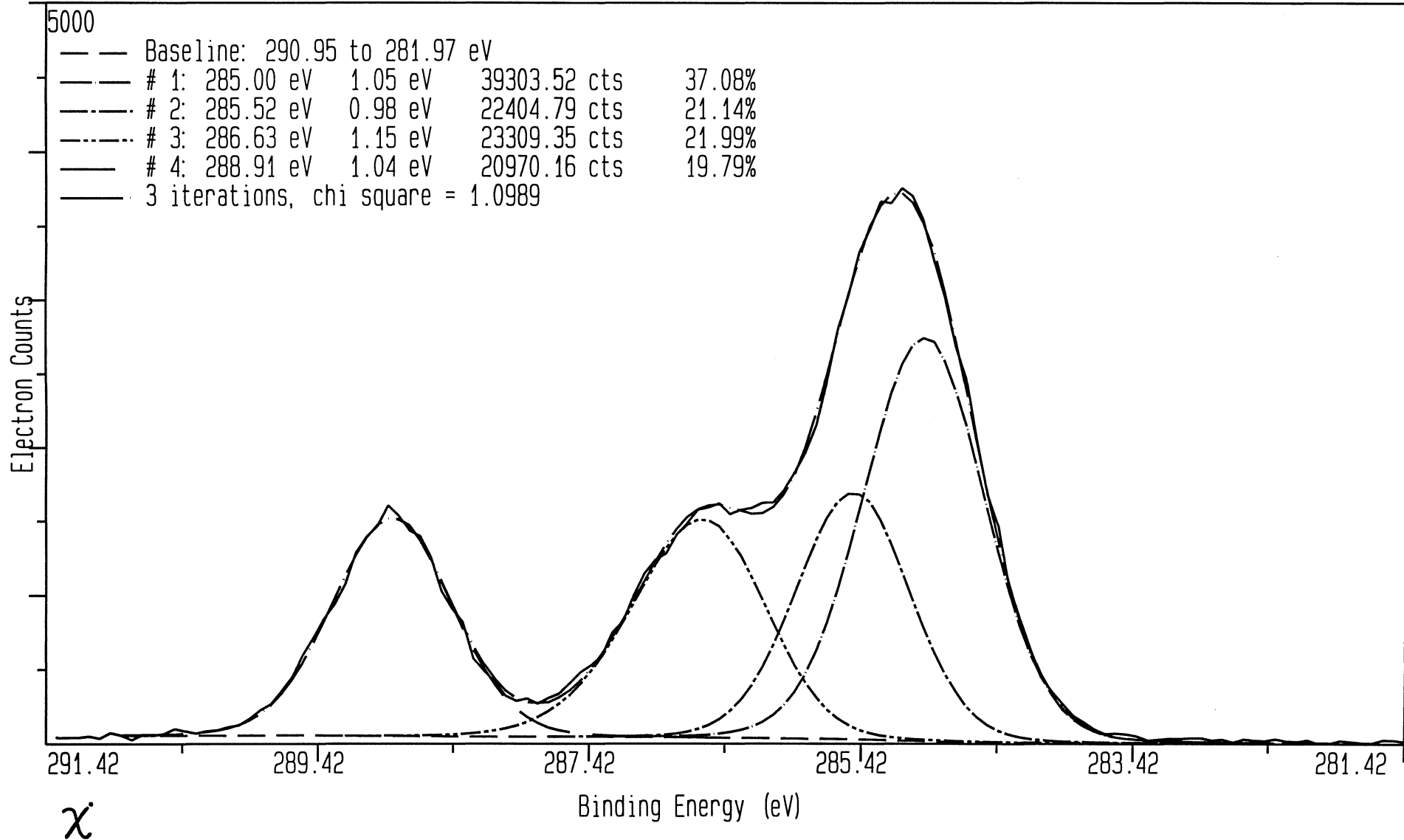
File: PEA_C	Spot: 600	Flood Gun: 2.0	Data Points: 128	Date: 8/28/1990
Region: 1	Resolution: 1	Scans, Time: 12	Time/Point: 200	Operator: DGC
Description: p(ETHYL ACRYLATE), 8/28/90, T.O. ANG ca.0 DEG, OP AP (null)				



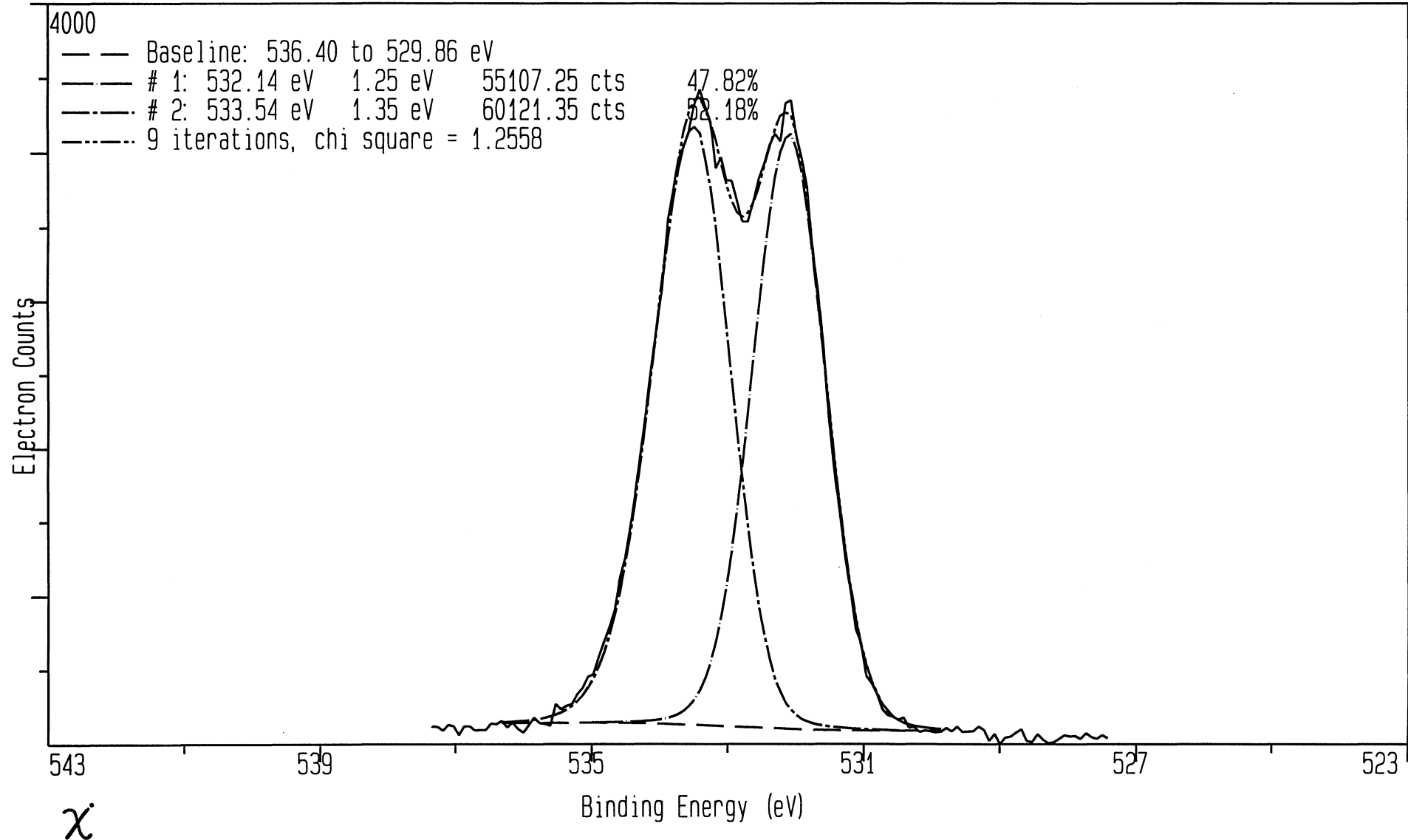
File: PEA_C	Spot: 600	Flood Gun: 2.0	Data Points: 128	Date: 8/28/1990
Region: 1	Resolution: 1	Scans, Time: 12	Time/Point: 200	Operator: DGC
Description: Poly (ETHYL ACRYLATE), 8/28/90, T.O. ANG ca.0 DEG				



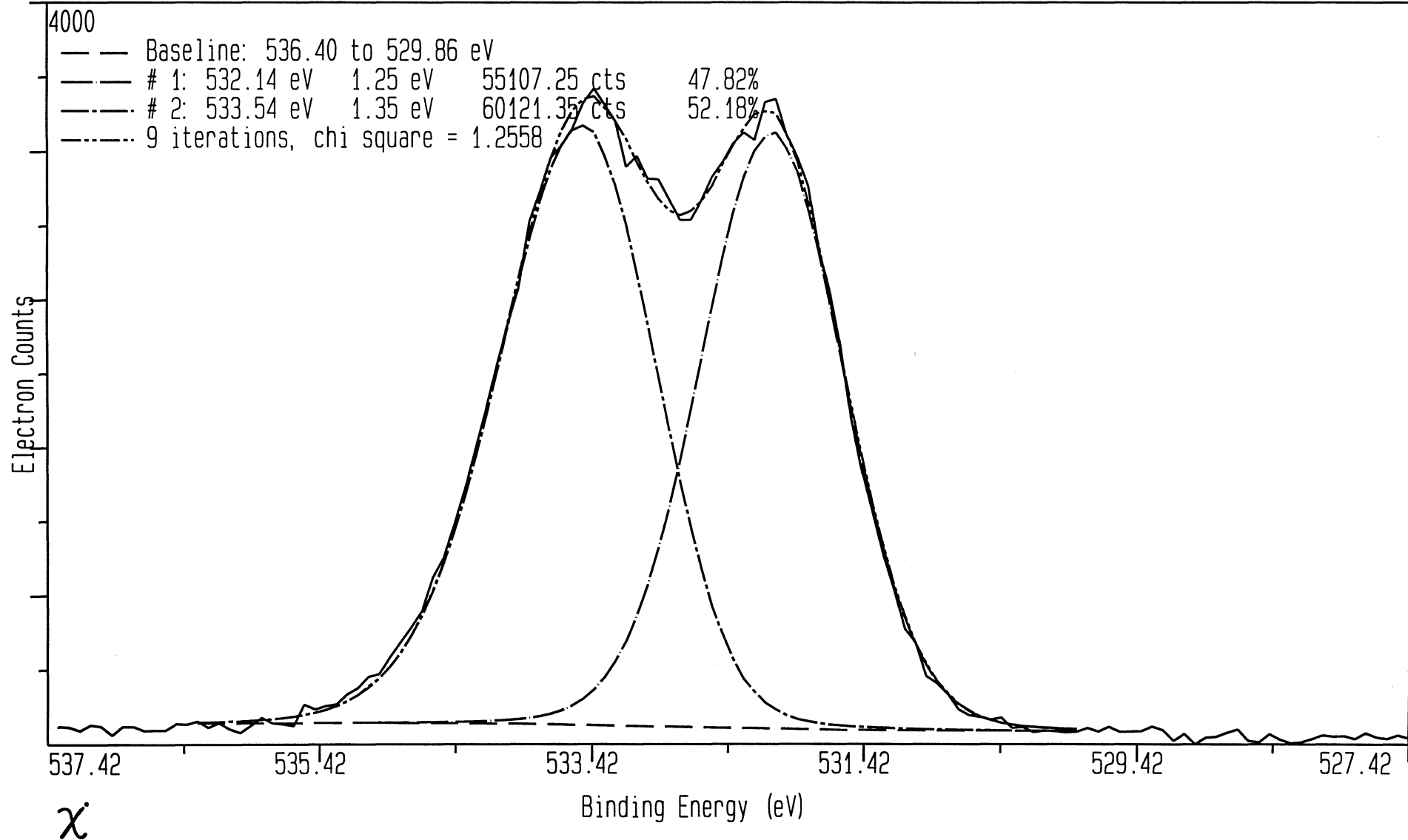
File: PEA_C	Spot: 600	Flood Gun: 2.0	Data Points: 128	Date: 8/28/1990
Region: 1	Resolution: 1	Scans, Time: 12	Time/Point: 200	Operator: DGC
Description: Poly (ETHYL ACRYLATE), 8/28/90, T.O. ANG ca.0 DEG				



File: PEA_0	Spot: 600	Flood Gun: 2.0	Data Points: 128	Date: 8/28/1990
Region: 2	Resolution: 1	Scans, Time: 12	Time/Point: 200	Operator: DGC
Description: Poly (ETHYL ACRYLATE), 8/28/90, T.O. ANG ca.0 DEG				



File: PEA_0	Spot: 600	Flood Gun: 2.0	Data Points: 128	Date: 8/28/1990
Region: 2	Resolution: 1	Scans, Time: 12	Time/Point: 200	Operator: DGC
Description: Poly (ETHYL ACRYLATE), 8/28/90, T.O. ANG ca.0 DEG				



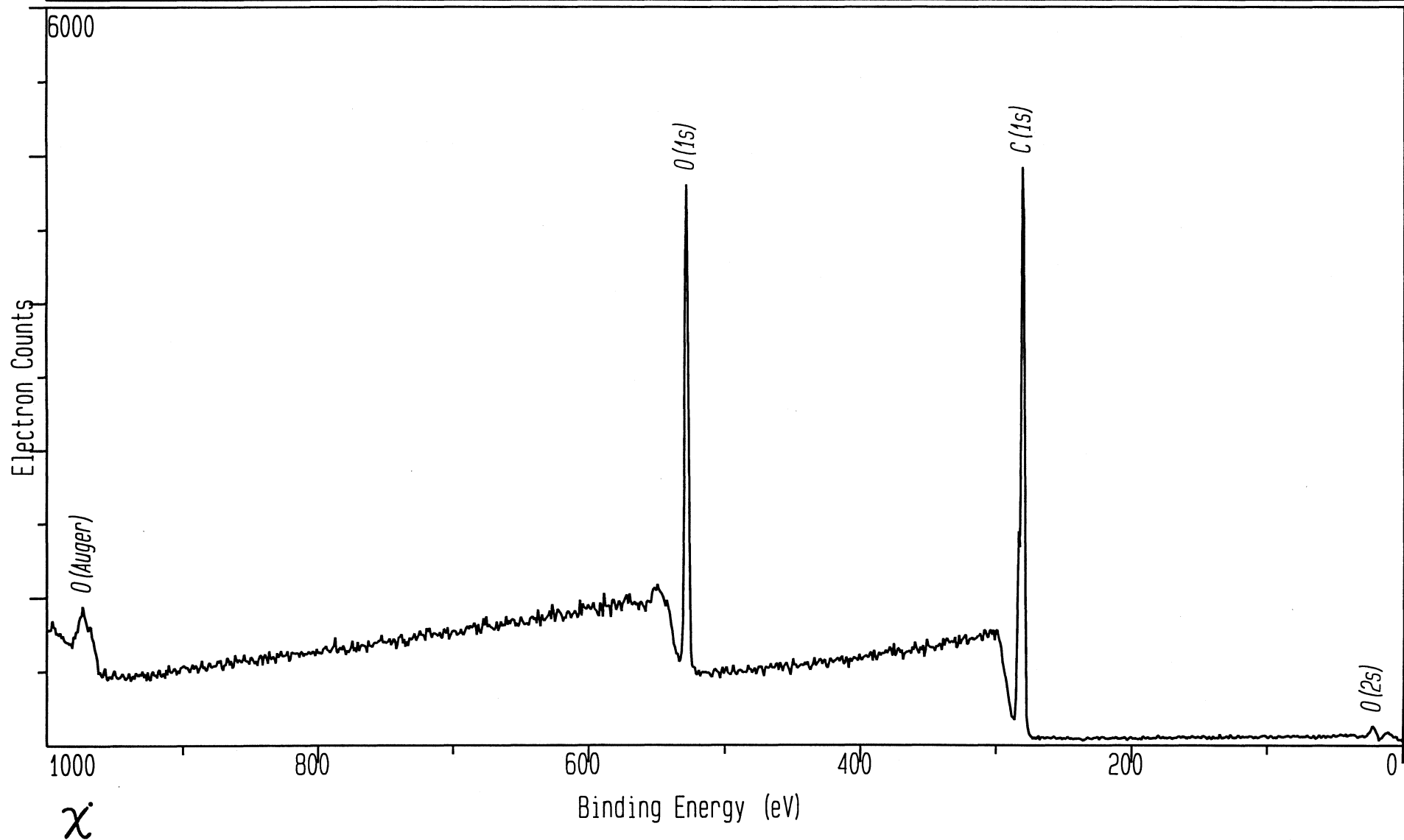
Poly Ethyl Methacrylate (film on glass)

Detailed Surface Composition Table

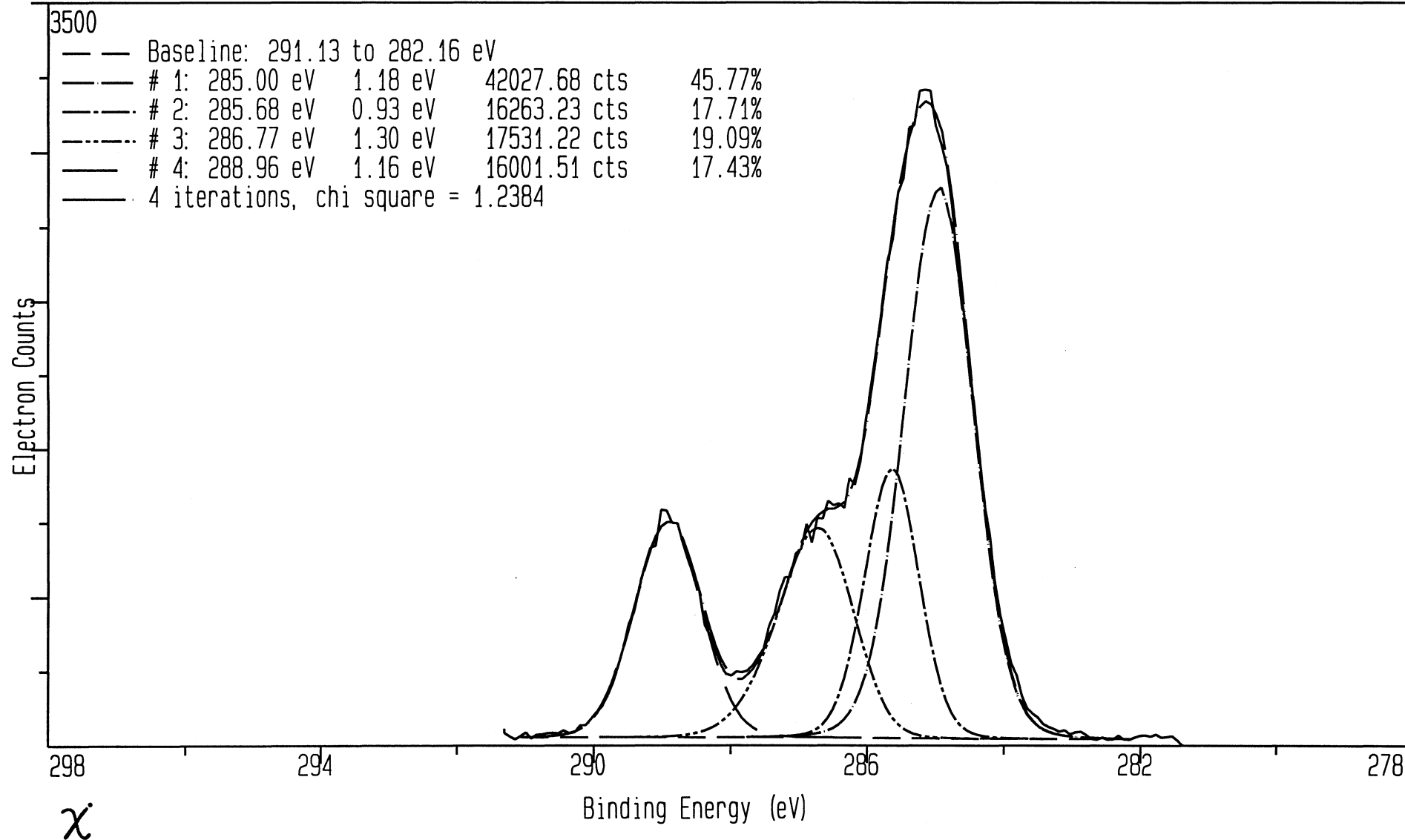
File name: EMA_SU.MRS
Region: 1
Description: poly-EMA (HOMEMADE) ON GLASS,WC9-96-2,TOA = 55
PEMA = Poly Ethyl Methacrylate
Operator: DGC
Date: Wed Mar 28 1990

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	974.6	973.6	0.00	11165	0	
* O 1s	528.5	527.5	2.50	32313	12916	23.83
* C 1s	280.5	279.5	1.00	41412	41291	76.17
O 2s	22.3	21.3	0.16	1343	8349	

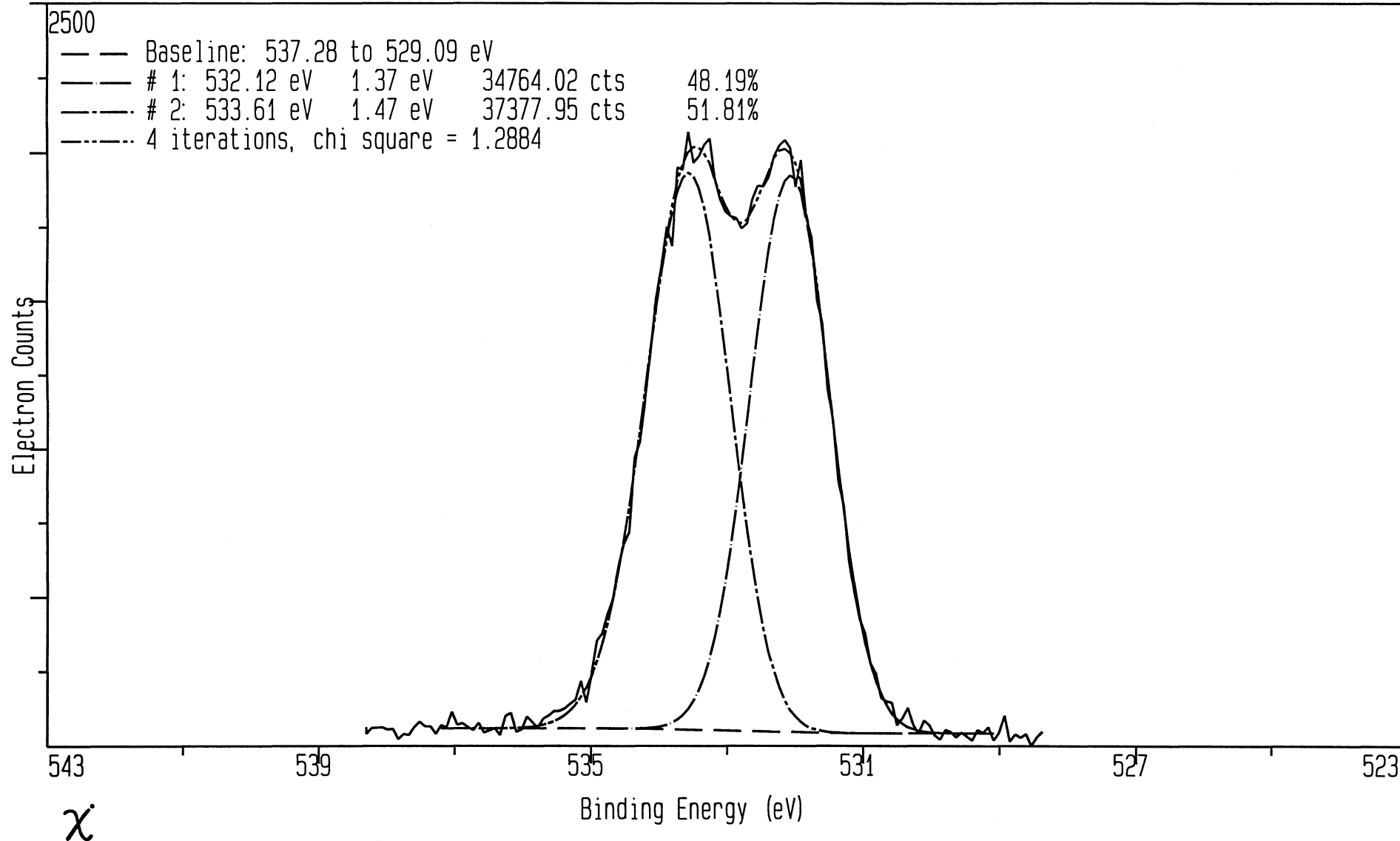
File: EMA_SU	Spot: 1000	Flood Gun: 1.0	Data Points: 1024	Date: 3/28/1990
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: pEMA (HOMEMADE) ON GLASS, WC9-96-2, T.O. ANG = 55 pEMA = Poly Ethyl Methacrylate				



File: EMA_C	Spot: 300	Flood Gun: 1.0	Data Points: 128	Date: 3/28/1990
Region: 1	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: pEMA (HOMEMADE) ON GLASS, WC9-96-2, T.O. ANG = 55 pEMA = Poly ethyl methacrylate				



File: EMA_0	Spot: 300	Flood Gun: 1.0	Data Points: 128	Date: 3/28/1990
Region: 2	Resolution: 1	Scans, Time: 40	Time/Point: 200	Operator: DGC
Description: pEMA (HOMEMADE) ON GLASS, WC9-96-2, T.O. ANG = 55 pEMA = Poly ethyl methacrylate				



Poly - Ethylene (freshly pressed)

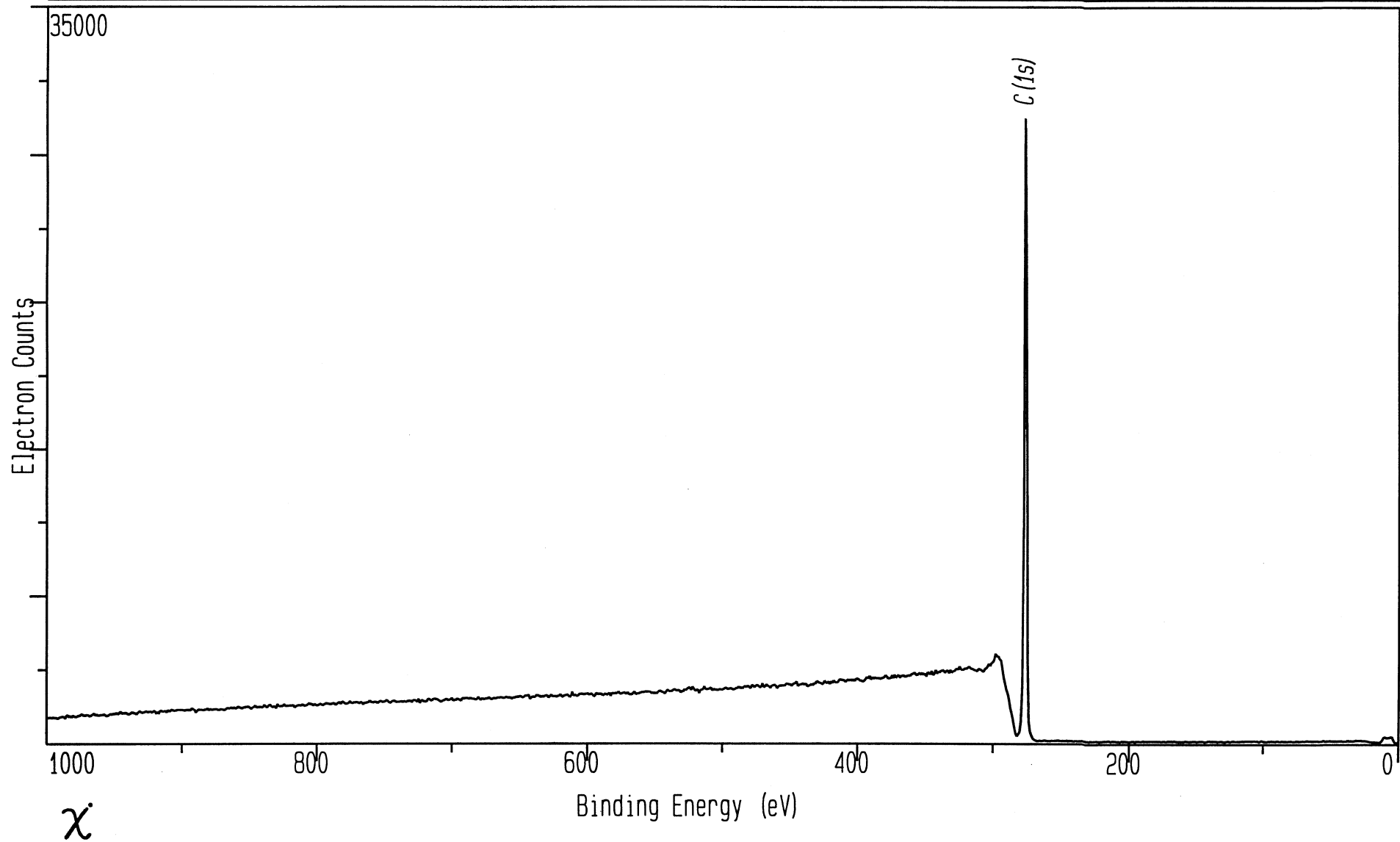
Detailed Surface Composition Table

File name: PE_SU.MRS
Region: 1
Description: Poly-Ethylene - Freshly pressed between Al sheets

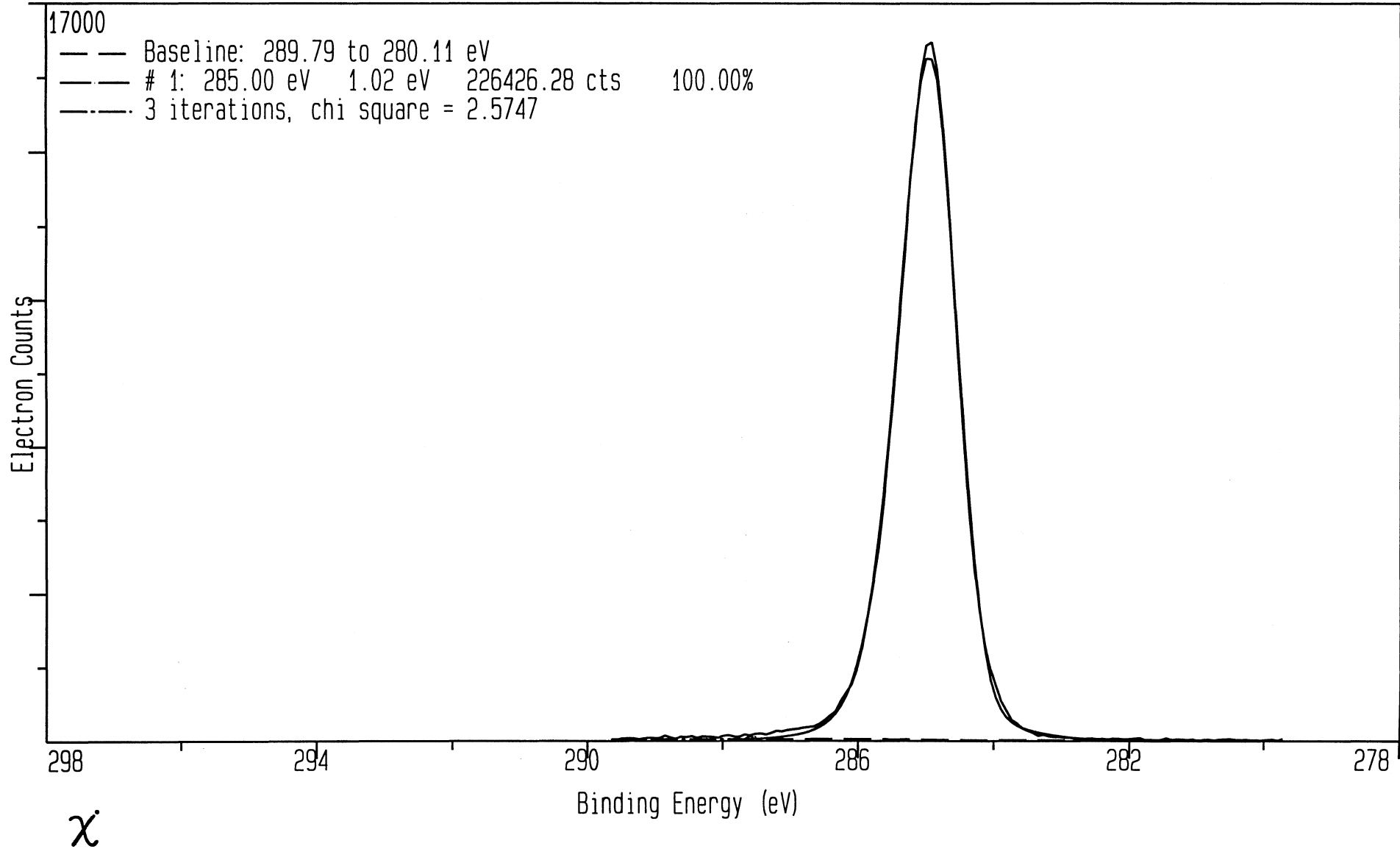
Operator: DGC
Date: Tue Nov 8 1988

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
* C 1s	280.7	275.7	1.01	86076	85634	100.00

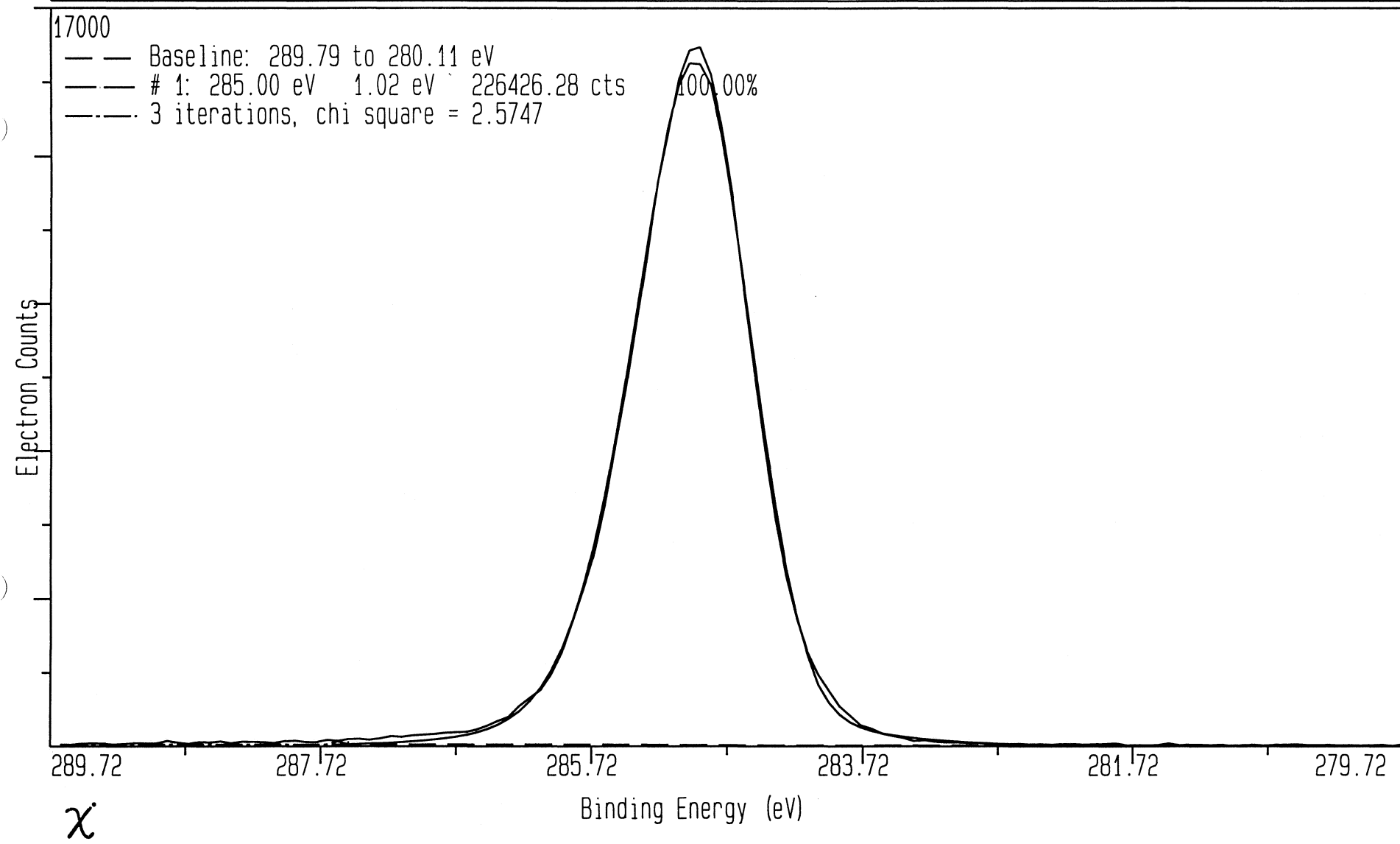
File: PE_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 11/8/1988
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: Poly-Ethylene - Freshly pressed between Al sheets				



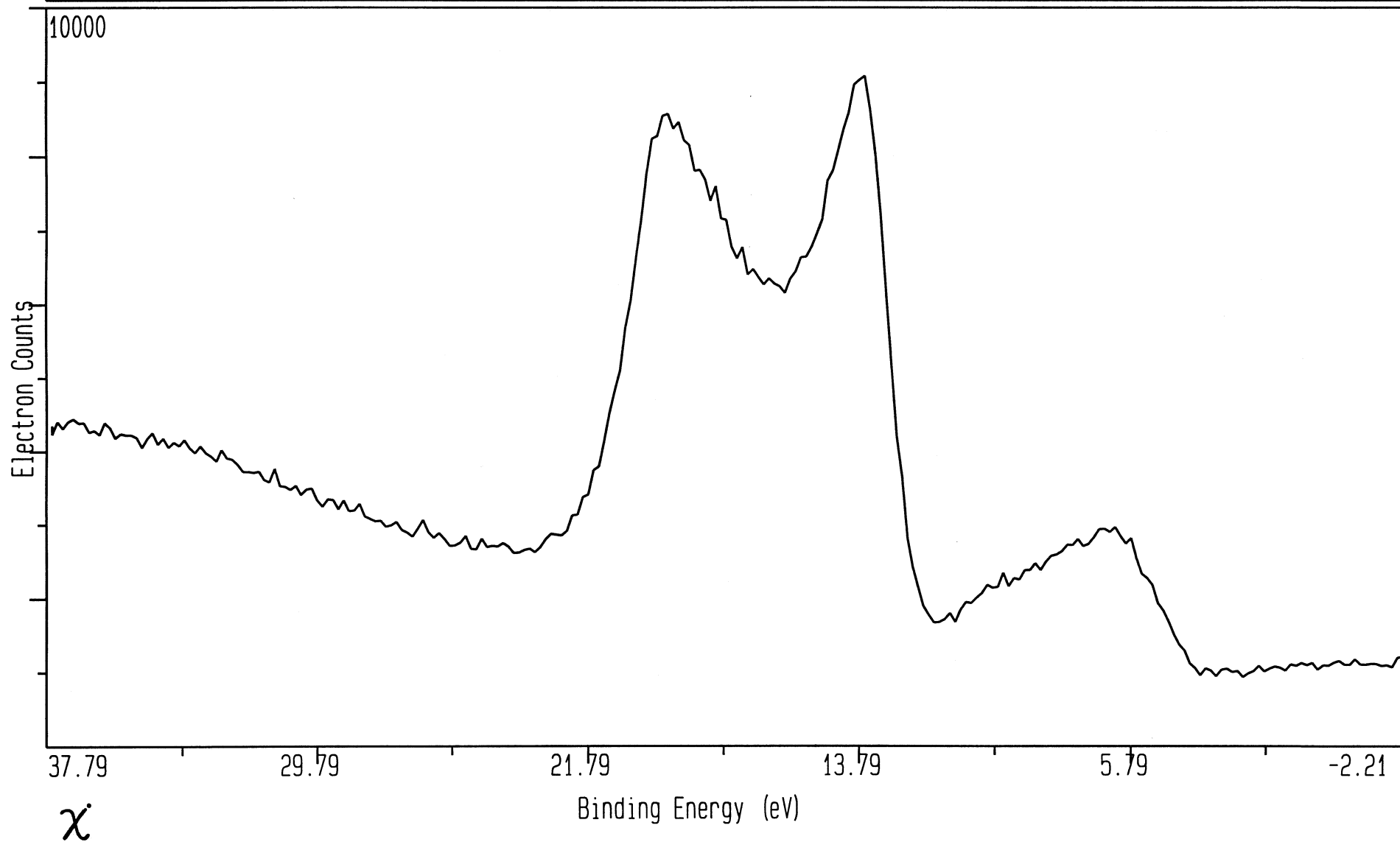
File: PE_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 11/8/1988
Region: 2	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: Poly-Ethylene - Freshly pressed between Al sheets				



File: PE_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 11/8/1988
Region: 2	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: Poly-Ethylene - Freshly pressed between Al sheets				



File: PE_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 11/8/1988
Region: 5	Resolution: 2	Scans, Time: 466	Time/Point: 200	Operator: DGC
Description: Poly-Ethylene - Freshly pressed between Al sheets				



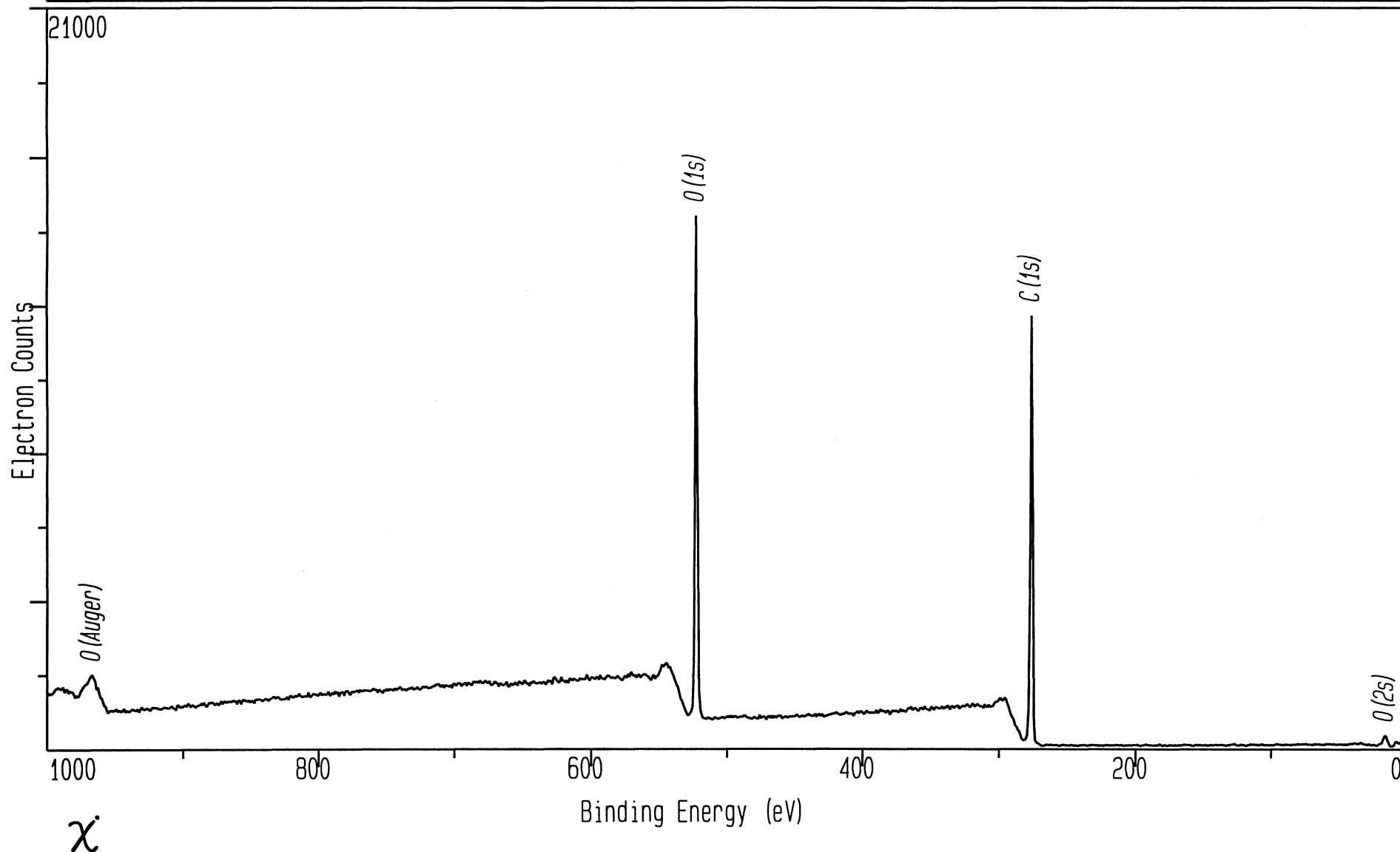
Poly - Ethylene Glycol (PEG 4000 flake)

Detailed Surface Composition Table

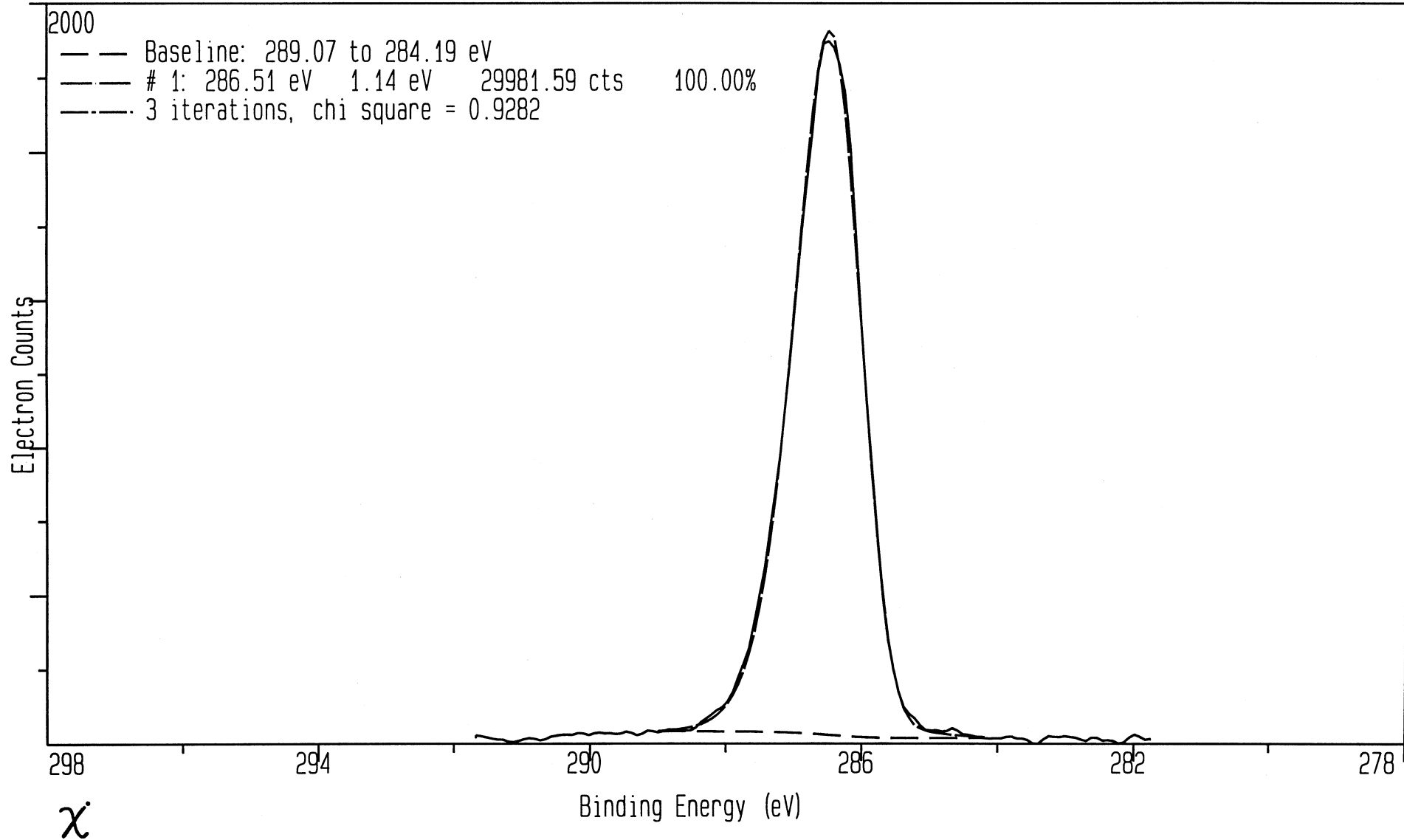
File name: PEG_SU.MRS
Region: 1
Description: PEG 4000 FLAKE AT 0 DEG TOA, WITH SCREEN
PEG = Poly Ethylene Glycol
Operator: DGC
Date: Tue Jun 7 1988

<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	972.0	967.0	0.00	22003	0	
* O 1s	527.5	522.5	2.51	75332	30004	32.43
* C 1s	280.9	275.9	1.01	62822	62505	67.57
O 2s	20.4	15.4	0.16	2935	18196	

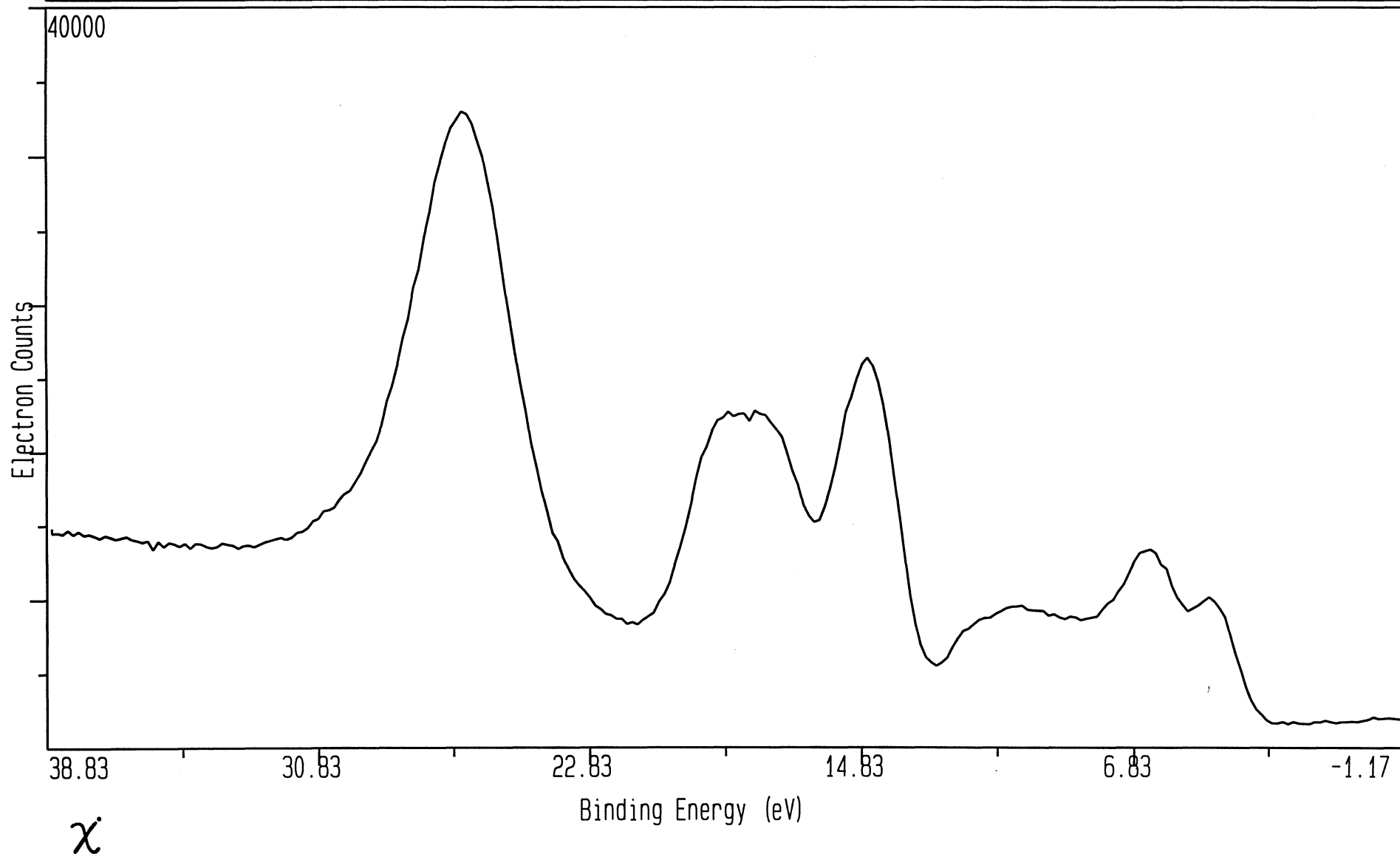
File: PEG_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 6/7/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: PEG 4000 FLAKE AT 0 DEG TOA, WITH SCREEN PEG = Poly Ethylene Glycol				



File: PEG_C	Spot: 300	Flood Gun: 1.0	Data Points: 128	Date: 4/18/1990
Region: 1	Resolution: 1	Scans, Time: 20	Time/Point: 200	Operator: DGC
Description: PEG 2000 FLAKE, HR SCANS, T.O. ANG=55, F.G=0 eV PEG = Poly Ethylene Glycol				



File: PEG_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 6/7/1988
Region: 4	Resolution: 2	Scans, Time: 790	Time/Point: 200	Operator: DGC
Description:	PEG 4000 FLAKE AT 0 DEG TOA, WITH SCREEN PEG = Poly Ethylene Glycol			



Poly - Ethylene Terephthalate (3X MeOH rinse)

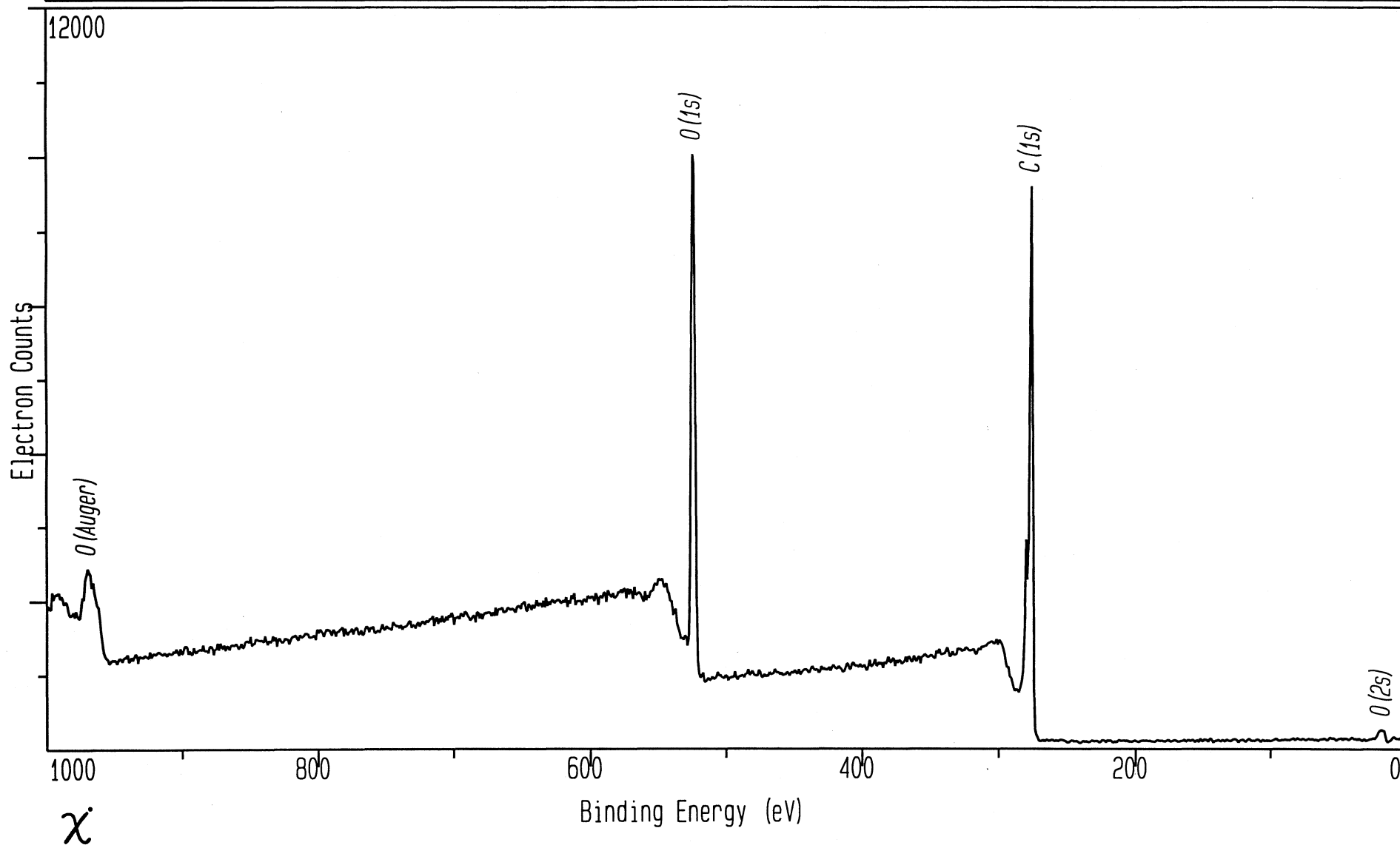
Detailed Surface Composition Table

File name: PET_SU.MRS
Region: 1
Description: 3516 MYLAR; MeOH RINSED 3X (8/3/8) @ 0 DEG. TOA
Mylar = PET = Poly-ethylene terephthalate
Operator: RDM
Date: Thu July 31 1997

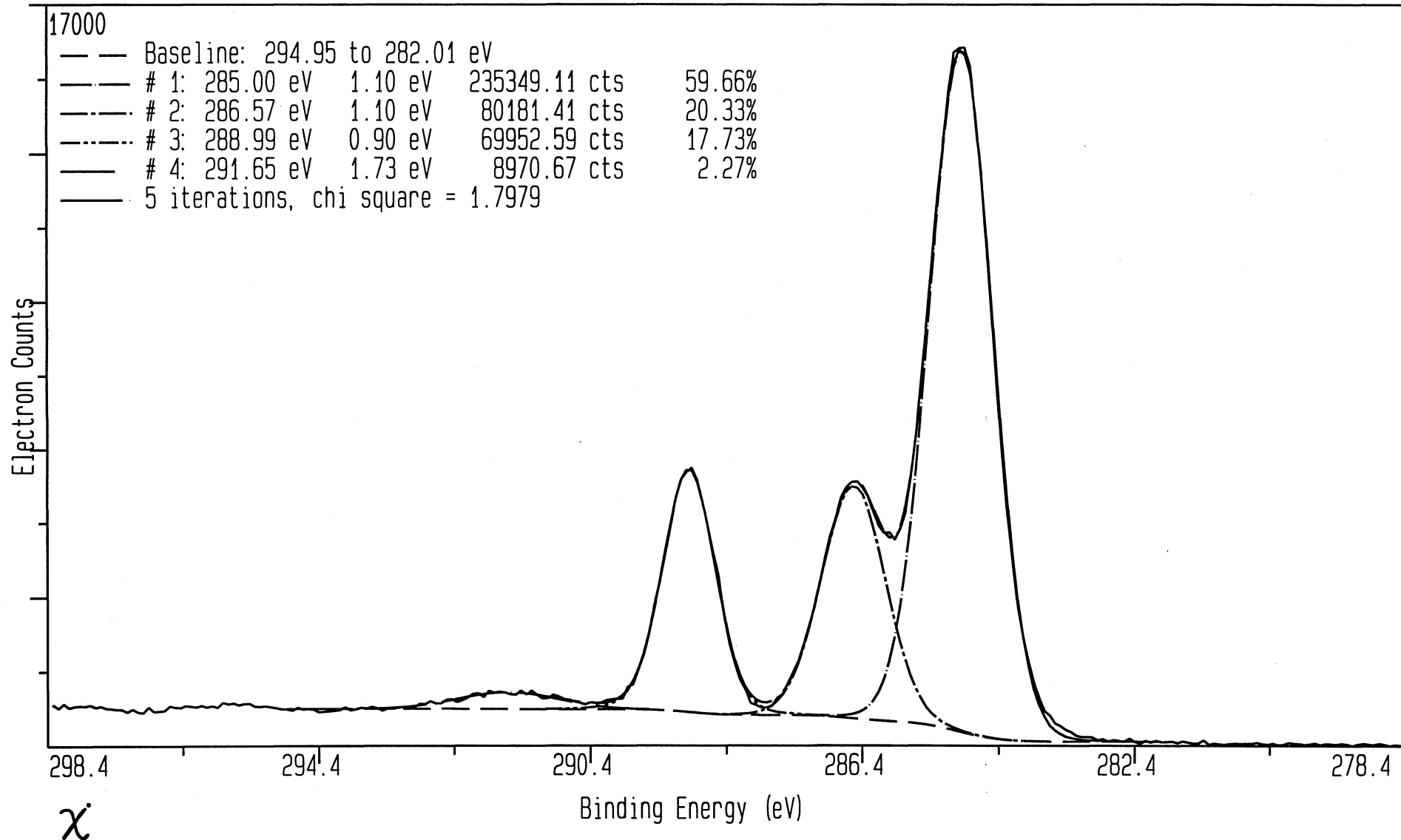
<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
O Auger	974.5	969.5	0.00	31832	0	
* O 1s	529.0	524.0	2.51	73314	29231	27.97
* C 1s	281.0	276.0	1.01	75666	75289	72.03
O 2s	22.7	17.7	0.16	2460	15269	

X

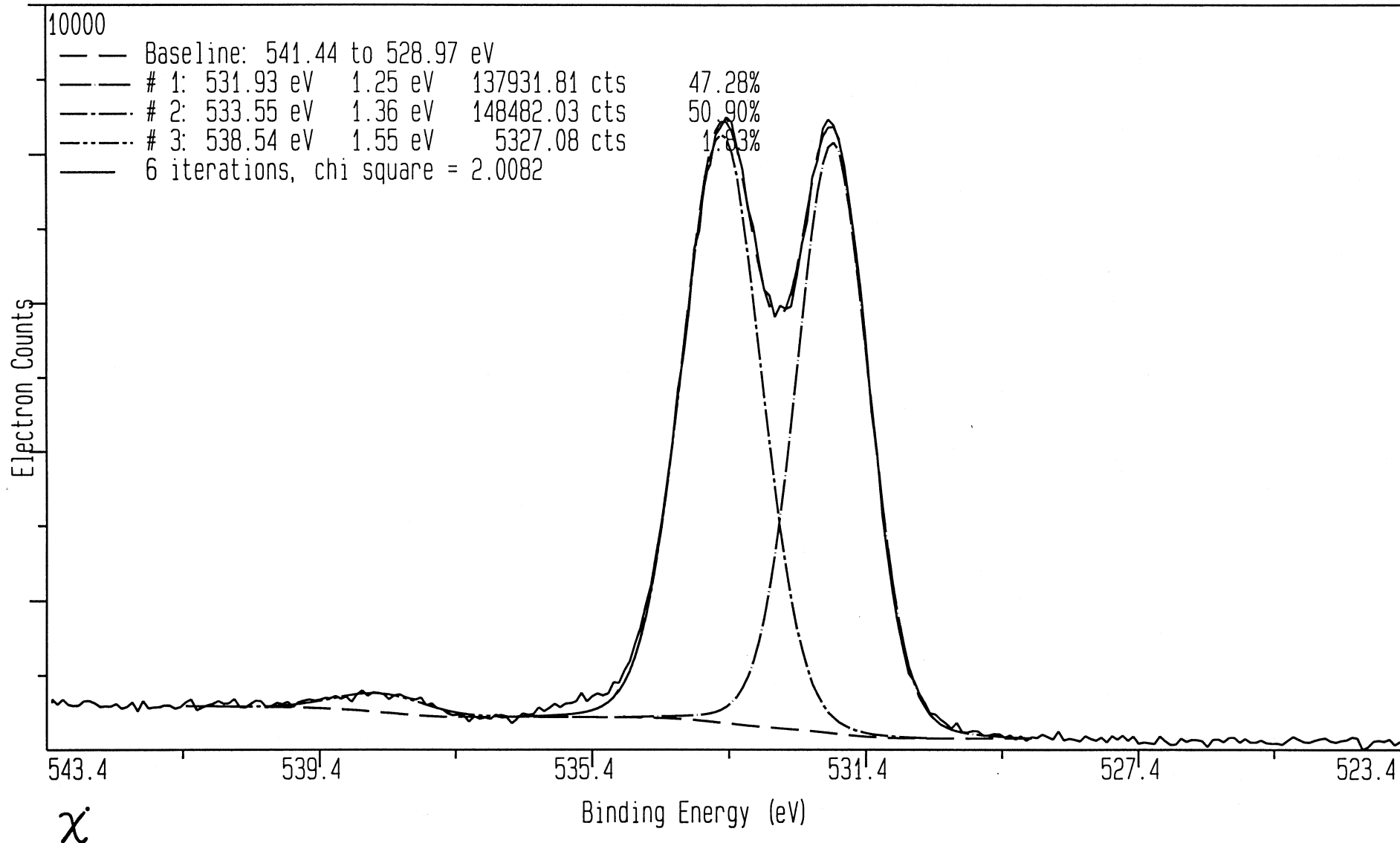
File: PET_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 7/31/1997
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: RDM
Description: 3516 MYLAR; MeOH RINSED 3X (8/3/8) @ 0 DEG. TOA Mylar = PET = Poly-ethylene terephthalate				



File: PET_C	Spot: 300	Flood Gun: 5.0	Data Points: 256	Date: 1/6/1989
Region: 1	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: DGC
Description: ACETONE WASHED MYLAR FILM, 1/5/89, TOA=0 Mylar = PET = Poly ethylene terephthalate				



File: PET_0	Spot: 300	Flood Gun: 5.0	Data Points: 256	Date: 1/6/1989
Region: 2	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: ACETONE WASHED MYLAR FILM, 1/5/89, TOA=0 Mylar = PET = Poly ethylene terephthalate				



Poly - Methyl Acrylate (3% solution)

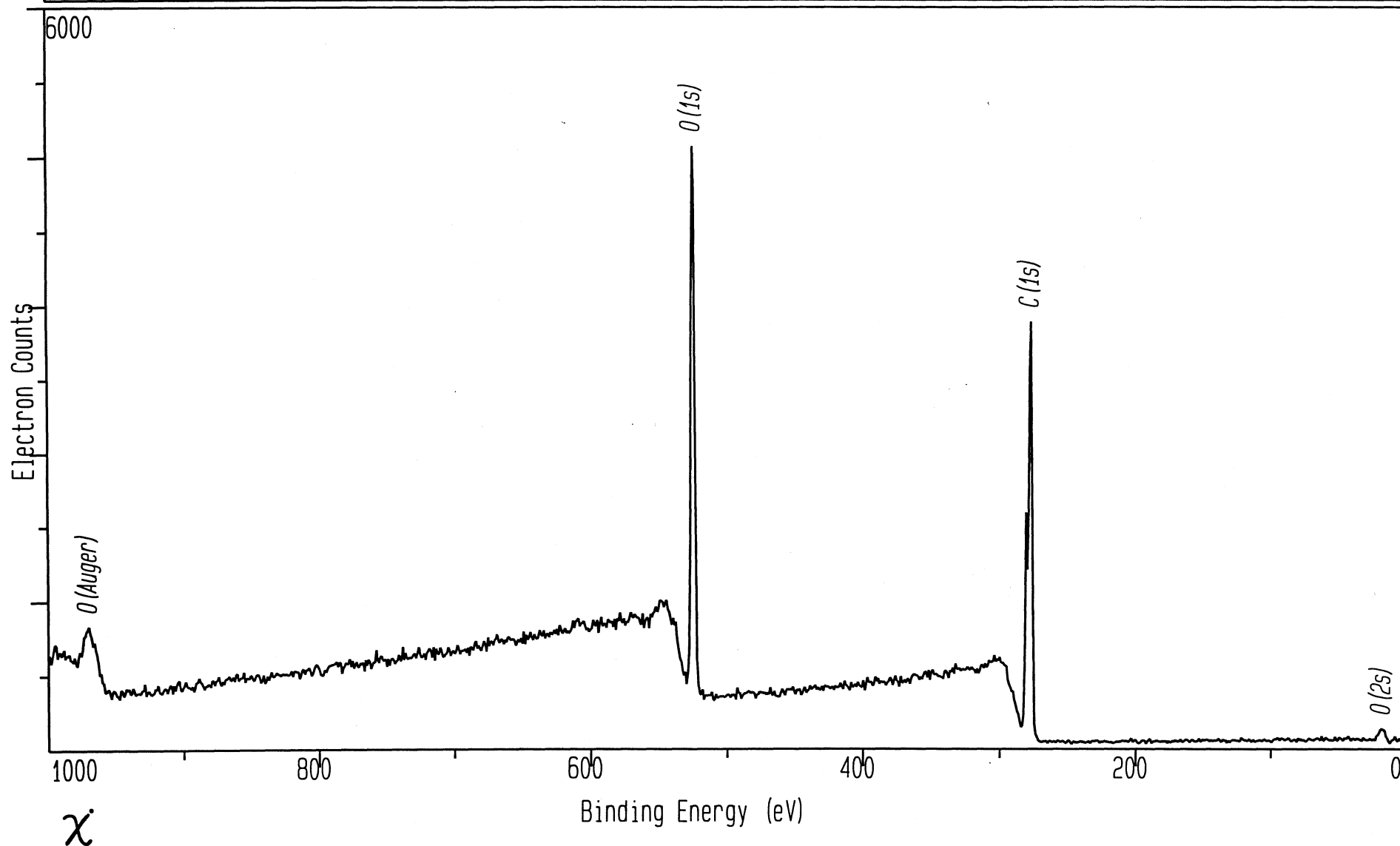
Detailed Surface Composition Table

File name: PMA_SU.MRS
Region: 1
Description: ACRYLATE STDS, 3%, DRIED & RE-DISSOLVED, PMA
PMA = Poly Methyl Acrylate
Operator: DGC
Date: Thu Sep 6 1990

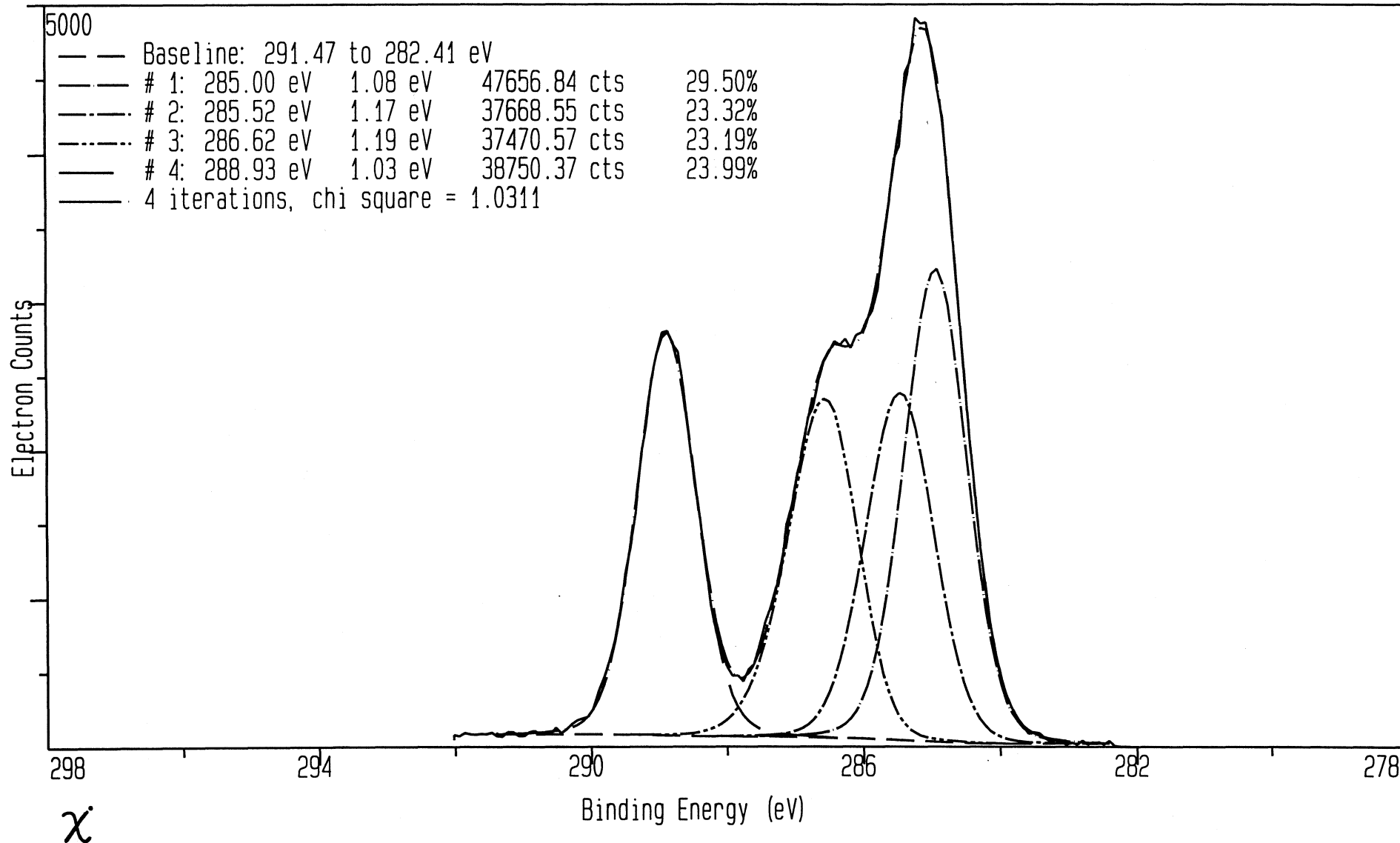
<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
O Auger	974.9	969.9	0.00	8365	0	
* O 1s	529.9	524.9	2.51	37188	14837	31.79
* C 1s	281.3	276.3	1.00	31996	31842	68.21
O 2s	22.8	17.8	0.16	1514	9397	

χ

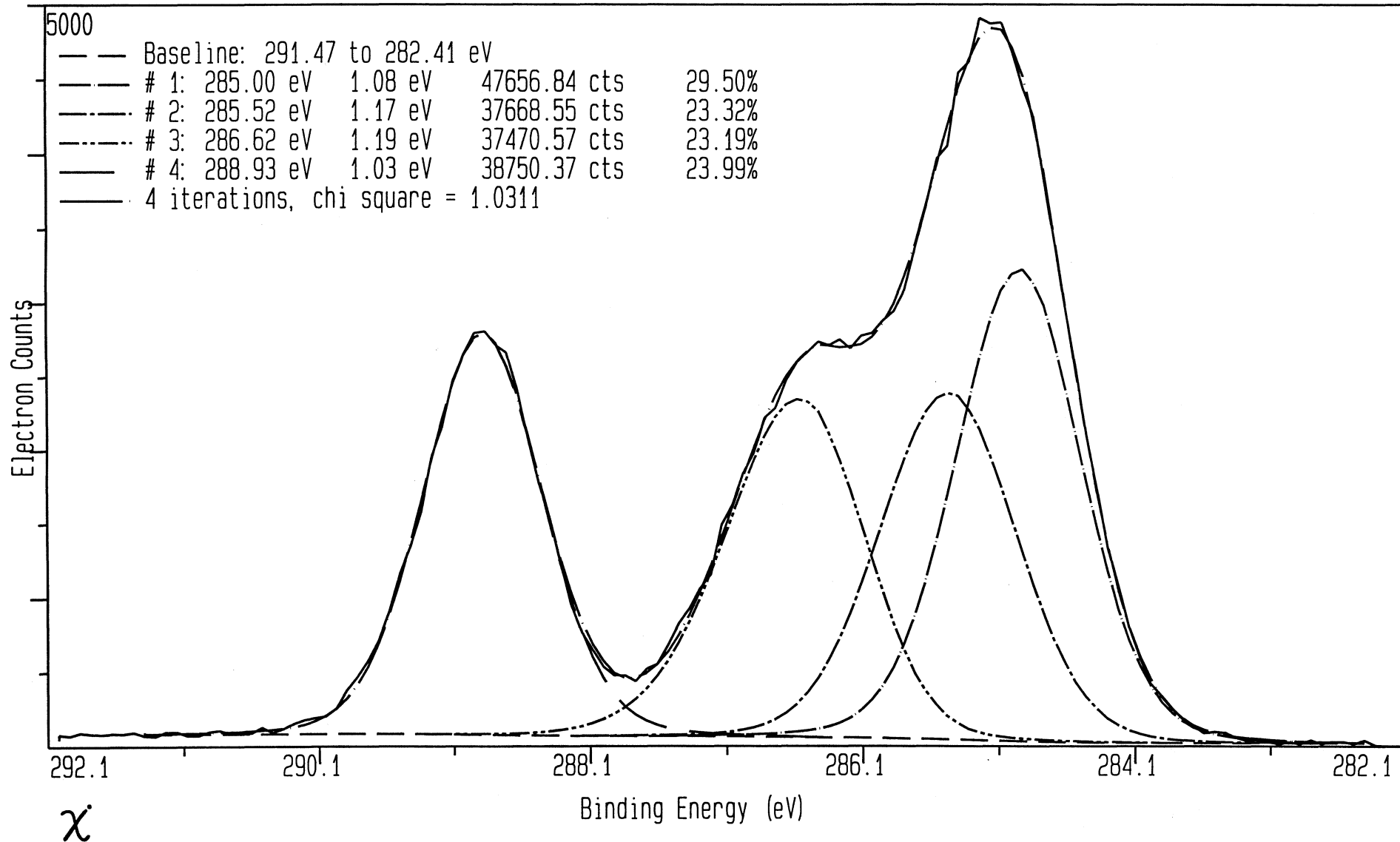
File: PMA_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 9/6/1990
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: ACRYLATE STDS, 3%, DRIED & REDISSOL, PMA PMA = Poly Methyl Acrylate				



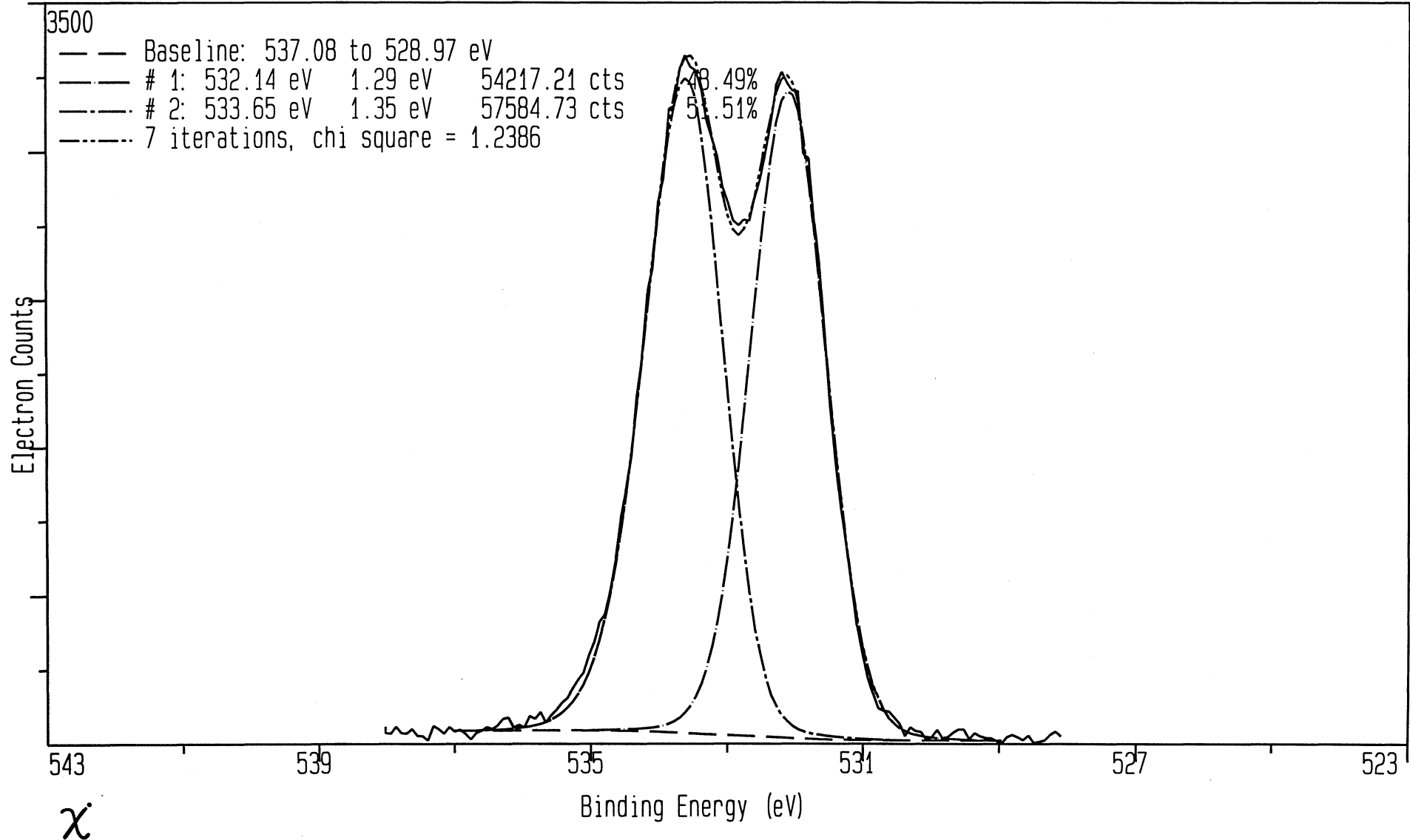
File: PMA_C	Spot: 600	Flood Gun: 1.0	Data Points: 128	Date: 8/28/1990
Region: 1	Resolution: 1	Scans, Time: 20	Time/Point: 200	Operator: DGC
Description: Poly (METHYL ACRYLATE), 8/28/90, TOA ca.0 DEG				



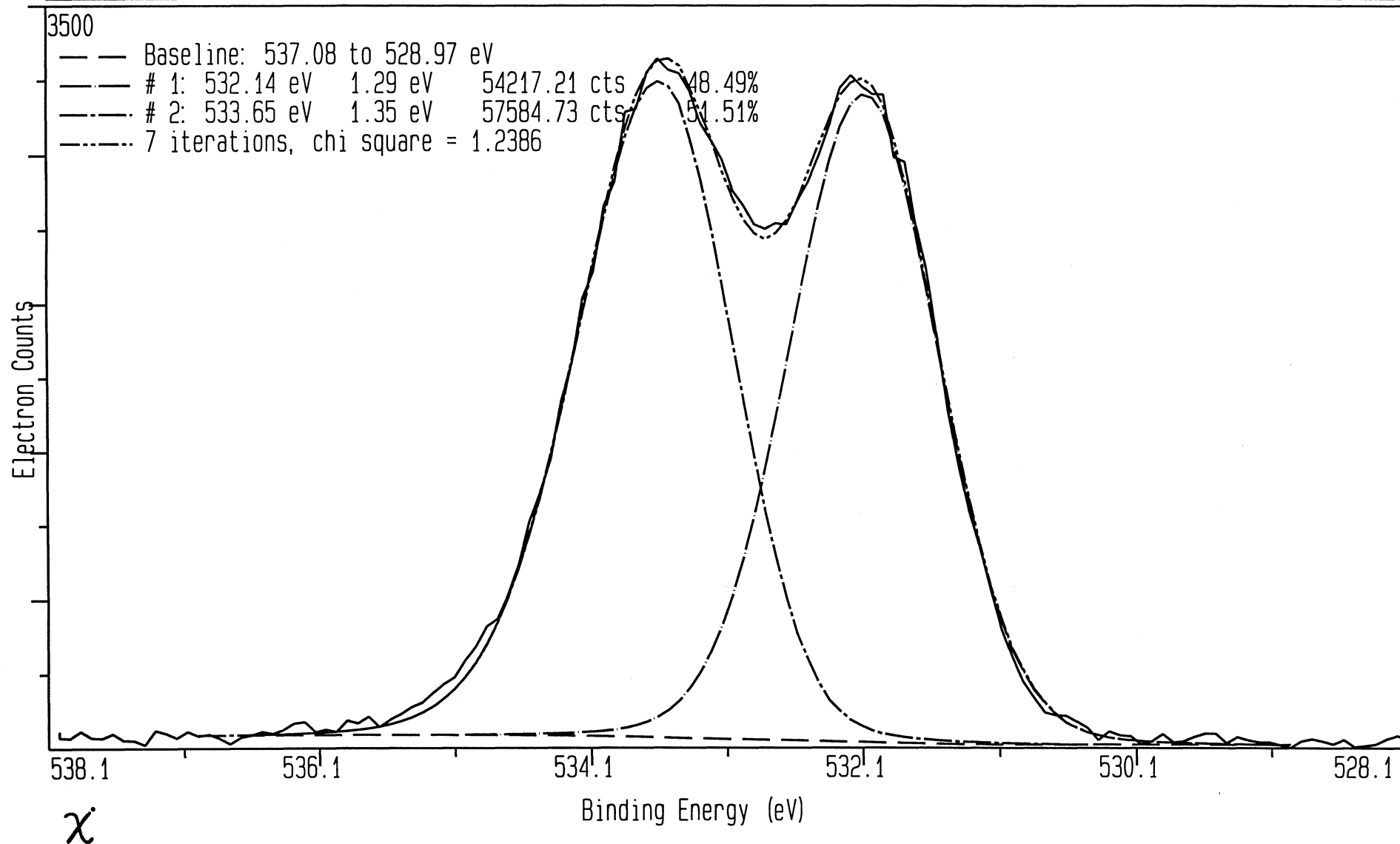
File: PMA_C	Spot: 600	Flood Gun: 1.0	Data Points: 128	Date: 8/28/1990
Region: 1	Resolution: 1	Scans, Time: 20	Time/Point: 200	Operator: DGC
Description: Poly (METHYL ACRYLATE), 8/28/90, TOA ca.0 DEG				



File: PMA_0	Spot: 600	Flood Gun: 1.0	Data Points: 128	Date: 8/28/1990
Region: 2	Resolution: 1	Scans, Time: 10	Time/Point: 200	Operator: DGC
Description: Poly (METHYL ACRYLATE), 8/28/90, TOA ca.0 DEG				



File: PMA_0	Spot: 600	Flood Gun: 1.0	Data Points: 128	Date: 8/28/1990
Region: 2	Resolution: 1	Scans, Time: 10	Time/Point: 200	Operator: DGC
Description: Poly (METHYL ACRYLATE), 8/28/90, TOA ca.0 DEG				



Poly Methyl Methacrylate (film on disk)

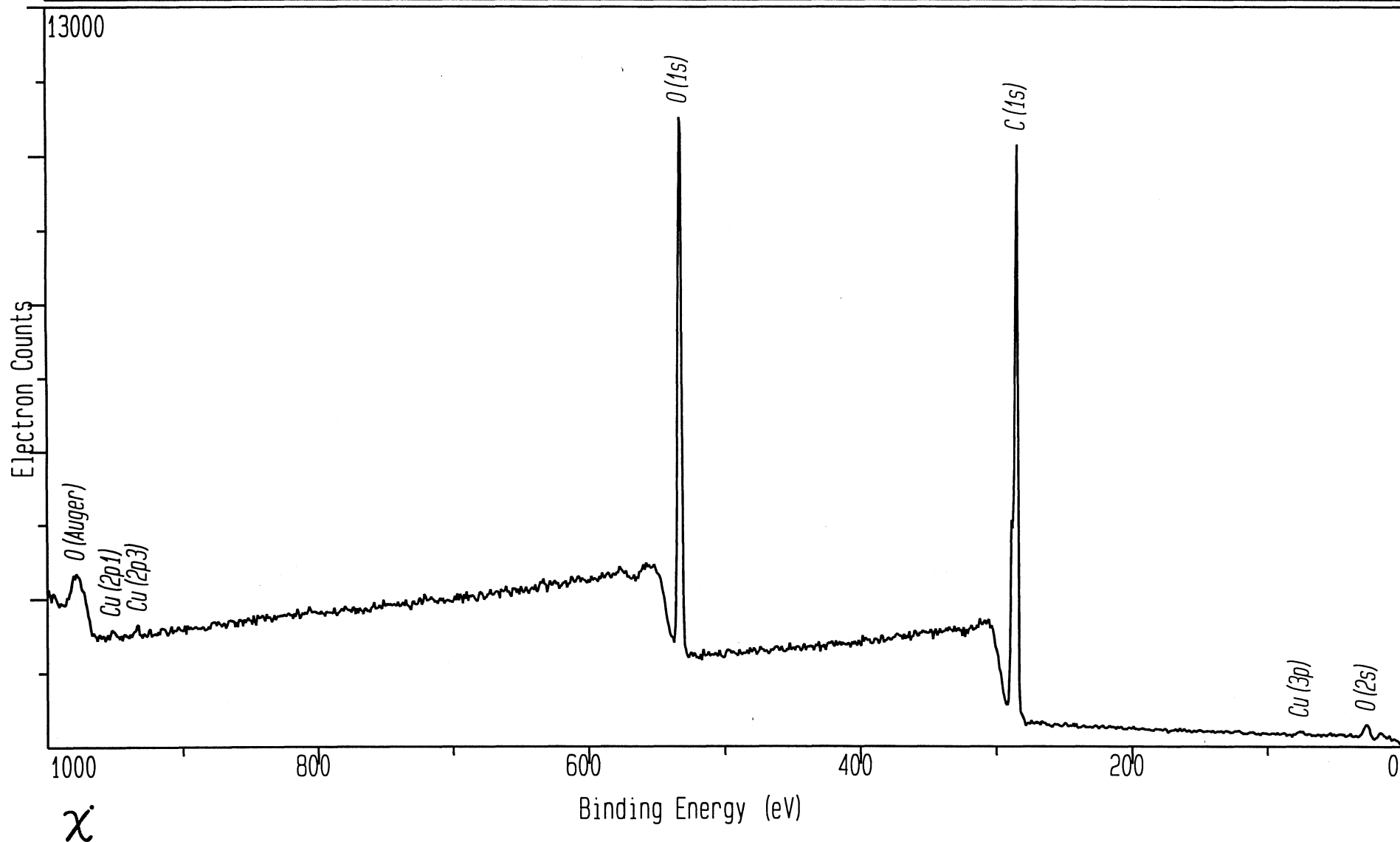
Detailed Surface Composition Table

File name: PMMA_SU.MRS
Region: 1
Description: PMMA spun on etch Cu disk, T=150C, ang=55, open aperture
PMMA = Poly Methyl Methacrylate
Operator: DGC
Date: Mon Sep 18 19

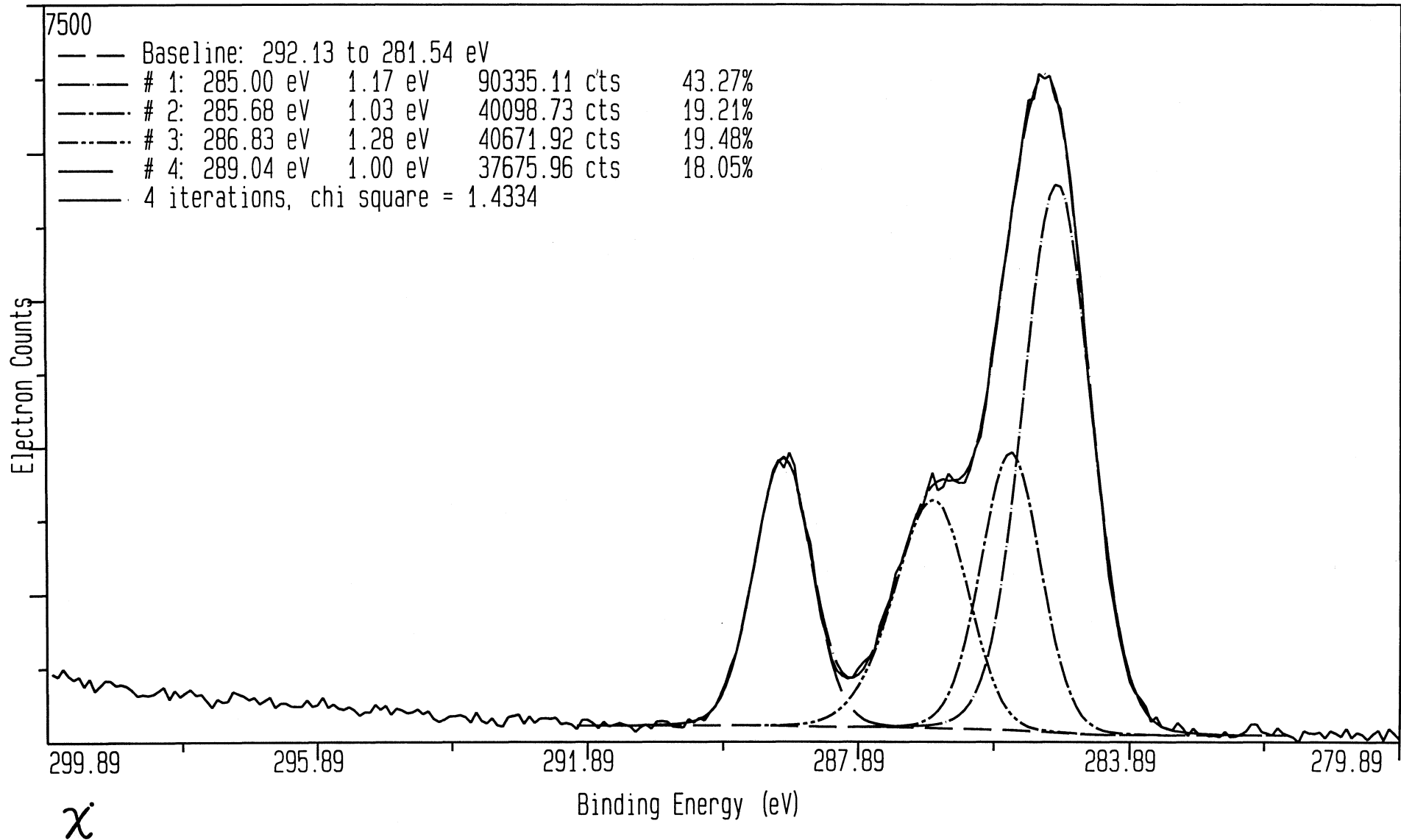
<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
O Auger	978.3	978.3	0.00	12395	0	
Cu2p1	952.1	952.1	4.91	518	105	
Cu2p3	932.6	932.6	9.73	555	57	
* O 1s	532.9	532.9	2.49	39547	15870	26.88
* C 1s	284.9	284.9	1.00	42988	42995	72.82
* Cu3p	75.4	75.4	2.77	490	177	0.30
O 2s	26.5	26.5	0.16	1579	9840	

X

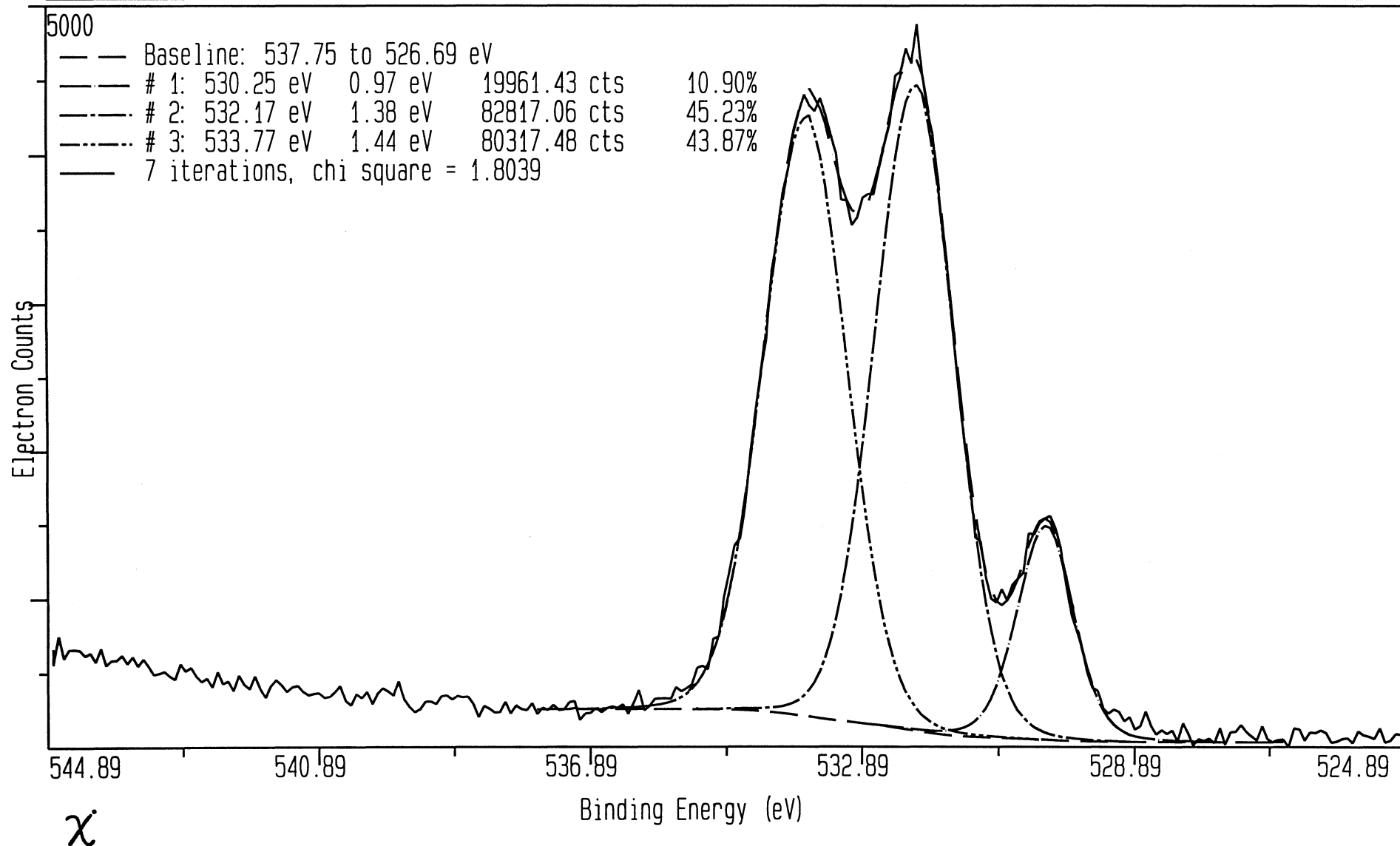
File: PMMA_SU Region: 1	Spot: 1000 Resolution: 4	Flood Gun: Off Scans, Time: 4	Data Points: 1024 Time/Point: 200	Date: 9/18/1989 Operator: DGC
Description: PMMA spun on etch Cu disk, T=150C, ang=55, op apert PMMA = Poly Methyl Methacrylate				



File: PMMA_C	Spot: 300	Flood Gun: Off	Data Points: 256	Date: 9/18/1989
Region: 2	Resolution: 1	Scans, Time: 80	Time/Point: 200	Operator: DGC
Description: PMMA spun on etch Cu disk, T=150C, ang=55, op apert PMMA = Poly Methyl Methacrylate				



File: PMMA_0	Spot: 300	Flood Gun: Off	Data Points: 256	Date: 9/18/1989
Region: 3	Resolution: 1	Scans, Time: 70	Time/Point: 200	Operator: DGC
Description: PMMA spun on etch Cu disk, T=150C, ang=55, op apert PMMA = Poly Methyl Methacrylate				



Poly Methylene Di-isocyanate:Butane-diol

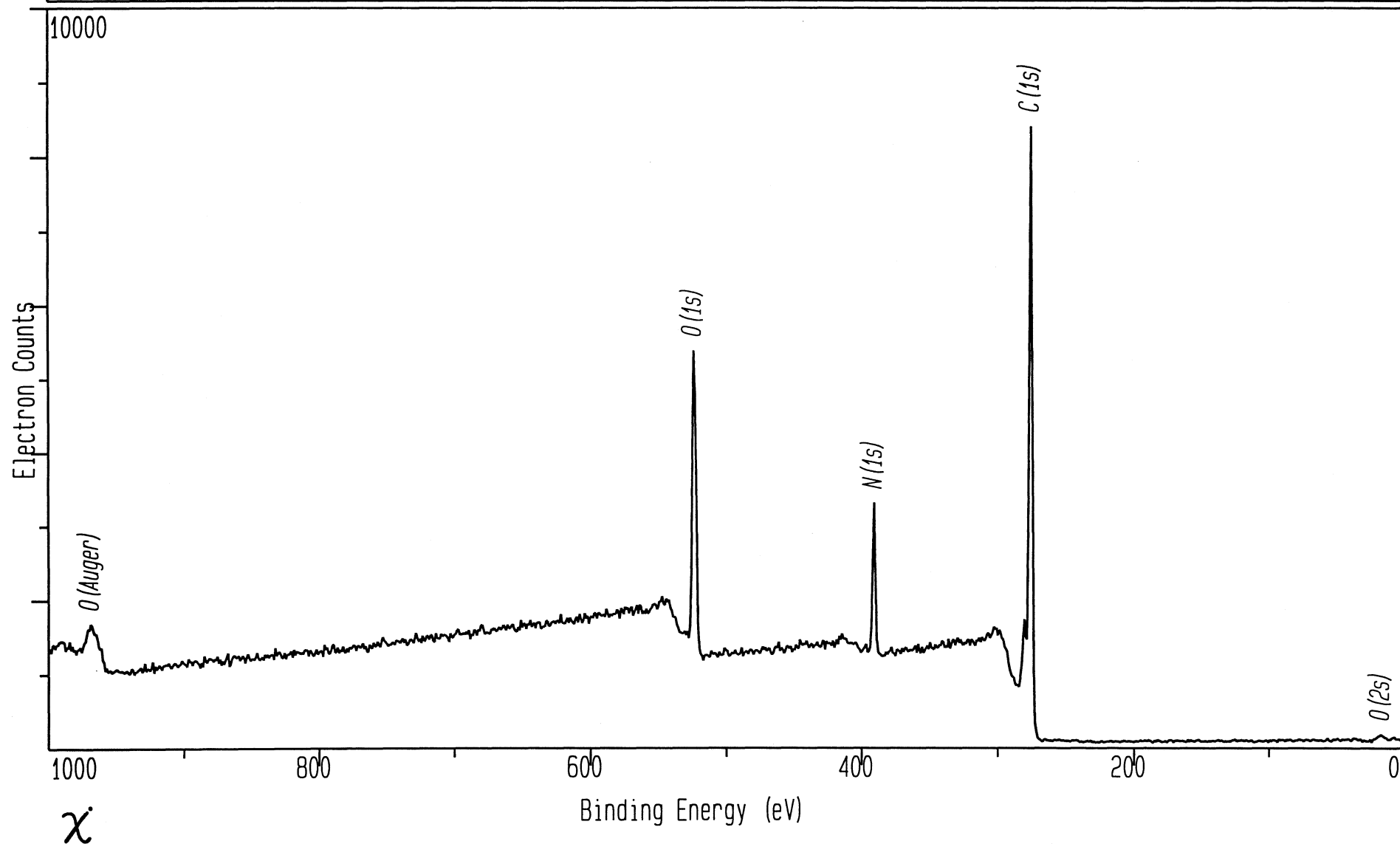
Detailed Surface Composition Table

File name: MDBD_SU.MRS
Region: 1
Description: Methylene di-isocyanate / Butane diol 1:1 copolymer
(urethane)
Operator: RDM
Date: Sat Mar 30 1988

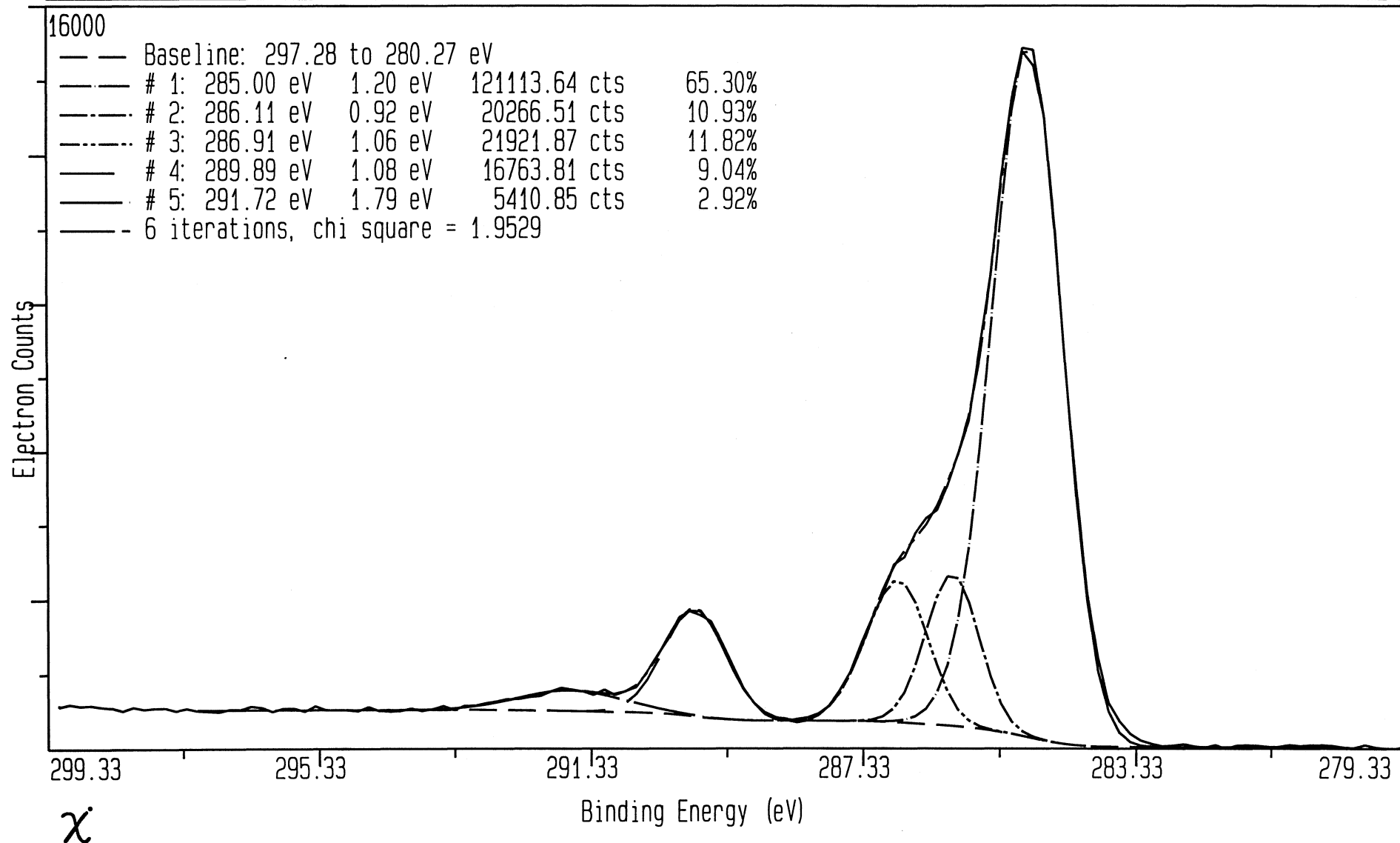
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	973.4	968.4	0.00	6607	0	
* O 1s	528.3	523.3	2.51	17840	7109	16.52
* N 1s	395.5	390.5	1.69	6064	3578	8.31
* C 1s	280.0	275.0	1.01	32536	32355	75.17
O 2s	21.6	16.6	0.16	552	3427	

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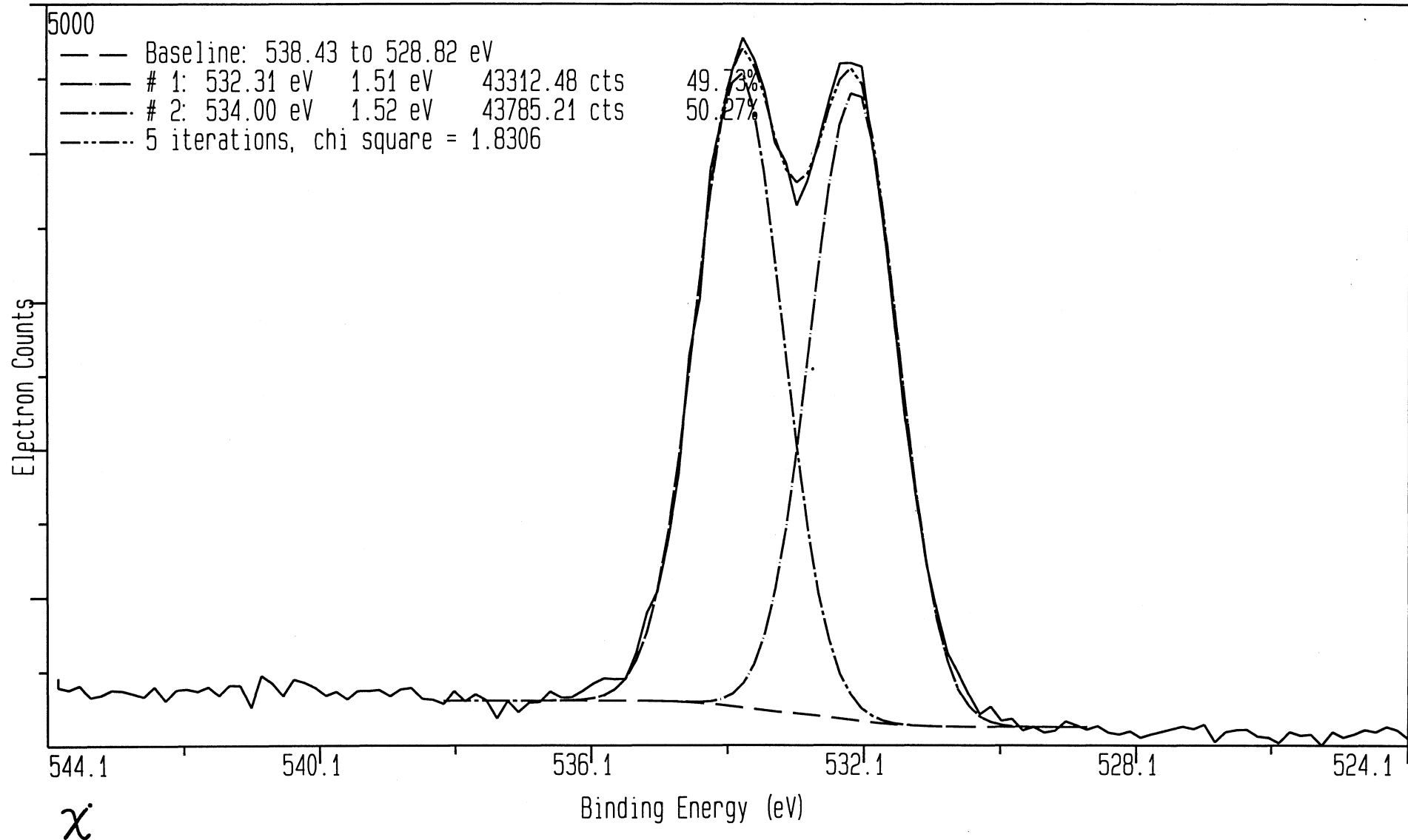
File: MDD_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 11/21/1987
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: RDM
Description: 1:1 Methylene di-isocyanate / Butane diol copolymer				



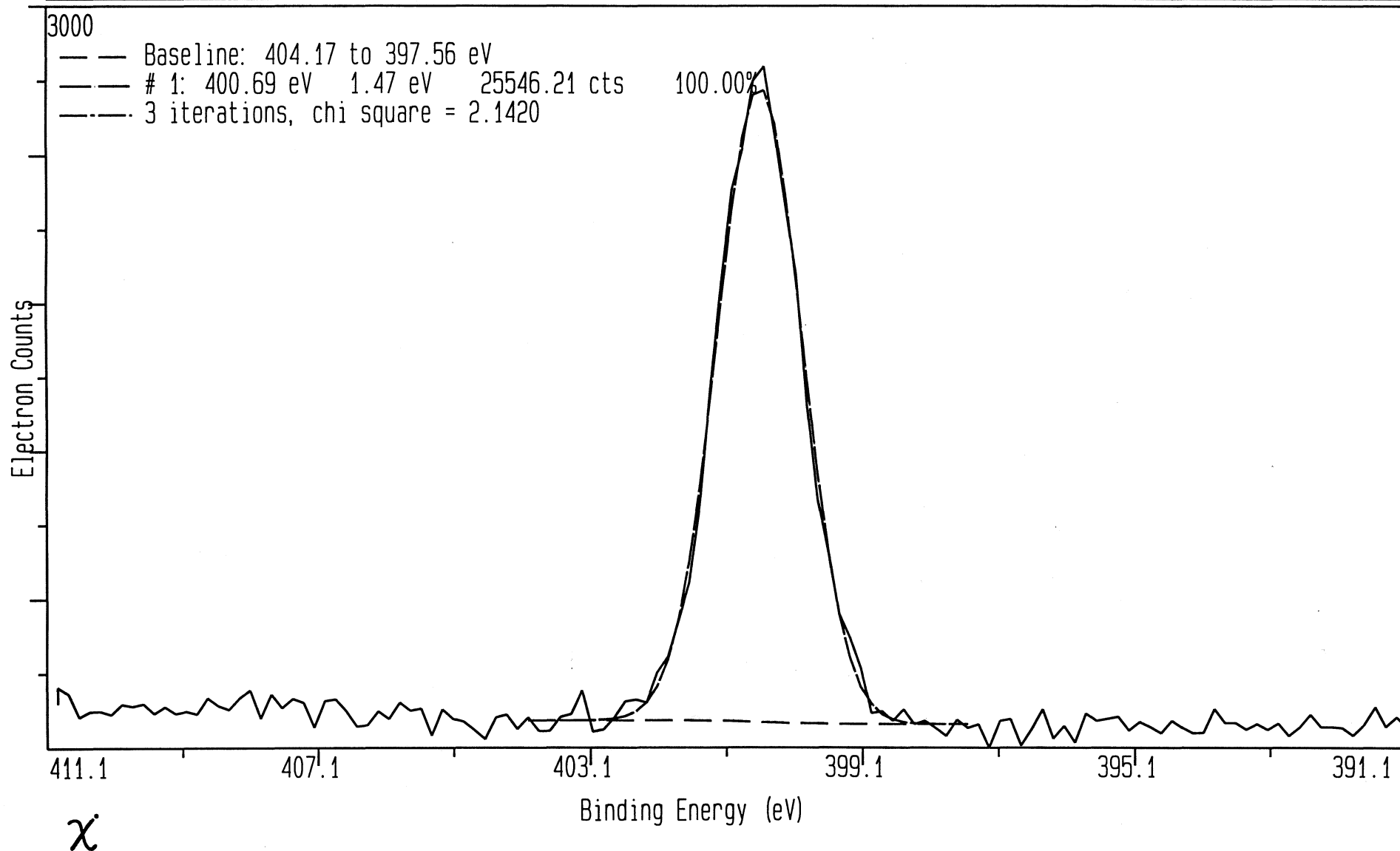
File: M0BD_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 3/30/1988
Region: 2	Resolution: 1	Scans, Time: 130	Time/Point: 200	Operator: RDM
Description: T.O. ANGLE=0; MDI+BUTANE DIOL URETHANE HRD SG Methylene di-isocyanate/butane diol copolymer				



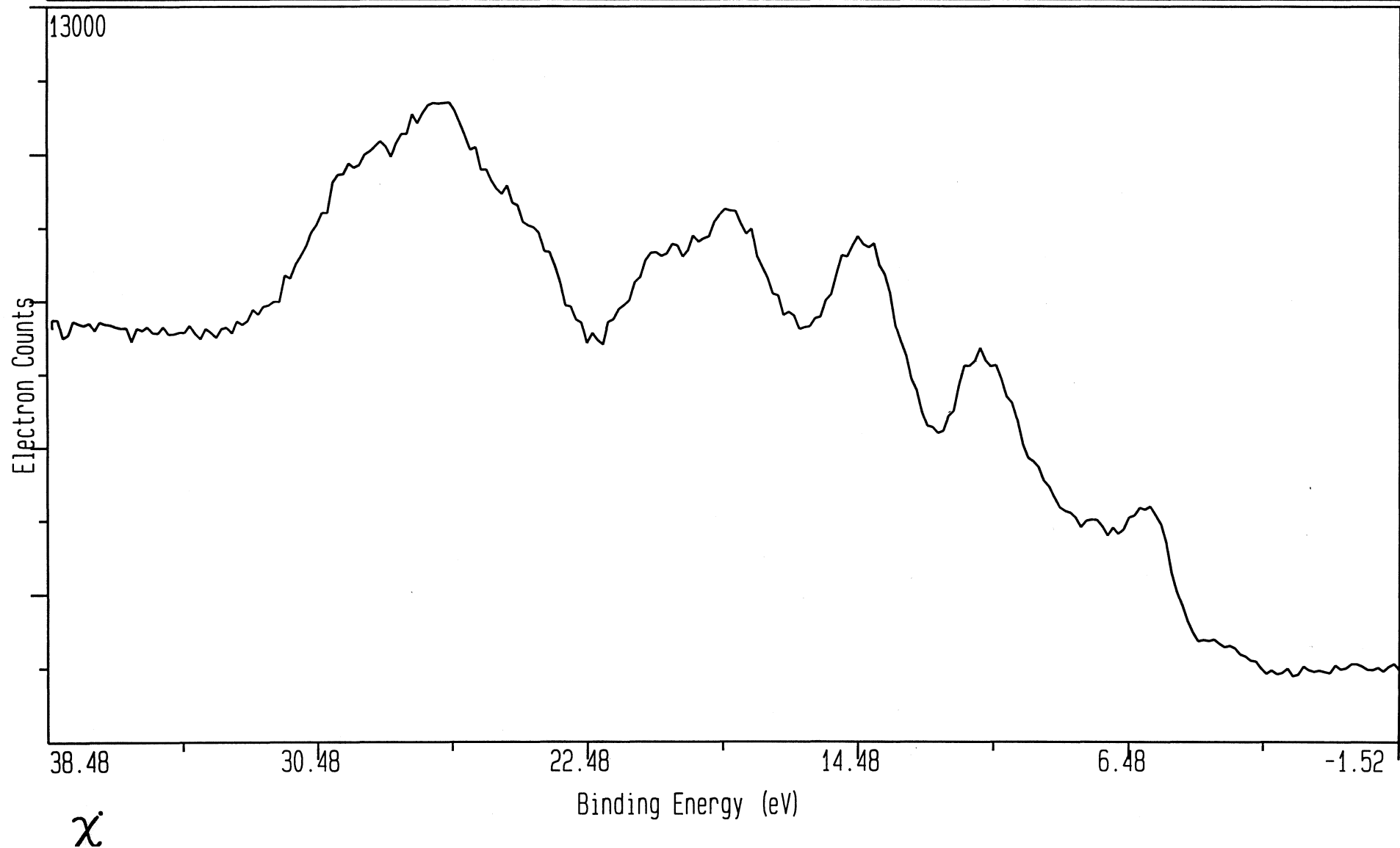
File: MDBD_0	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 10/24/1987
Region: 3	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: RDM
Description: MDI: BD--1:1 AT TAKEOFF ANGLE=0 Methylene di-isocyanate / Butane diol copolymer				



File: MDBD_N	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 10/24/1987
Region: 4	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: RDM
Description: MDI: BD--1: 1 AT TAKEOFF ANGLE=0 Methylene di-isocyanate / Butane diol copolymer				



File: MDBD_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 3/30/1988
Region: 4	Resolution: 2	Scans, Time: 630	Time/Point: 200	Operator: RDM
Description: T.O. ANGLE=0; MDI+BUTANE DIOL URETHANE HRD SG Methylene di-isocynate / Butane diol copolymer				



Poly Methylene Di-isocyanate:Butane-diol

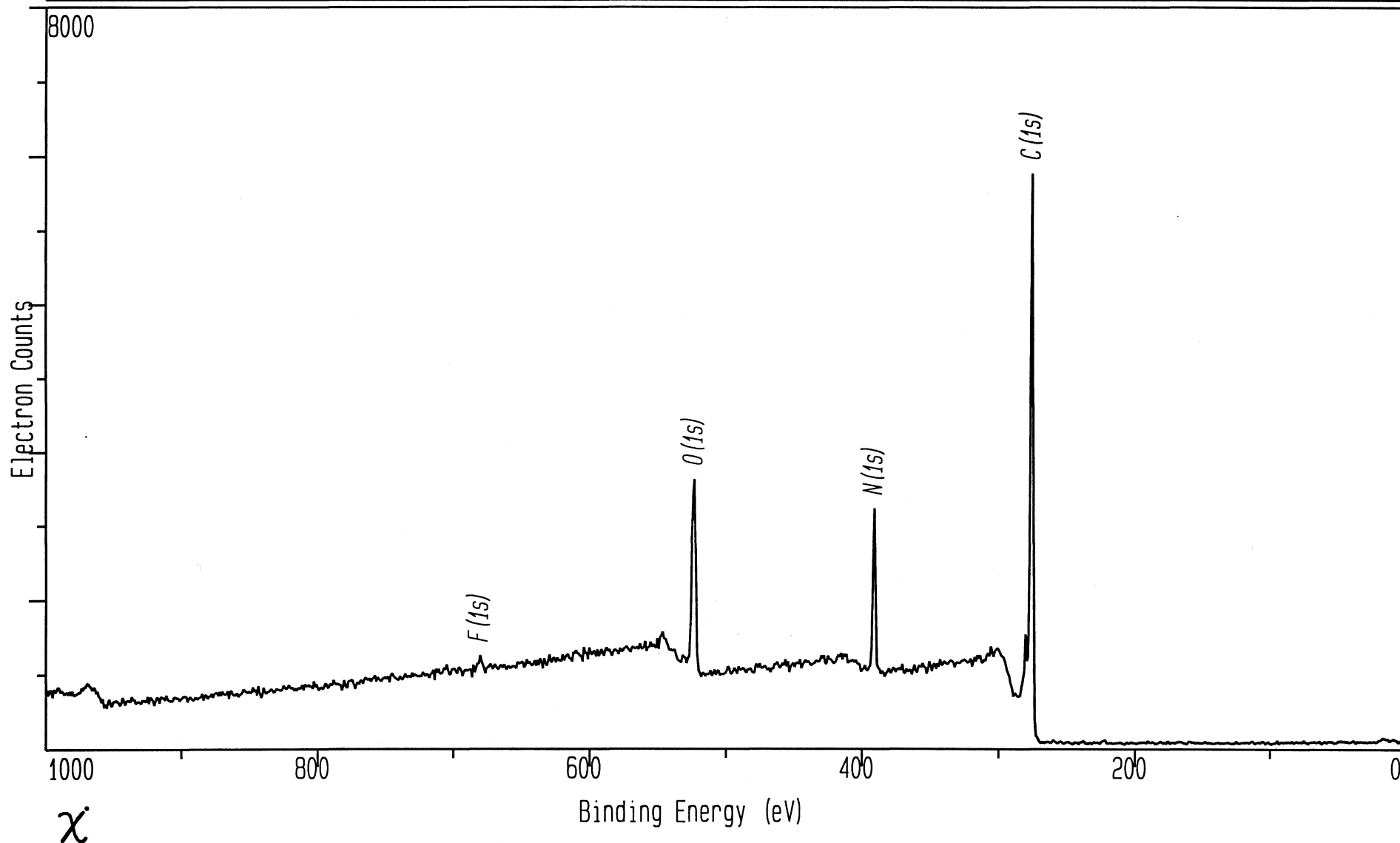
Detailed Surface Composition Table

File name: MDBP_SU.MRS
Region: 1
Description: MDI + BUTANE DIOL + PROPANE DIAMINE; MIXED HARD SEGMENT
MDI = Methylene di-isocyanate
Operator: RDM
Date: Fri Apr 1 1988

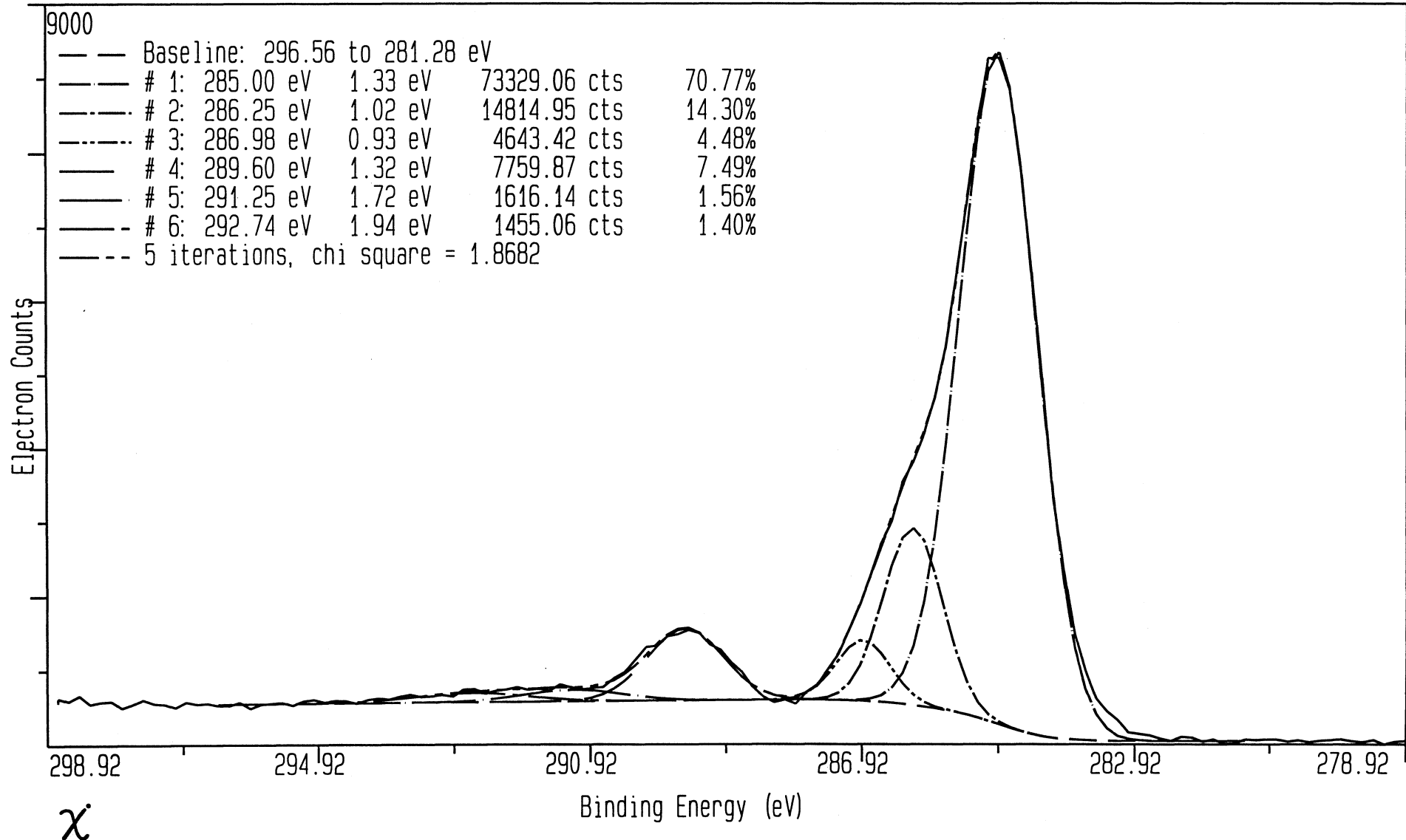
<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
* O 1s	527.9	522.9	2.51	18833	7503	12.96
* N 1s	395.6	390.6	1.70	10487	6184	10.69
* C 1s	280.2	275.2	1.01	44209	43968	75.97
* F 1s	685.4	680.4	3.35	735	219	0.38

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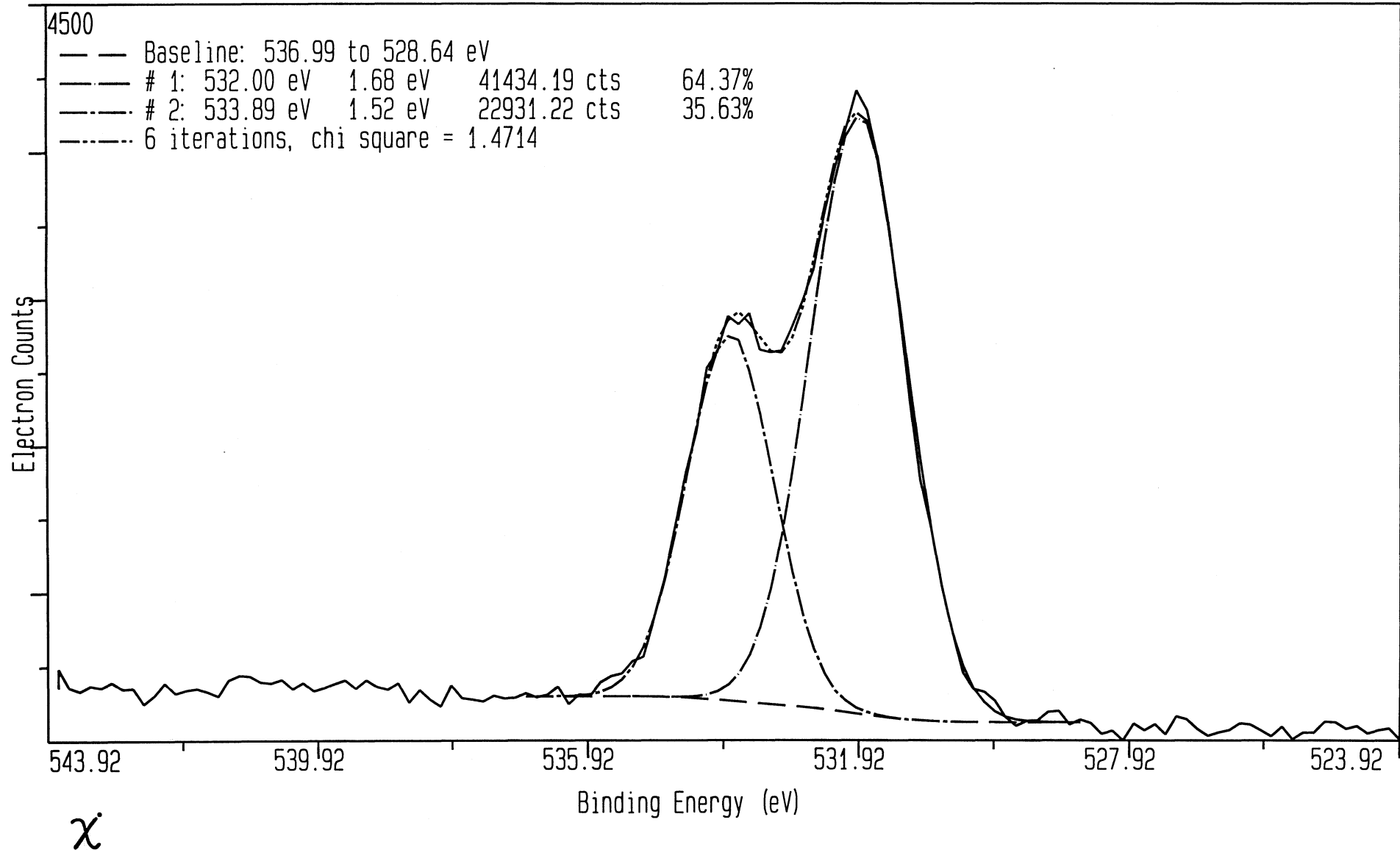
File: MDBP_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 4/1/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: RDM
Description: MDI+BUTANE DIOL+PROPANE DIAMINE; MIXED HARD SEGMNT MDI = Methylene di-isocyanate				



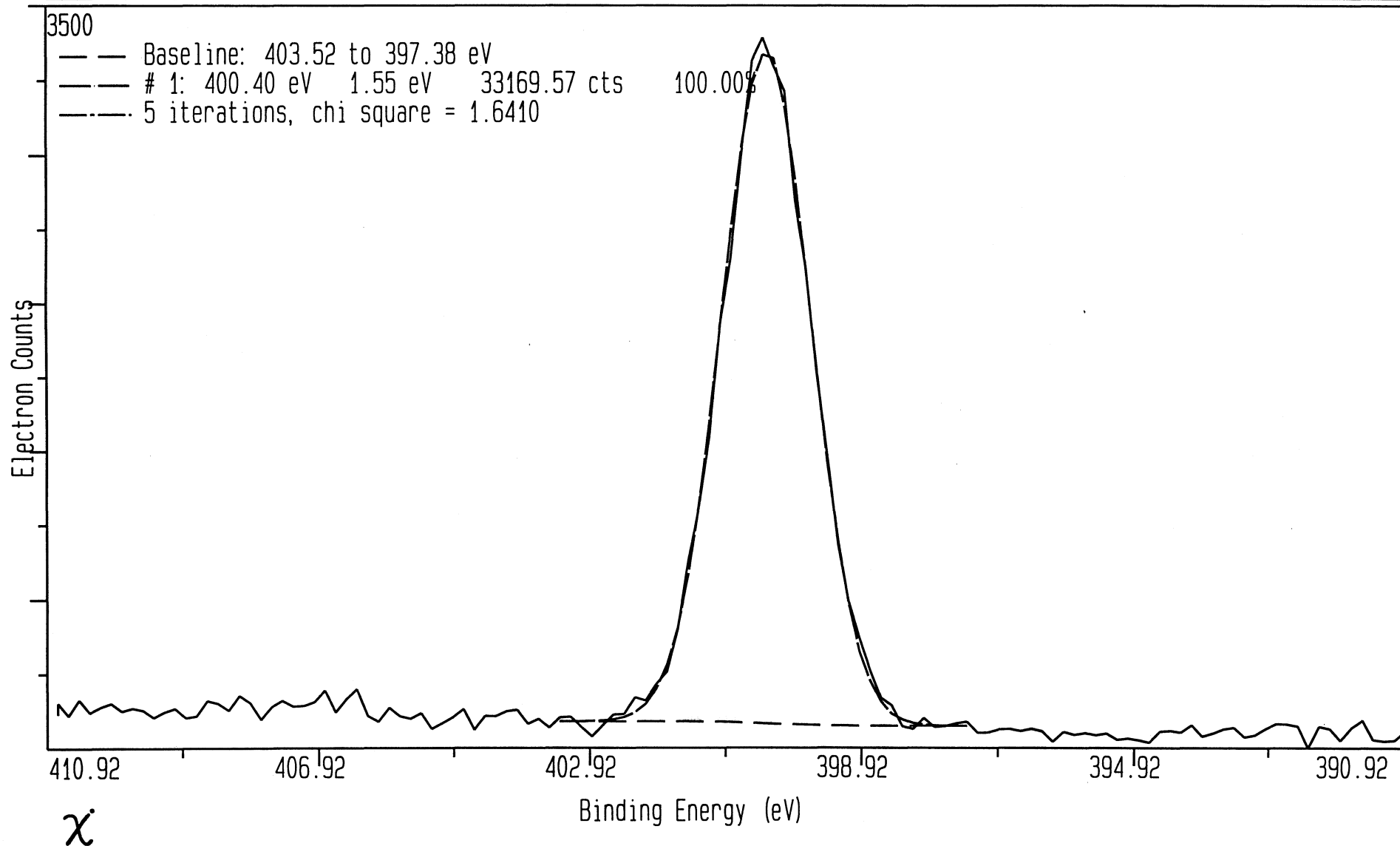
File: MDBP_C	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 10/24/1987
Region: 2	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: RDM
Description: MDI: BD: PD--2: 1: 1 AT TAKEOFF ANGLE=0 Methylene di-isocynate/butane diol/propane diamine				



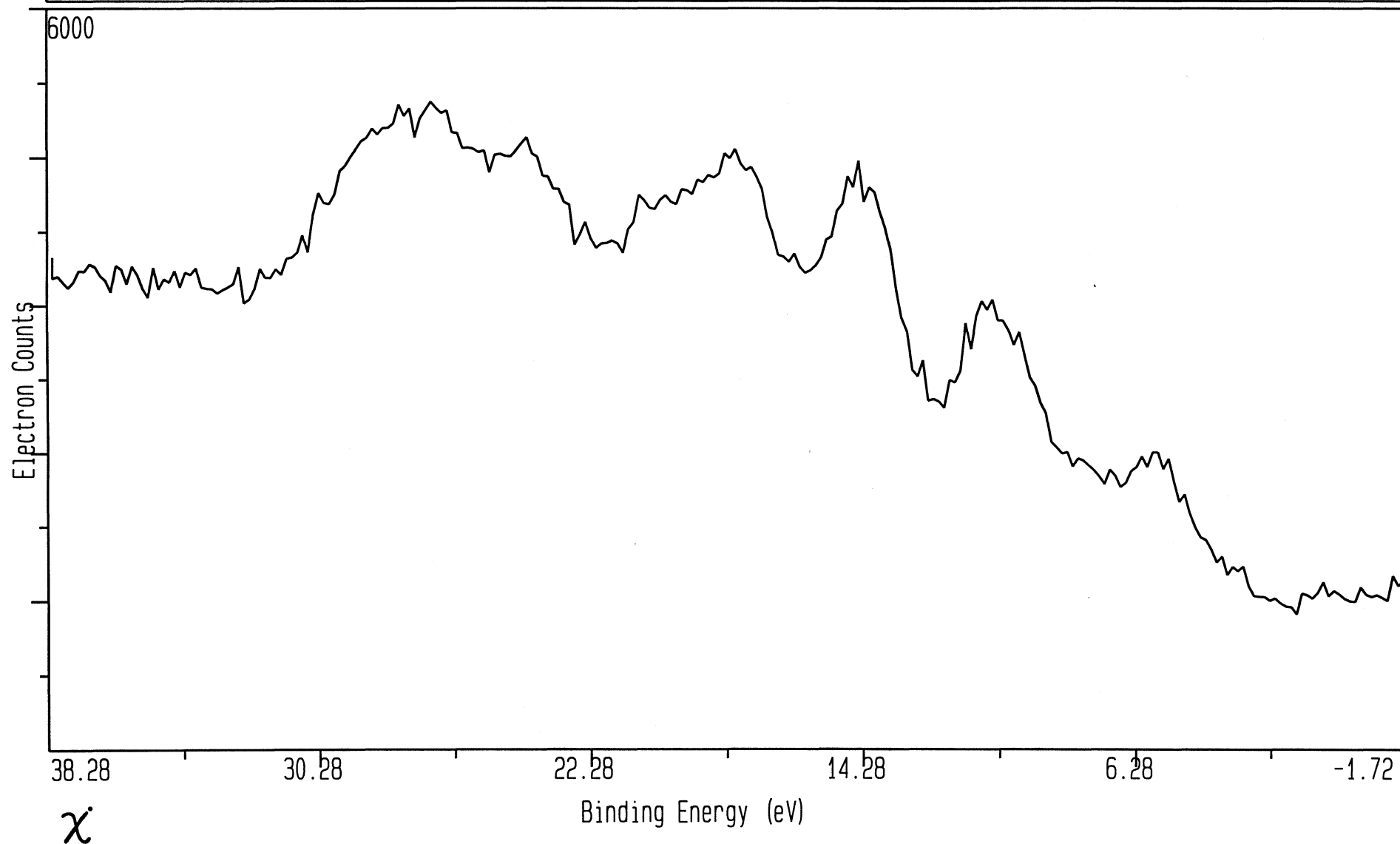
File: MDBP_0	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 10/24/1987
Region: 3	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: RDM
Description: MDI: BD: PD--2: 1: 1 AT TAKEOFF ANGLE=0 Methylene di-isocyanate/butane diol/propane diamine				



File: MDBP_N	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 10/24/1987
Region: 4	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: RDM
Description: MDI: BD: PD--2: 1: 1 AT TAKEOFF ANGLE=0 Methylene di-isocyanate/butane diol/propane diamine				



File: MDBP_VB Region: 4	Spot: 1000 Resolution: 2	Flood Gun: 5.0 Scans, Time: 624	Data Points: 256 Time/Point: 200	Date: 4/1/1988 Operator: RDM
Description: MDI+BUTANE DIOL+PROPANE DIAMINE; MIXED HARD SEGMENT MDI = Methylene di-isocyanate				



Poly Methylene Di-isocyanate:Butane-diol

Detailed Surface Composition Table

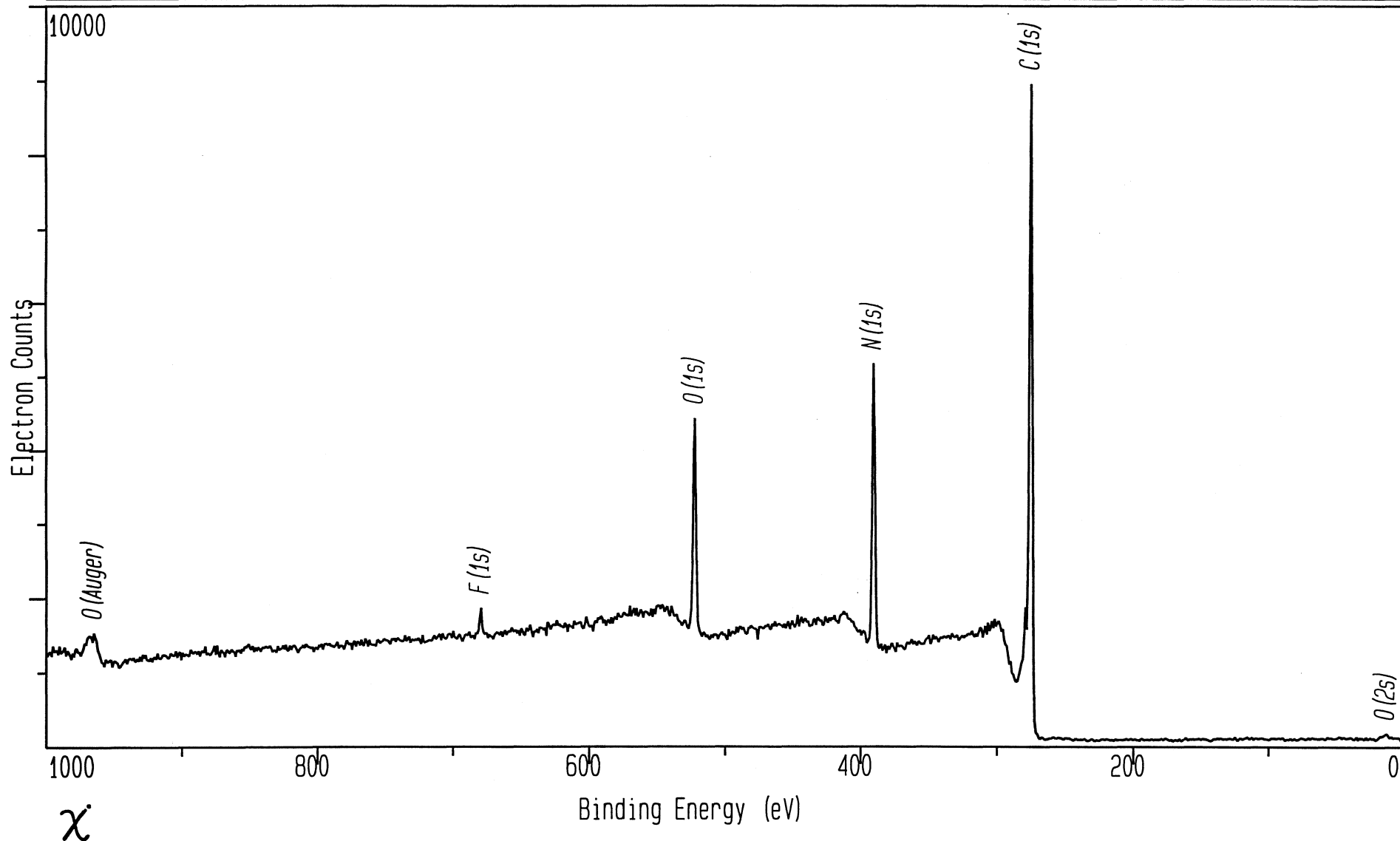
File name: MDPD_SU.MRS
Region: 1
Description: Methylene di-isocyanate/propane diamine, 1:1 copolymer

Operator: RDM
Date: Sun Nov 22 1987

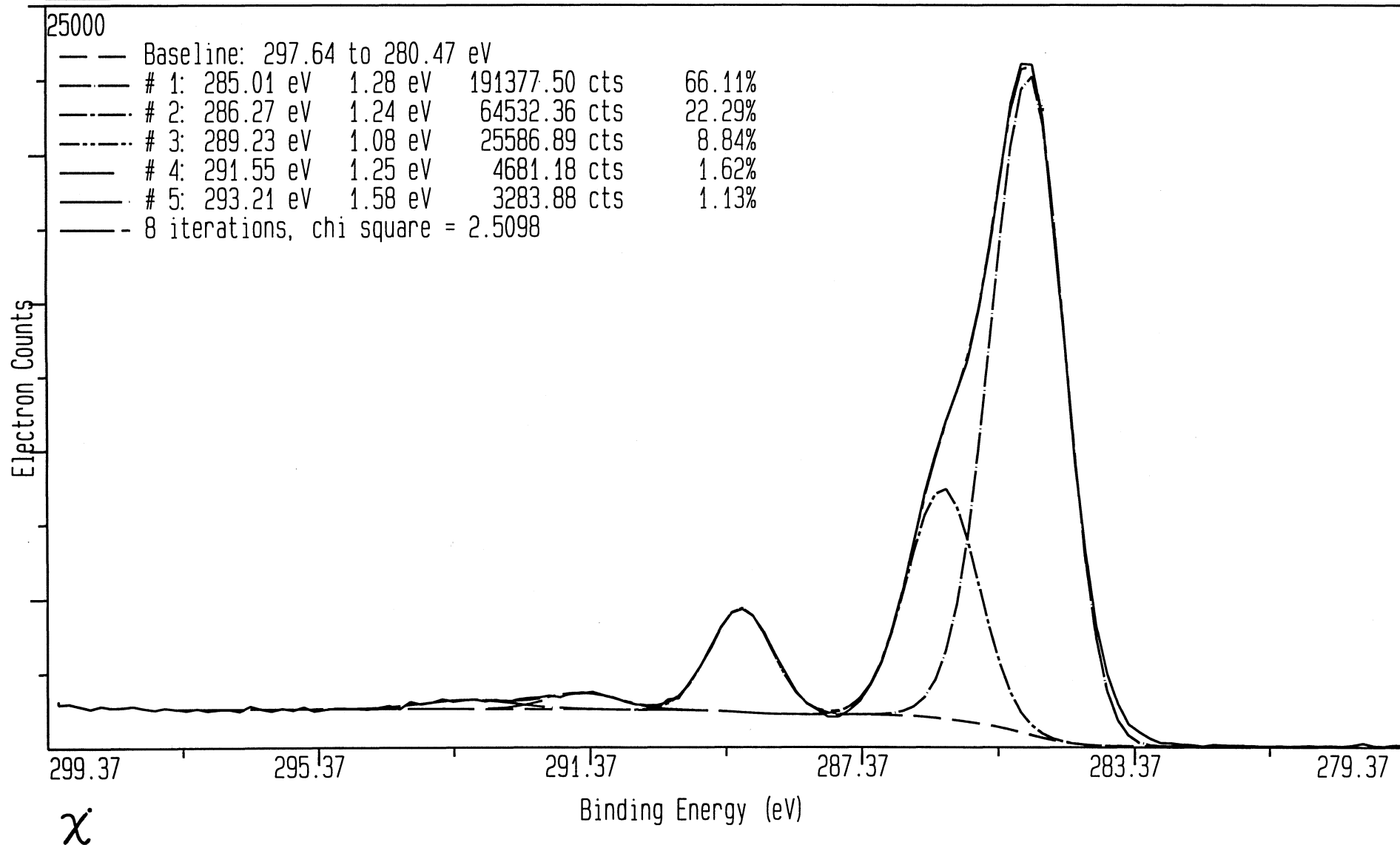
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> <u>%</u>
O Auger	969.6	964.6	0.00	3764	0	
* F 1s	684.2	679.2	3.36	1422	423	0.94
* O 1s	526.8	521.8	2.51	9596	3820	8.52
* N 1s	395.2	390.2	1.70	11572	6826	15.23
* C 1s	280.0	275.0	1.01	33952	33764	75.31
O 2s	17.6	12.6	0.16	383	2374	

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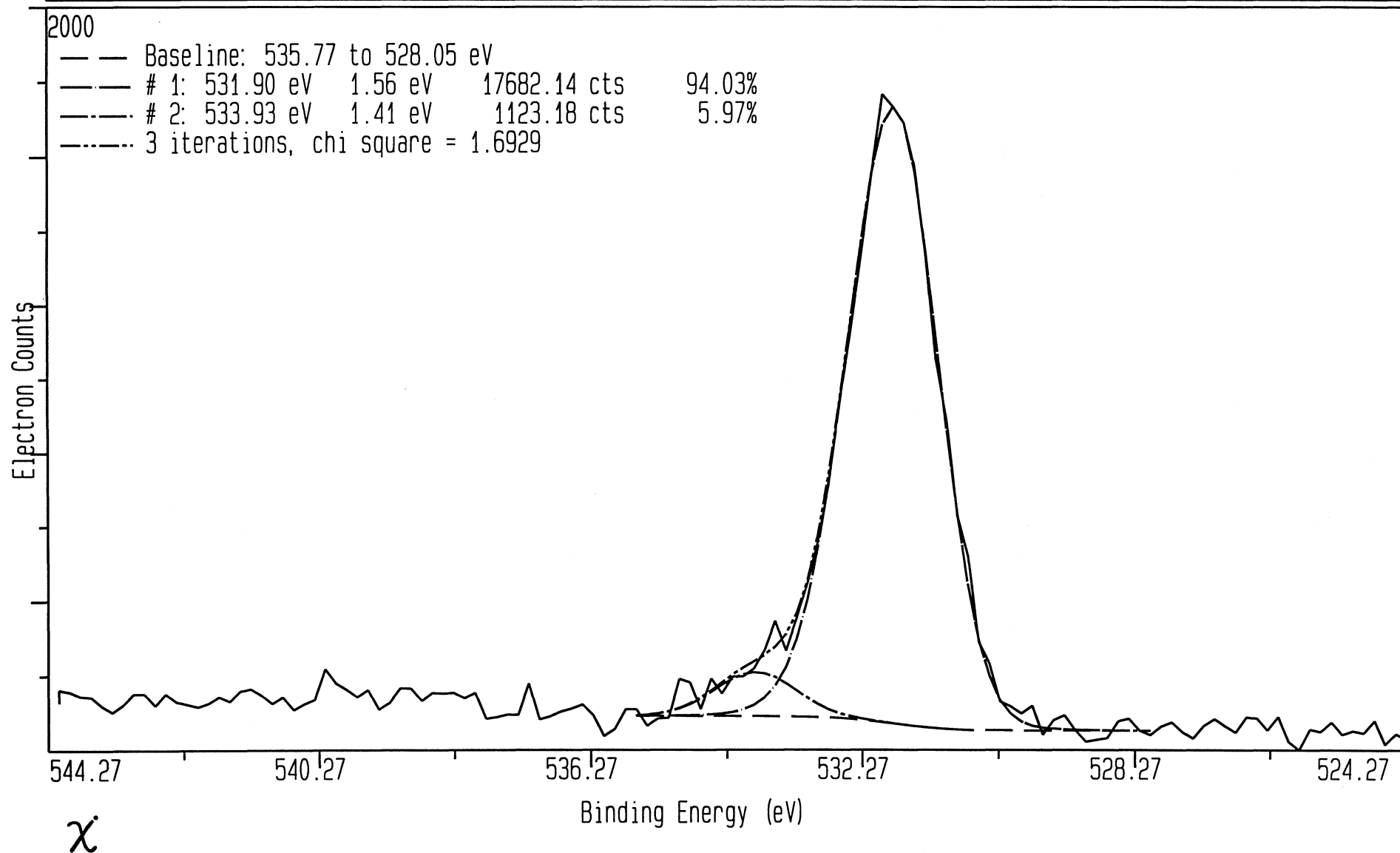
File: MDPD_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 11/22/1987
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: RDM
Description: 1:1 Methylene di-isocynate/propane diamine copoly.				



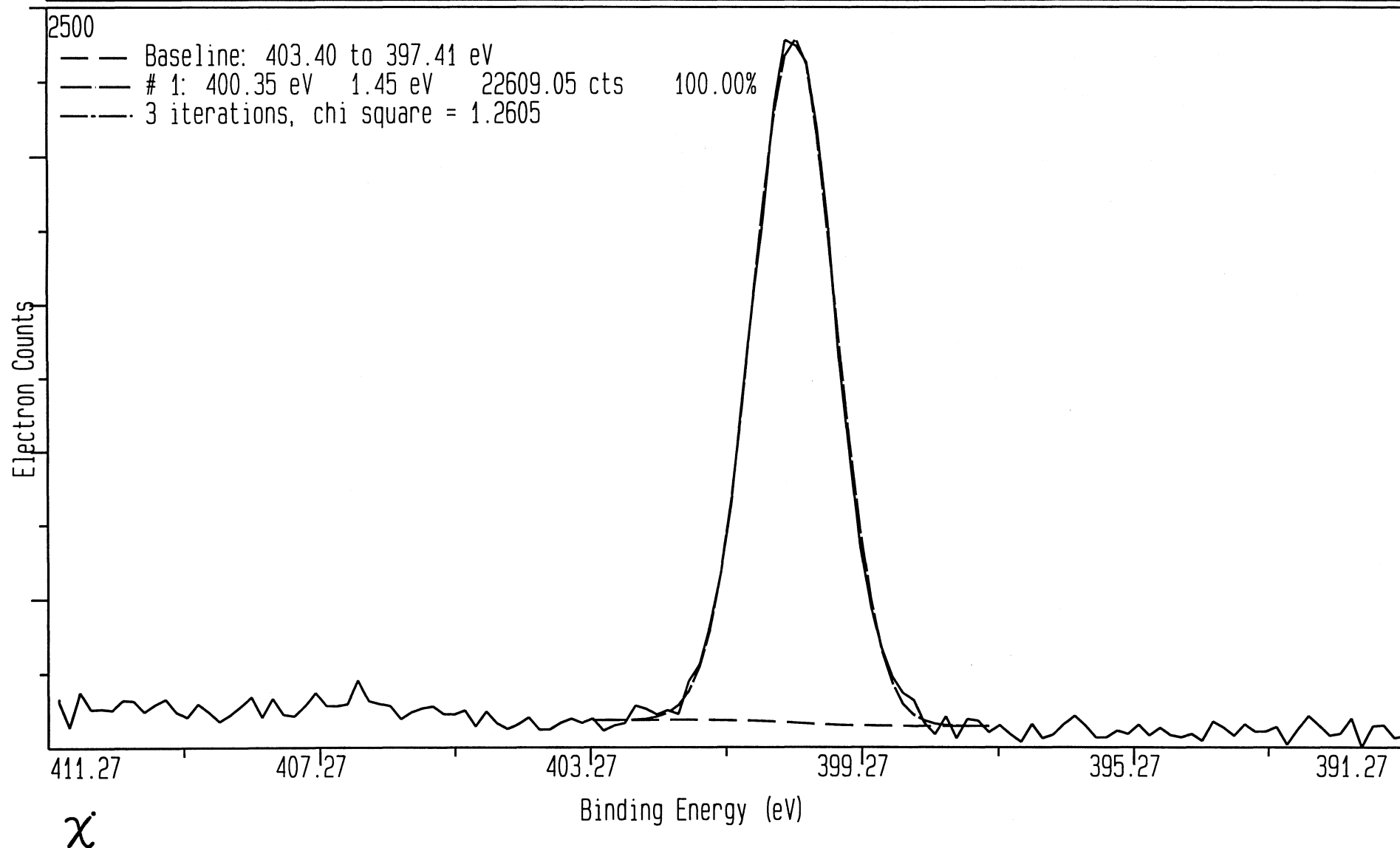
File: MDPD_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 10/9/1987
Region: 2	Resolution: 1	Scans, Time: 150	Time/Point: 200	Operator: RDM
Description: 1: 1-Methylene di-isocynate: PROPANE DIAMINE				



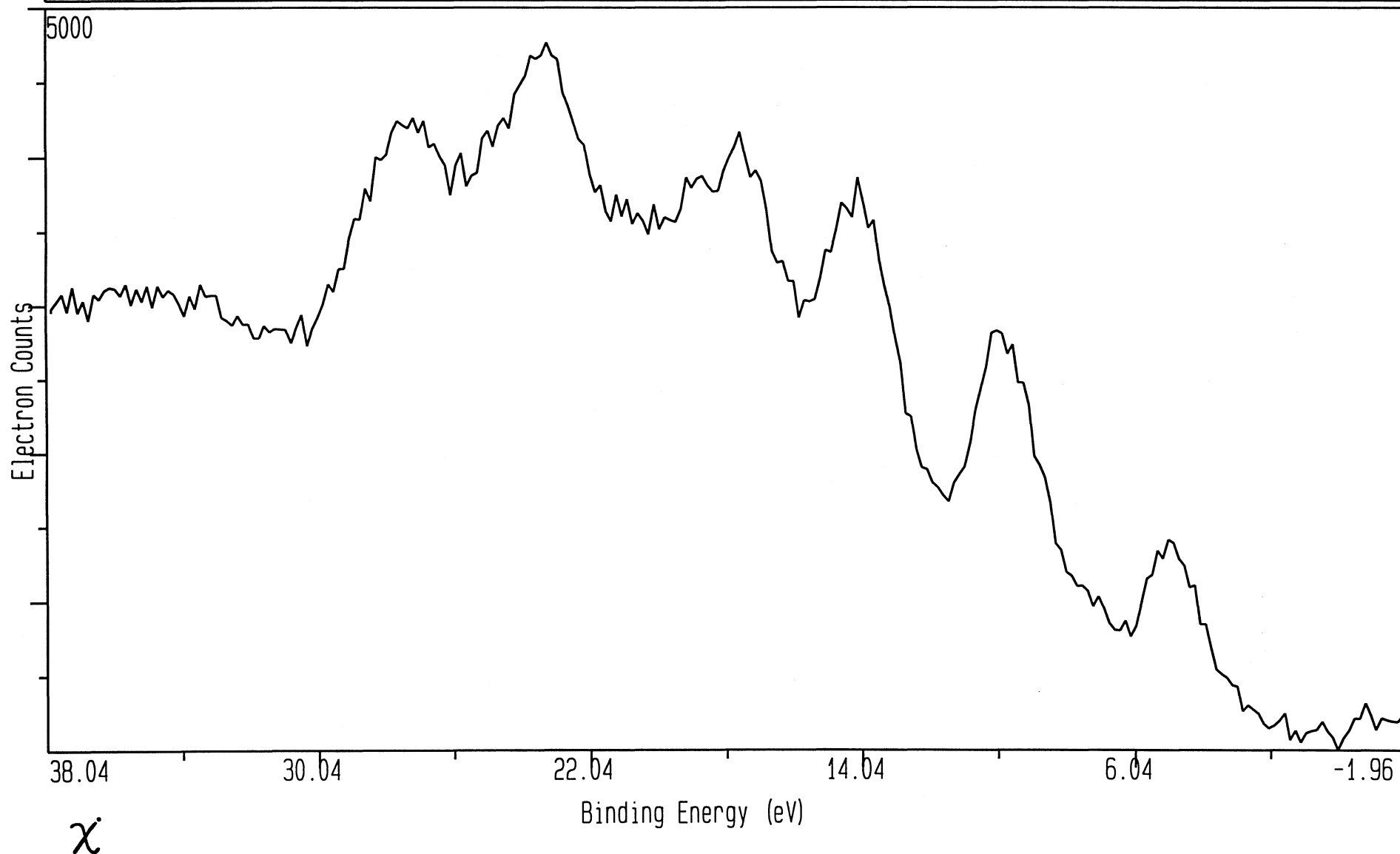
File: MDPD_0	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 11/22/1987
Region: 3	Resolution: 1	Scans, Time: 50	Time/Point: 200	Operator: RDM
Description: 1:1 Methylene di-isocynate:propane diamine copoly.				



File: MDPD_N	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 11/22/1987
Region: 4	Resolution: 1	Scans, Time: 60	Time/Point: 200	Operator: RDM
Description: 1:1 Methylene di-isocyanate:Propane diamine copoly.				



File: MDPD_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 3/31/1988
Region: 4	Resolution: 2	Scans, Time: 600	Time/Point: 200	Operator: RDM
Description: MDI + PROPANE DIAMINE (UREA HARD SETGMENT) MDI = Methylene di-isocynate				



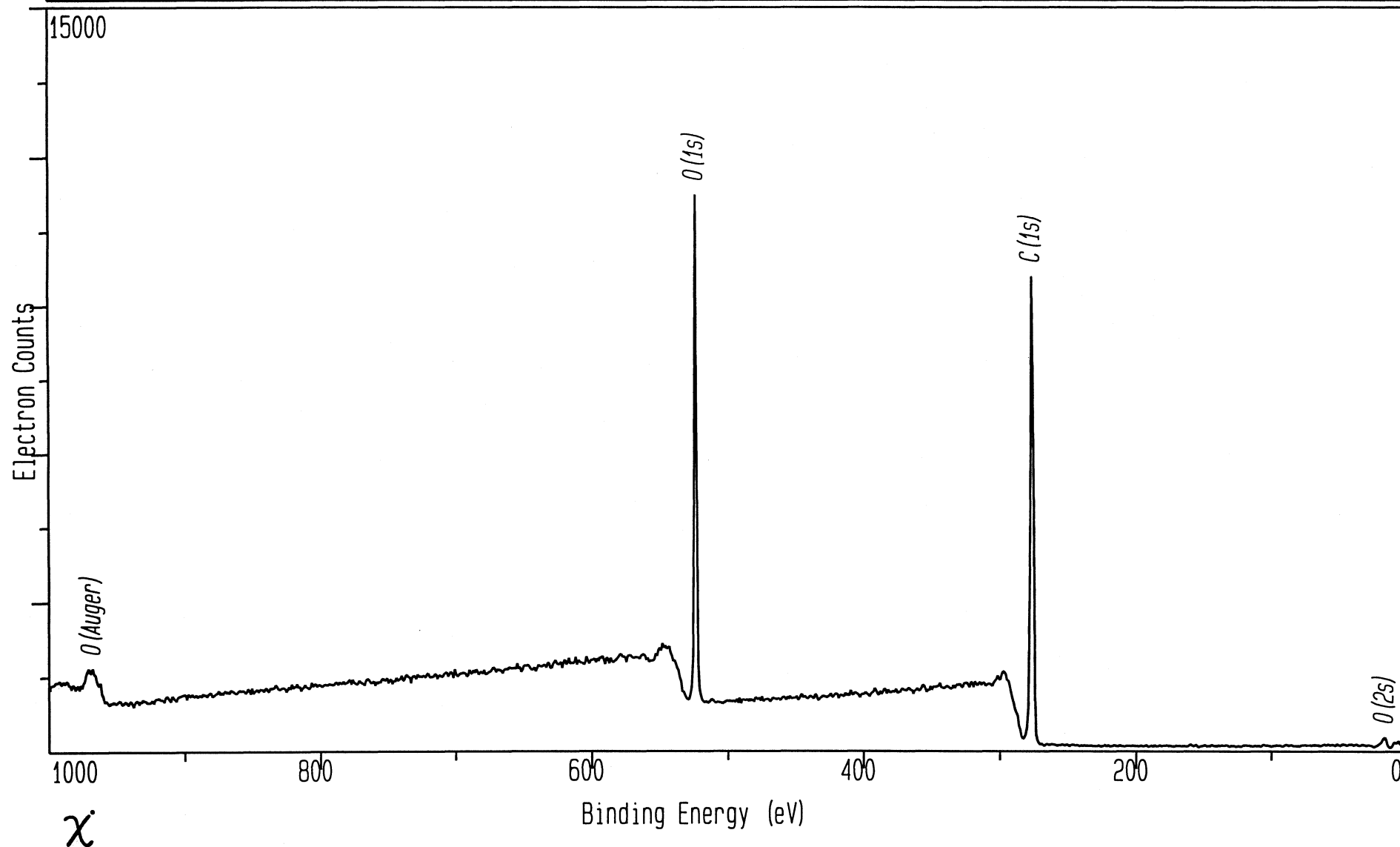
Poly - Propylene Glycol (2000)

Detailed Surface Composition Table

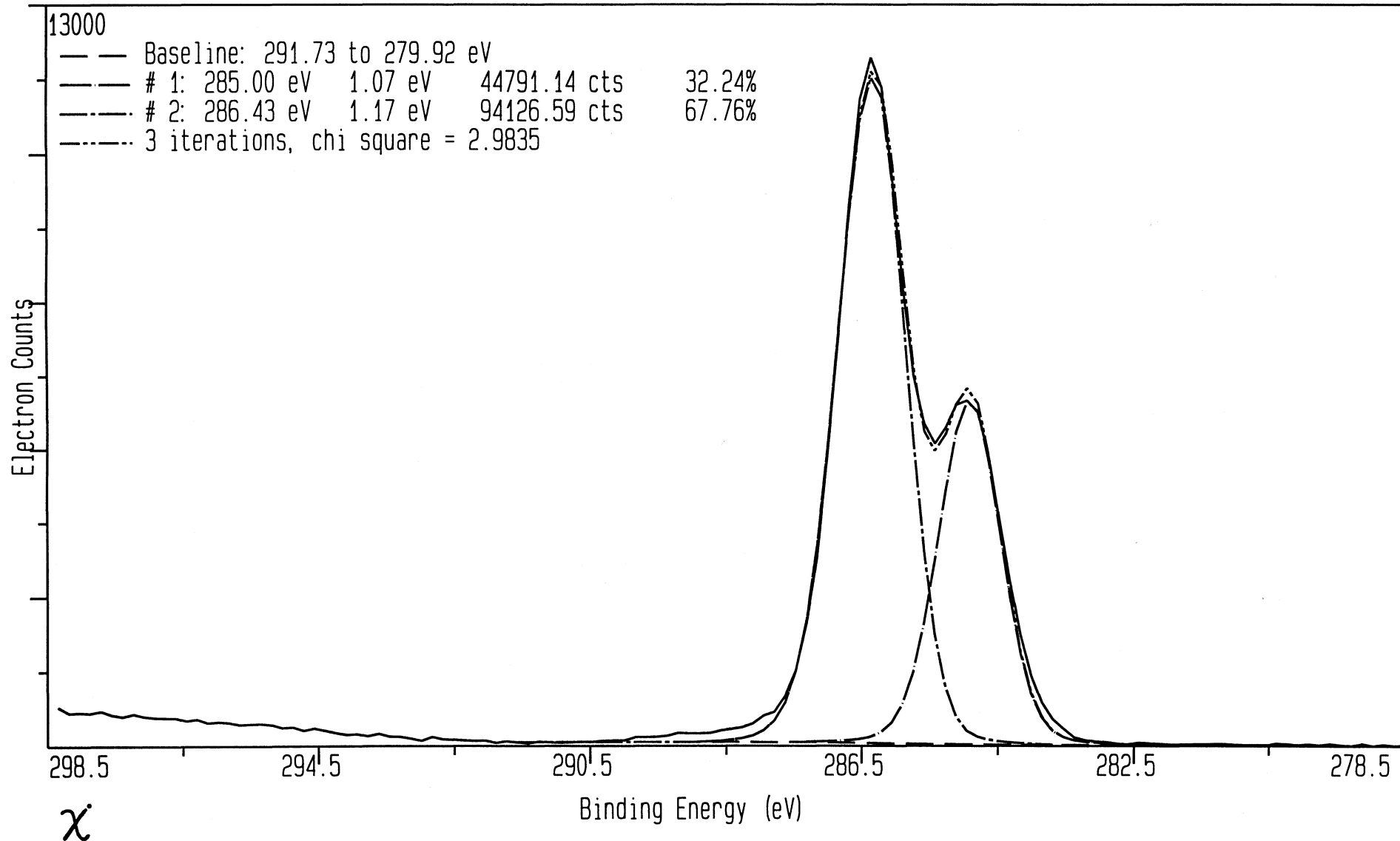
File name: PPG_SU.MRS
Region: 1
Description: PPG-2000 (REICHHOLD), FROM MeOH, WC8-84-3, 5-10-88
PPG = Poly Propylene Glycol
Operator: DGC
Date: Sun Jun 26 1988

<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
O Auger	972.8	967.8	0.00	9766	0	
* O 1s	528.5	523.5	2.51	54427	21692	25.03
* C 1s	281.7	276.7	1.00	65273	64973	74.97
O 2s	21.0	16.0	0.16	4048	25107	

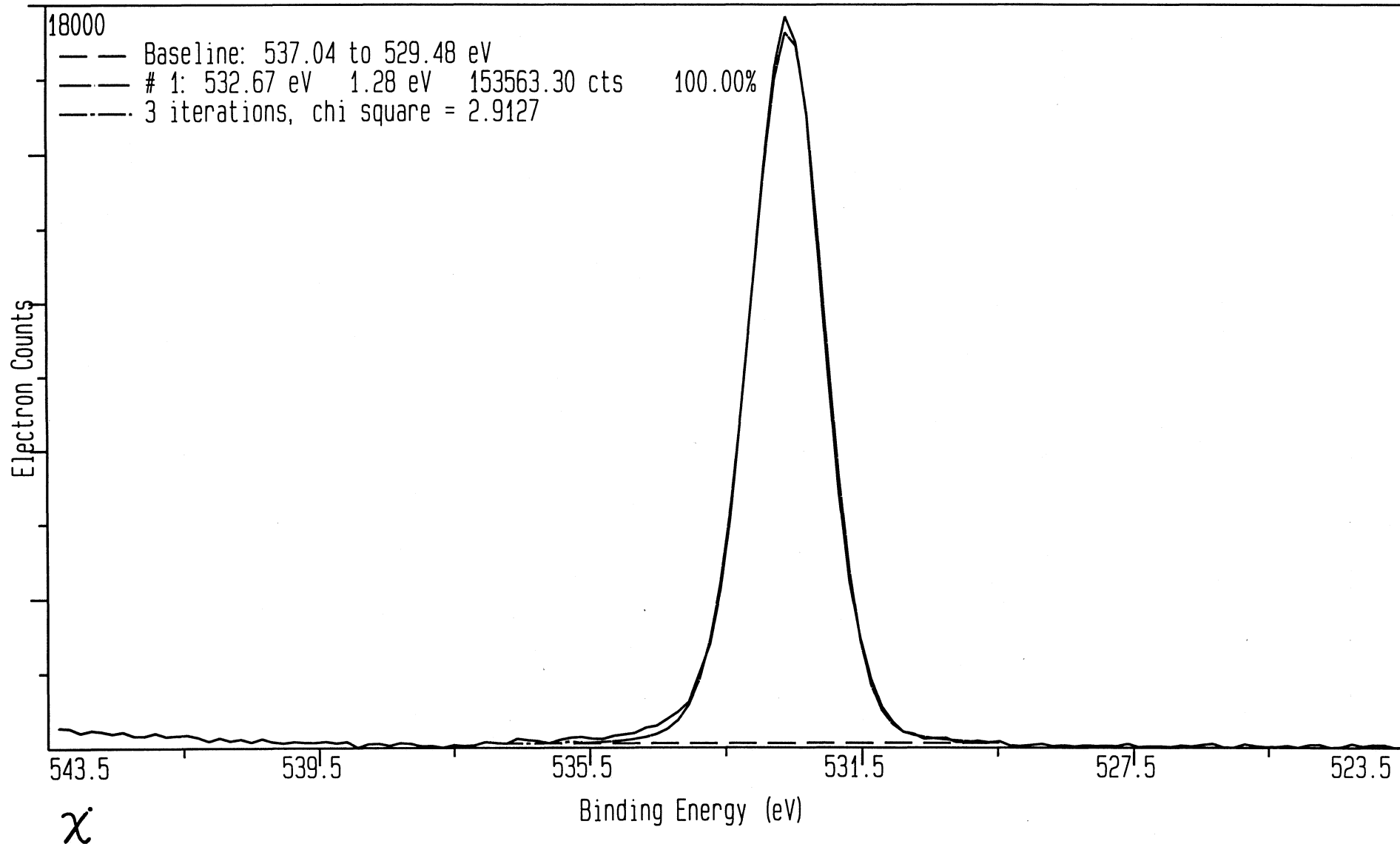
File: PPG_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 6/26/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: PPG-2000 (REICHHOLD), FROM MeOH, WC8-84-3, 5-10-88 PPG = Poly Propylene Glycol				



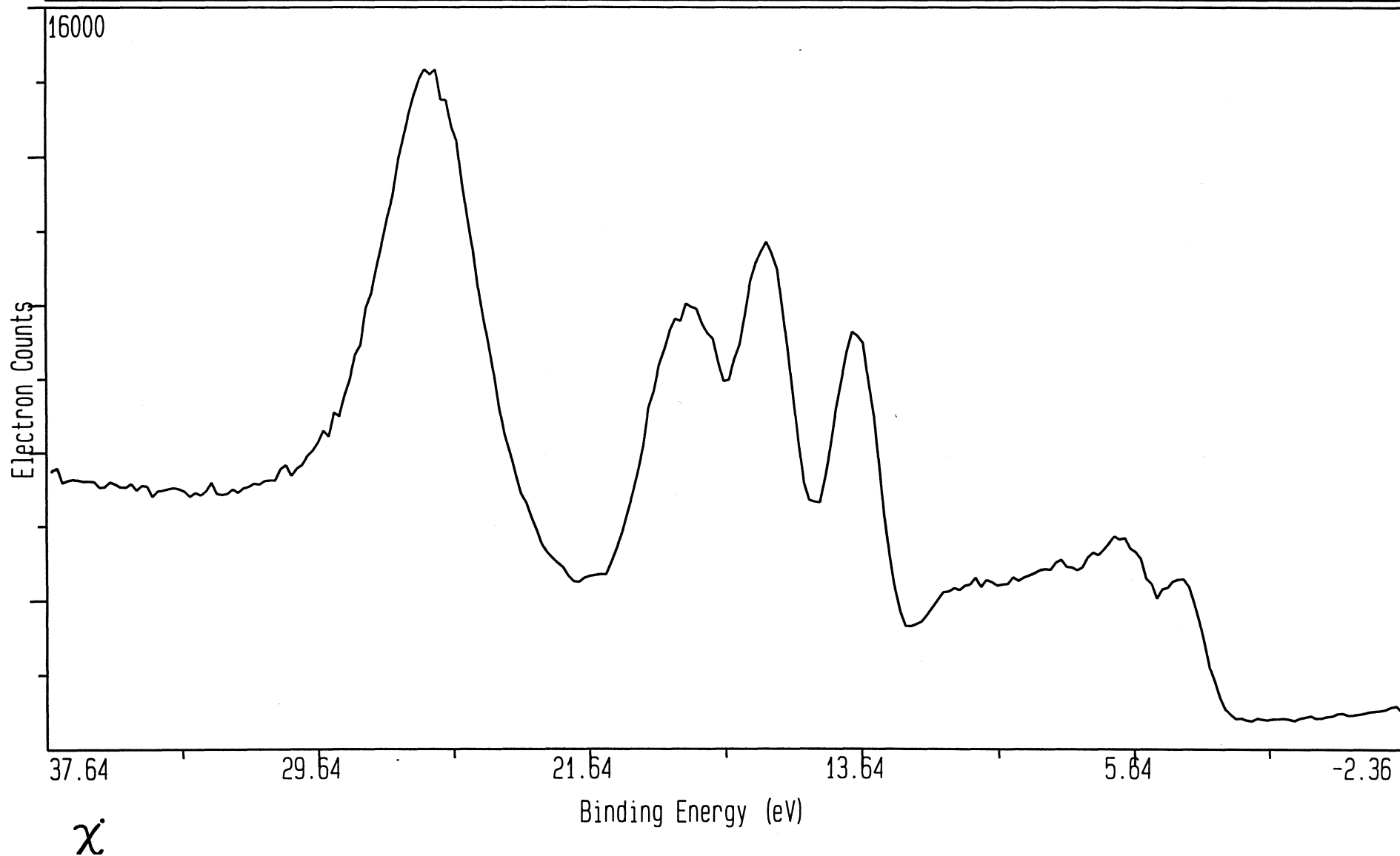
File: PPG_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/26/1988
Region: 2	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: PPG-2000 (REICHHOLD), FROM MeOH, WC8-84-3, 5-10-88 PPG = Poly Propylene Glycol				



File: PPG_0	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 6/26/1988
Region: 3	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: PPG-2000 (REICHHOLD), FROM MeOH, WC8-84-3, 5-10-88 PPG = Poly Propylene Glycol				



File: PPG_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 6/26/1988
Region: 7	Resolution: 2	Scans, Time: 446	Time/Point: 200	Operator: DGC
Description: PPG-2000 (REICHHOLD), FROM MeOH, WC8-84-3, 5-10-88 PPG = Poly Propylene Glycol				



Poly - Styrene (4% in toluene)

Detailed Surface Composition Table

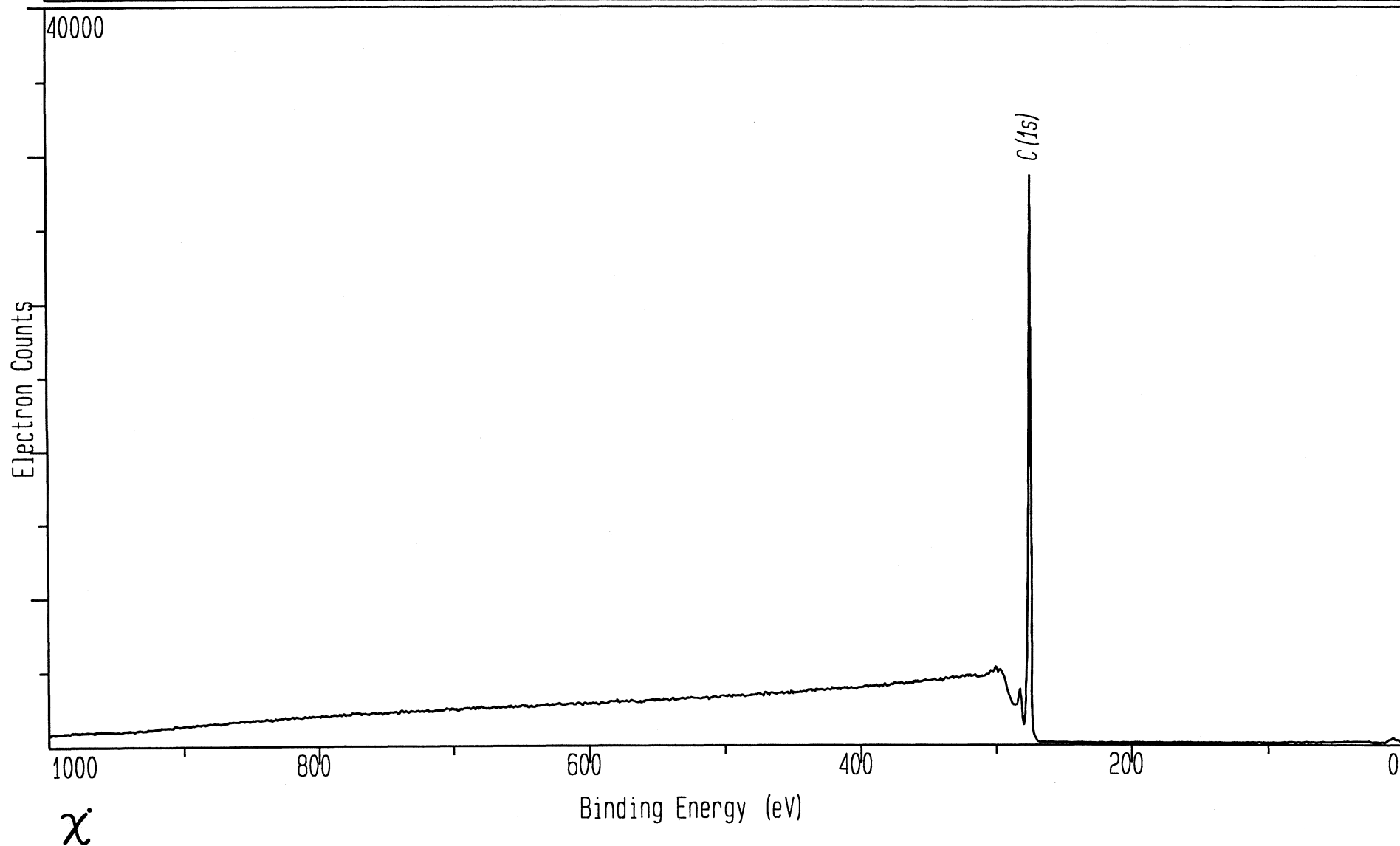
File name: PS_SU.MRS
Region: 1
Description: Poly (Styrene), 4% IN TOLUENE, 4/11/88

Operator: DGC
Date: Tue Apr 12 1988

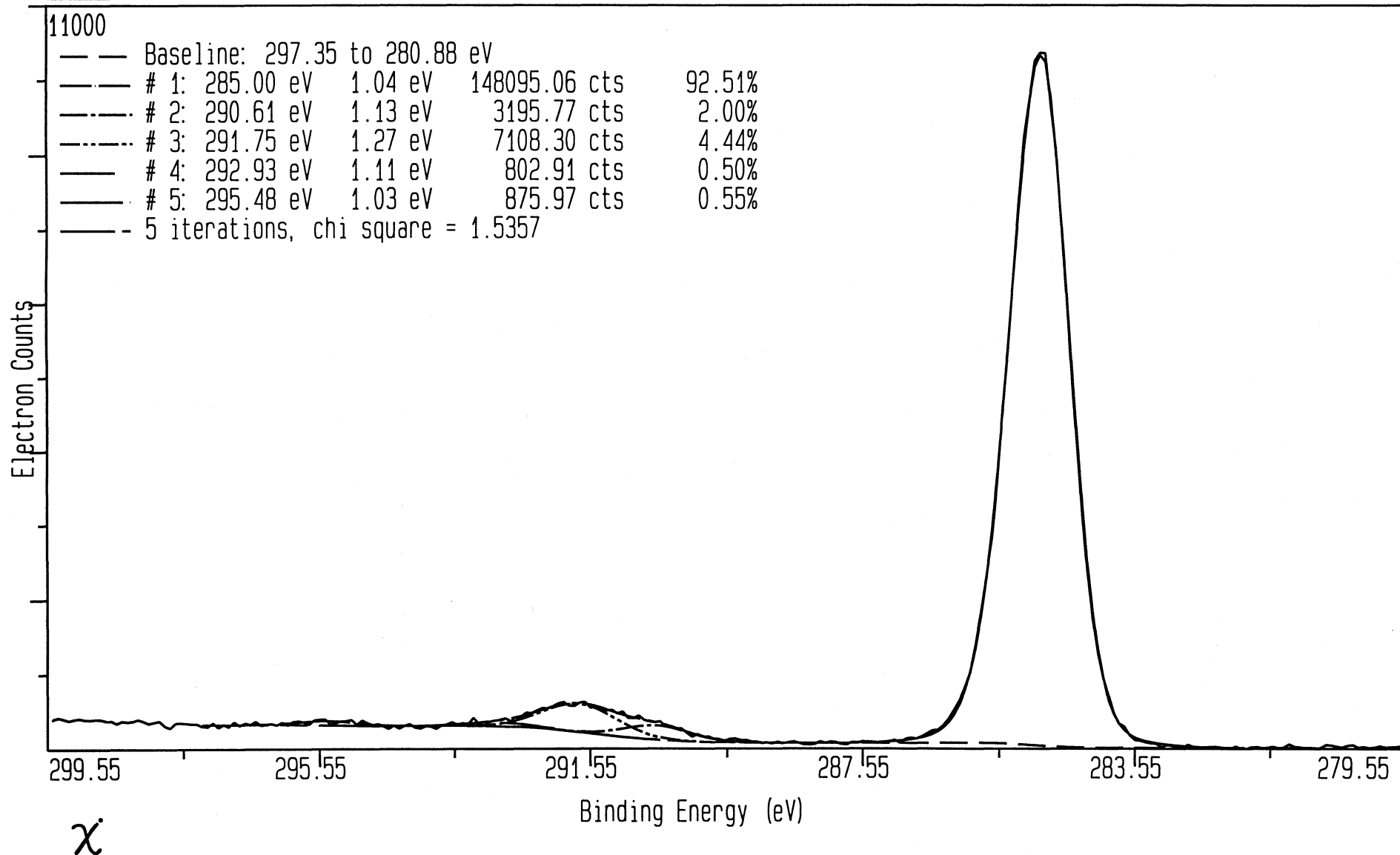
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
* C 1s	280.0	275.0	1.01	164517	163603	100.00

X

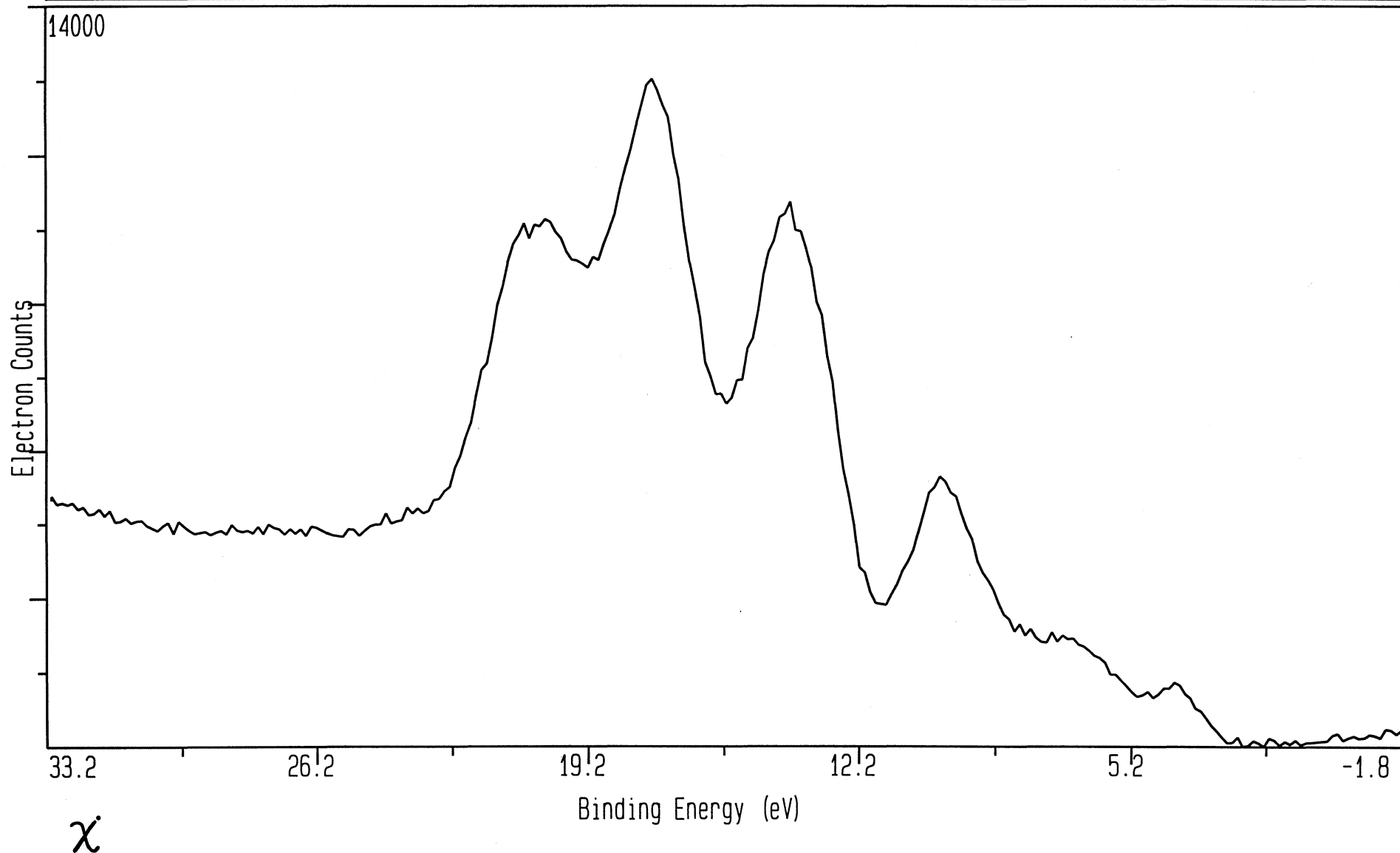
File: PS_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 4/12/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Sample Description: Poly (Styrene), 4% IN TOLUENE, 4/11/88				



File: PS_C	Spot: 150	Flood Gun: 5.0	Data Points: 256	Date: 4/12/1988
Region: 2	Resolution: 1	Scans, Time: 80	Time/Point: 200	Operator: DGC
Description: Poly (Styrene), 4% IN TOLUENE, 4/11/88				



File: PS_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 4/5/1988
Region: 4	Resolution: 2	Scans, Time: 710	Time/Point: 200	Operator: DGC
Description: FILM FROM 4% PS IN TOLUENE, 2/11/88; TAKEOFF ANG=0 Poly Styrene film (from 4% in toluene soln)				



Poly - Tetra Fluoro Ethylene (PTFE)

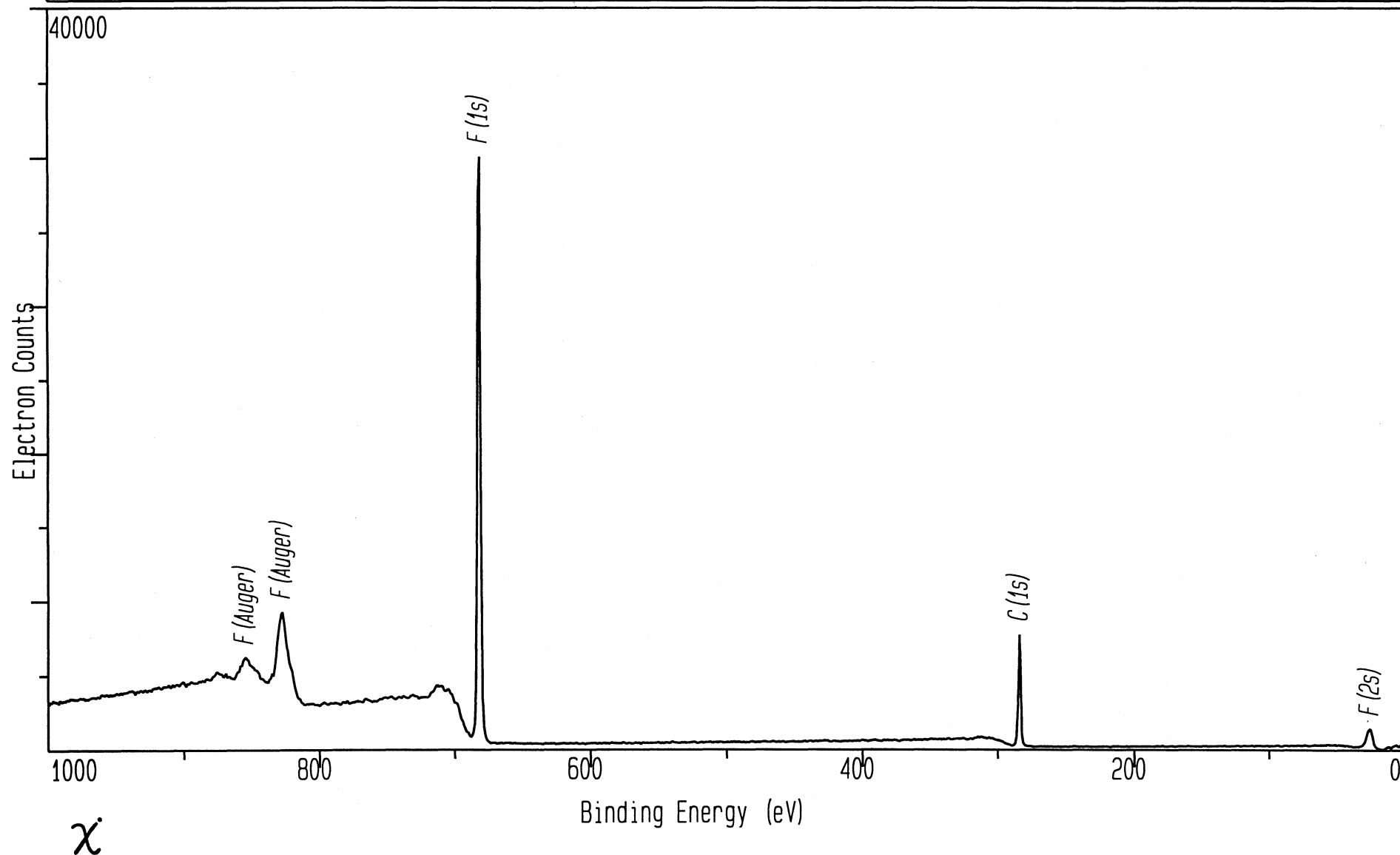
Detailed Surface Composition Table

File name: PTFE_SU.MRS
Region: 5
Description: Poly Tetrafluoro ethylene, STANDARD, CLEANED
12/1/89
Operator: DGC
Date: Tue Dec 26 1989

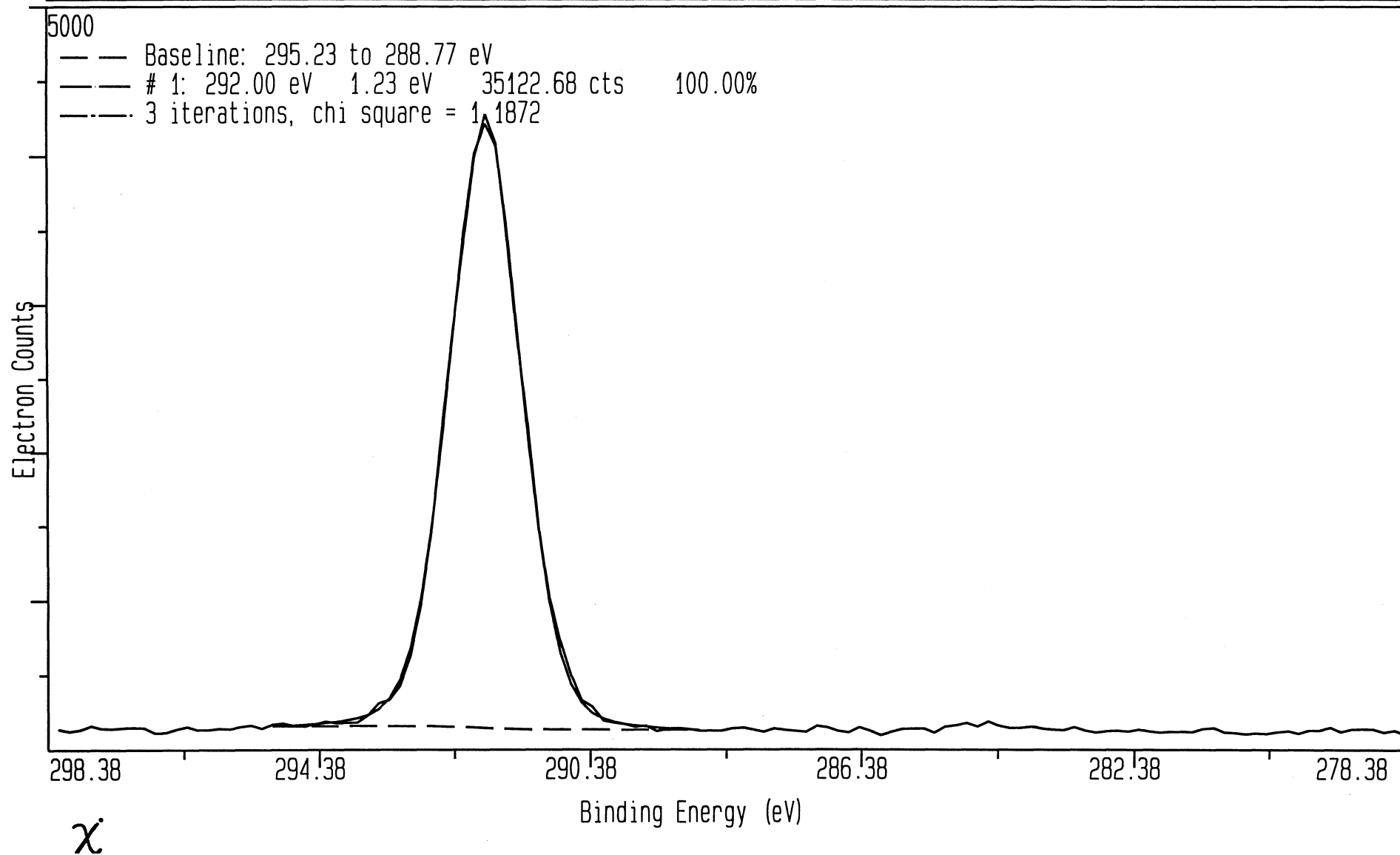
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
F Auger	859.3	854.3	0.00	33917	0	
F Auger	832.1	827.1	0.00	101423	0	
* F 1s	686.4	681.4	3.35	221228	66107	66.83
* C 1s	288.6	283.6	1.00	32826	32808	33.17
F 2s	30.8	25.8	0.24	14717	61139	

X

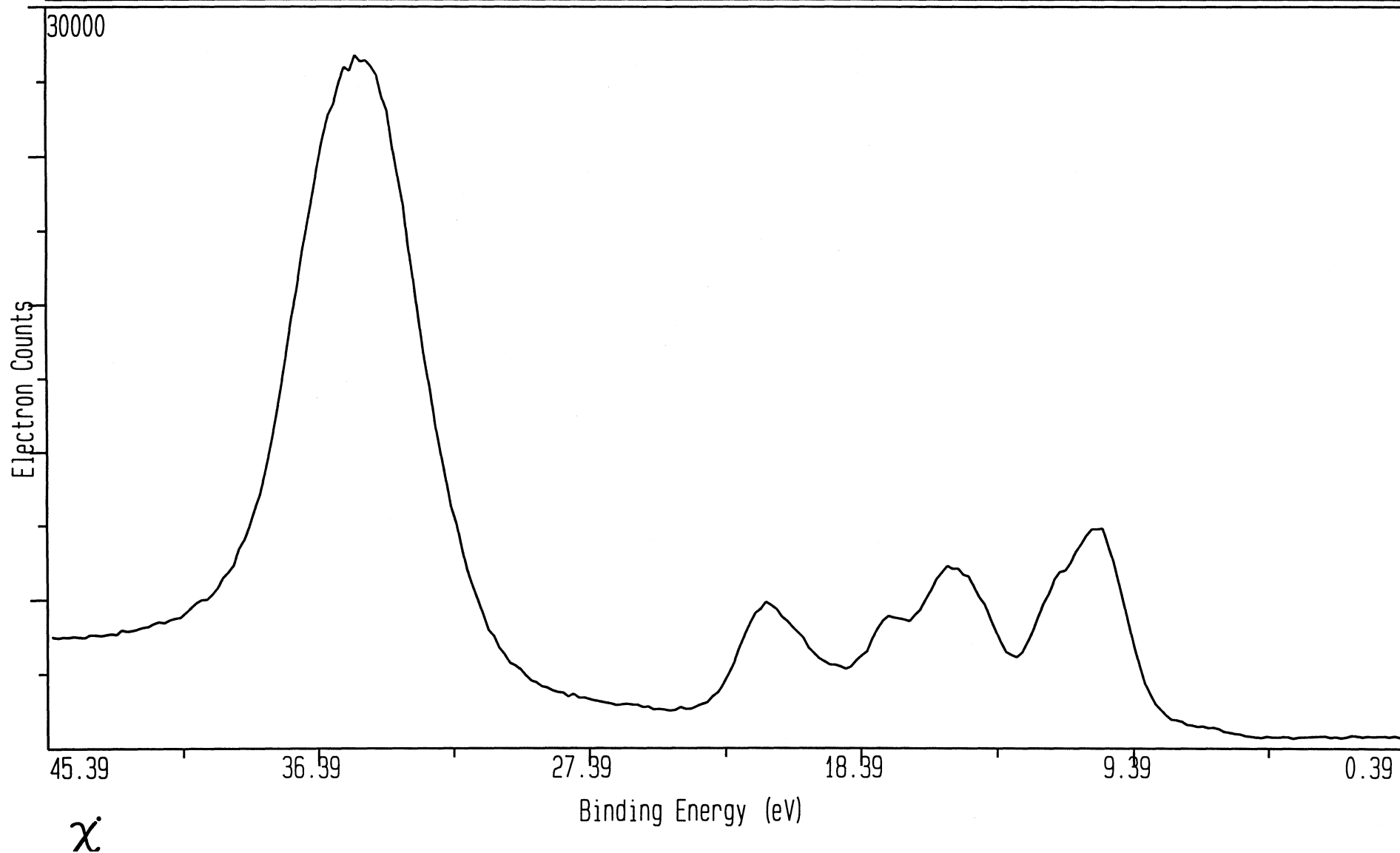
File: PTFE_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 12/26/1989
Region: 5	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: Poly Tetrafluoro ethylene STANDARD, CLEANED 12/1/89				



File: PTFE_C	Spot: 600	Flood Gun: 5.0	Data Points: 128	Date: 12/26/1989
Region: 4	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: Poly Tetra fluoro ethylene STANDARD, CLEANED 2/2/89				



File: PTFE_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 8/21/1988
Region: 3	Resolution: 2	Scans, Time: 200	Time/Point: 200	Operator: MJS
Description: PTFE VB STUDY; OPEN AP; T.O. ANG=ZERO DEGREES PTFE = Poly Tetra Fluoro Ethylene				



Poly - Tetra Methylene Glycol (cast from CHCl₃)

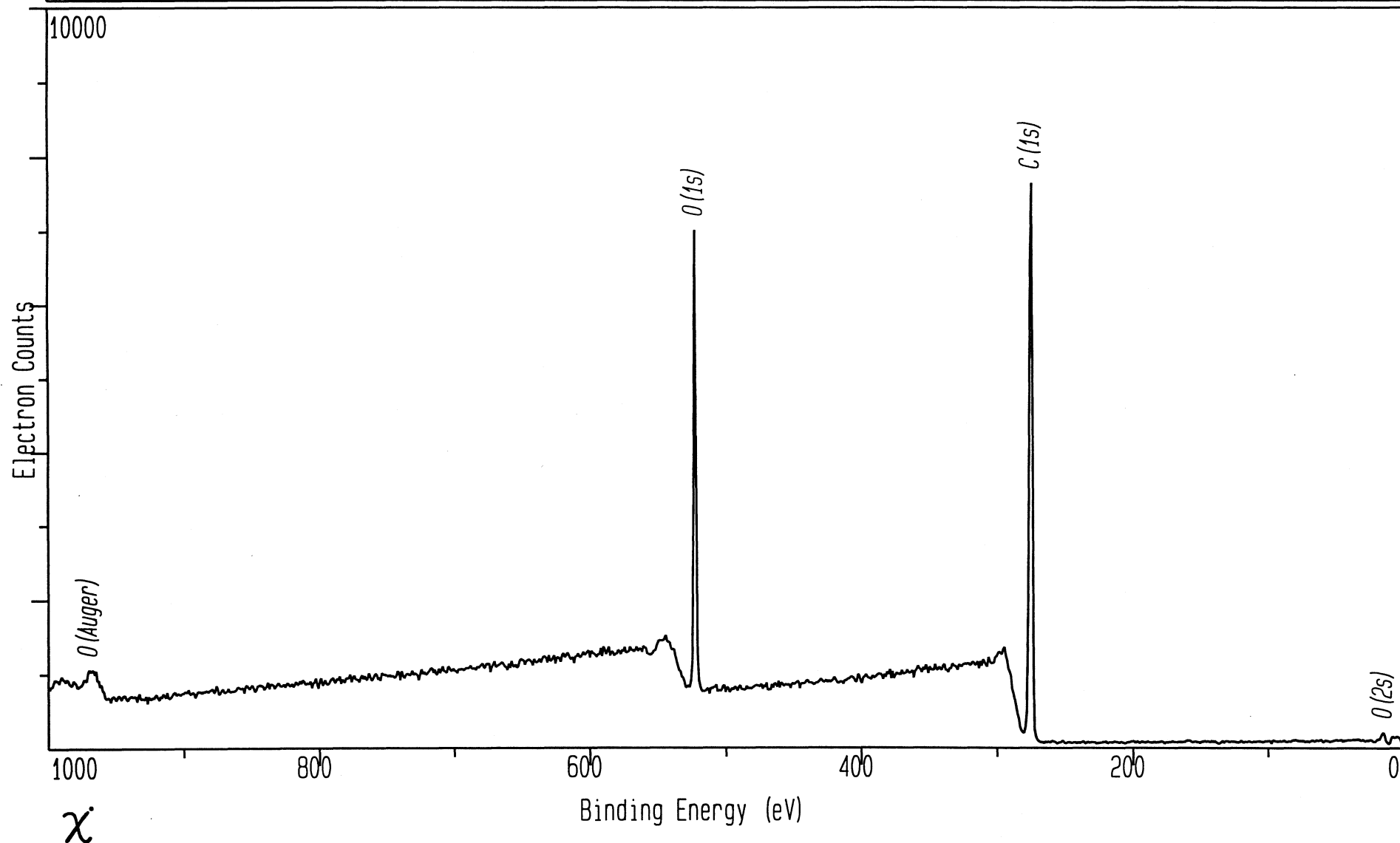
Detailed Surface Composition Table

File name: PTMG_SU.MRS
Region: 1
Description: PTMG-2000, CAST FROM CHCl₃, 8/2/88, TOA = 0
PTMG = Poly tetra methylene glycol
Operator: DGC
Date: Tue Aug 2 1988

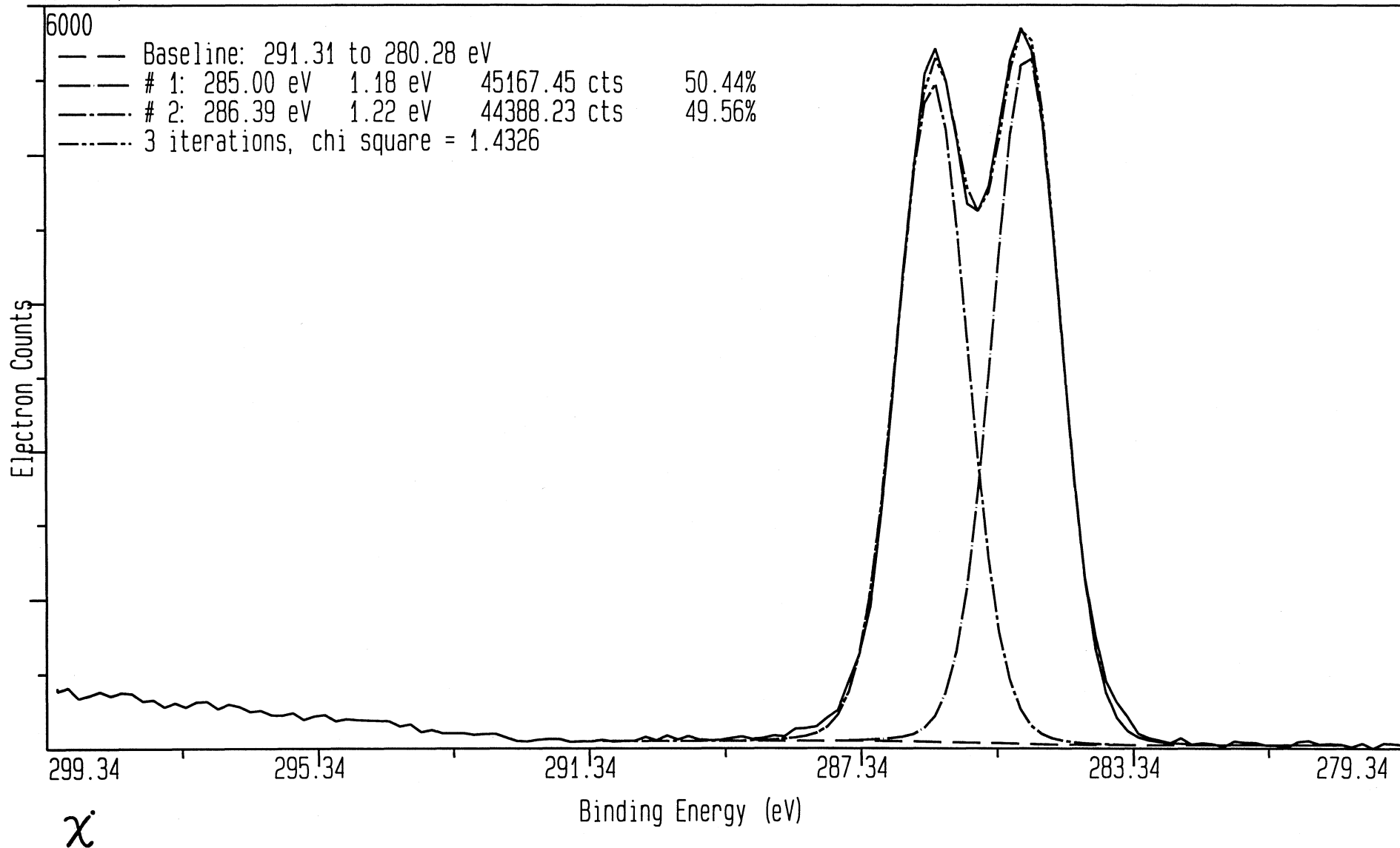
<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
O Auger	974.7	969.7	0.00	2001	0	
* O 1s	527.5	522.5	2.51	16246	6470	19.08
* C 1s	280.1	275.1	1.01	27592	27441	80.92
O 2s	19.8	14.8	0.16	635	3935	

X

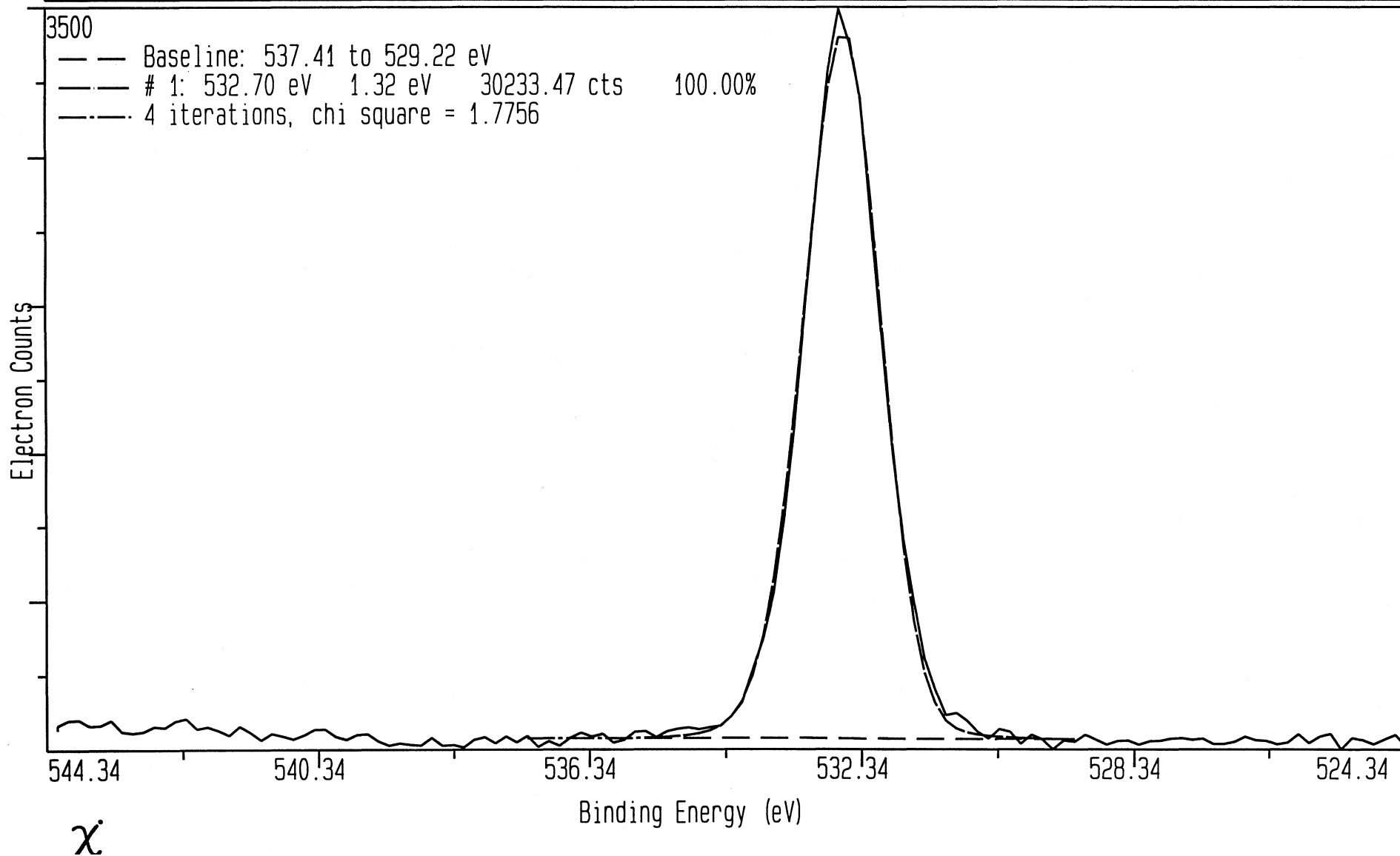
File: PTMG_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 8/2/1988
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: DGC
Description: PTMG-2000, CAST FROM CHCl ₃ , 8/2/88, T.O. ANG = 0 PTMG = Poly tetra methylene glycol				



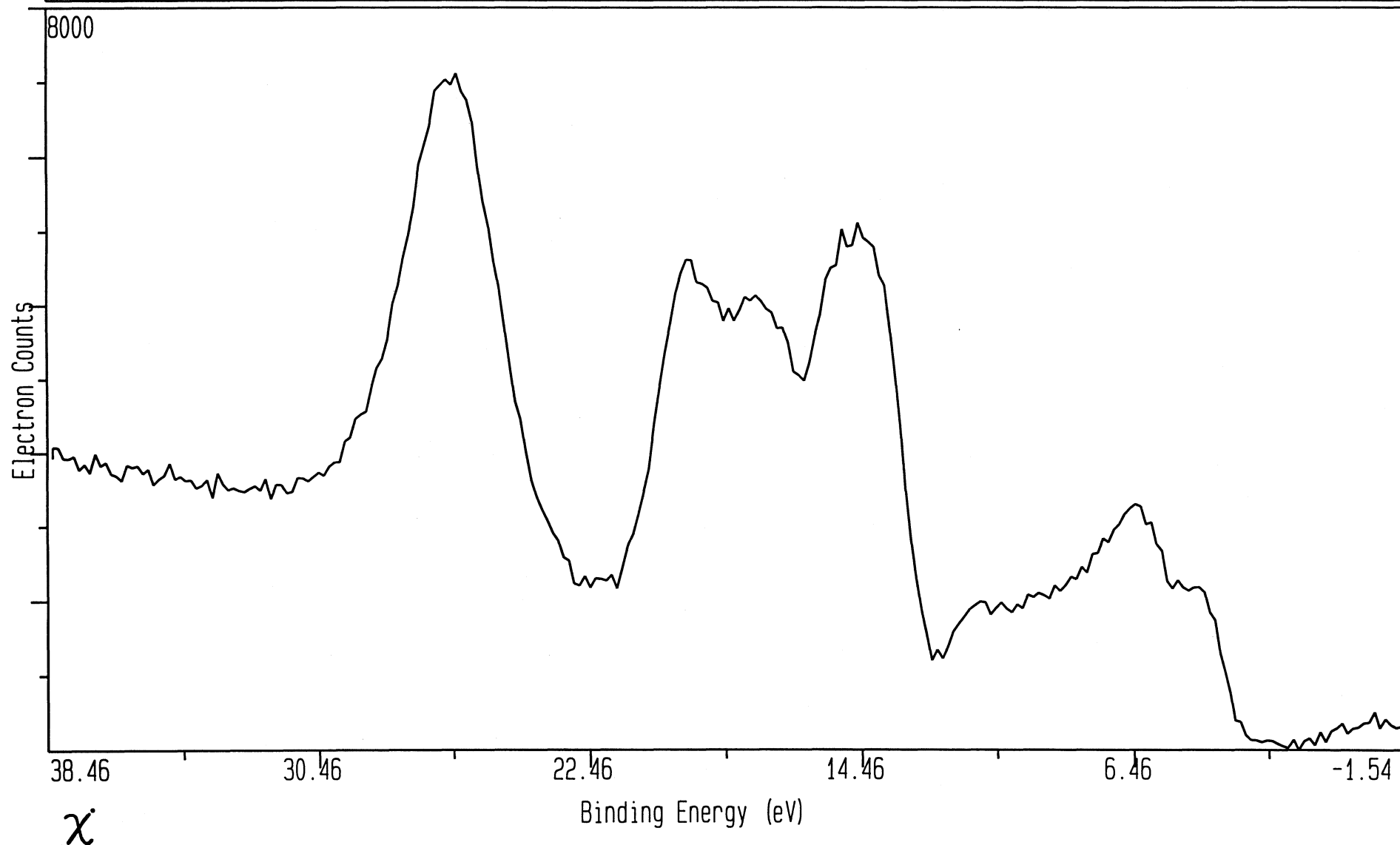
File: PTMG_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 8/2/1988
Region: 2	Resolution: 1	Scans, Time: 40	Time/Point: 200	Operator: DGC
Description: PTMG-2000, CAST FROM CHCl ₃ , 8/2/88, T.O. ANG = 0 PTMG = Poly tetra methylene glycol				



File: PTMG_0	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 8/2/1988
Region: 3	Resolution: 1	Scans, Time: 20	Time/Point: 200	Operator: DGC
Description: PTMG-2000, CAST FROM CHCl ₃ , 8/2/88, T.O. ANG = 0 PTMG = Poly tetra methylene glycol				



File: PTMG_VB	Spot: 1000	Flood Gun: 5.0	Data Points: 256	Date: 8/2/1988
Region: 7	Resolution: 2	Scans, Time: 680	Time/Point: 200	Operator: DGC
Description: PTMG-2000, CAST FROM CHCl ₃ , 8/2/88, T.O. ANG = 0 PTMG = Poly tetra methylene glycol				



Poly - Vinyl Alcohol (2.5% H2O solution)

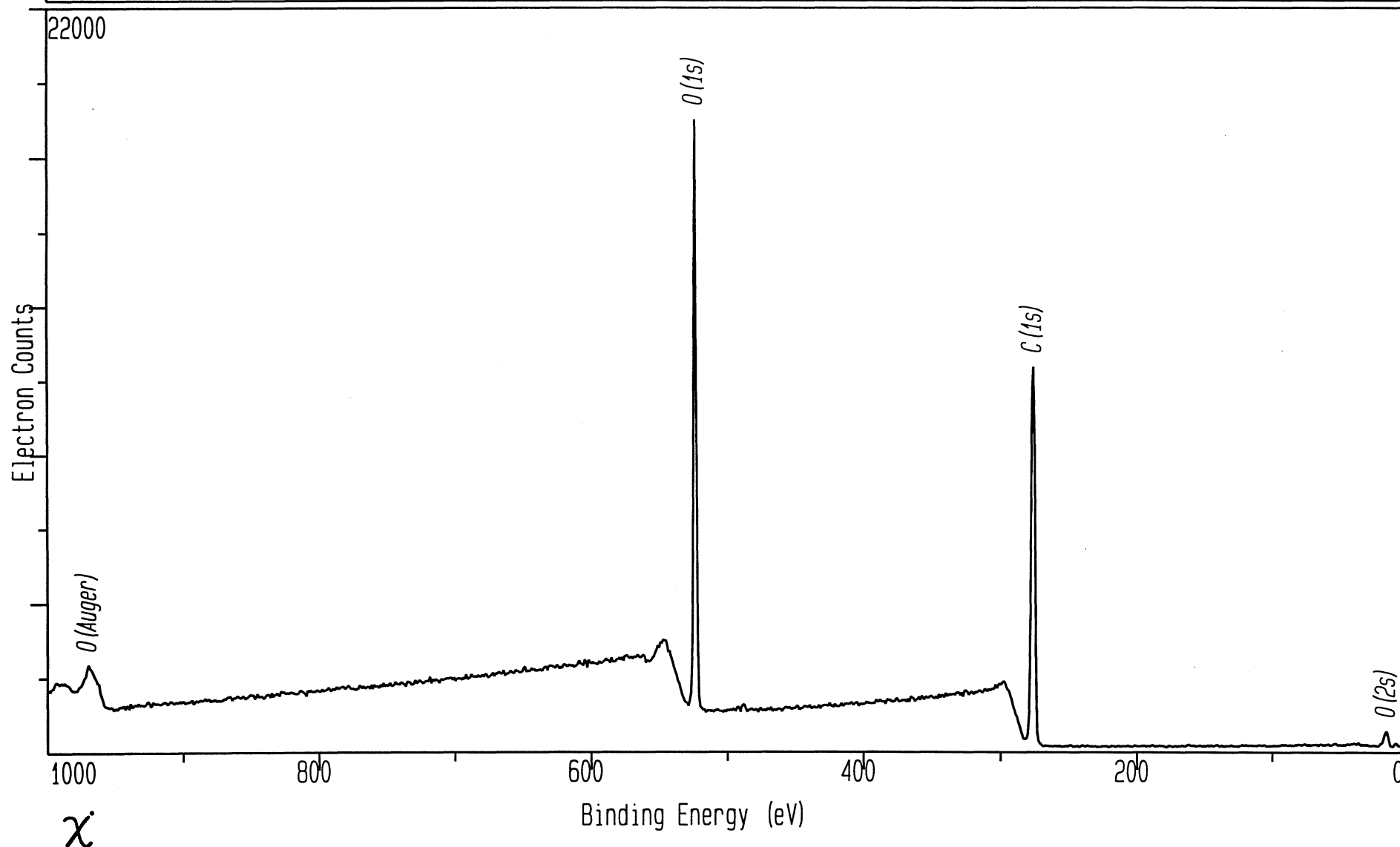
Detailed Surface Composition Table

File name: PVA_SU.MRS
Region: 1
Description: PVA-2.5% H2O SOLN, 12/28/88
PVA = Poly vinyl alcohol
Operator: DGC
Date: Wed Dec 28 1988

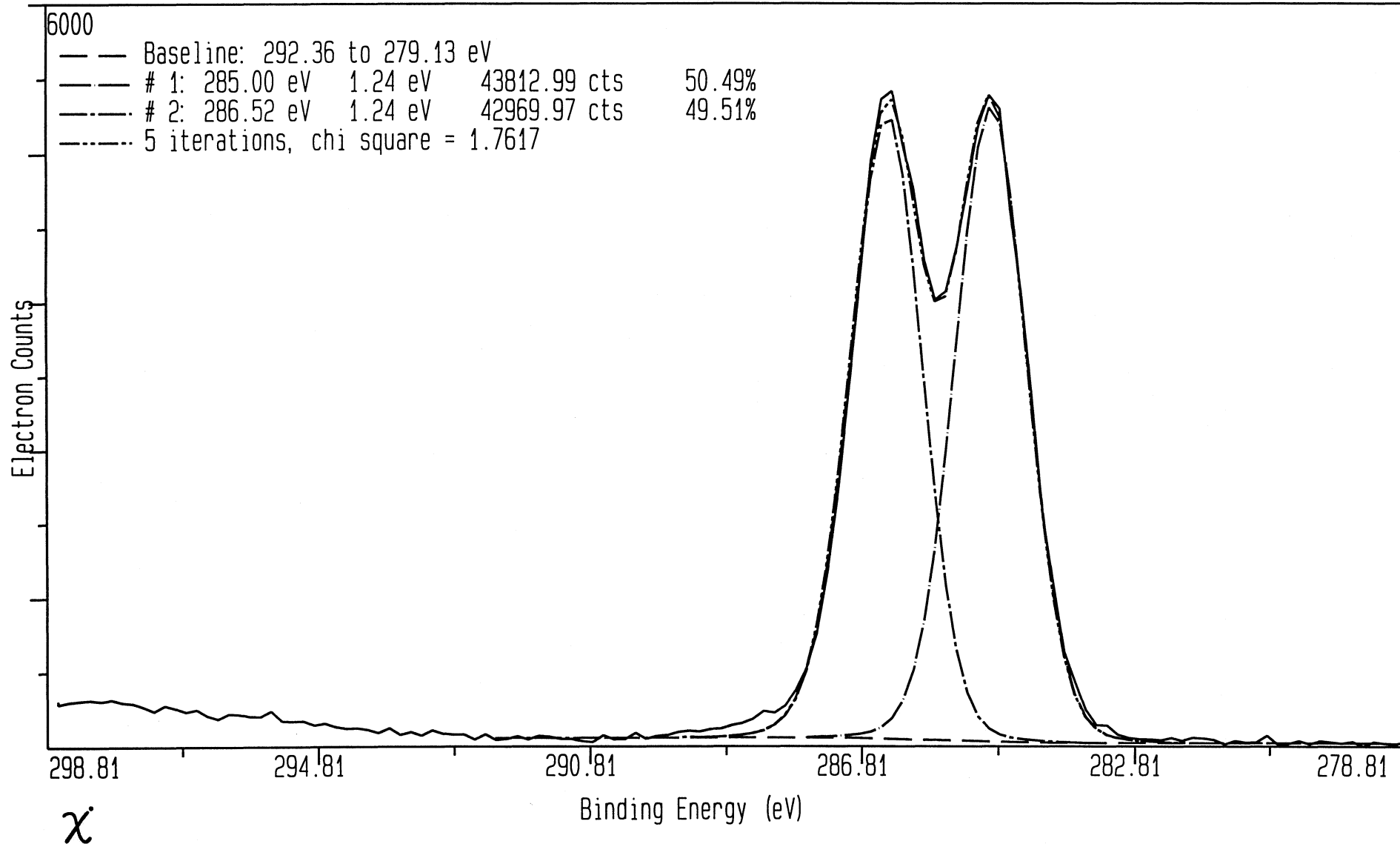
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
O Auger	974.6	969.6	0.00	26387	0	
* O 1s	528.4	523.4	2.51	101181	40324	30.52
* C 1s	281.1	276.1	1.00	92244	91792	69.48
O 2s	20.9	15.9	0.16	5443	33757	

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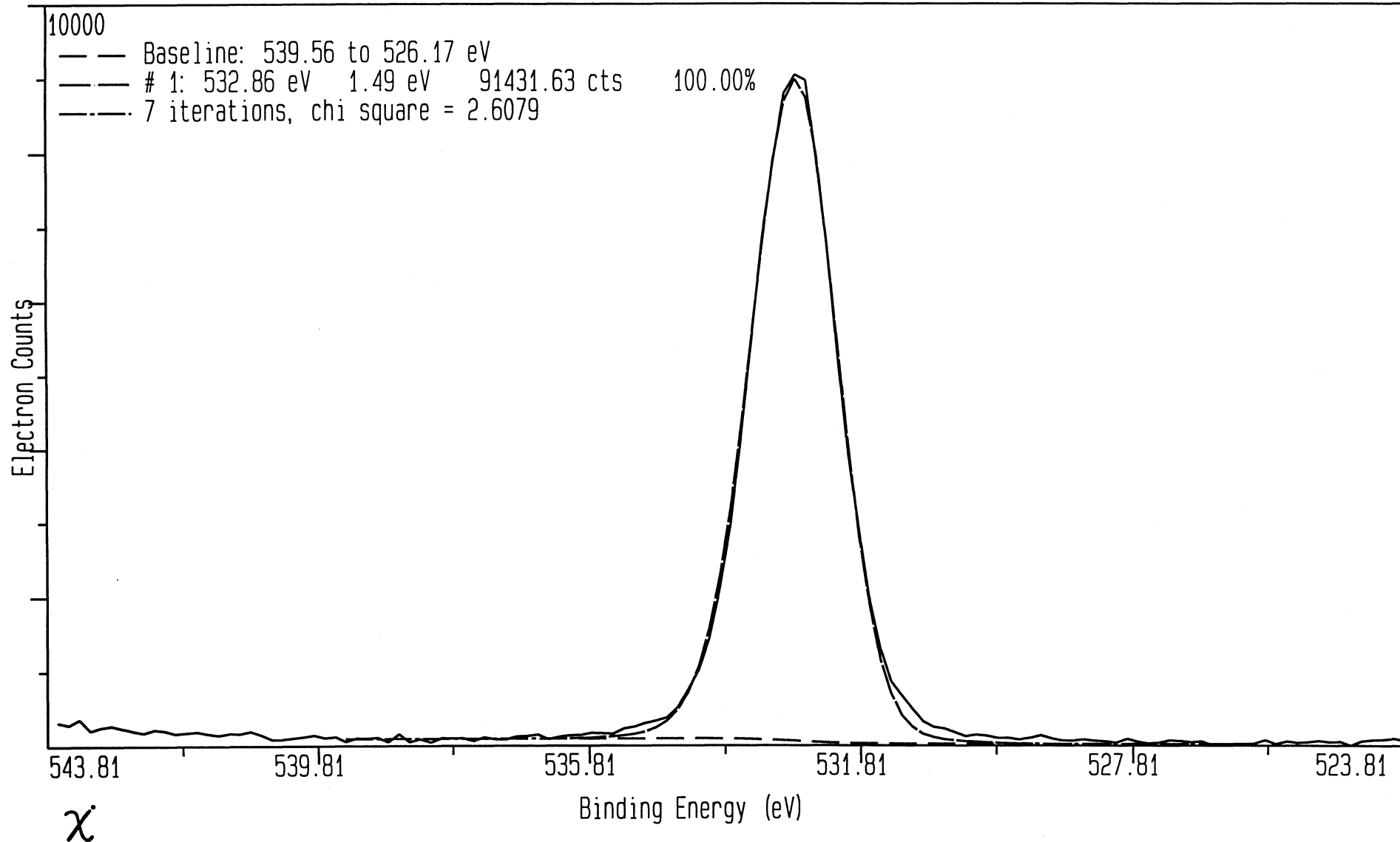
File: PVA_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 12/28/1988
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: DGC
Description: PVA-2.5% H2O SOLN, 12/28/88, OP AP, TOA=0 PVA = Poly vinyl alcohol				



File: PVA_C	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 12/28/1988
Region: 2	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: DGC
Description: PVA-2.5% H2O SOLN, 12/28/88, OP AP, TOA=0 PVA = Poly vinyl alcohol				



File: PVA_0	Spot: 300	Flood Gun: 5.0	Data Points: 128	Date: 12/28/1988
Region: 3	Resolution: 1	Scans, Time: 20	Time/Point: 200	Operator: DGC
Description: PVA-2.5% H2O SOLN, 12/28/88, OP AP, TOA=0 PVA = Poly vinyl alcohol				



Poly - Vinyl Chloride

Detailed Surface Composition Table

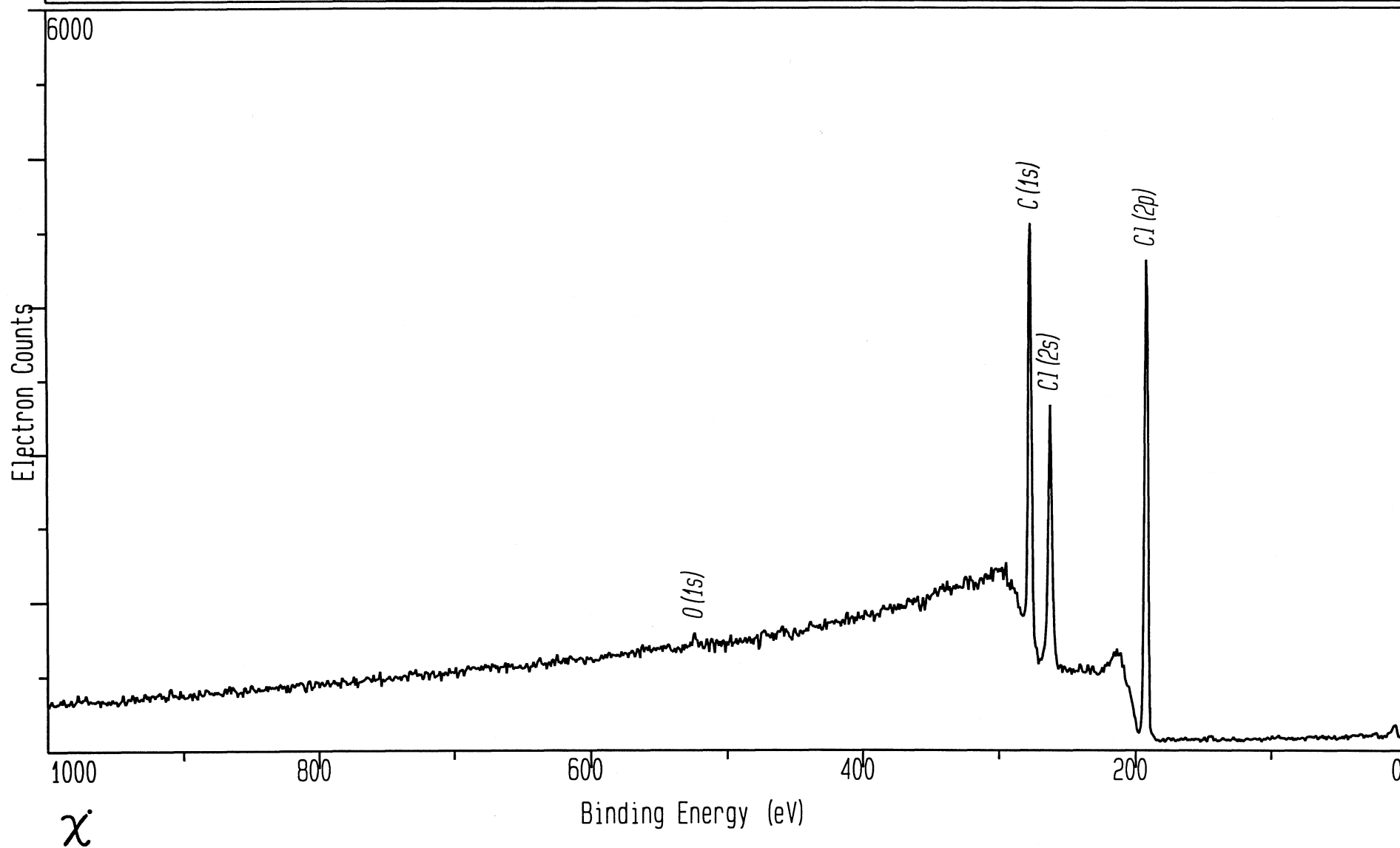
File name: PVC_SU.MRS
Region: 1
Description: Poly Vinyl Chloride (PVC)

Operator: MRR
Date: Tue Oct 10 1989

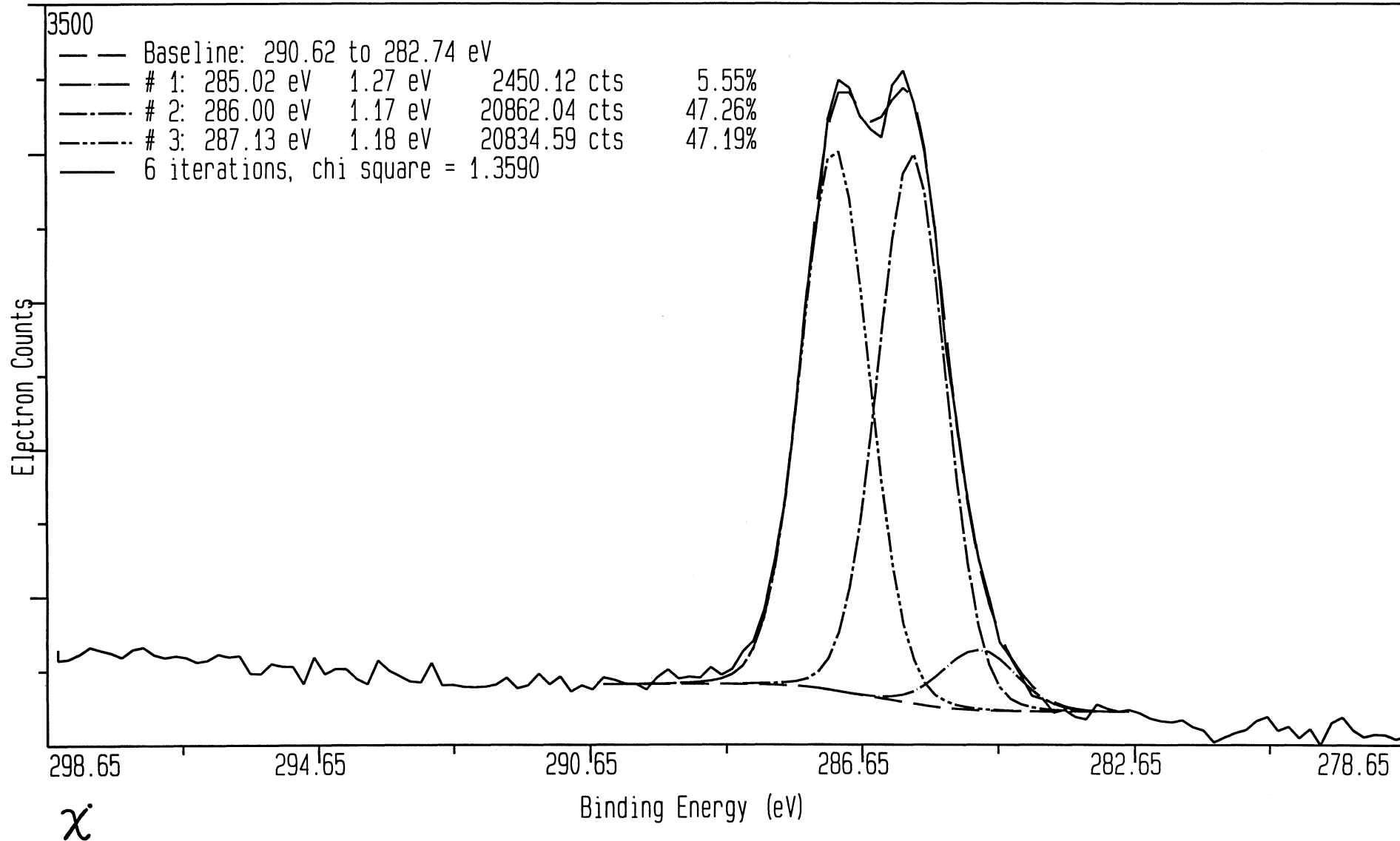
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom %</u>
* O 1s	528.9	523.9	2.51	542	216	0.57
* C 1s	282.3	277.3	1.00	25231	25124	66.07
Cl2s	267.3	262.3	1.71	18571	10848	
* Cl2p	196.5	191.5	2.41	30546	12688	33.36

X

File: PVC_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 10/10/1989
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: MRR
Description: Poly Vinyl Chloride (PVC)				



File: PVC_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 7/15/1989
Region: 4	Resolution: 1	Scans, Time: 30	Time/Point: 200	Operator: MRR
Description: Poly Vinyl Chloride (PVC) VISC=.55				



Poly - Vinylidene Di-Fluoride (old)

Detailed Surface Composition Table

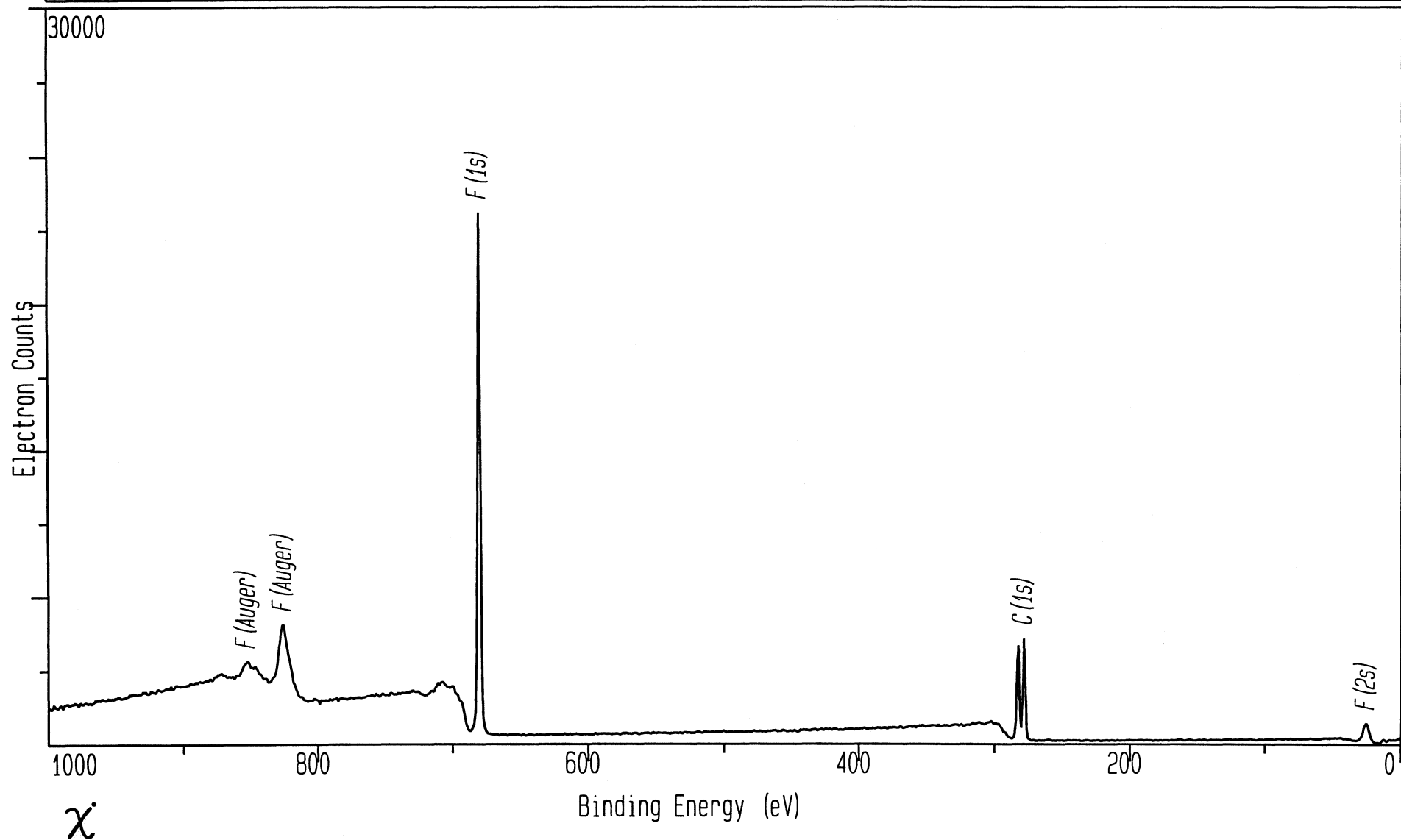
File name: PVDF_SU.MRS
Region: 1
Description: Poly Vinylidene di-fluoride (PVDF) old

Operator:
Date: Wed Jan 11 1989

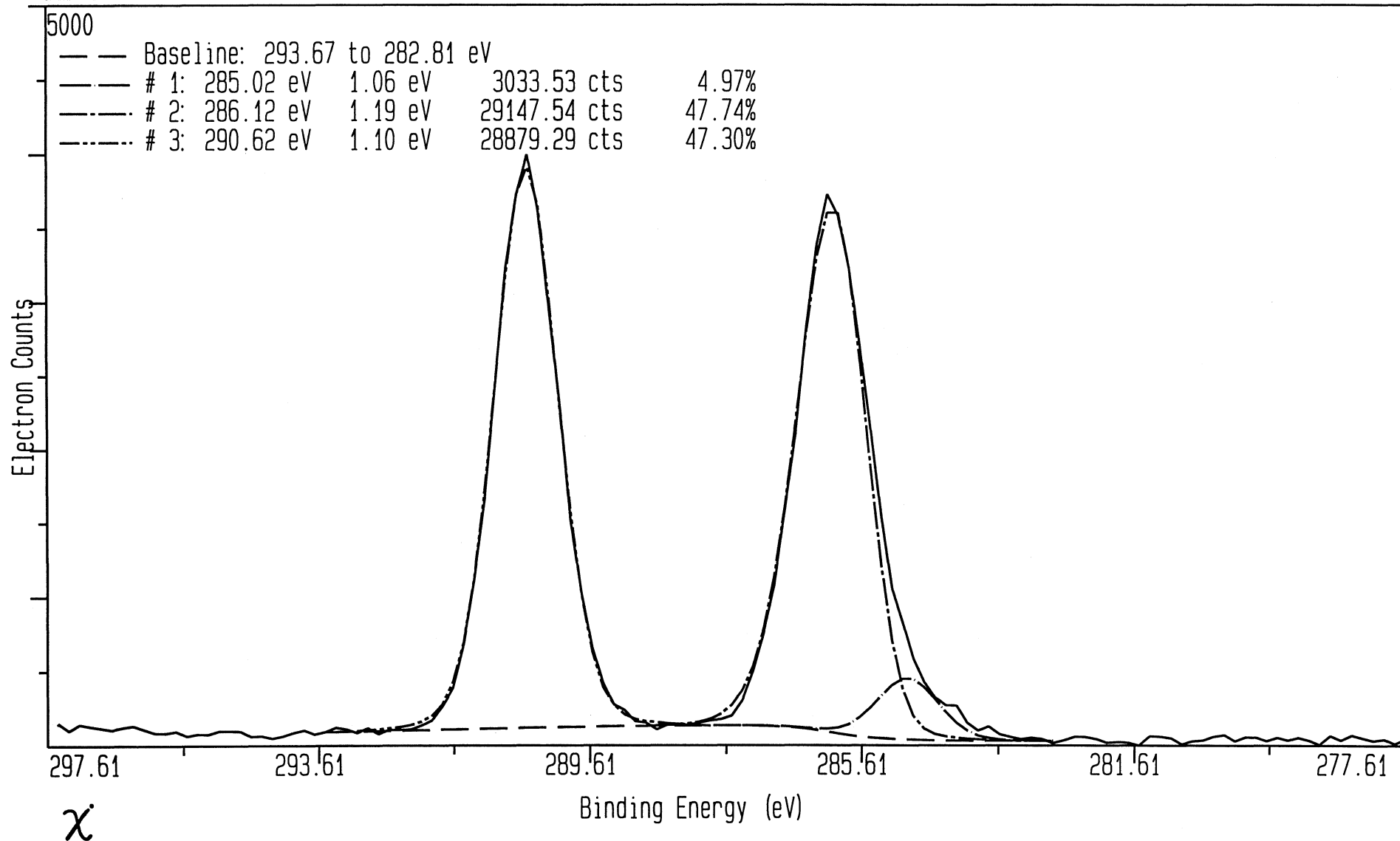
<u>Signal</u>	<u>Corrected</u>	<u>Exper.</u>	<u>Sens</u>	<u>Norm</u>	<u>Relative</u>	
	<u>BE</u>	<u>BE</u>	<u>Factor</u>	<u>Area</u>	<u>Area</u>	<u>Atom %</u>
F Auger	856.9	851.9	0.00	22076	0	
F Auger	830.3	825.3	0.00	57868	0	
* F 1s	685.0	680.0	3.35	133577	39866	47.33
* C 1s	282.8	277.8	1.00	44537	44361	52.67
F 2s	29.4	24.4	0.24	9903	41114	

X

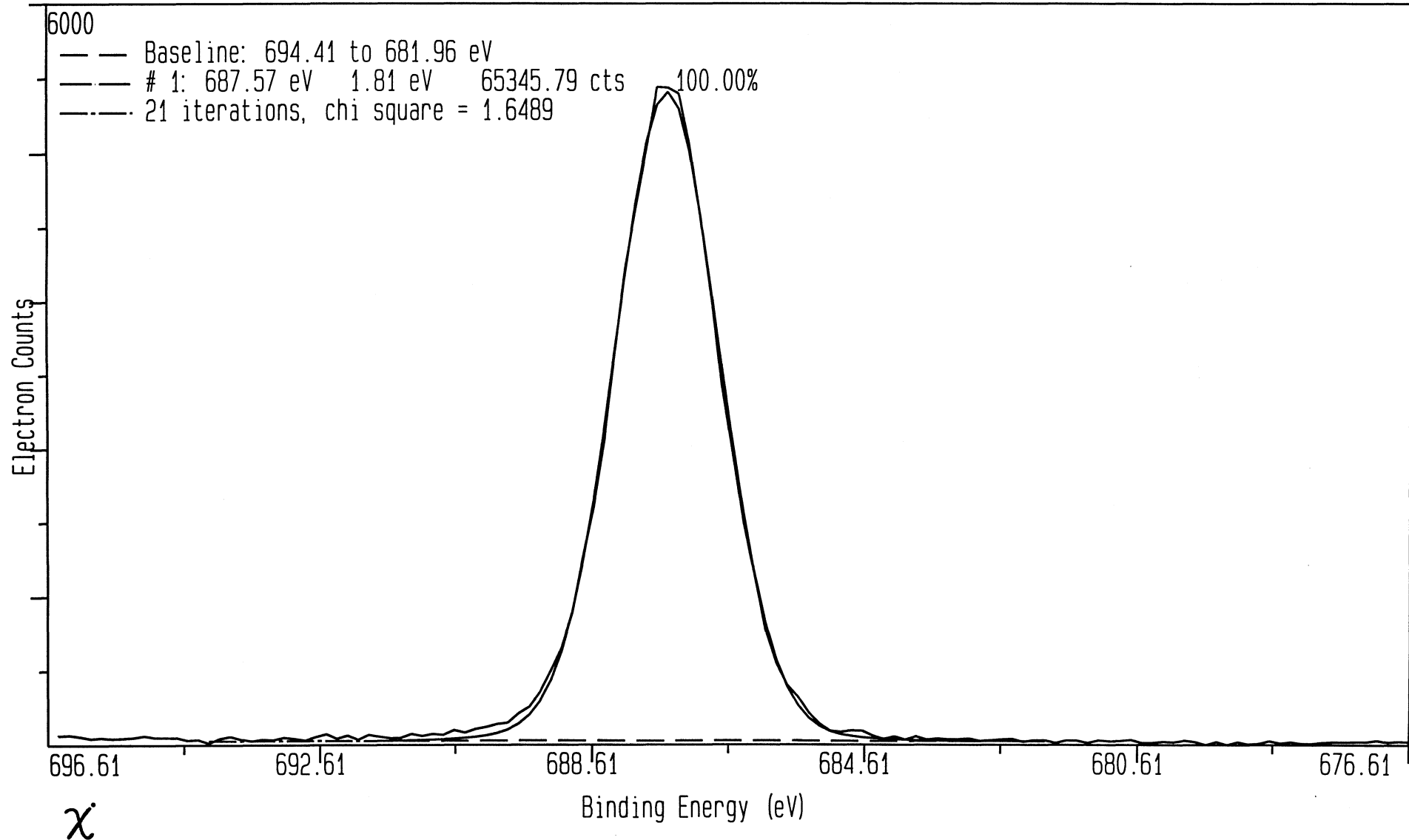
File: PVDF_SU	Spot: 1000	Flood Gun: 5.0	Data Points: 1024	Date: 1/11/1989
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator:
Description: Poly Vinylidene di-fluoride (PVDF) old				



File: PVDF_C	Spot: 1000	Flood Gun: 5.0	Data Points: 128	Date: 2/21/1991
Region: 2	Resolution: 1	Scans, Time: 40	Time/Point: 200	Operator: DGC
Description: PVDF, CAST on 12mm GLASS; 2 x 4% in DMAC PVDF = Poly Vinylidene Di-Fluoride				



File: PVDF_F Region: 4	Spot: 1000 Resolution: 1	Flood Gun: 5.0 Scans, Time: 10	Data Points: 128 Time/Point: 200	Date: 2/21/1991 Operator: DGC
Description: PVDF, CAST on 12mm GLASS; 2 x 4% in DMAC PVDF = Poly Vinylidene di-fluoride				



Poly – Tetra-fluoro ethylene (Teflon™)

Detailed Surface Composition Table

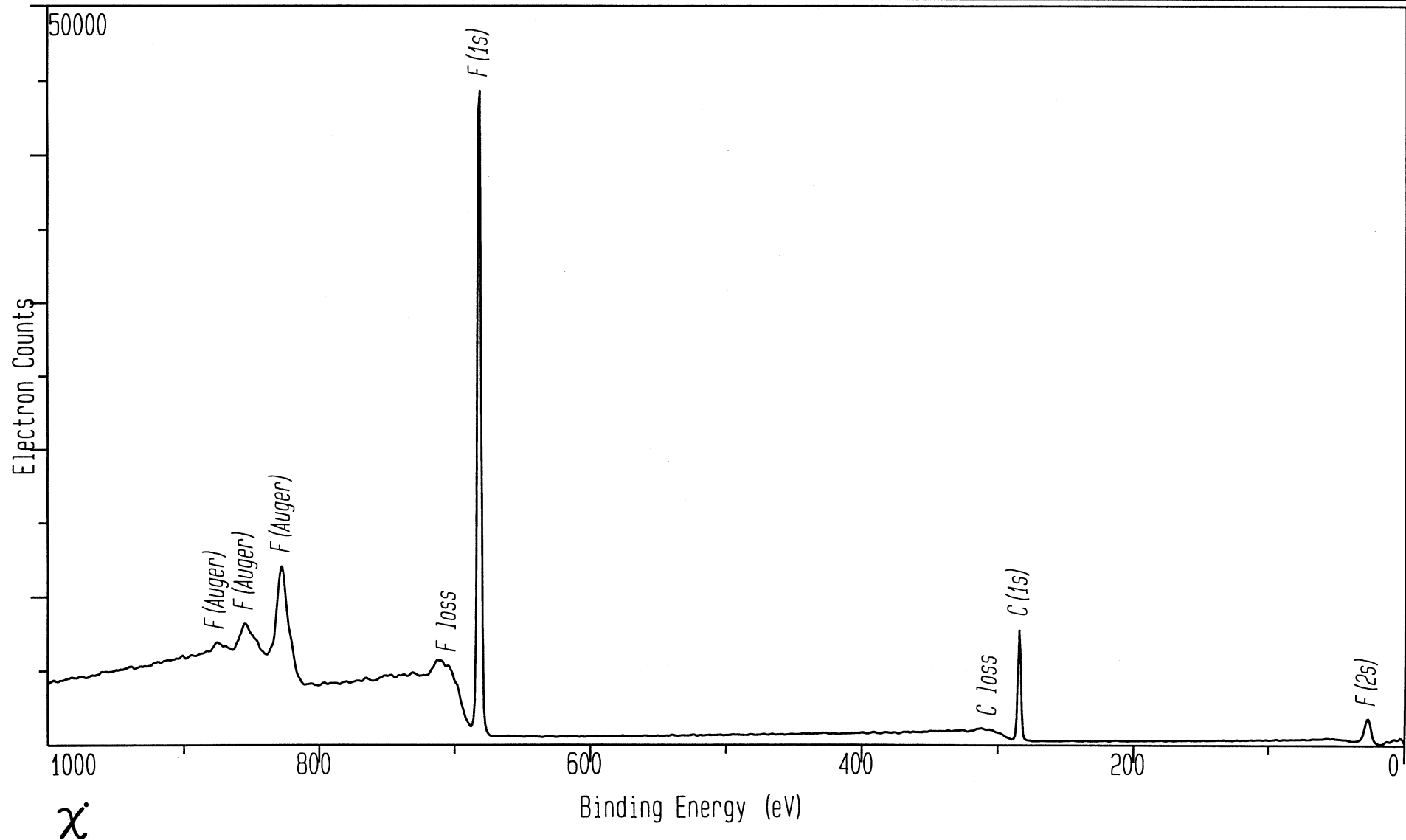
File name: TEFLON3.MRS
Region: 1
Description: POLY-TETRA-FLUORO ETHYLENE (TEFLON) (FILM ON TAPE)

Operator: BVC
Date: Thu Feb 3 14:23 1988

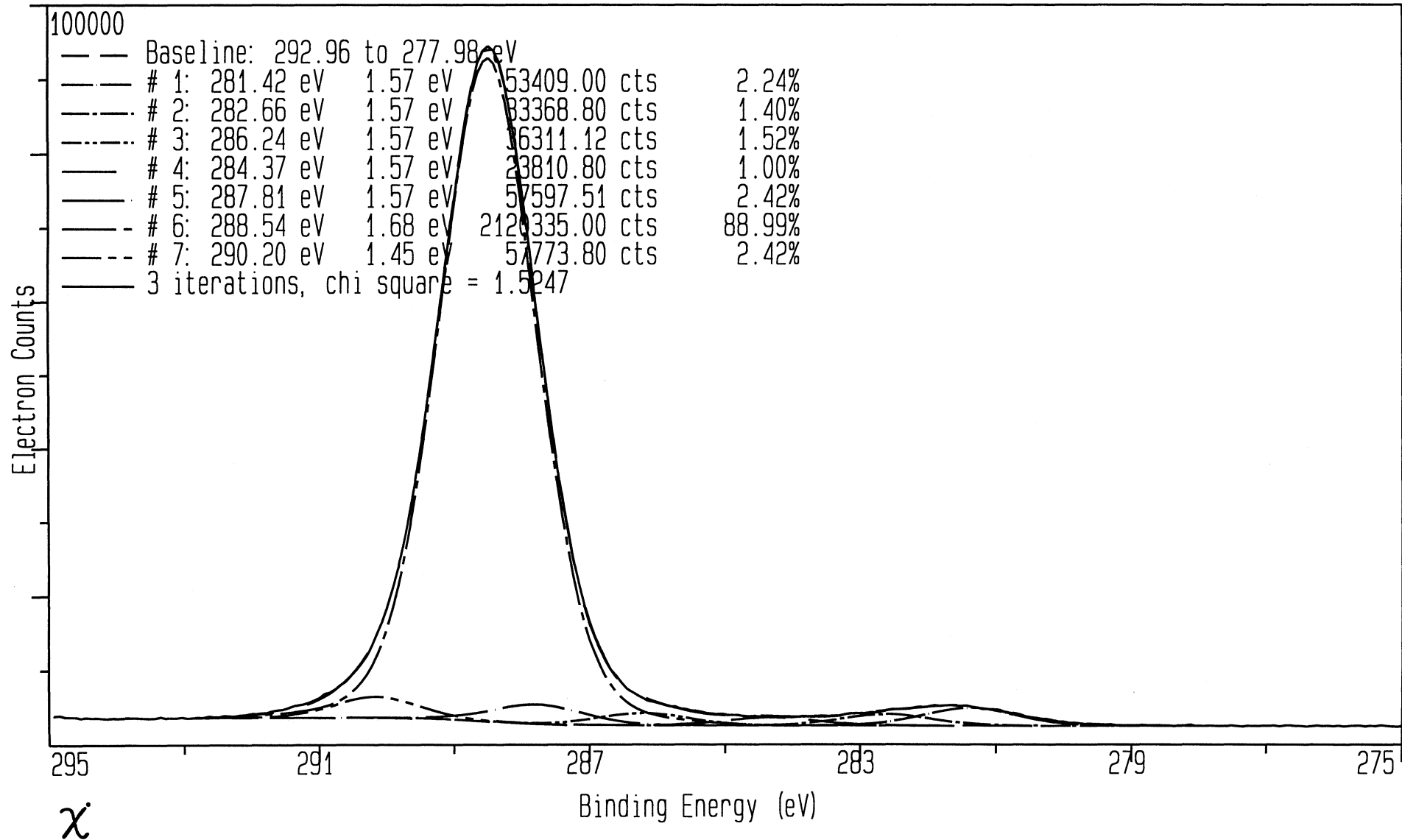
<u>Signal</u>	<u>Corrected</u> <u>BE</u>	<u>Exper.</u> <u>BE</u>	<u>Sens</u> <u>Factor</u>	<u>Norm</u> <u>Area</u>	<u>Relative</u> <u>Area</u>	<u>Atom</u> %
F Auger	876.6	875.2	0.09	2924	31340	
F Auger	855.7	854.3	0.00	21635	0	
F Auger	828.6	827.2	0.00	66725	0	
F loss	705.9	704.6	0.00	51542	0	
* F 1s	682.8	681.5	3.61	146871	40713	65.13
C loss	307.3	306.0	0.00	6148	0	
* C 1s	285.0	283.6	1.00	21821	21799	34.87
F 2s	27.4	26.0	0.27	9651	36376	

χ

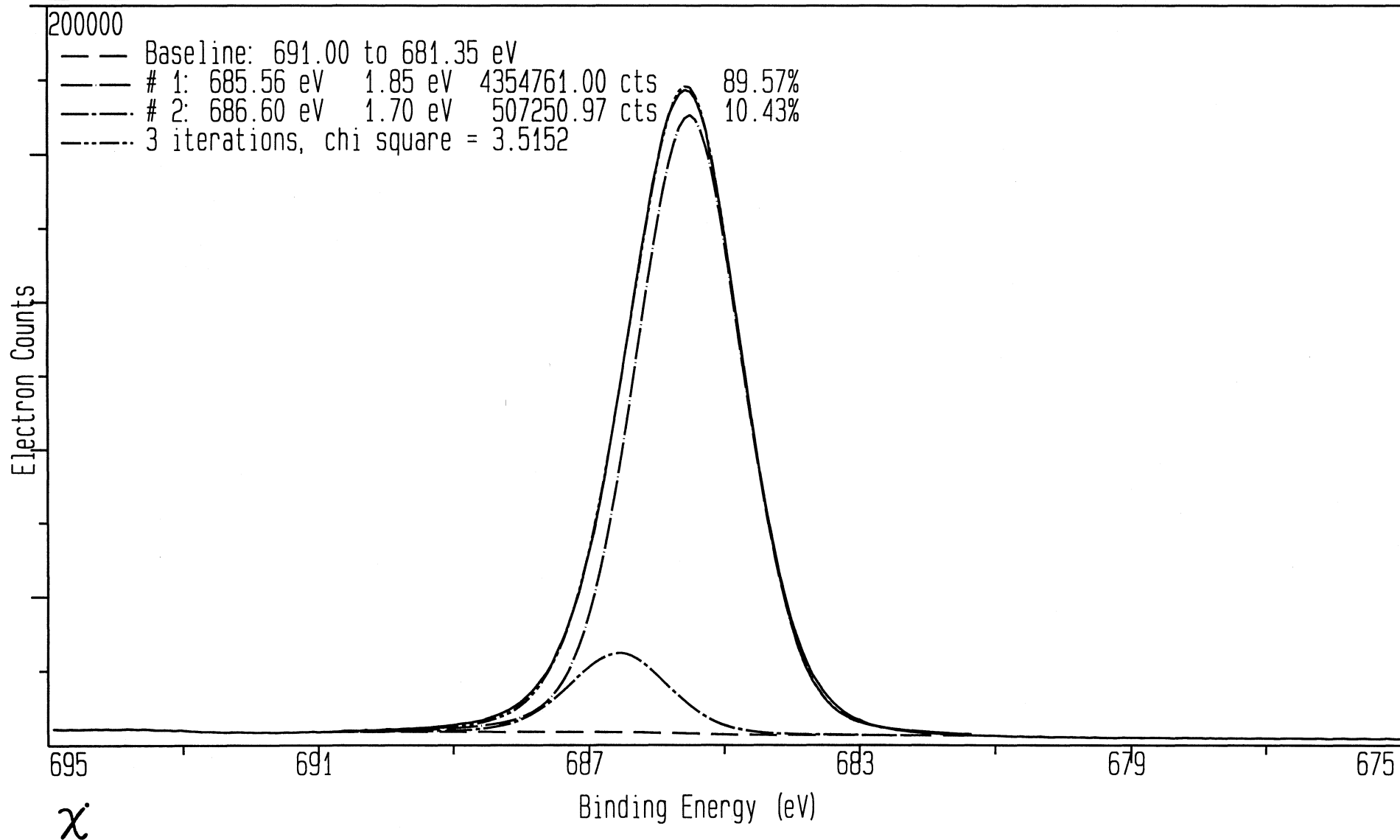
File: TEFLON3	Spot: 1000	Flood Gun: 4.0	Data Points: 1024	Date: 2/3/1988
Region: 1	Resolution: 4	Scans, Time: 5	Time/Point: 200	Operator: BVC
Sample Description: POLY-TETRA-FLUORO ETHYLENE (TEFLON) (FILM ON TAPE) (null)				



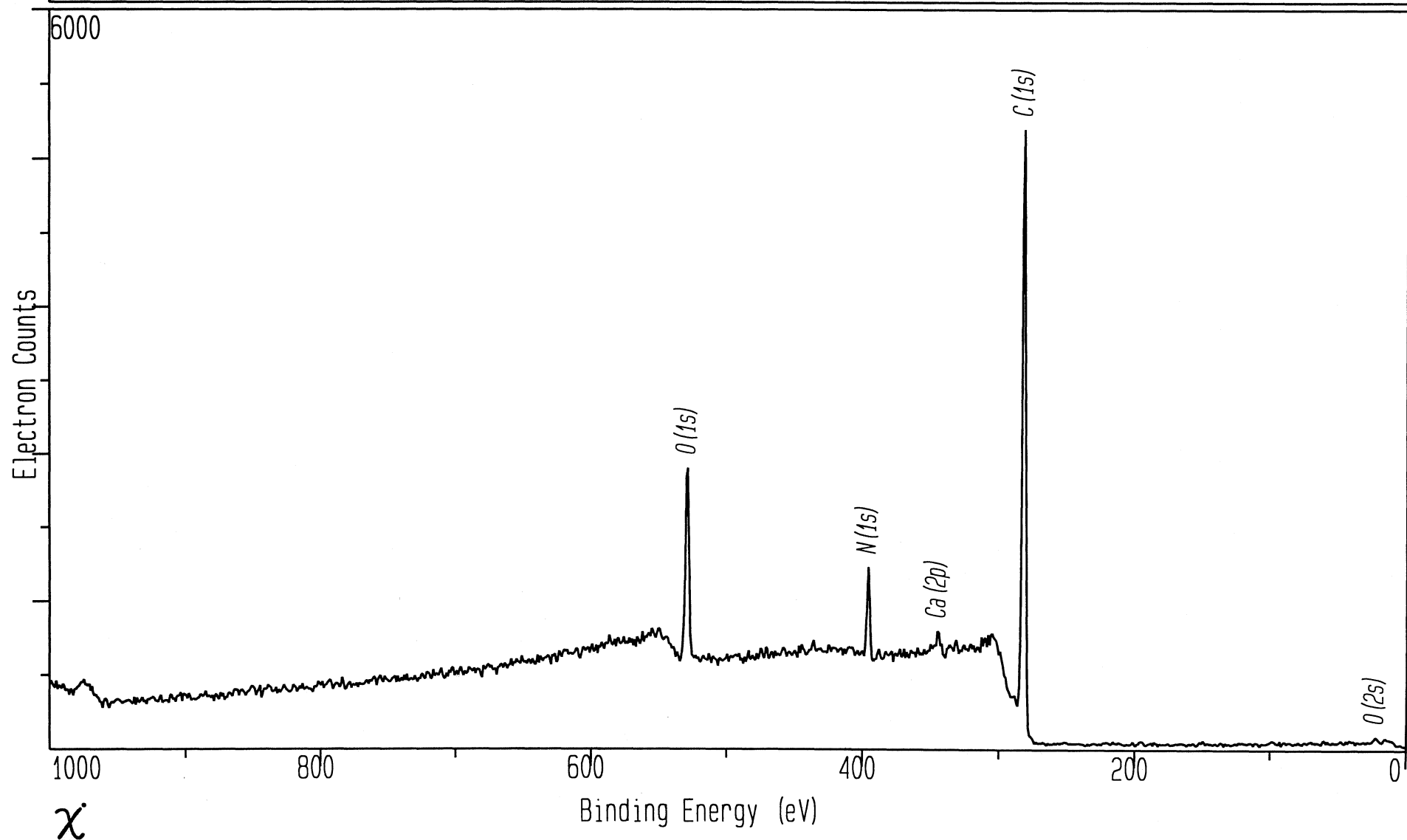
File: TEFLON	Spot: 1000	Flood Gun: 4.0	Data Points: 256	Date: 2/2/1988
Region: 2	Resolution: 2	Scans, Time: 80	Time/Point: 200	Operator: BVC
Description: POLY-TETRA-FLUORO ETHYLENE (TEFLON) (FILM ON TAPE) X-RAY DAMAGE STUDY, SOURCE: ?, MESH AT 1MM, AS REC				



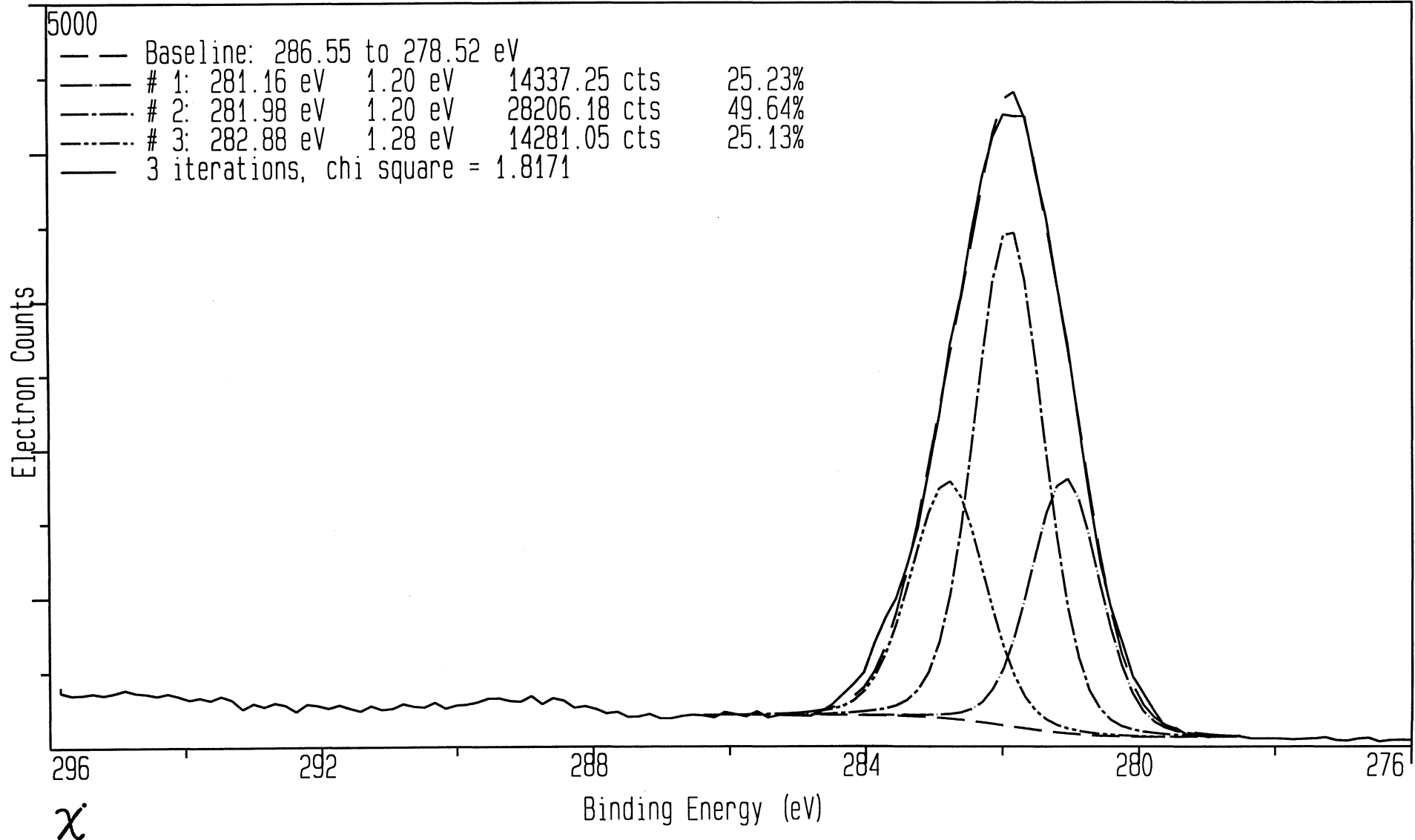
File: TEFLON	Spot: 1000	Flood Gun: 4.0	Data Points: 256	Date: 2/2/1988
Region: 1	Resolution: 2	Scans, Time: 20	Time/Point: 200	Operator: BVC
Description: POLY-TETRA-FLUORO ETHYLENE (TEFLON) (FILM ON TAPE) X-RAY DAMAGE STUDY, SOURCE: ?, MESH AT 1MM, AS REC				



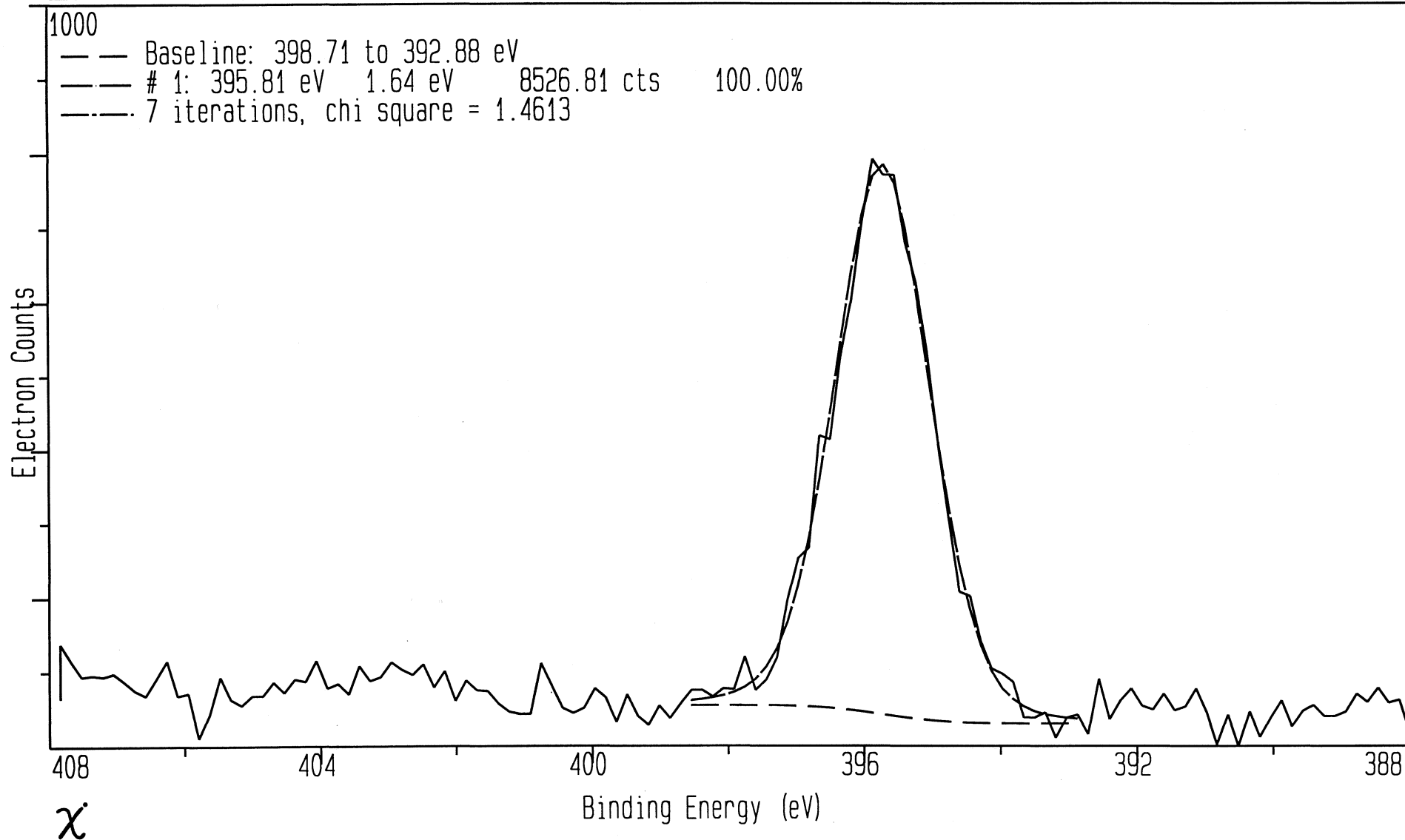
File: PVPYRIDN	Spot: 300	Flood Gun: 2.0	Data Points: 1024	Date: 10/19/1985
Region: 1	Resolution: 4	Scans, Time: 2	Time/Point: 200	Operator: BVC
Description: POLY-VINYLPYRIDINE (SINGLE BEAD, AS RECEIVED) unknown source, no mesh				



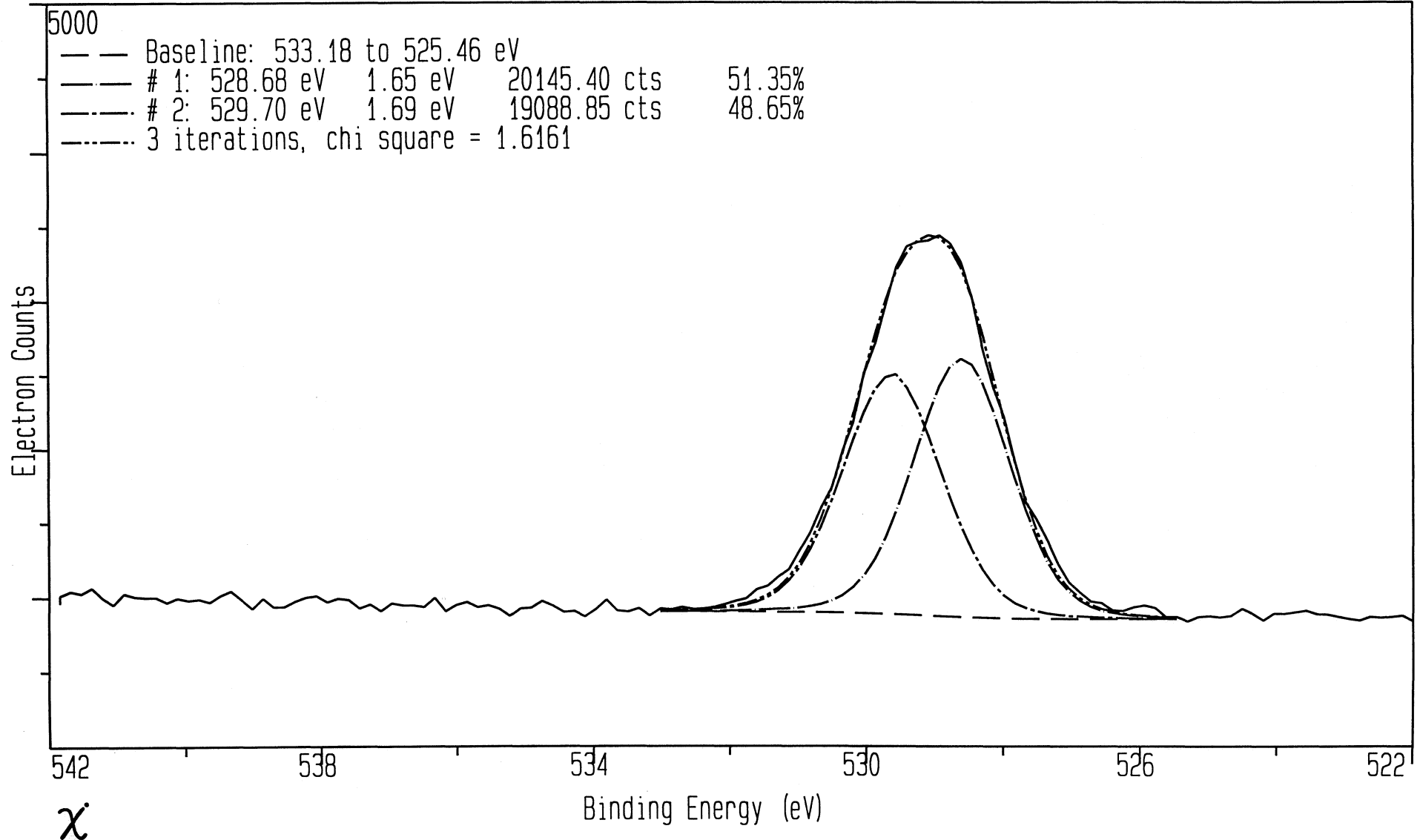
File: PVPYRIDN	Spot: 300	Flood Gun: 2.0	Data Points: 128	Date: 10/19/1985
Region: 3	Resolution: 2	Scans, Time: 6	Time/Point: 200	Operator: BVC
Description: POLY-VINYLPYRIDINE (SINGLE BEAD, AS RECEIVED) unknown source, no mesh				



File: PVPYRIDN	Spot: 300	Flood Gun: 2.0	Data Points: 128	Date: 10/19/1985
Region: 4	Resolution: 2	Scans, Time: 6	Time/Point: 200	Operator: BVC
Description: POLY-VINYLPYRIDINE (SINGLE BEAD, AS RECEIVED) unknown source, no mesh				



File: PVPYRIDN	Spot: 300	Flood Gun: 2.0	Data Points: 128	Date: 10/19/1985
Region: 5	Resolution: 2	Scans, Time: 10	Time/Point: 200	Operator: BVC
Description: POLY-VINYLPYRIDINE (SINGLE BEAD, AS RECEIVED) unknown source, no mesh				



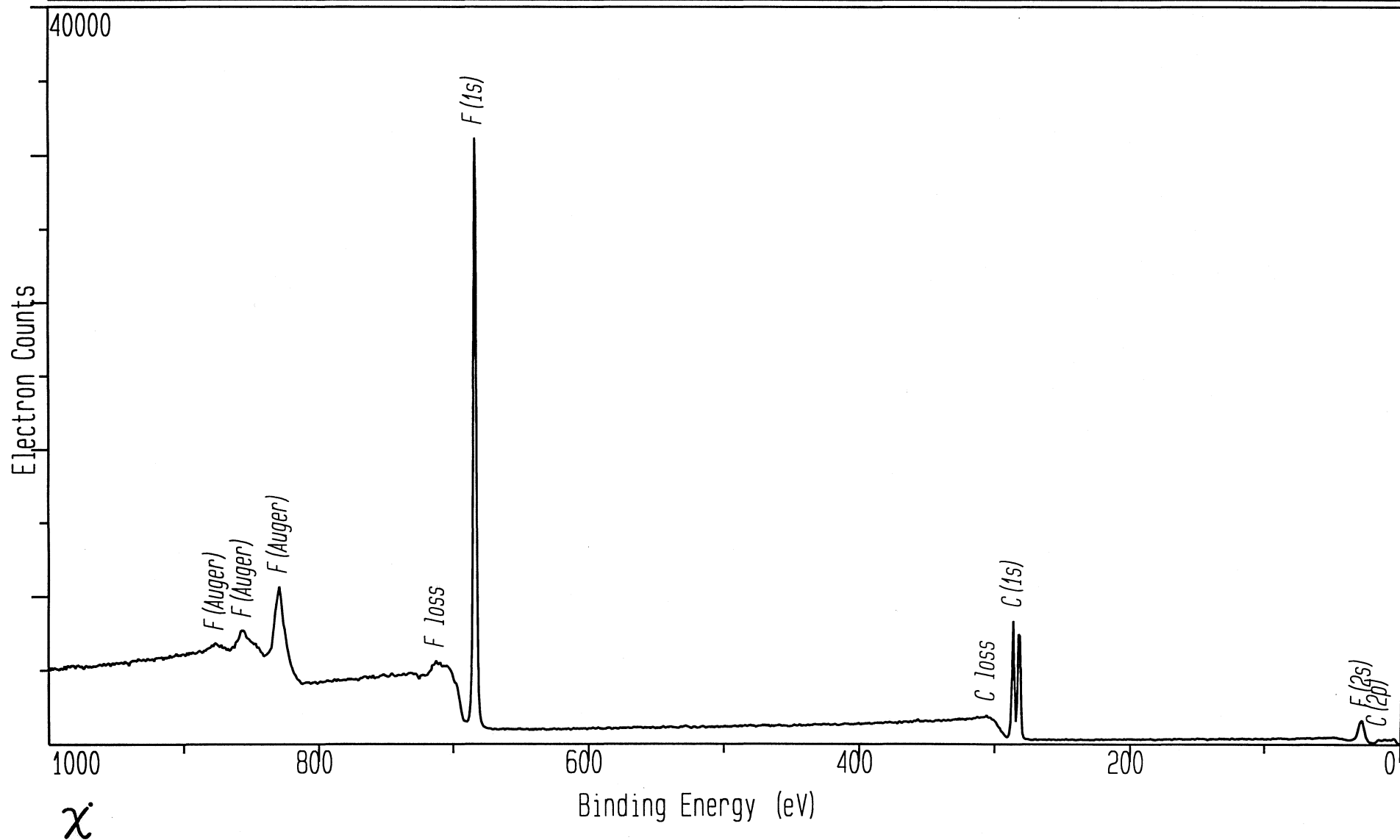
Poly - Vinylidene di-Fluoride (PVDF)

Detailed Surface Composition Table

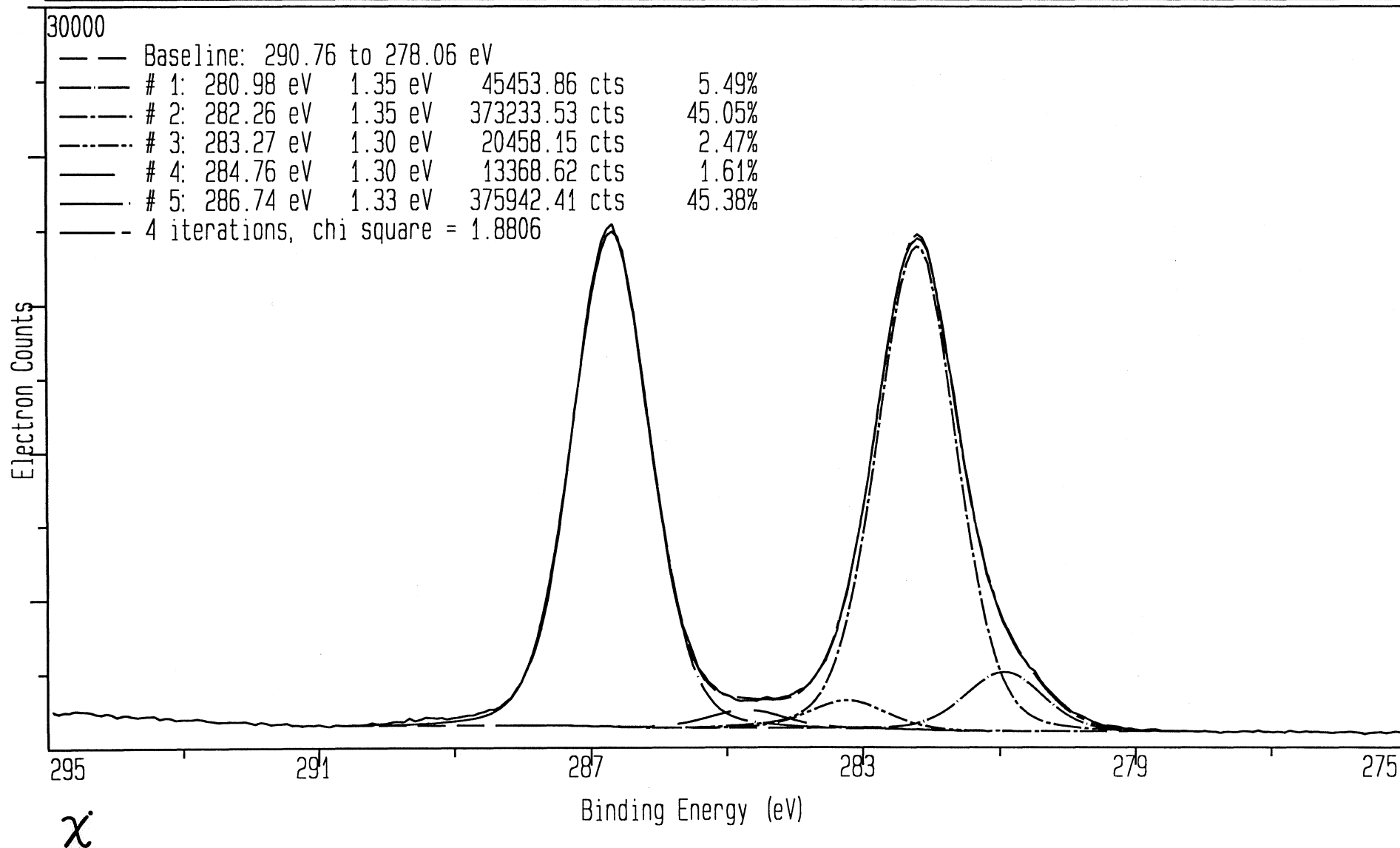
File name: PVDF.MRS
Region: 1
Description: POLY-VINYLLIDENE di-FLUORIDE (PVDF) (90 TOA, POWDER)
X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)
Operator: BVC
Date: Mon Mar 28 1988

Signal	Corrected BE	Exper. BE	Sens Factor	Norm Area	Relative Area	Atom %
F Auger	875.4	876.2	0.10	3567	35793	
F Auger	854.8	855.5	0.00	14303	0	
F Auger	828.1	828.8	0.00	46616	0	
F loss	711.6	712.3	0.00	4917	0	
* F 1s	682.9	683.6	2.84	112721	39657	52.28
C loss	304.6	305.4	0.00	7226	0	
* C 1s	285.0	285.8	1.00	36165	36204	47.72
F 2s	27.0	27.8	0.26	7592	29217	
C 2s	14.5	15.3	0.19	542	2893	

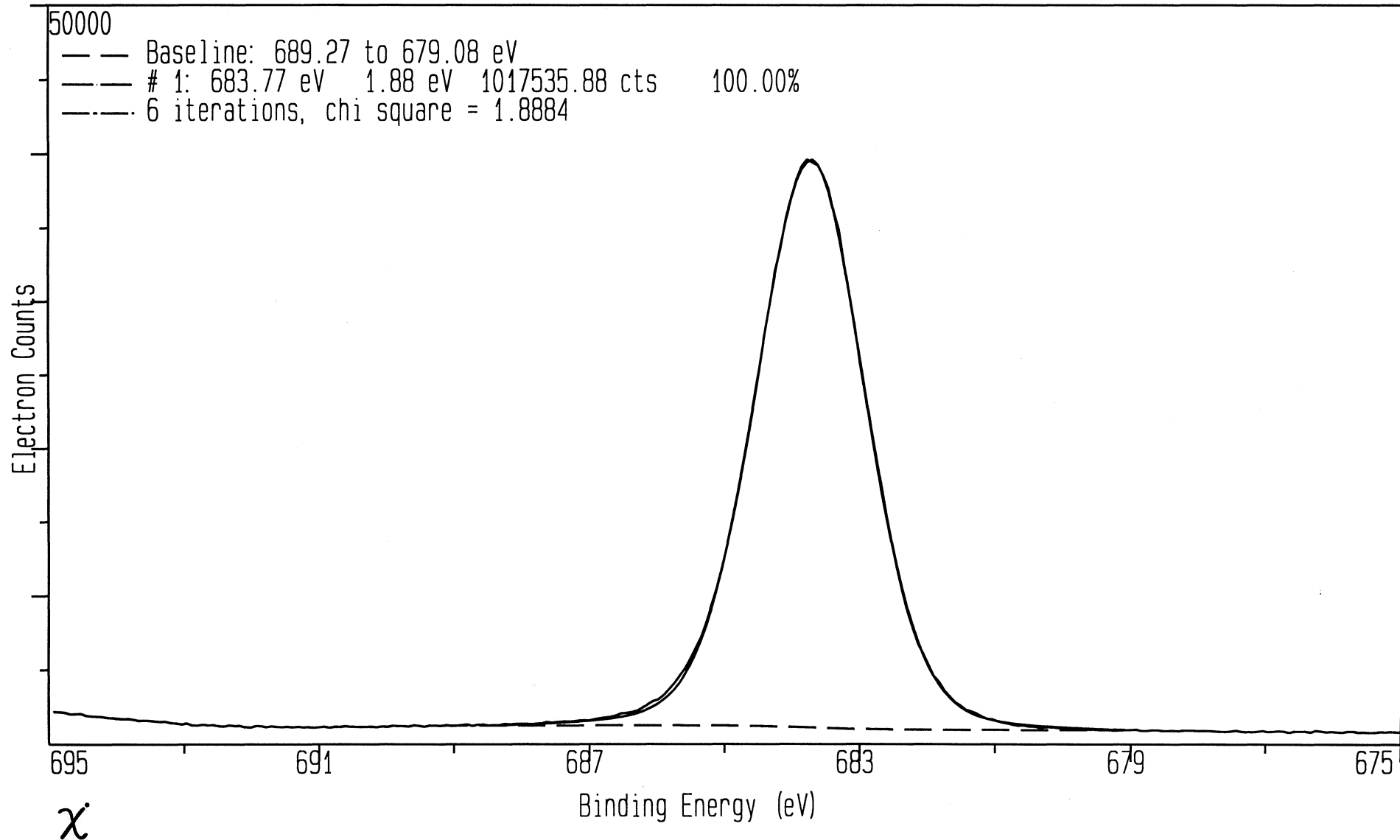
File: PVDF Region: 1	Spot: 600 Resolution: 4	Flood Gun: 4.0 Scans, Time: 4	Data Points: 1024 Time/Point: 200	Date: 3/28/1988 Operator: BVC
Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



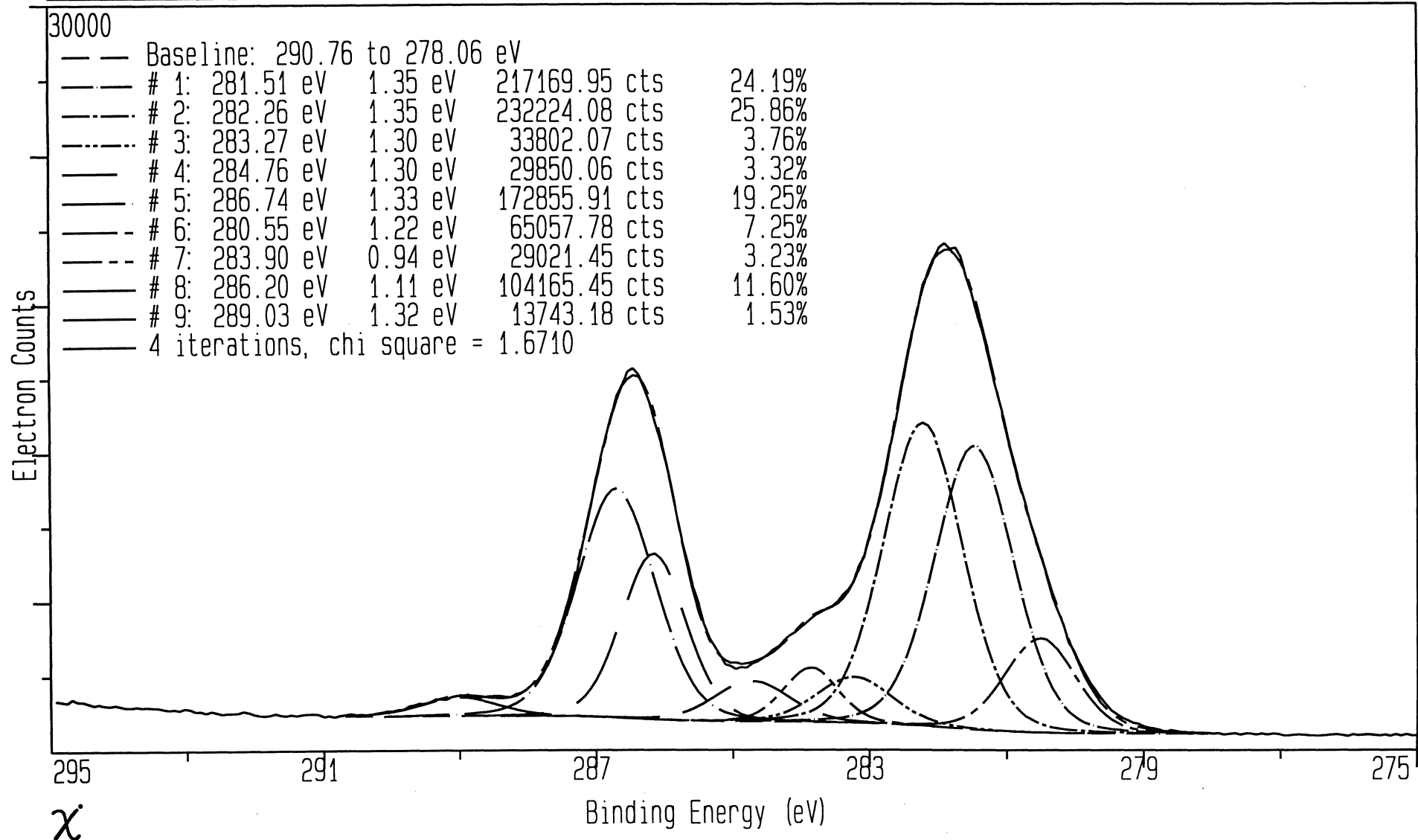
File: PVDF	Spot: 600	Flood Gun: 4.0	Data Points: 256	Date: 3/28/1988
Region: 2	Resolution: 2	Scans, Time: 60	Time/Point: 200	Operator: BVC
Sample Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



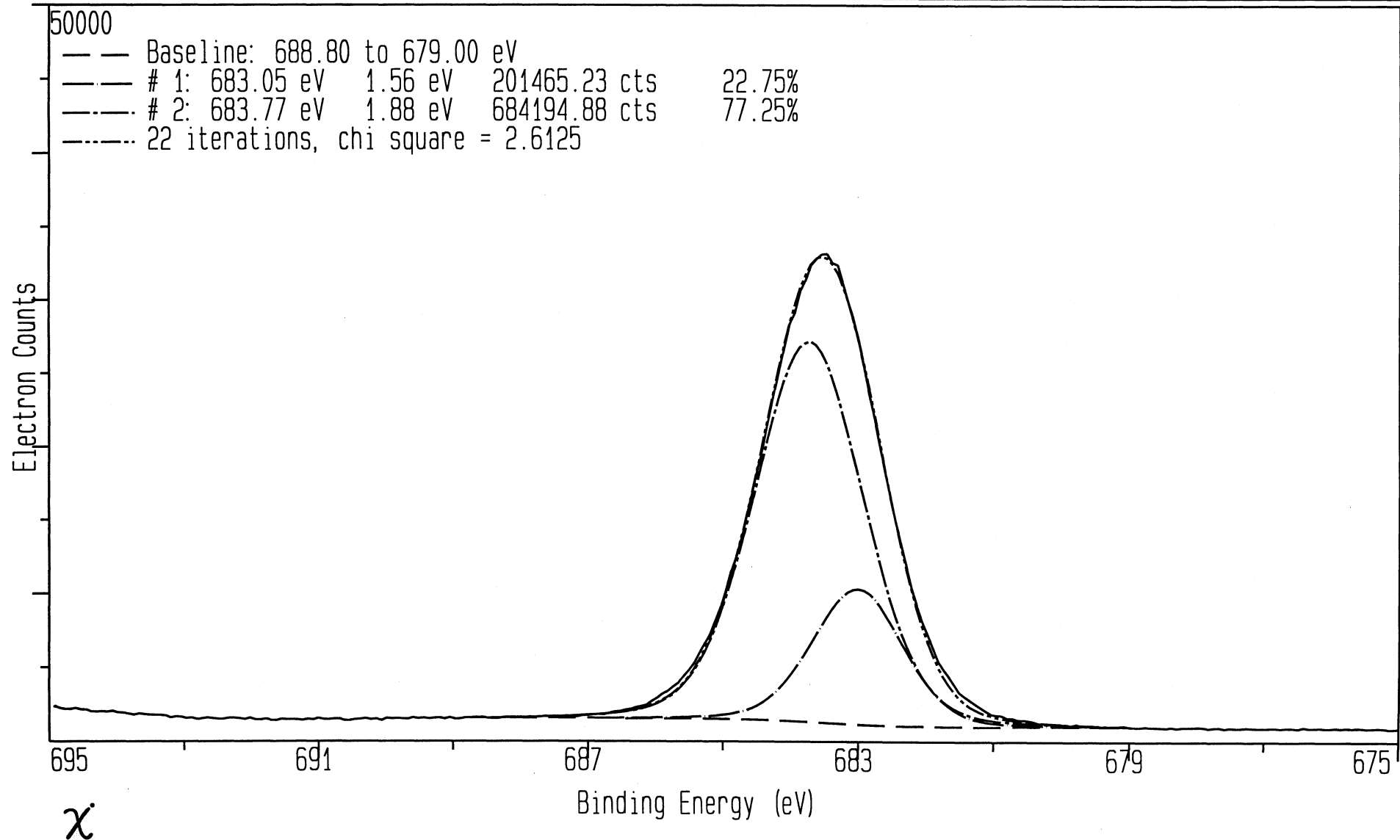
File: PVDF	Spot: 600	Flood Gun: 4.0	Data Points: 256	Date: 3/28/1988
Region: 3	Resolution: 2	Scans, Time: 20	Time/Point: 200	Operator: BVC
Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



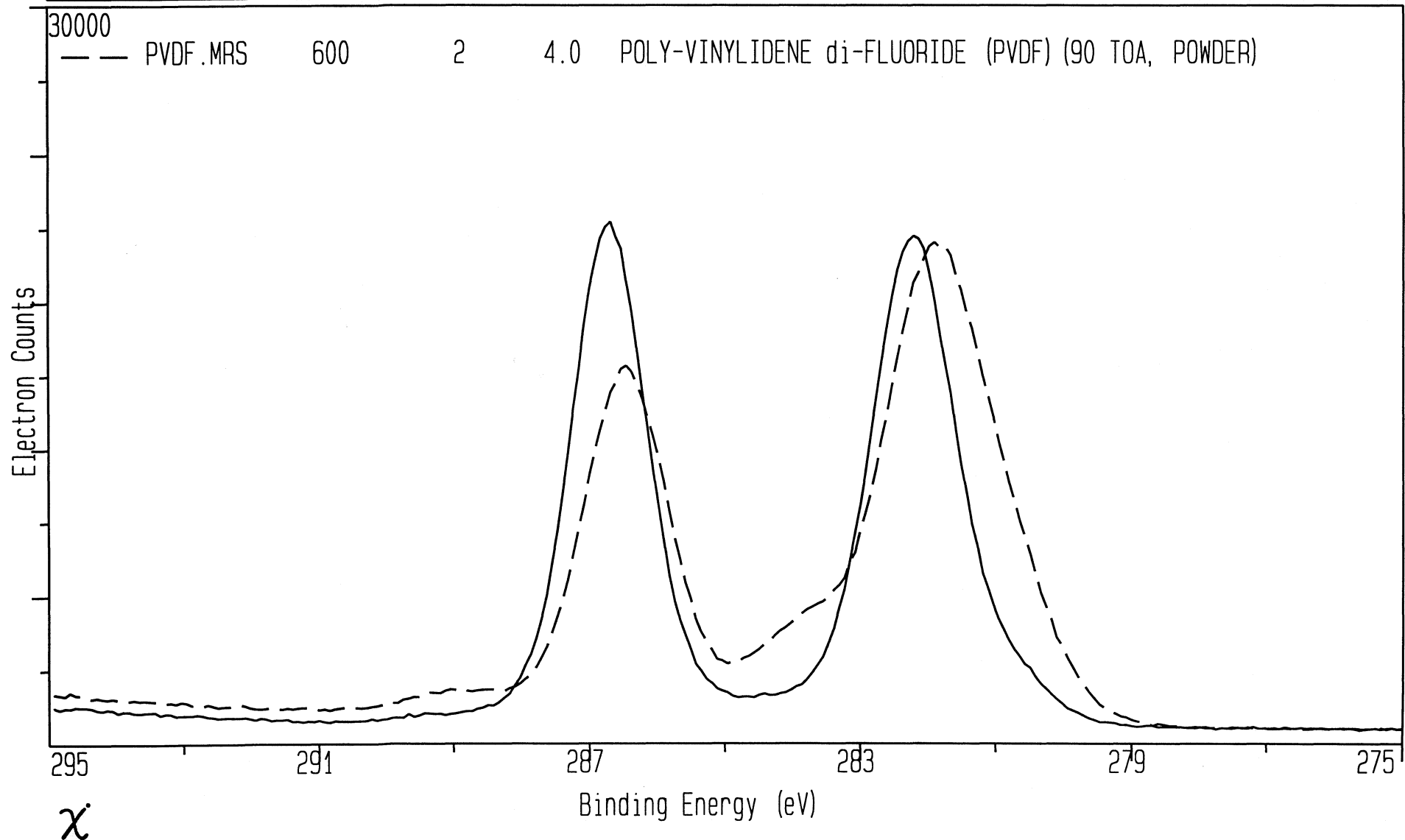
File: PVDF Region: 18	Spot: 600 Resolution: 2	Flood Gun: 4.0 Scans, Time: 60	Data Points: 256 Time/Point: 200	Date: 3/28/1988 Operator: BVC
Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



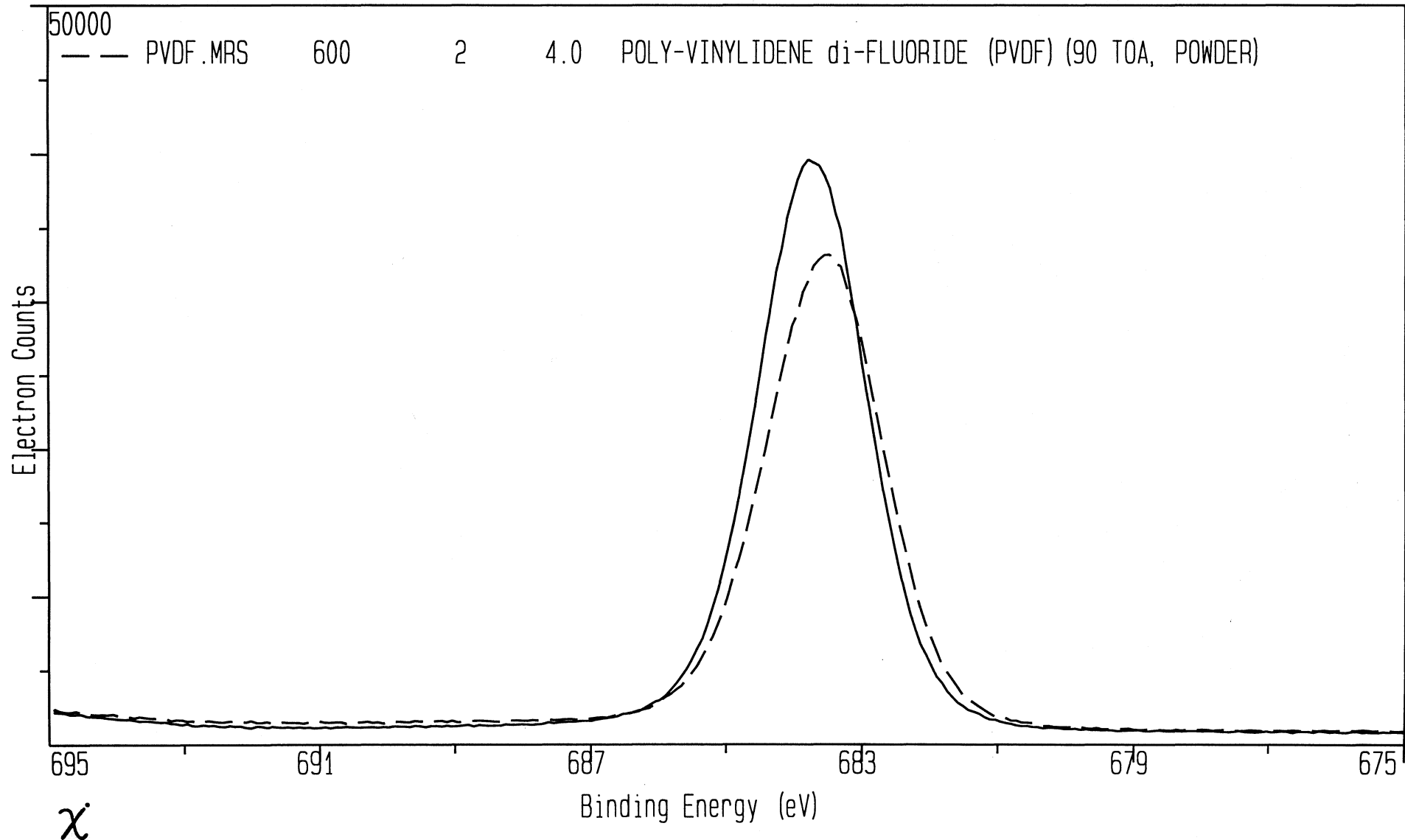
File: PVDF Region: 19	Spot: 600 Resolution: 2	Flood Gun: 4.0 Scans, Time: 20	Data Points: 256 Time/Point: 200	Date: 3/28/1988 Operator: BVC
Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



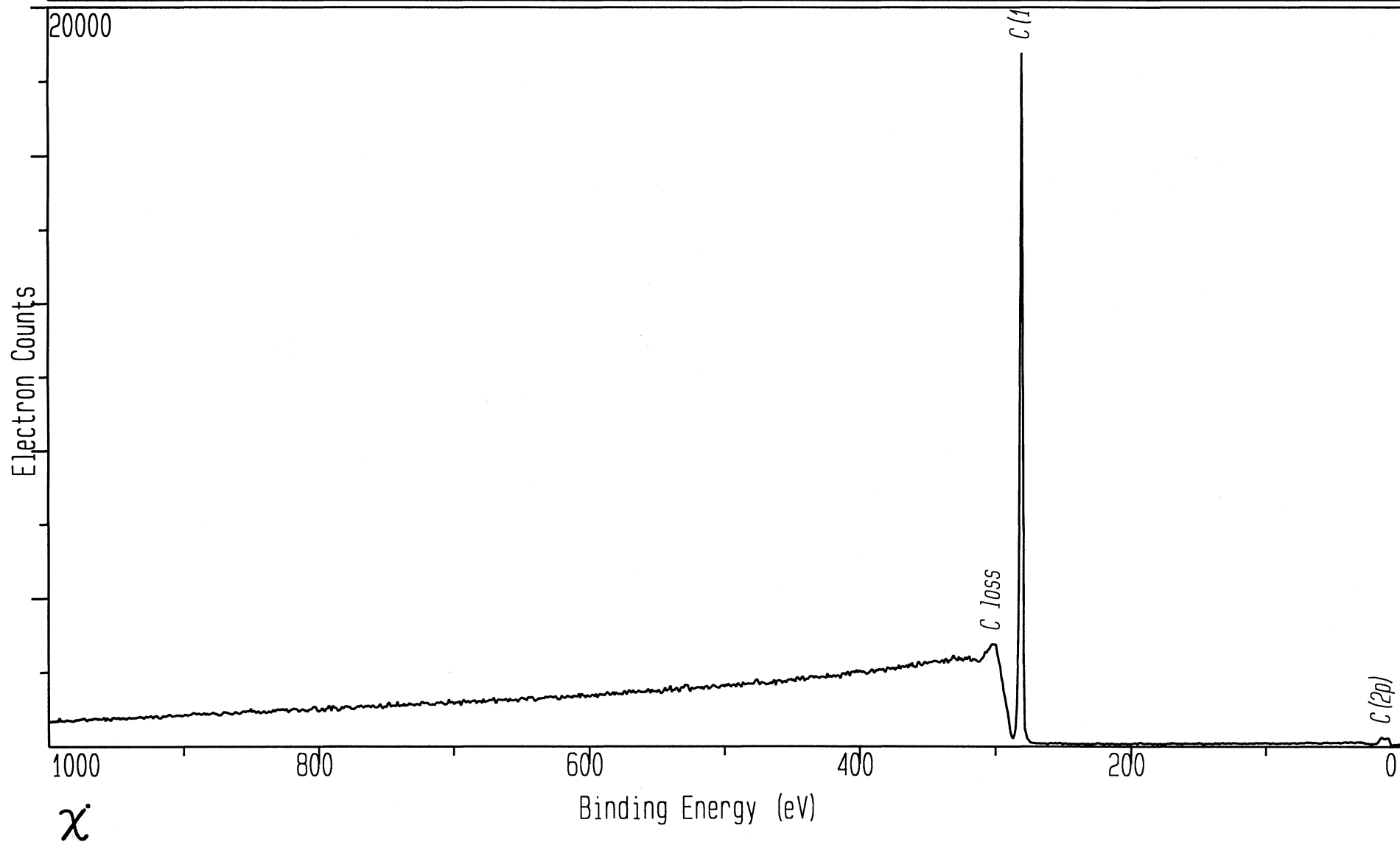
File: PVDF	Spot: 600	Flood Gun: 4.0	Data Points: 256	Date: 3/28/1988
Region: 2	Resolution: 2	Scans, Time: 60	Time/Point: 200	Operator: BVC
Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



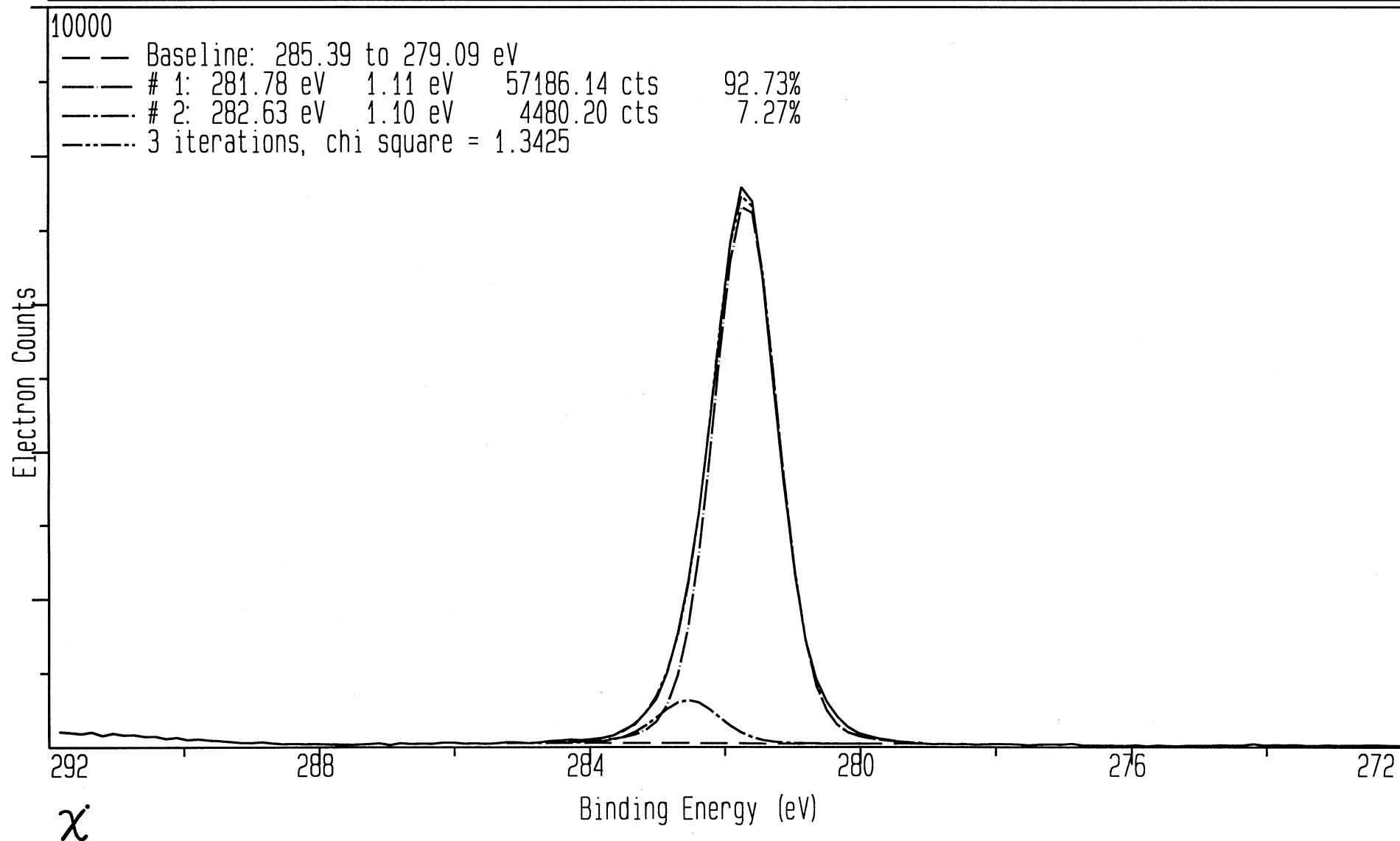
File: PVDF	Spot: 600	Flood Gun: 4.0	Data Points: 256	Date: 3/28/1988
Region: 3	Resolution: 2	Scans, Time: 20	Time/Point: 200	Operator: BVC
Description: POLY-VINYLDENE di-FLUORIDE (PVDF) (90 TOA, POWDER) X-RAY DAMAGE STUDY, SOURCE: SPP, INC. (MESH AT 1MM)				



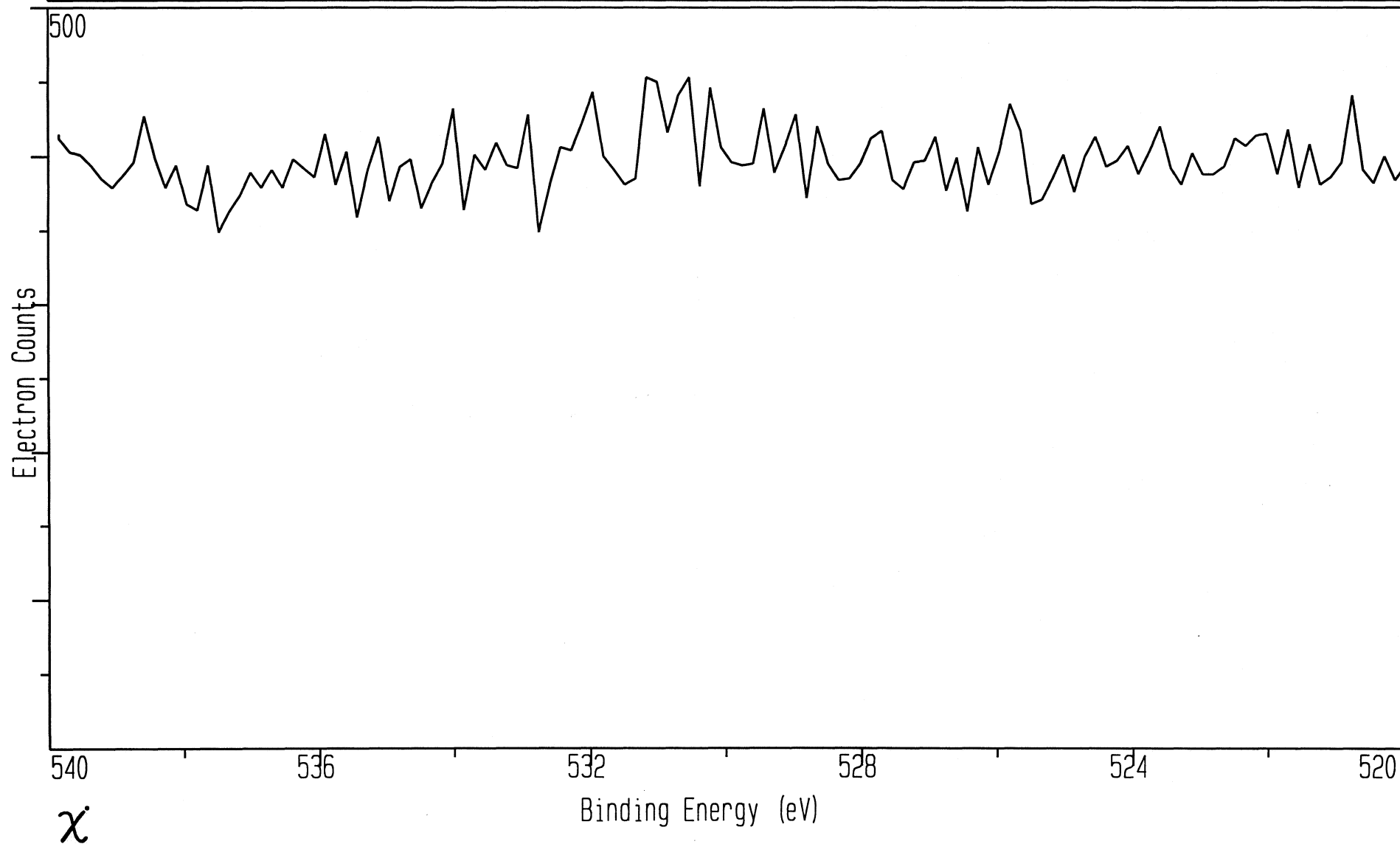
File: ZIPLOC	Spot: 600	Flood Gun: 2.0	Data Points: 1024	Date: 11/2/1985
Region: 1	Resolution: 4	Scans, Time: 4	Time/Point: 200	Operator: BVC
Description: ZIPLOC SANDWICH BAG (INTERIOR, no mesh) (null)				



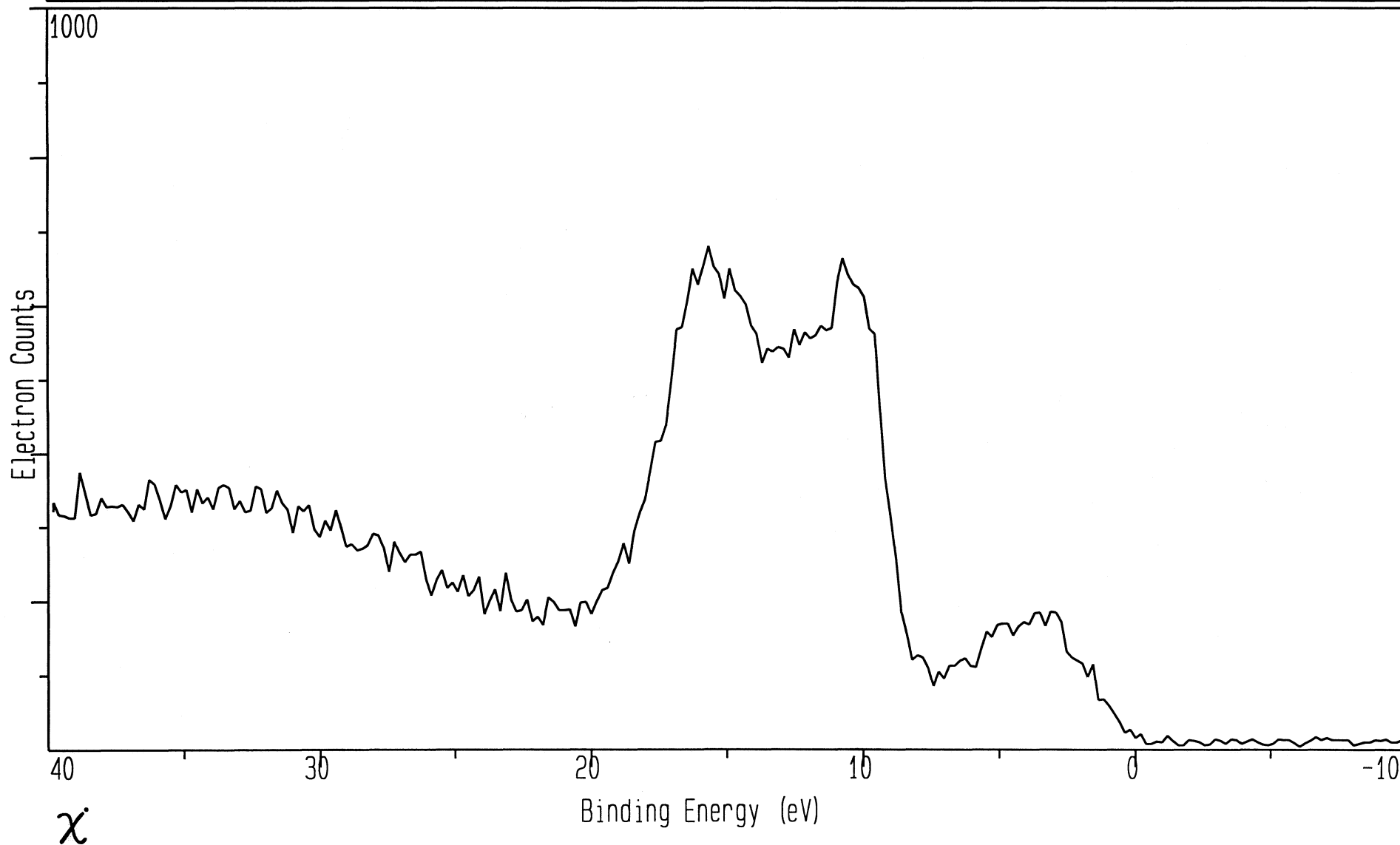
File: ZIPLOC	Spot: 300	Flood Gun: 2.0	Data Points: 128	Date: 11/2/1985
Region: 3	Resolution: 2	Scans, Time: 6	Time/Point: 200	Operator: BVC
Description: ZIPLOC SANDWICH BAG (INTERIOR, no mesh) (null)				



File: ZIPLOC	Spot: 300	Flood Gun: 2.0	Data Points: 128	Date: 11/2/1985
Region: 4	Resolution: 2	Scans, Time: 6	Time/Point: 200	Operator: BVC
Description: ZIPLOC SANDWICH BAG (INTERIOR, no mesh) (null)				



File: ZIPLOC	Spot: 600	Flood Gun: 2.0	Data Points: 256	Date: 11/2/1985
Region: 2	Resolution: 4	Scans, Time: 10	Time/Point: 200	Operator: BVC
Description: ZIPLOC SANDWICH BAG (INTERIOR, no mesh) (null)				



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APPENDIX “A”

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POLYMERS & POLYMERS DAMAGED BY X-RAYS

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